

# HMC-MD777

## SERVICE MANUAL

E Model

**Self Diagnosis**  
Supported model

Ver. 1.2 2006.09



HMC-MD777 is the CD player and MD Deck section in DHC-MD777.

U.S. and foreign patents licensed from Dolby Laboratories Licensing Corporation.

CD Section	Model Name Using Similar Mechanism	NEW
	CD Mechanism Type	CDM53-K1BD33
	Base Unit Name	BU-K1BD33
	Optical Pick-up Name	KSM-213BFN
MD Section	Model Name Using Similar Mechanism	HCD-MD515
	MD Mechanism Type	MDM-C1F
	Base Unit Name	MBU-C1F
	Optical Pick-up Name	KMS-260B

### SPECIFICATIONS

#### CD player section

System	Compact disc and digital audio system
Laser	Semiconductor laser ( $\lambda = 780 \text{ nm}$ ) Emission duration: continuous Max. $44.6 \mu\text{W}^*$
Laser output	* This output is the value measured at a distance of 200 mm from the objective lens surface on the Optical Pick-up Block with 7 mm aperture.
Frequency response	2 Hz to 20 kHz

#### MD deck section

System	MiniDisc digital audio system
Laser	Semiconductor laser ( $\lambda = 780 \text{ nm}$ ) Emission duration: continuous Max. $44.6 \mu\text{W}^*$
Laser output	* This output is the value measured at a distance of 200 mm from the objective lens surface on the Optical Pick-up Block with 7 mm aperture.

#### Inputs

OPTICAL IN (square optical connector jack):	voltage 250 mV, impedance 47 kilohms
MD IN (phono jacks):	voltage 250 mV, impedance 47 kilohms
MD WALKMAN LINK IN (stereo mini jack):	voltage 150 mV, impedance 15 ohms

#### Outputs

CD OUT, MD OUT (phono jacks):	voltage 250 mV, impedance 1 kilohm
Recording time	74 minutes max. (using MDW-74)
Sampling frequency	44.1 kHz
Frequency response	5 Hz to 20 kHz
Dimensions (w/h/d) incl. projecting parts and controls	215 x 220 x 355 mm
Mass	4.6 kg

Design and specifications are subject to change without notice.

## CD PLAYER/MINI DISC DECK

## SELF-DIAGNOSIS FUNCTION

### MD SECTION

The self-diagnosis function consists of error codes for customers which are displayed automatically when errors occur, and error codes which show the error history in the test mode during servicing. For details on how to view error codes for the customer, refer to the following box in the instruction manual. For details on how to check error codes during servicing, refer to the following "Procedure for using the Self-Diagnosis Function (Error History Display Mode)".

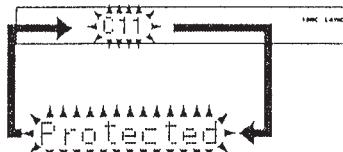
### Self-diagnosis Display Function

(If a 3-digit code and a message appear alternately)

This system has a Self-diagnosis display function that alternately displays a 3-digit code and a message to inform you when it is not operating properly.

Check the display, then perform the measures in the table below to remedy the problem.

Should any problem persist even after two or three times, consult your nearest Sony dealer.



Code/Message	Cause and countermeasure
C11/Protected	The inserted disc is protected against erasure. → Eject the disc, then slide the tab closed to cover the hole (see page 36).
C12/Cannot Copy	You are attempting to play a CD or MD with a format that the system does not support, such as a CD-ROM or MD data. → Insert a CD or MD that is playable.
C13/REC Error	Recording could not be performed properly. → Move the system to a place without vibration, then start recording over from the beginning (see the MD item "The sound skips." under "Troubleshooting" on page 89).  The disc is dirty (e.g., oil film, fingerprints) or scratched, or a non-standard disc is inserted in the deck. → Replace the disc, then start recording over from the beginning.
C13/Read Error	The disc could not be read properly. → Eject the disc, then insert it again.
C14/Toc Error	The disc could not be read properly. → Insert a different disc. → If the entire contents of the disc may be erased, use the All Erase Function to erase all the recorded contents (see page 56).
C41/Cannot Copy	The sound source is a copy of a commercially available music software. → The Serial Copy Management System prevents you from making a digital copy (see page 88).
C71/Check OPT-IN	This may appear momentarily and then disappear depending on the digital broadcast signal being recorded. There is no effect on the recording contents.  The optical cable was pulled out or the connected digital component was turned off during digital recording from a component connected to the OPTICAL IN input jack. → Connect the optical cable, or turn on the digital component.

### PROCEDURE FOR USING THE SELF-DIAGNOSIS FUNCTION (ERROR HISTORY DISPLAY MODE)

**Note:** Perform the self-diagnosis function in the "error history display mode" in the test mode. The following describes the least required procedure. Be careful not to enter other modes by mistake. If you set other modes accidentally, press the [MENU/NO] button to exit the mode.

1. While pressing the both [ENTER/YES] and [ ] buttons, turn the power ON. ("TEMP CHECK" will be displayed)
2. Press the [MENU/NO] button to display "[CHECK]".
3. Turn the [ ] dial and when "[Service]" is displayed, press the [ENTER/YES] button.
4. Turn the [ ] dial to display "ERR DP MODE" (C17).
5. Press the [ENTER/YES] button to sets the error history mode and displays "total rec".
6. Select the contents to be displayed or executed using the [ ] dial.
7. Press the [MD WALKMAN SYNC] button to display or execute the contents selected.
8. Press the [MD WALKMAN SYNC] button again and returns to step 5.
9. When press the [MENU/NO] button to displays "ERROR DP MODE", exits the error history mode.
10. To exit the test mode, press the [REPEAT] button. The disc is ejected when loaded, and set will be normal mode.

## Items of Error History Mode Items and Contents

Display	Details of History
total rec	Displays the recording time. Displayed as “r□□□□□□h”. The displayed time is the total time the laser is set to the high power state. This is about 1/4 of the actual recording time. The time is displayed in decimal digits from 0h to 65535h.
total play	Displays the play time. Displayed as “p□□□□□□h”. The time displayed is the total actual play time. Pauses are not counted. The time is displayed in decimal digits from 0h to 65535h.
retry err	Displays the total number of retries during recording and number of retry errors during play. Displayed as “r□□ p□□”. “r” indicates the retries during recording while “p” indicates the retry errors during play. The number of retries and retry errors are displayed in hexadecimal digits from 00 to FF.
total err	Displays the total number of errors. Displayed as “total □□”. The number of errors is displayed in hexadecimal digits from 00 to FF.
err history	Displays the 10 latest errors. Displayed as “0□ E@@”. □ indicates the history number. The smaller the number, the more recent is the error. (00 is the latest). @@ indicates the error code. Refer to the following table for the details. The error history can be switched by turning the [◀◀◀▶▶] dial.
er refresh (*1)	Mode which erases the “retry err”, “total err”, and “err history” histories When returning the unit to the customer after completing repairs, perform this to erase the past error history. After pressing the [MD WALKMAN SYNC] button and “er refresh?” is displayed, press the [ENTER/YES] button to erase the history. “Complete!” will be displayed momentarily. Be sure to check the following when this mode has been executed. <ul style="list-style-type: none"><li>• The data has been erased.</li><li>• The mechanism operates normally when recording and play are performed.</li></ul>
tm refresh (*1)	Mode which erases the “total rec” and “total play” histories. These histories serve as approximate indications of when to replace the optical pickup. If the optical pickup has been replaced, perform this operation and erase the history. After pressing the [MD WALKMAN SYNC] button and “tm refresh?” is displayed, press the [ENTER/YES] button to erase the history. “Complete!” will be displayed momentarily. Be sure to check the following when this mode has been executed. <ul style="list-style-type: none"><li>• The data has been erased.</li><li>• The mechanism operates normally when recording and play are performed.</li></ul>

(\*1) If “err refresh” or “tm refresh” is performed, the error history data are all erased. Only when “OP Replacement” was executed, perform this operation to clear the error history data, otherwise, never perform this operation.

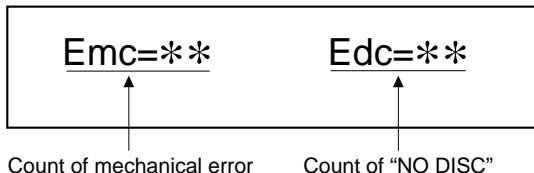
## Table of Error Codes

Error Code	Details of Error	Error Code	Details of Error
0□ E00	No error	0□ E05	FOK has deviated
0□ E01	Disc error. PTOC cannot be read (DISC ejected)	0□ E06	Cannot focus (Servo has deviated)
		0□ E07	Recording retry
0□ E02	Disc error. UTOC error (DISC not ejected)	0□ E08	Recording retry error
		0□ E09	Playback retry error (Access error)
0□ E03	Loading error	0□ E0A	Playback retry error
0□ E04	Address cannot be read (Servo has deviated)		

## CD SECTION

### OPERATING THE DISPLAYED HISTORIES

- Press the [PLAY MODE] and [REPEAT] button simultaneously, and the count of mechanical error and “NO DISC” that optical system judged are displayed.

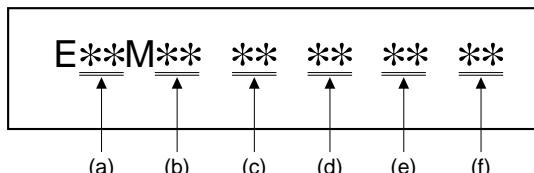


- Under this condition press the buttons in Table 1, and the respective operations are executed as listed below.

**Table 1.**

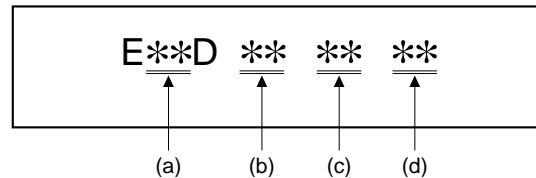
Button	Function
CD 1	Mechanical error code from latest one to last ten are displayed each time this button is pressed. (*1)
CD 2	The reasons of “NO DISC” from latest one to last ten are displayed each time this button is pressed. (*2)
△ (CD1)	Reset the count of mechanical error.
△ (CD2)	Reset the count of “NO DISC”.

(\*1) Mechanical error code



- The number of Mechanical error.  
Latest one “00” to last ten “09”  
(Turn the [◀◀◀▶▶] dial and change the error No.)
- “FF” : Mechanical error, when mechanical initialize to completion.
- “1\*” { : Mechanical error in the midst of sub tray loading  
“2\*” } from the stocker.
- “\*\*” : Don’t care. (not used in servicing)
- “2\*” : Mechanical error in the midst of the stocker up/down.
- “2\*” : Mechanical error of the clamper or in the midst of changing the mode.

(\*2) NO DISC error code



- The number of NO DISC error.  
Latest one “00” to last ten “09”  
(Turn the [◀◀◀▶▶] dial and change the error No.)
- “01”: Focus error  
“02”: GFS error  
“03”: Set up error
- “00”: NO DISC error (Did not chucking retry)  
“02”: NO DISC error (Chuckng retry to completion)
- The status, when judged NO DISC error.  
“1\*” : Stop  
“2\*” : Set up  
“3\*” : TOC read  
“4\*” : Access  
“5\*” : Play  
“6\*” : Pause  
“7\*” : Manual search (Play)  
“8\*” : Manual search (Pause)

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# SECTION 1

## SERVICING NOTES

### NOTES ON HANDLING THE OPTICAL PICK-UP BLOCK OR BASE UNIT

The laser diode in the optical pick-up block may suffer electrostatic break-down because of the potential difference generated by the charged electrostatic load, etc. on clothing and the human body.

During repair, pay attention to electrostatic break-down and also use the procedure in the printed matter which is included in the repair parts.

The flexible board is easily damaged and should be handled with care.

### NOTES ON LASER DIODE EMISSION CHECK

The laser beam on this model is concentrated so as to be focused on the disc reflective surface by the objective lens in the optical pick-up block. Therefore, when checking the laser diode emission, observe from more than 30 cm away from the objective lens.

### LASER DIODE AND FOCUS SEARCH OPERATION CHECK

Carry out the "S curve check" in "CD section adjustment" and check that the S curve waveforms is output three times.

### Notes on chip component replacement

- Never reuse a disconnected chip component.
- Notice that the minus side of a tantalum capacitor may be damaged by heat.

### Flexible Circuit Board Repairing

- Keep the temperature of the soldering iron around 270 °C during repairing.
- Do not touch the soldering iron on the same conductor of the circuit board. (within 3 times)
- Be careful not to apply force on the conductor when soldering or unsoldering.

#### Note:

Be sure to connect all wires (including FFC) in the MD section before applying power or ICs may be damaged.

### CAUTION

Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

This appliance is classified as a CLASS 1 LASER product. The CLASS 1 LASER PRODUCT MARKING is located on the rear exterior.

CLASS 1 LASER PRODUCT  
LUOKAN 1 LASERLAITE  
KLASS 1 LASERAPPARAT

Laser component in this product is capable of emitting radiation exceeding the limit for Class 1.

The following caution label is located inside the unit.

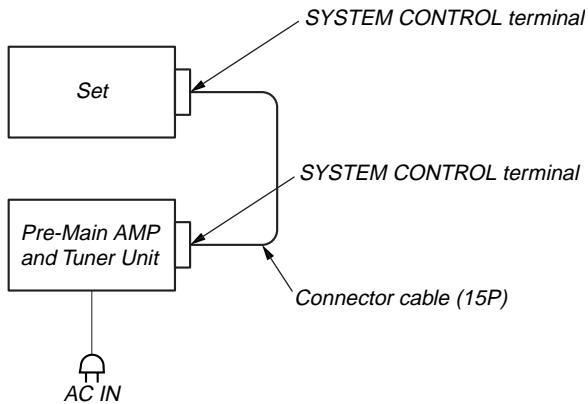
CAUTION : INVISIBLE LASER RADIATION WHEN OPEN AND INTERLOCKS DEFECTED. AVOID EXPOSURE TO BEAM.  
ADVARSEL : USYNLIG LASERSTRÅLING VED ÅBNING NÅR SIKKERHEDSAFTRYDRE ER UDE AF FUNKTION. UNDGÅ UDSAETTELSE FOR STRÅLING.  
VORSICHT : UNSICHTBARE LASERSTRÄHLUNG, WENN ABDECKUNG GEÖFFNET UND SICHEREITSVERREGELUNG ÜBERBRÜCKT. NICHT DEM STRAHL AUSSETZEN.  
VARO! : AVATTESSA JA SUOJALUKITUS OHJETTAESSA OLET ALTINA NÄKYMÄTTÖMÄLLE LASERSATEILYLLÉ. ÄLÄ KATSO SÄTEESEEN.  
WARNING : OSYNLIG LASERSTRÅLING NÅR DENNA DEL ÄR ÖPPNAD OCH SPÄRREN AR URKOPPLAD, BETRÄKTA EJ STRÅLEN.  
ADVERSEL : USYNLIG LASERSTRÅLING NÅR DEKSEL ÄPNES OG SIKKERHEDSLÅS BYTES. UNNGÅ EKSPOSERING FOR STRÅLEN.  
VÍGYAZÁT! : A BURKOLAT NYÍTÁSAKOR LÁTHATATLAN LÉZERSUGÁRVEZSÉLY! KERÜLJE A BESUGÁRZÁST!

### SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY A △ MARK ON THE SCHEMATIC DIAGRAMS, EXPLODED VIEWS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

## POWER SUPPLY DURING SERVICING

- As this set has not own power supply, it does not operate independently. Therefore, during servicing, connect it to the Pre-Main amplifier and Tuner Unit (STR-MD777) of DHC-MD777.



If STR-MD777 are not available, use the Power Feed Jig (PFJ-1) and Relay Connector Jig.

In this case, after turn on the POWER switch on the Power Feed Jig, supply power with the following methods.

### - CD Section -

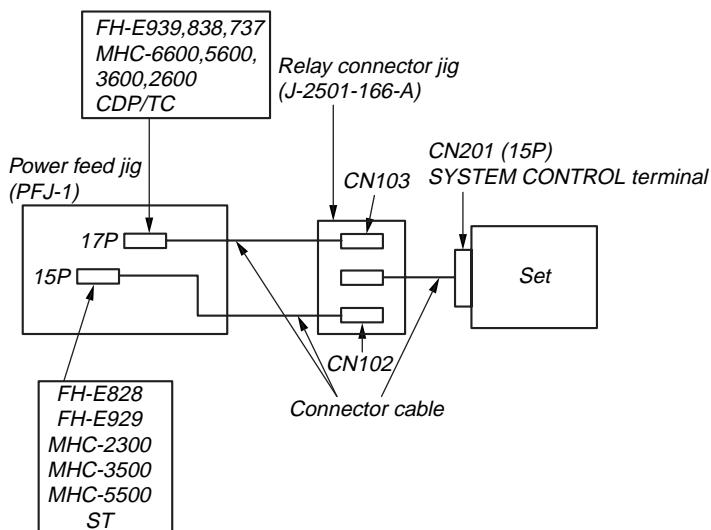
Press the [REPEAT] and [1/ALL] buttons simultaneously.  
(Power is turned off, when press the [CLEAR] and [1/ALL] button simultaneously)

### - MD Section -

Insert the disc in the any MD disc slot.

**Note:** Enter the test mode, when Insert the disc while pressing the both [ENTER/YES] and [ ] buttons  
(or [ENTER/YES] button only).

### Connection:

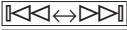


## MD SECTION

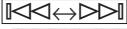
### IOP DATA RECORDING AND DISPLAY WHEN PICK-UP AND NON-VOLATILE MEMORY (IC171 ON BD (MD) BOARD) ARE REPLACED

The IOP value labeled on the pick-up can be recorded in the non-volatile memory. By recording the value, it will eliminate the need to look at the value on the label of the optical pick-up. When replacing the pick-up or non-volatile memory (IC171 on BD (MD) board), record the IOP value on the pick-up according to the following procedure.

#### Record Procedure:

1. Enter the test mode. (See the “SECTION 5 TEST MODE” for detail of test mode)
2. Turn the  dial to display “[Service]”, and press the **[ENTER/YES]** button.
3. Turn the  dial to display “Iop.Write” (C28), and press the **[ENTER/YES]** button.
4. The display becomes “Ref=@@.@@” (@ is an arbitrary number) and the numbers which can be changed will blink.
5. Input the IOP value written on the optical pick-up.  
To select the number: Turn the  dial.  
To select the digit : Press the **[MD WALKMAN SYNC]** button.
6. When the **[ENTER/YES]** button is pressed, the display becomes “Measu=@@.@@” (@ is an arbitrary number).
7. As the adjustment results are recorded for the step 6. value. Leave it as it is and press the **[ENTER/YES]** button.
8. “Complete!” will be displayed momentarily. The value will be recorded in the non-volatile memory and the display will become “Iop Write”.
9. Press the **[REPEAT]** button to complete, and the set returns to normal mode.

#### Display Precedure:

1. Enter the test mode. (See the “SECTION 5 TEST MODE” for detail of test mode)
2. Turn the  dial to display “[Service]”, and press the **[ENTER/YES]** button.
3. Turn the  dial to display “Iop Read” (C27).
4. Press the **[ENTER/YES]** button. “@@.@@/#.#” is displayed and the recorded contents are displayed.  
@@.@@ : indicates the Iop value labeled on the pick-up.  
#.# : indicates the Iop value after adjustment
5. To end, press the **[MENU/NO]** button to display “Iop Read”. Then press the **[REPEAT]** button, and the set returns to normal mode.

## DISPLAY TEST MODE

This mode is test for fluorescent indicator tube, LED, buttons and jog dial.

This mode can not exit in the middle of the test, therefore finish the test when enter this mode.

### Fluorescent Indicator Tube and Buttons Test Mode

1. While pressing the both **[ENTER/YES]** and **[REC]** buttons, turn the power ON.
2. After display “FL AllOn key”, lights up all segments on fluorescent indicator tube immediately.
3. Press every buttons of except **[MD WALKMAN SYNC]** button on the MD section, then each segment goes off and remain the “L-SYNC”.
4. Press the **[MD WALKMAN SYNC]** button to display “Push YES”.
5. Press the **[ENTER/YES]** button and switch over to next check mode “5x7 Segments on Fluorescent Indicator Tube check”.

### 5x7 Segments on Fluorescent Indicator Tube Check Mode

1. After display “Seg Chk”, 5x7 segments part changes to display mesh pattern immediately.
2. Press the **[ENTER/YES]** button to display “Jog & LED”, and switch over to next check mode “JOG & LED Check”.

### JOG & LED Check Mode

1. Each time the  dial is turned, **[MD WALKMAN SYNC]** LED lights on/off and **[MD1-5]** LED color changes into green/amber.
2. Press the **[ENTER/YES]** button to display “Check End!”.

### Exiting or Repeat the Display Test Mode

Press the **[ENTER/YES]** button: Exit to “Display Test Mode” and enter the other test mode.

Press the **[MENU/NO]** button : Repeat the “Display Test Mode”

## AGING MODE

Record 5 seconds repeat to each five discs.

**Note:** Aging mode can not perform, if disconnect to the pre-main amplifier and tuner unit (STR-MD777) of DHC-MD777.

### Setting the Aging Mode

1. Insert recordable discs in all MD disc slots.
2. Press the [▶] and [REC MODE] buttons simultaneously for a moment, then [□] and [REC] buttons simultaneously for a few seconds.
3. Enter the Aging Mode and start loading DISC1.

### Exiting the Aging Mode

Press the [MENU/NO] button.

However exiting the aging mode, it continues performing action.

### Display during the Aging Mode

Normal displays in recording, but displays as follow when change the disc.

00000 D-0;\*

**Note:** •“00000” indicates the count of complete cycle.

•“D-0” indicates disc slot No. of active disc.

•“;\*” indicates that loading is on.

### Display of error happened

Displays “00000 D-0;\*” and error message alternately when error happened.

Error Message	Contents
NG TOCWRITE	Disagree count of aging cycle and TOC.
NG CHACKING	Time over (20 seconds), when tried chucking
NG RELEAS	Time over (20 seconds), when tried eject.
MECHA ERR	Mechanical error, after retry two times.
NG RECPAUSE	Did not REC pause condition. (Head did not down, or etc.)
NG REC 5s	Could not start recording.
NG BLANK	Could not all erase.

### Clear the error

Press the [◀◀] or [CLEAR] button to clear the error, and restart the aging mode.

## CHANGER TEST MODE

### Setting Changer Test Mode

1. While pressing the both [ENTER/YES] and [▷II] buttons, turn the power ON.
2. Display “CHANGER TEST!!” and enter the changer test mode.

### Exiting the Changer Test Mode

Press the [ENTER/YES] button to normal mode.

### Operation for Changer Test Mode

Refer to the following operations, and each button except MD1 to 5 is active while it is pressed.

Function	Contents
▶▶	Elevator up. Stop when reset switch (S571) is turned on (*1)
CLEAR	Elevator down. Stop when home switch (S570) is turned on (*1)
REC	Loading in. Stop when loading in switch (S573) is turned on (*1, 2)
□	Loading out. Stop when loading out switch (S572) is turned on (*1, 2)
NAME EDIT	Head down. Stop when head down switch (S7) is turned on (*3)
1/ALL	Head up. Stop when head up switch (S6) is turned on (*3)
MD1 to 5	Elevator up/down to each MD slot (slit) position (*1)

\*1) Can not operation, when head is down (S6: off).

\*2) Make it sure to perform these operations after pressing the MD1 to 5 button and elevator up/down to each MD slot position.

\*3) Make it sure to perform these operations are after elevator down to home position (bottom). Because, these operations no have relation to with the elevator position.

### LED Indication

LEDs of MD1 to 5 turn on (green) when press MD1 to 5 button and elevator up/down to each MD slot position. (Once turned on LED does not turn off until exit the changer test mode)

When insert disc in the disc slot and disc1 to 5 switch (S1 to 5) turn on, change the color to amber.

## CHECKS PRIOR TO PARTS REPLACEMENT AND ADJUSTMENTS

Before performing repairs, perform the following checks to determine the faulty locations up to a certain extent.  
Details of the procedures are described in “5 Electrical Adjustments”.

	Criteria for Determination (Unsatisfactory if specified value is not satisfied)	Measure if unsatisfactory:
Laser power check (See page 33)	<ul style="list-style-type: none"> <li>• 0.9 mW power Specified value : 0.84 to 0.92 mW</li> <li>• 7.0 mW power Specified value : 6.8 to 7.2 mW</li> </ul>	<ul style="list-style-type: none"> <li>• Clean the optical pick-up</li> <li>• Adjust again</li> <li>• Replace the optical pick-up</li> </ul>
	<ul style="list-style-type: none"> <li>• Iop (at 7mW) • Labeled on the optical pickup Iop value ± 10mA</li> </ul>	<ul style="list-style-type: none"> <li>• Replace the optical pick-up</li> </ul>
Traverse check (See page 33)	<ul style="list-style-type: none"> <li>• Traverse waveform Specified value : Below 10% offset</li> </ul>	<ul style="list-style-type: none"> <li>• Replace the optical pick-up</li> </ul>
Focus bias check (See page 34)	<ul style="list-style-type: none"> <li>• Error rate check Specified value : For points a, b, and c C1 error : Below 220 AD error : Below 2</li> </ul>	<ul style="list-style-type: none"> <li>• Replace the optical pick-up</li> </ul>
C PLAY check (See page 34)	<ul style="list-style-type: none"> <li>• Error rate check Specified value:           <ul style="list-style-type: none"> <li>a. When using test disc (MDW-74/AU-1) C1 error : Below 80 AD error : Below 2</li> <li>b. When using check disc (TDYS-1) C1 error : Below 50</li> </ul> </li> </ul>	<ul style="list-style-type: none"> <li>• Replace the optical pick-up</li> </ul>
Self-recording/playback check (REC/PLAY) (See page 34)	<ul style="list-style-type: none"> <li>• CPLAY error rate check Specified value: C1 error : Below 80 AD error : Below 2</li> </ul>	<p>If always unsatisfactory:</p> <ul style="list-style-type: none"> <li>• Replace the overwrite head</li> <li>• Check for disconnection of the circuits around the overwrite head</li> </ul>
		<p>If occasionally unsatisfactory:</p> <ul style="list-style-type: none"> <li>• Check if the overwrite head is distorted</li> <li>• Check the mechanism around the sled</li> </ul>
Temperature compensation offset check (See page 35)	<ul style="list-style-type: none"> <li>• If NG, displayed as “T=@@ (#) [NG]” (@ @, # are both arbitrary numbers)</li> </ul>	<ul style="list-style-type: none"> <li>• Check for disconnection of the circuits around D101 (BD (MD) board)</li> <li>• Check the signals around IC101, IC121, CN102, CN103 (BD (MD) board)</li> </ul>

**Note:**  
The criteria for determination above is intended merely to determine if satisfactory or not, and does not serve as the specified value for adjustments.  
When performing adjustments, use the specified values for adjustments.

## CD SECTION

### CD-TEXT TEST DISC

This unit is able to display the test data (character information) written in the CD on its fluorescent indicator tube. The CD-TEXT TEST DISC (TGCS-313: 4-989-366-01) is used for checking the display. To check, perform the following procedure.

#### Checking Method:

1. Turn ON the power, set the disc to the disc tray with the “test disc” label facing up, and chuck the disc.
2. Press the  button and play back the disc.
3. The following will be displayed on the fluorescent indicator tube.  
Display: 1kHz/0 dB/ L&R
4. Turn the  dial or press the  /  (CD) button on remote commander and select the track. The text data of each track will be displayed.  
For details of the displayed contents for each track, refer to “Table 1: CD-TEXT TEST DISC TEXT Data Contents” and “Table 2: CD-TEXT TEST DISC Recorded Contents and Display”.

#### Restrictions in CD-TEXT Display

In this unit, some special characters will not be displayed properly. These will be displayed as a space or a character resembling it. For details, refer to “Table 2: CD-TEXT DISC Recorded Contents and Display”.

**Table 1: CD-TEXT TEST DISC TEXT Data Contents (TRACKS No. 1 to 41: Normal Characters)**

TRACK No.	Displayed Contents	TRACK No.	Displayed Contents
1	1kHz/0dB/L&R	22	1kHz/-90dB/L&R
2	20Hz/0dB/L&R	23	Infinity Zero w/o emphasis//L&R
3	40Hz/0dB/L&R	24	Infinity Zero with emphasis//L&R
4	100Hz/0dB/L&R	25	400Hz+7kHz(4:1)/0dB/L&R
5	200Hz/0dB/L&R	26	400Hz+7kHz(4:1)/-10dB/L&R
6	500Hz/0dB/L&R	27	19kHz+20kHz(1:1)/0dB/L&R
7	1kHz/0dB/L&R	28	19kHz+20kHz(1:1)/-10dB/L&R
8	5kHz/0dB/L&R	29	100Hz/0dB/L*
9	7kHz/0dB/L&R	30	1kHz/0dB/L*
10	10kHz/0dB/L&R	31	10kHz/0dB/L*
11	16kHz/0dB/L&R	32	20kHz/0dB/L*
12	18kHz/0dB/L&R	33	100Hz/0dB/R*
13	20kHz/0dB/L&R	34	1kHz/0dB/R*
14	1kHz/0dB/L&R	35	10kHz/0dB/R*
15	1kHz/-1dB/L&R	36	20kHz/0dB/R*
16	1kHz/-3dB/L&R	37	100Hz Squer Wave//L&R
17	1kHz/-6dB/L&R	38	1kHz Squer Wave//L&R
18	1kHz/-10dB/L&R	39	1kHz w/emphasis/-0.37dB/L&R
19	1kHz/-20dB/L&R	40	5kHz w/emphasis/-4.53dB/L&R
20	1kHz/-60dB/L&R	41	16kHz w/emphasis/-9.04dB/L&R
21	1kHz/-80dB/L&R		

**Note:** The contents of Track No. 1 to 41 are the same as those of the current TEST DISC-their titles are displayed.

**Table 2: CD-TEXT TEST DISC Recorded Contents and Display**

(In this unit, some special characters cannot be displayed. This is no a fault.)

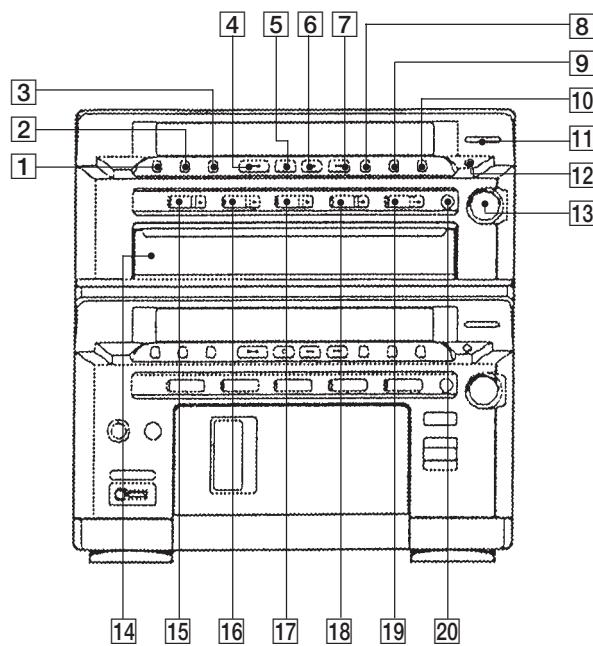
TRACK No.	Recorded contents	Display
42	! " # \$ % & ' (21h to 27h) 1kHz 0dB L&R	← All the same
43	( ) * + , - . / (28h to 2Fh)	← All the same
44	0 1 2 3 4 5 6 7 (30h to 37h)	← All the same
45	8 9 : ; < = > ? (38h to 3Fh)	← All the same
46	@ A B C D E F G (40h to 47h)	← All the same
47	H I J K L M N O (48h to 4Fh)	← All the same
48	P Q R S T U V W (50h to 57h)	← All the same
49	X Y Z [ ¥ ] ^ _ (58h to 5Fh)	X Y Z [ \ ] ^ _ (58h to 5Fh)
50	` a b c d e f g (60h to 67h)	← All the same
51	h i j k l m n o (68h to 6Fh)	← All the same
52	p q r s t u v w (70h to 77h)	← All the same
53	x y z {   } ~   (78h to 7Fh)	← All the same
54	¤ i ¢ £ ¤ ¥ ¤ § (A0h to A7h) 8859-1	(A0h to A7h) 8859-1
55	♪ © ª « ¬ ® ® (A8h to AFh)	(A8h to AFh)
56	• ± ² ³ ¹ µ ¶ • (B0h to B7h)	(B0h to B7h)
57	† ¹ º » ¼ ½ ¾ ˙ (B8h to BFh)	(B8h to BFh)
58	À Á Â Ã Ä Å Æ Ç (C0h to C7h)	A A A A A C (C0h to C7h)
59	È É Ê Ë Ì Í Î Ï (C8h to CFh)	E E E E I I I I (C8h to CFh)
60	Ð Ñ Ò Ó Ô Õ Ö (D0h to D7h)	D N O O O O O (D0h to D7h)
61	Ø Ù Ú Û Ü Ý Þ ß (D8h to DFh)	O U U U U Y (D8h to DFh)
62	à á â ã ä å æ ç (E0h to E7h)	a a a a a a c (E0h to E7h)
63	è é ê ë ì í î ï (E8h to FFh)	e e e e i i i i (E8h to EFh)
64	ð ñ ò ó ô õ ö ÷ (F0h to F7h)	d n o o o o o (F0h to F7h)
65	ø ù ú û ü ý Þ ÿ (F8h to FFh)	o u u u u y y (F8h to FFh)
66	No.66	← All the same
67	No.67	← All the same
to	to	to
99	No.99	← All the same

## SECTION 2 GENERAL

### LOCATION OF CONTROLS

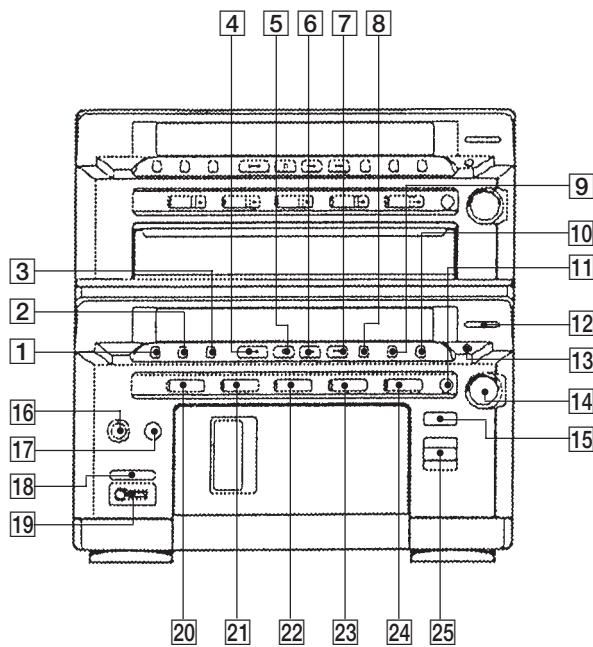
#### - Front Panel -

- CD PLAYER Section



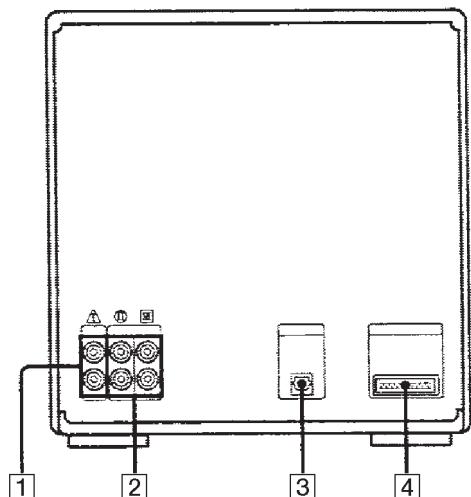
- [1] 1/ALL button
- [2] PLAY MODE button
- [3] REPEAT button
- [4] ▶▷ button
- [5] □ button
- [6] ◀◀ button
- [7] ▶▶ button
- [8] NAME EDIT button
- [9] MENU/NO button
- [10] ENTER/YES button
- [11] DISPLAY button
- [12] CLEAR button
- [13] ▲▼◀▶ dial
- [14] CD disc tray
- [15] CD1 button and indicator
- [16] CD2 button and indicator
- [17] CD3 button and indicator
- [18] CD4 button and indicator
- [19] CD5 button and indicator
- [20] DISC SKIP button

- MD DECK Section



- [1] 1/ALL button
- [2] PLAY MODE button
- [3] REPEAT button
- [4] ▶▷ button
- [5] □ button
- [6] ◀◀ button
- [7] ▶▶ button
- [8] NAME EDIT button
- [9] MENU/NO button
- [10] ENTER/YES button
- [11] DISC SKIP button
- [12] DISPLAY button
- [13] CLEAR button
- [14] ▲▼◀▶ dial
- [15] OPEN button
- [16] REC button
- [17] REC MODE button
- [18] MD WALKMAN SYNC button and indicator
- [19] MD WALKMAN LINK jack
- [20] MD1 button and indicator
- [21] MD2 button and indicator
- [22] MD3 button and indicator
- [23] MD4 button and indicator
- [24] MD5 button and indicator
- [25] ▲ button

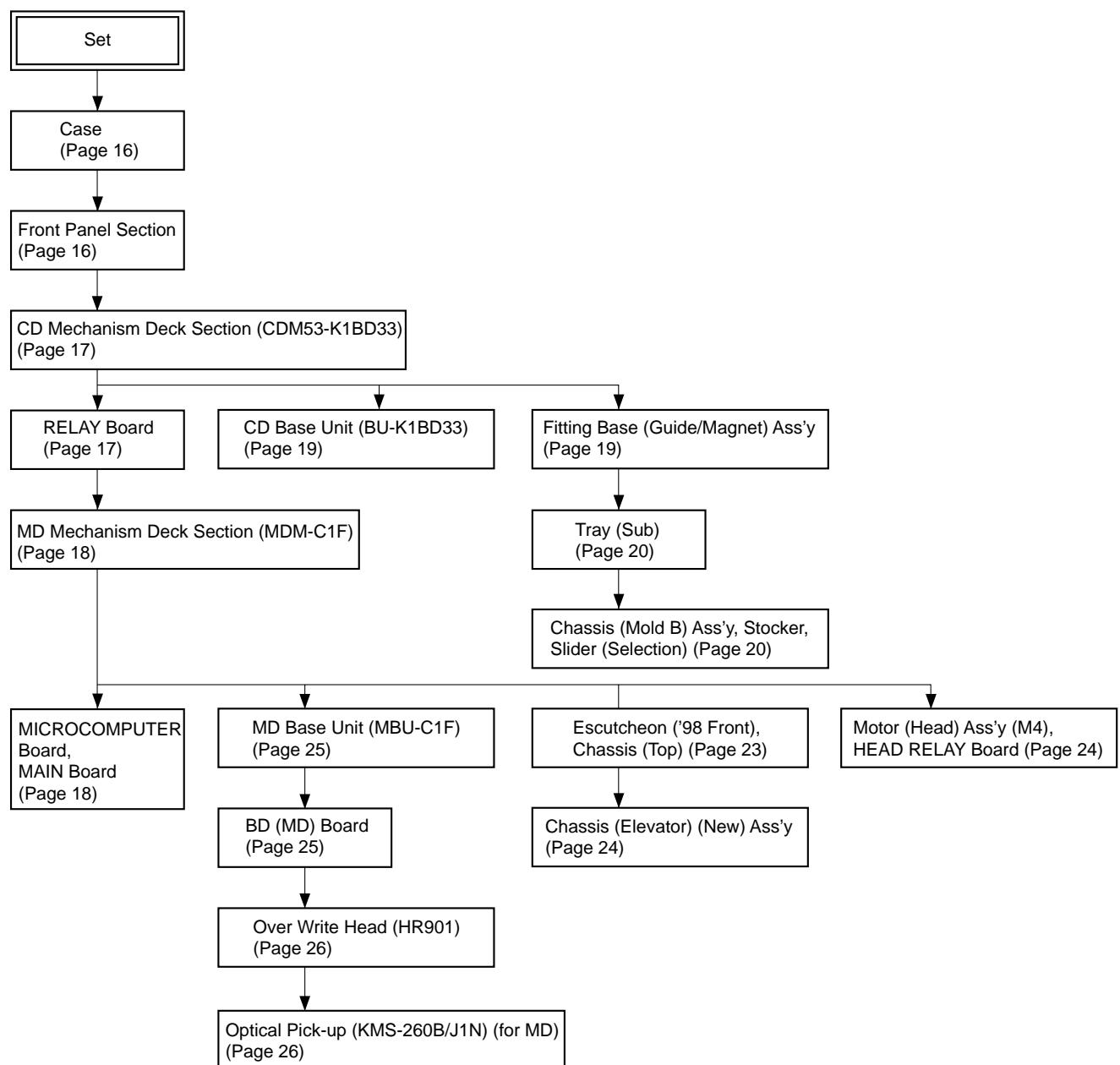
**- REAR PANEL -**



- 1** CD ANALOG OUT jack
- 2** MD ANALOG IN/OUT jack
- 3** OPTICAL IN, DIGITAL IN connector
- 4** SYSTEM CONTROL terminal

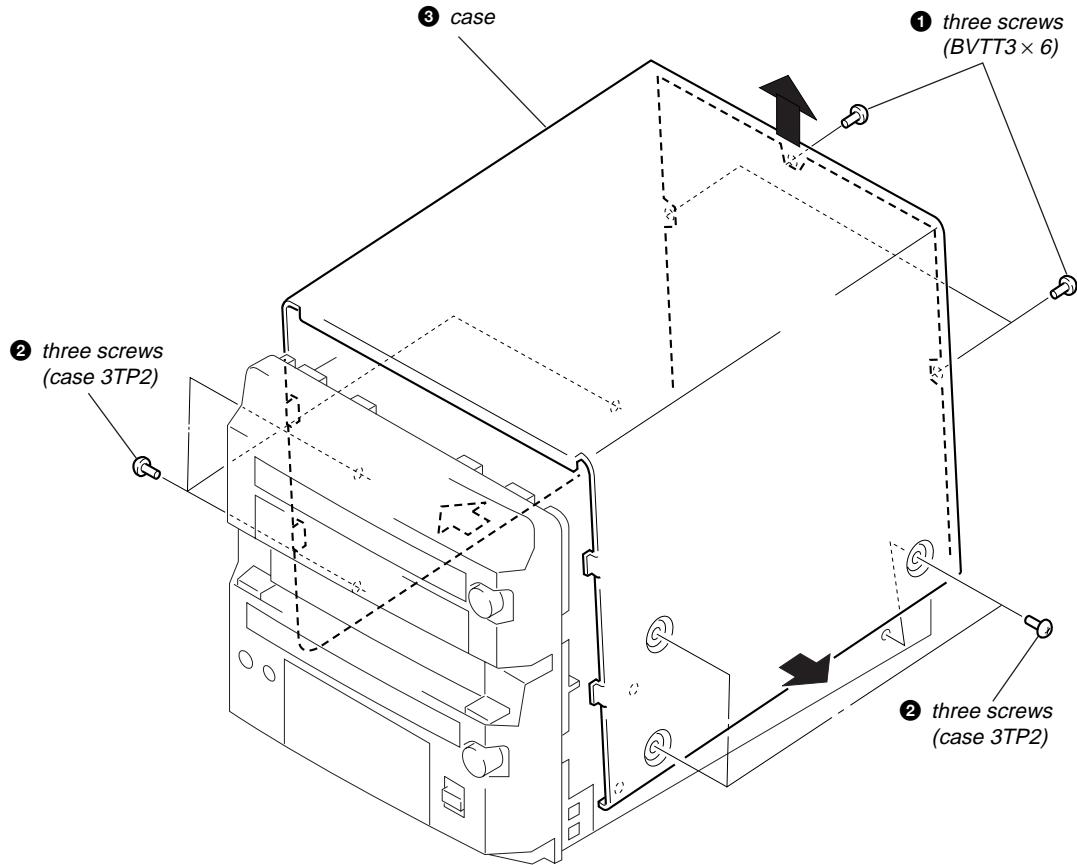
## SECTION 3 DISASSEMBLY

- This set can be disassembled in the order shown below.

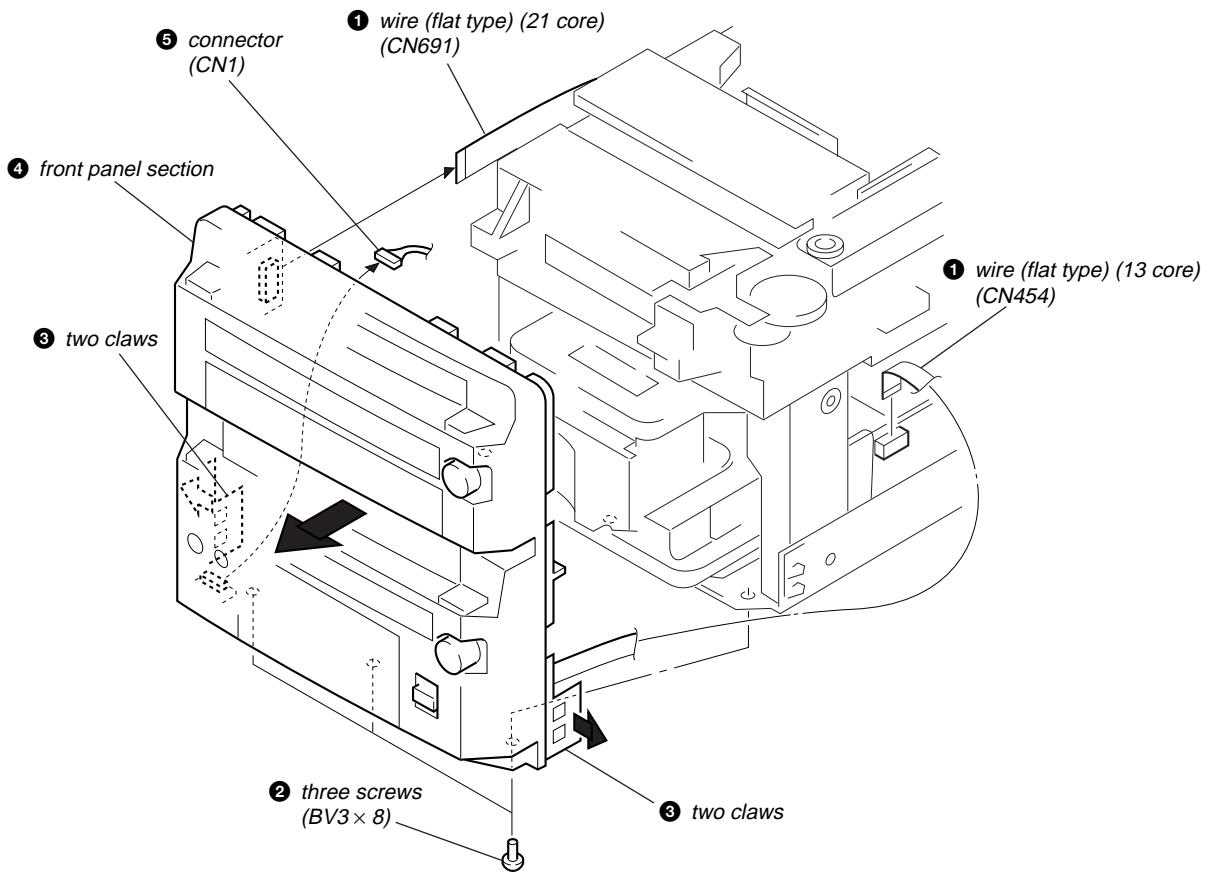


**Note:** Follow the disassembly procedure in the numerical order given.

## CASE

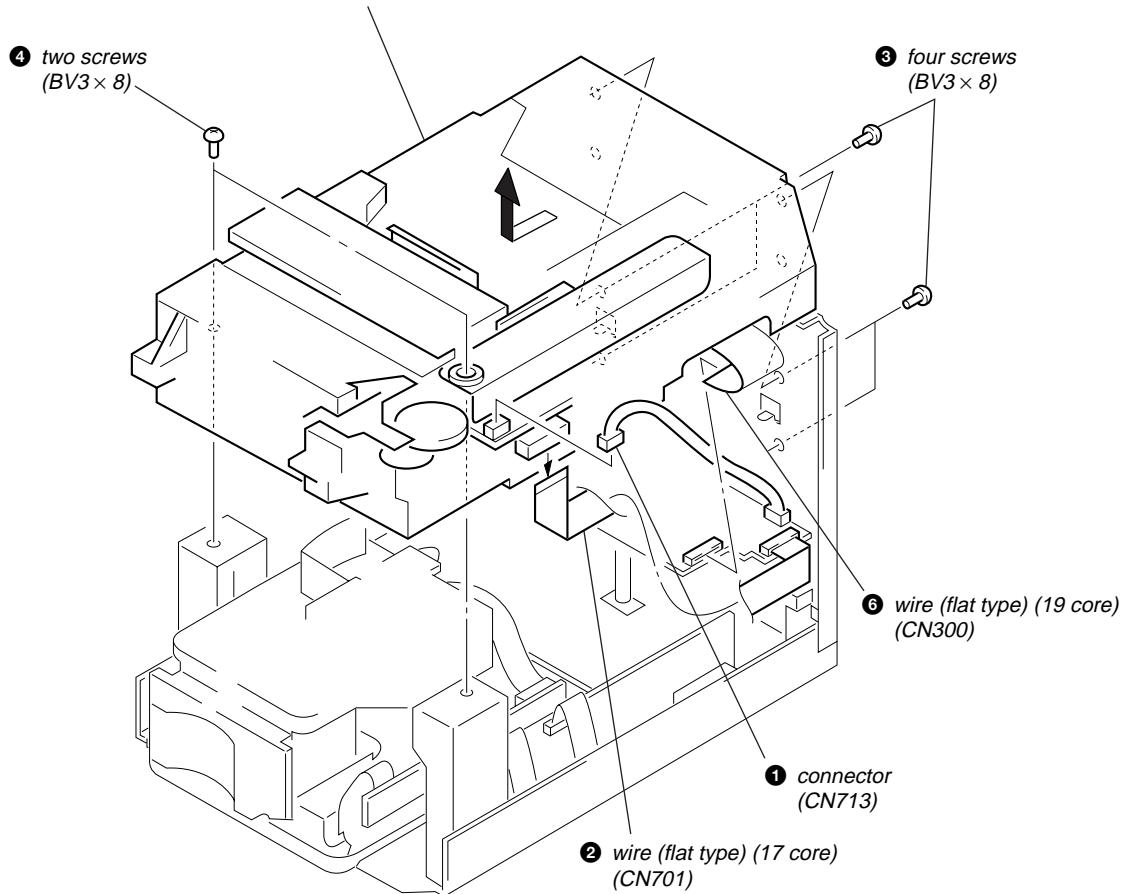


## FRONT PANEL SECTION

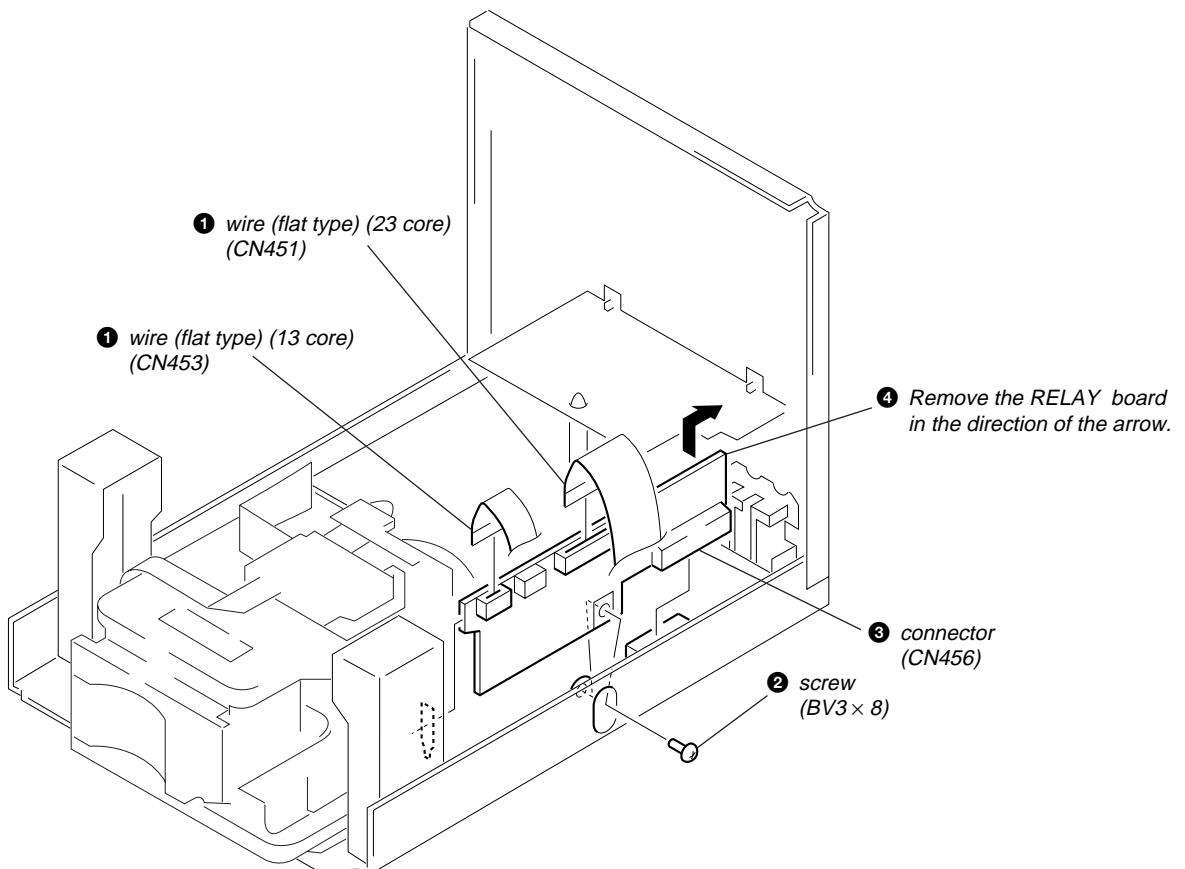


## CD MECHANISM DECK SECTION (CDM53-K1BD33)

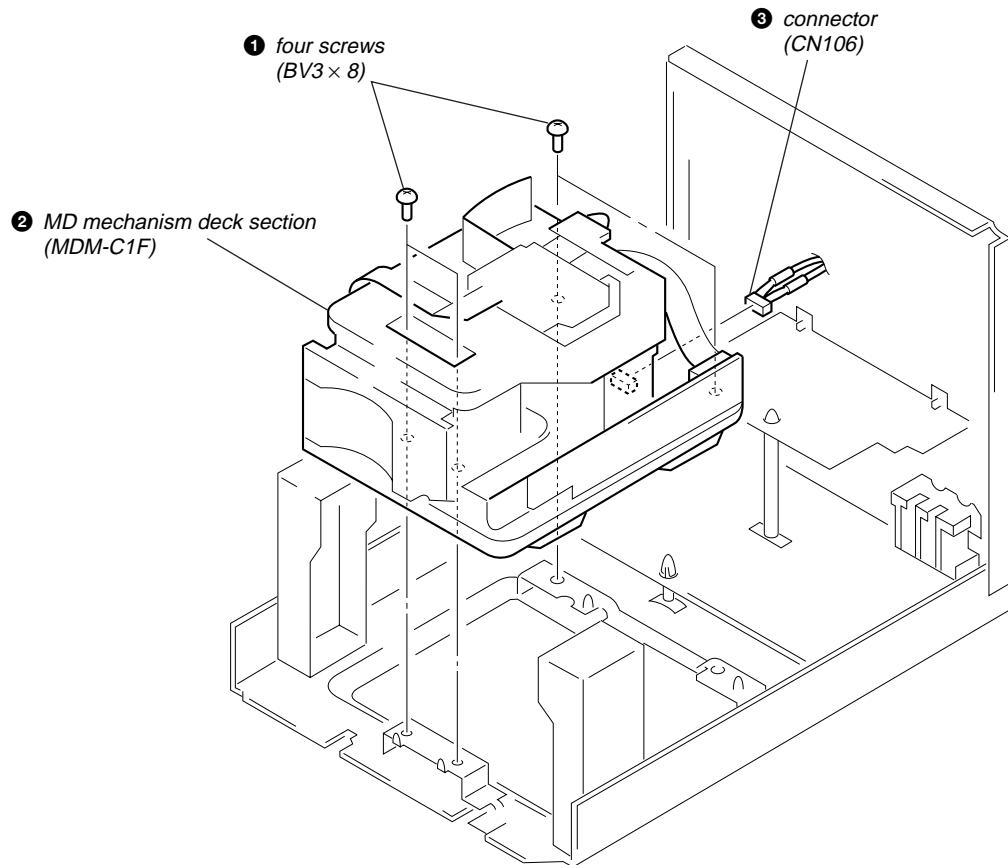
- ⑤ Remove the CD mechanism deck section (CDM53-K1BD33) in the direction of the arrow.



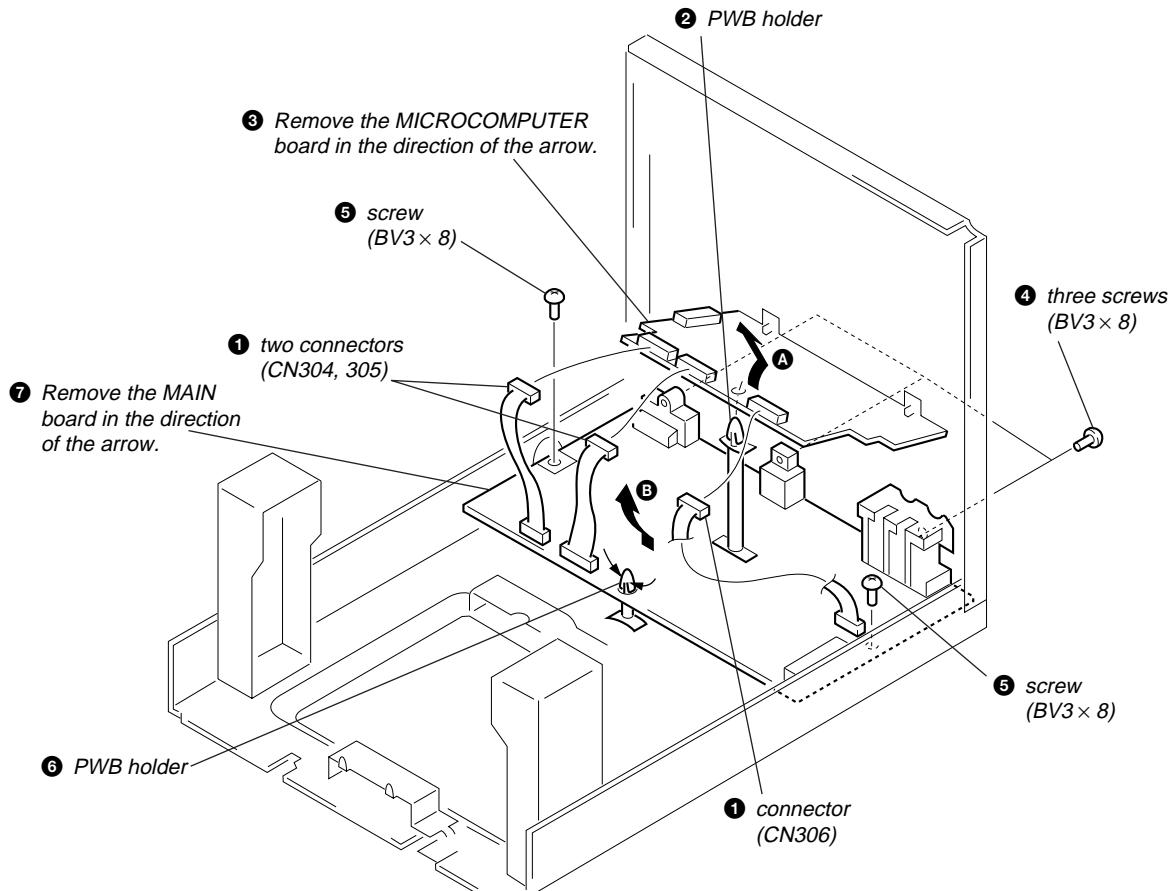
## RELAY BOARD



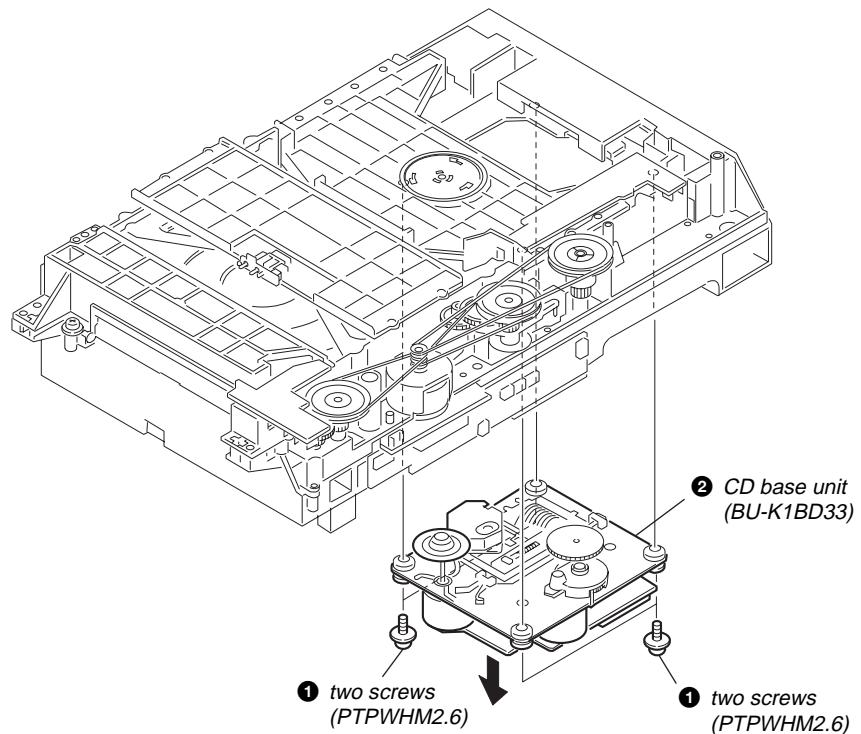
## MD MECHANISM DECK SECTION (MDM-C1F)



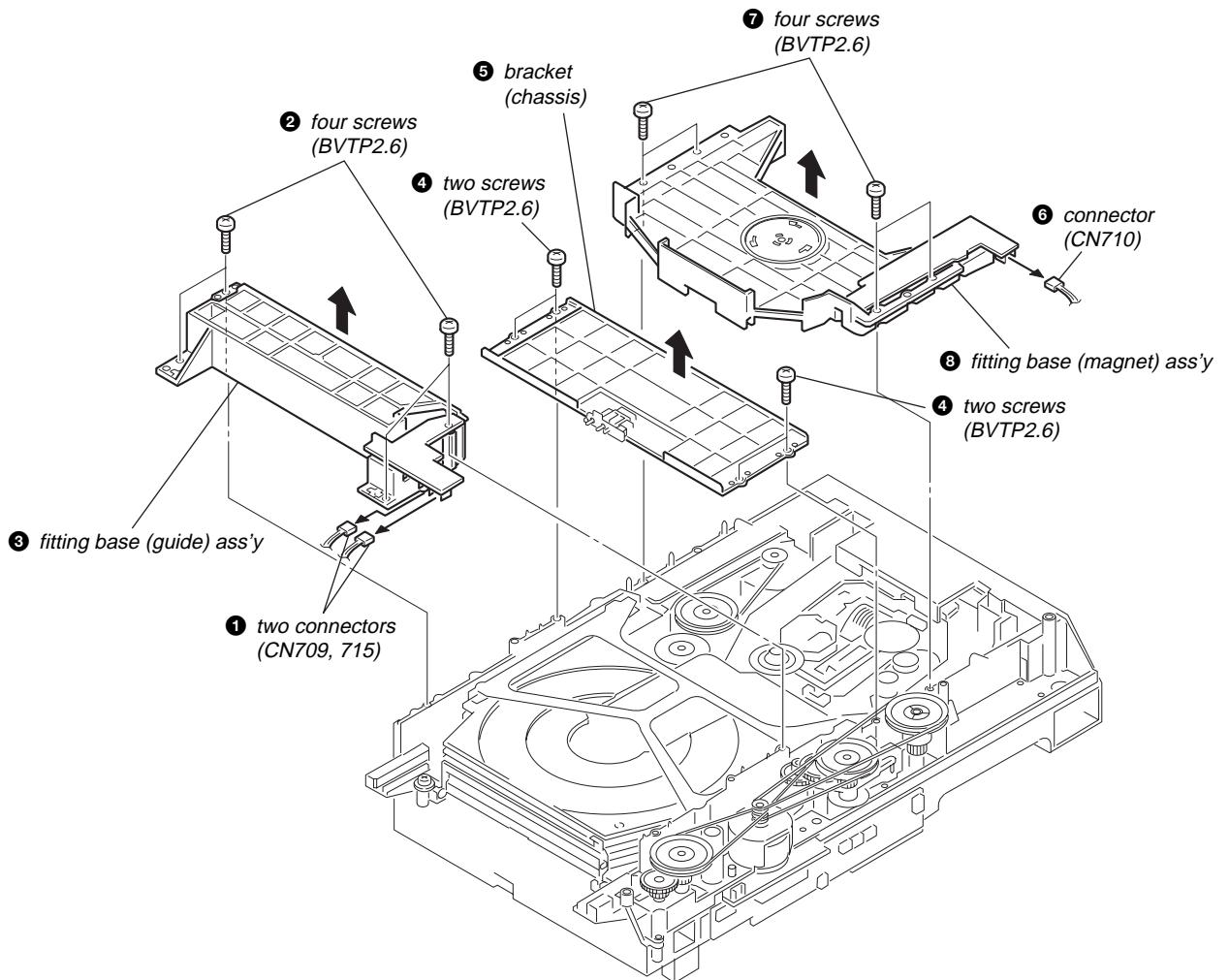
## MICROCOMPUTER BOARD, MAIN BOARD



## CD BASE UNIT (BU-K1BD33)

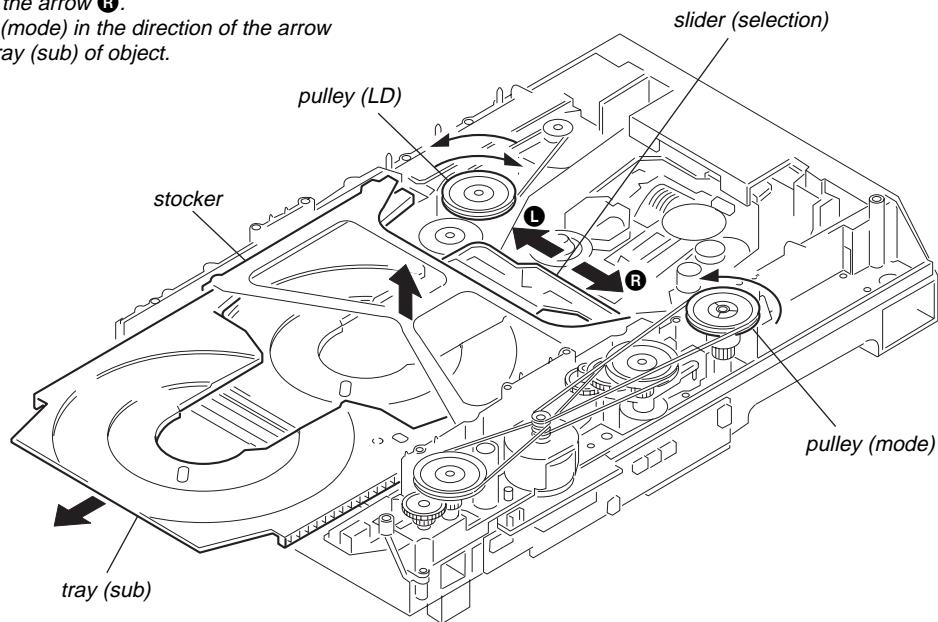


## FITTING BASE (GUIDE/MAGNET) ASS'Y



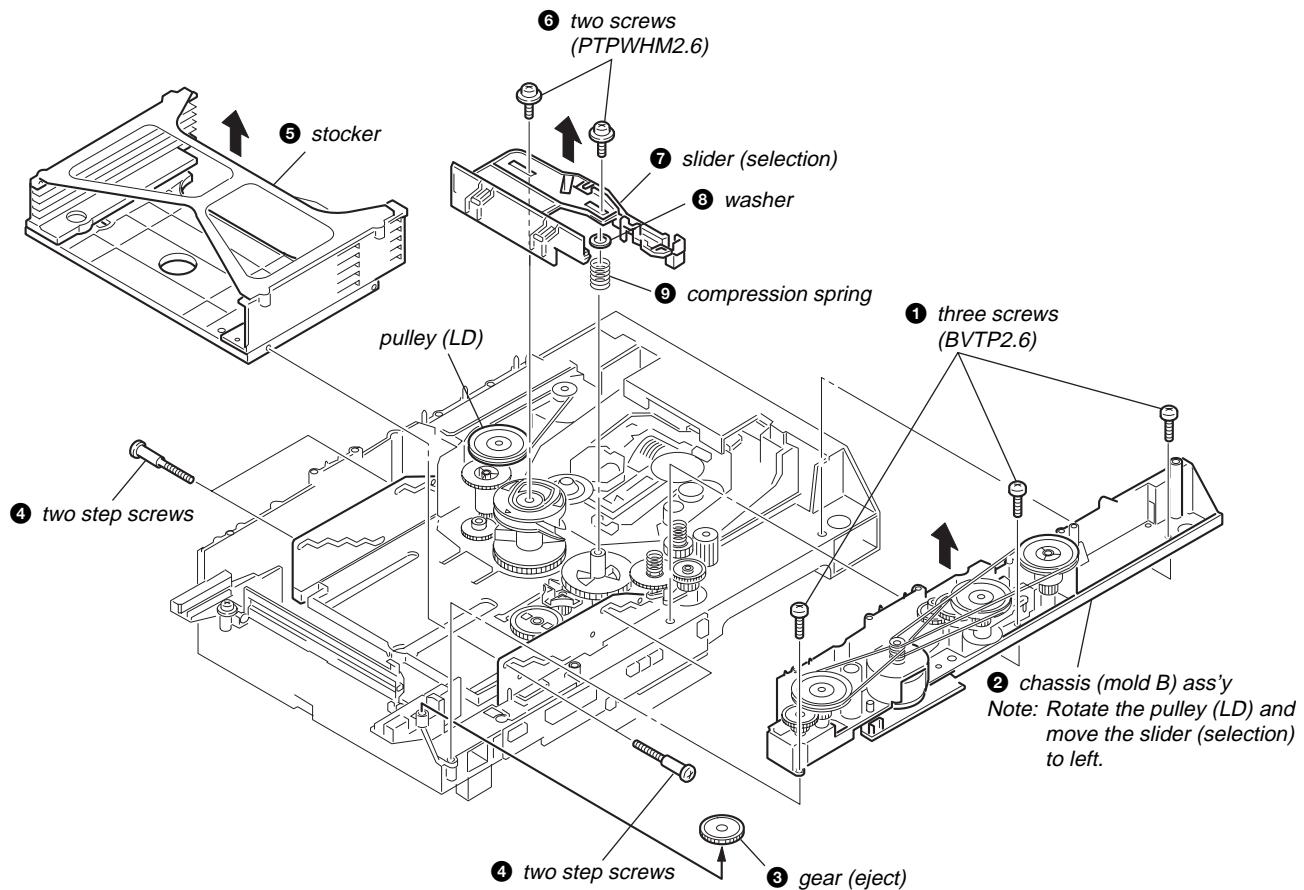
## TRAY (SUB)

- ① Rotate the pulley (LD) and move the slider (selection) in the direction of the arrow **L**.
- ② Rotate the pulley (mode) in the direction of the arrow and adjust the tray (sub) of object.
- ③ Rotate the pulley (LD) and move the slider (selection) in the direction of the arrow **R**.
- ④ Rotate the pulley (mode) in the direction of the arrow and remove the tray (sub) of object.

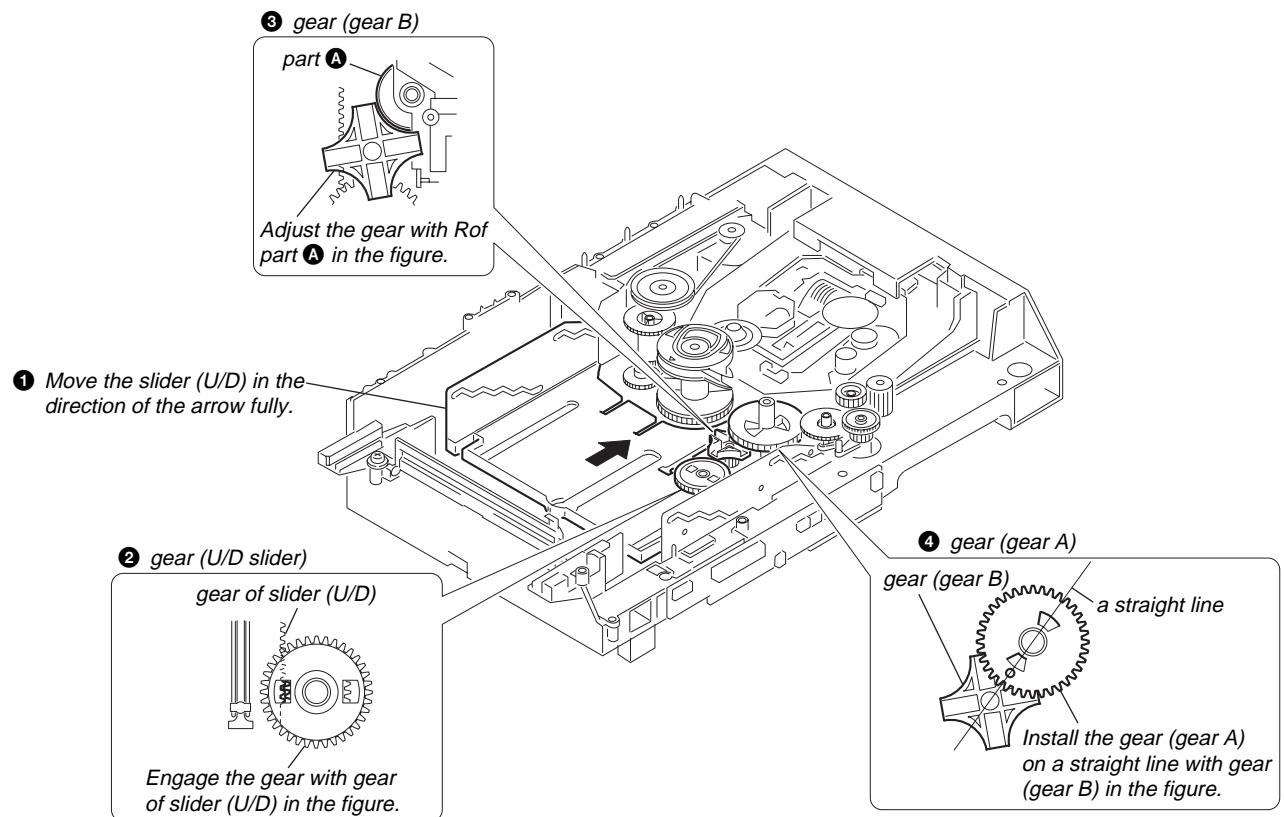


## CHASSIS (MOLD B) ASS'Y, STOCKER, SLIDER (SELECTION)

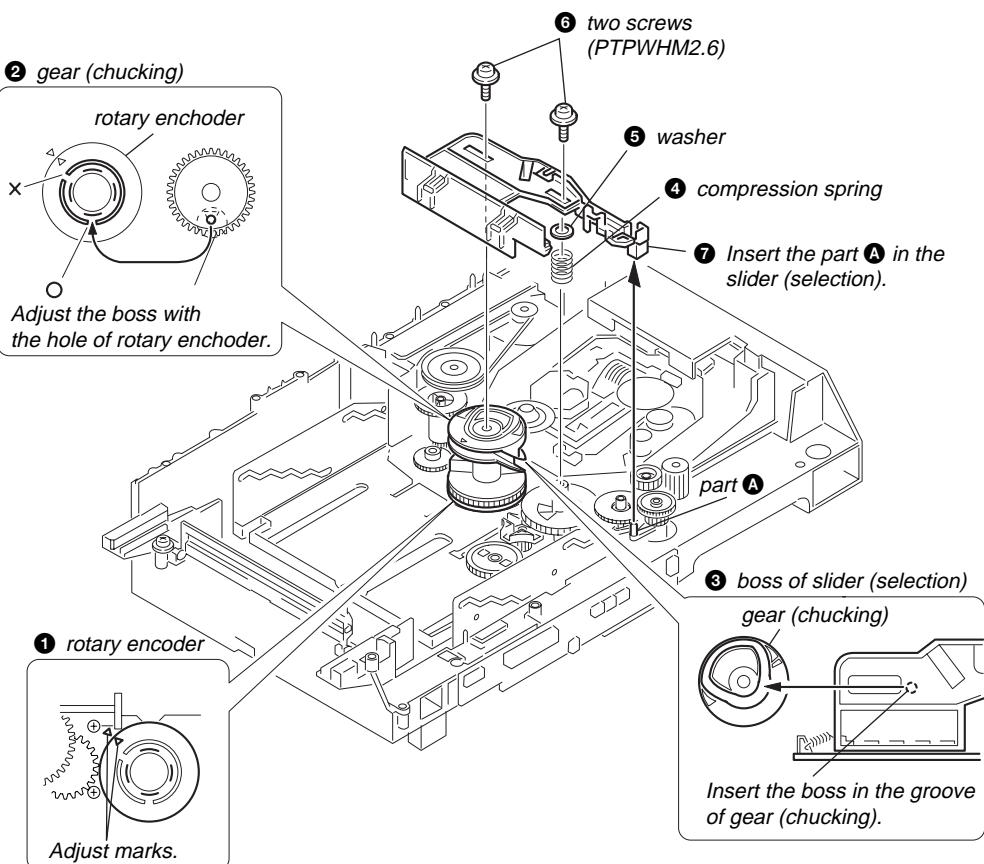
**Note:** Refer to page 21, 22 when install.



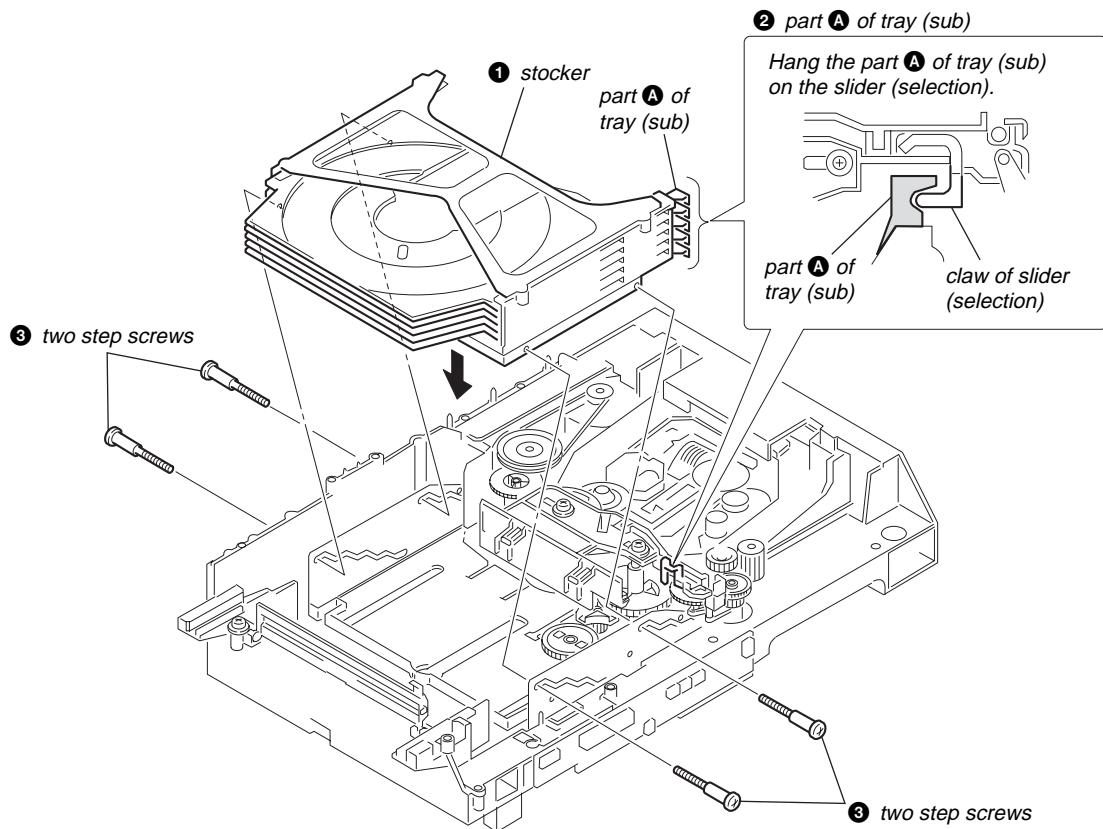
## INSTALLATION OF GEARS



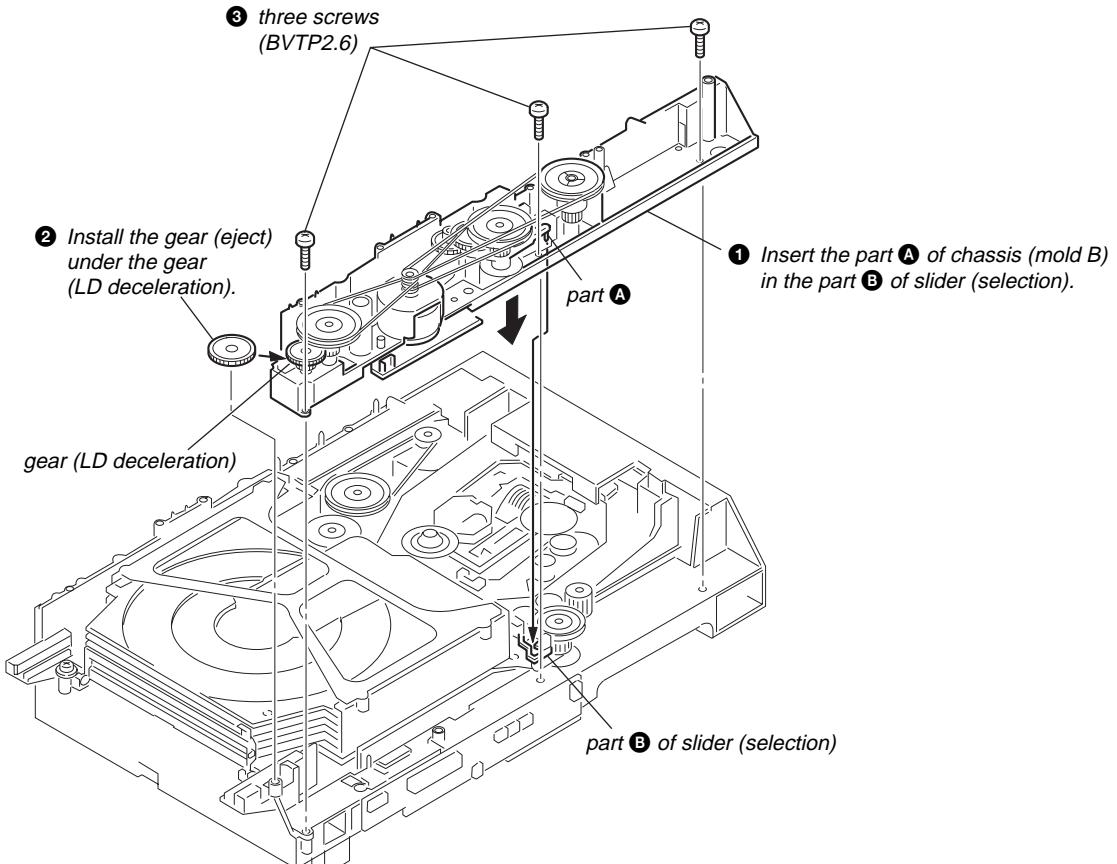
## INSTALLATION OF SLIDER (SELECTION)



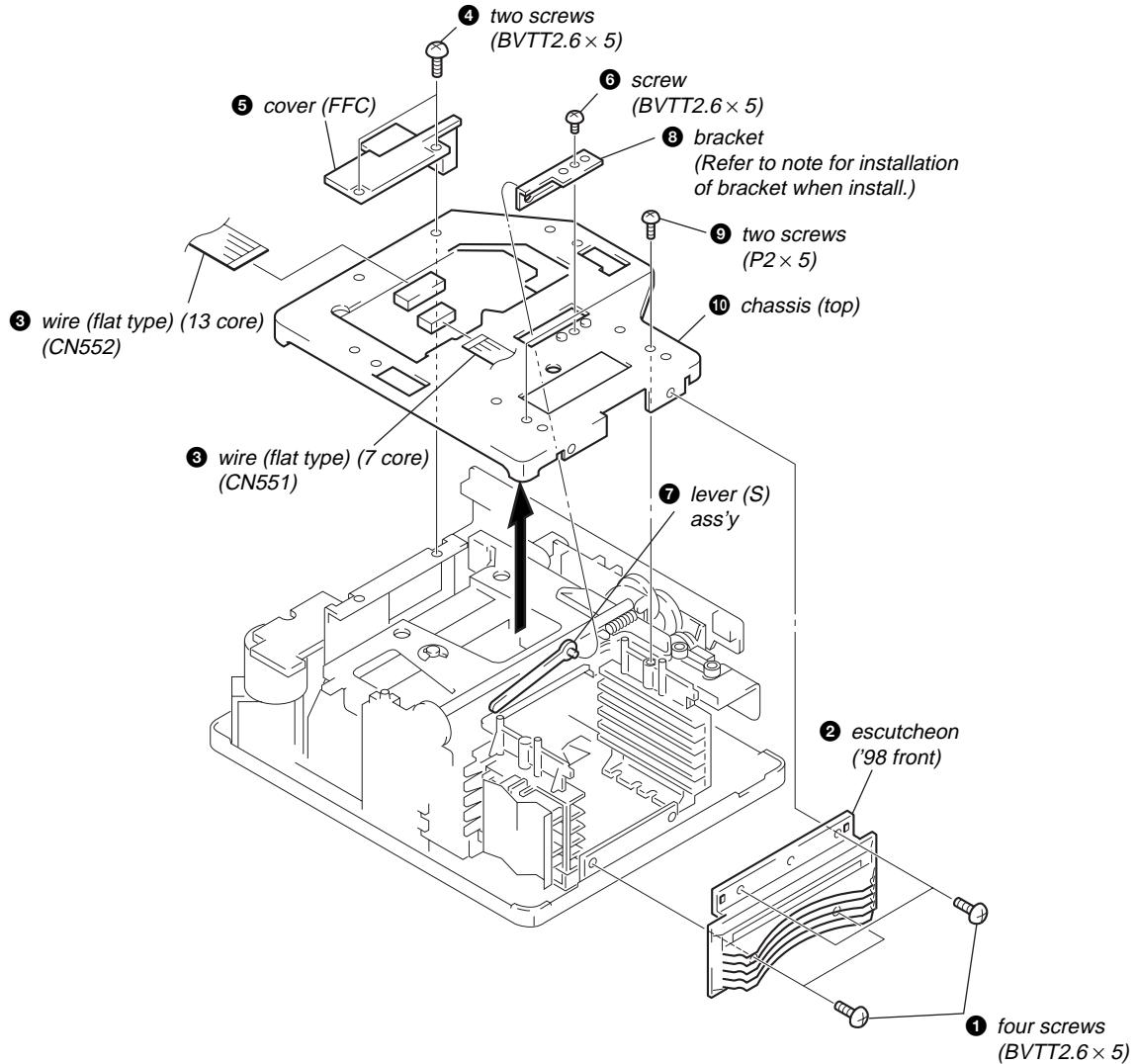
## INSTALLATION OF STOCKER



## INSTALLATION OF CHASSIS (MOLD B)

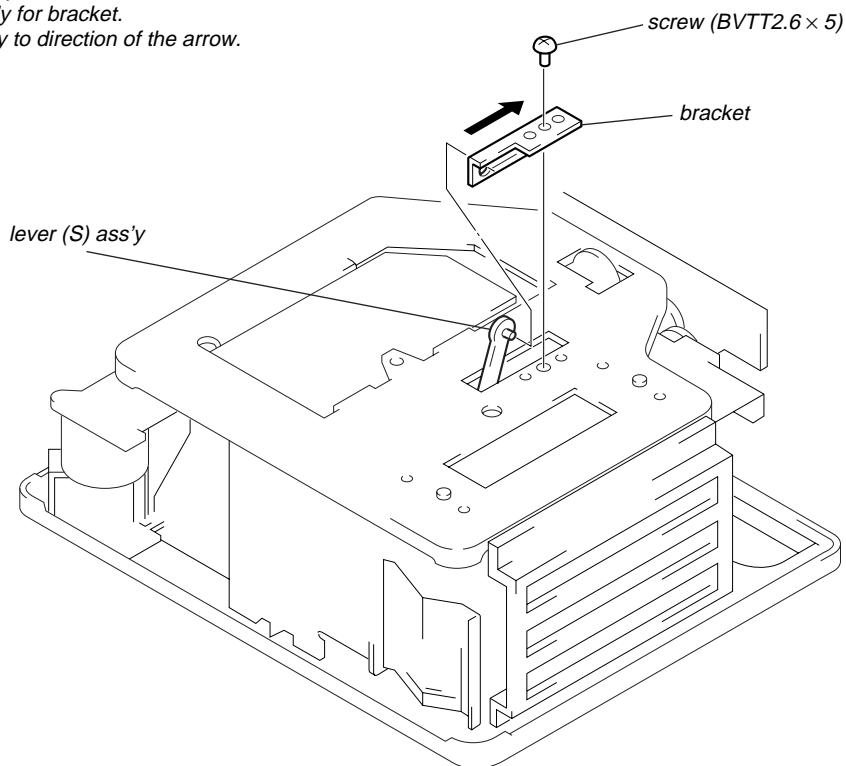


## ESCUTCHEON ('98 FRONT), CHASSIS (TOP)



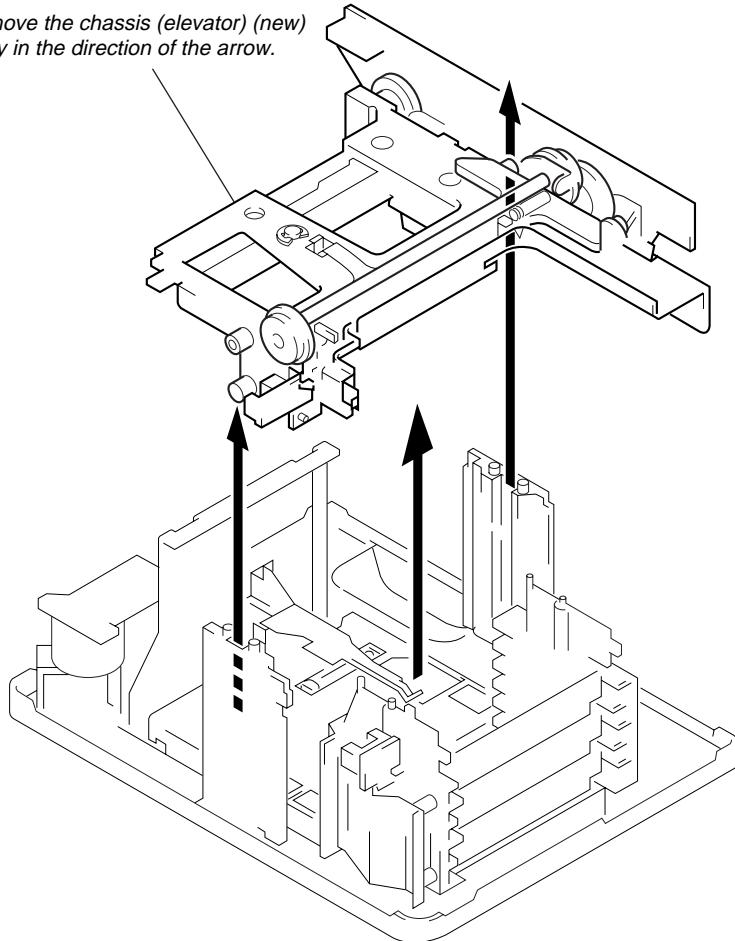
### NOTE FOR INSTALLATION OF BRACKET

- ① Lift up the lever (S) ass'y.
- ② Hang the lever (S) ass'y for bracket.
- ③ Slide the lever (S) ass'y to direction of the arrow.

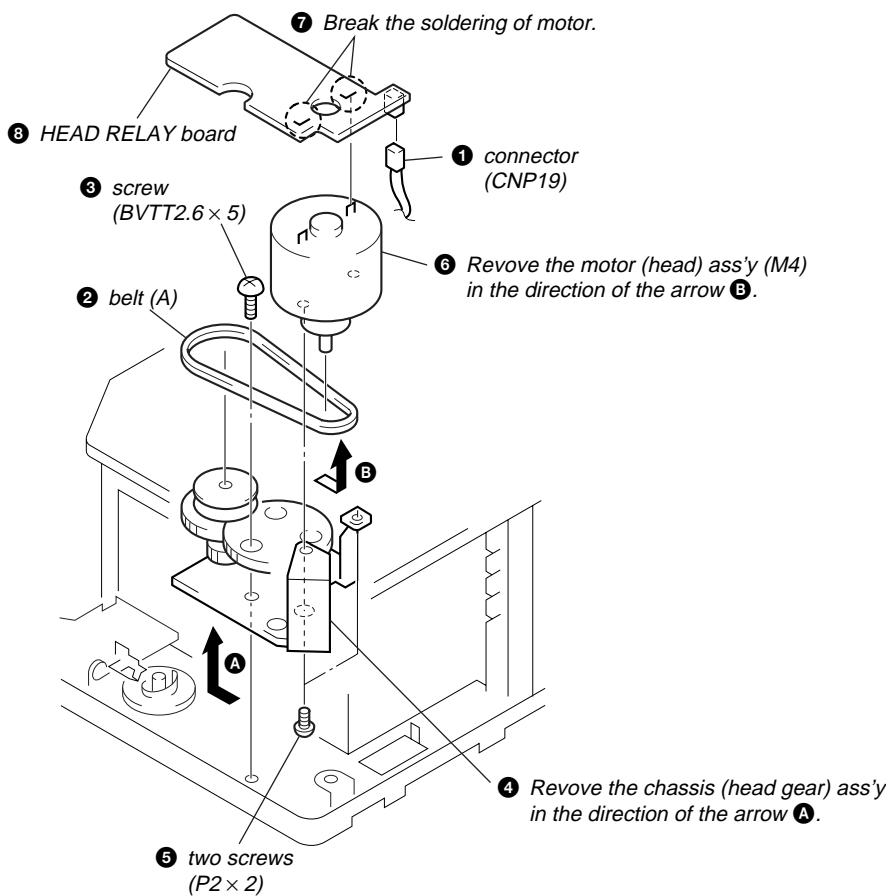


## CHASSIS (ELEVATOR) (NEW) ASS'Y

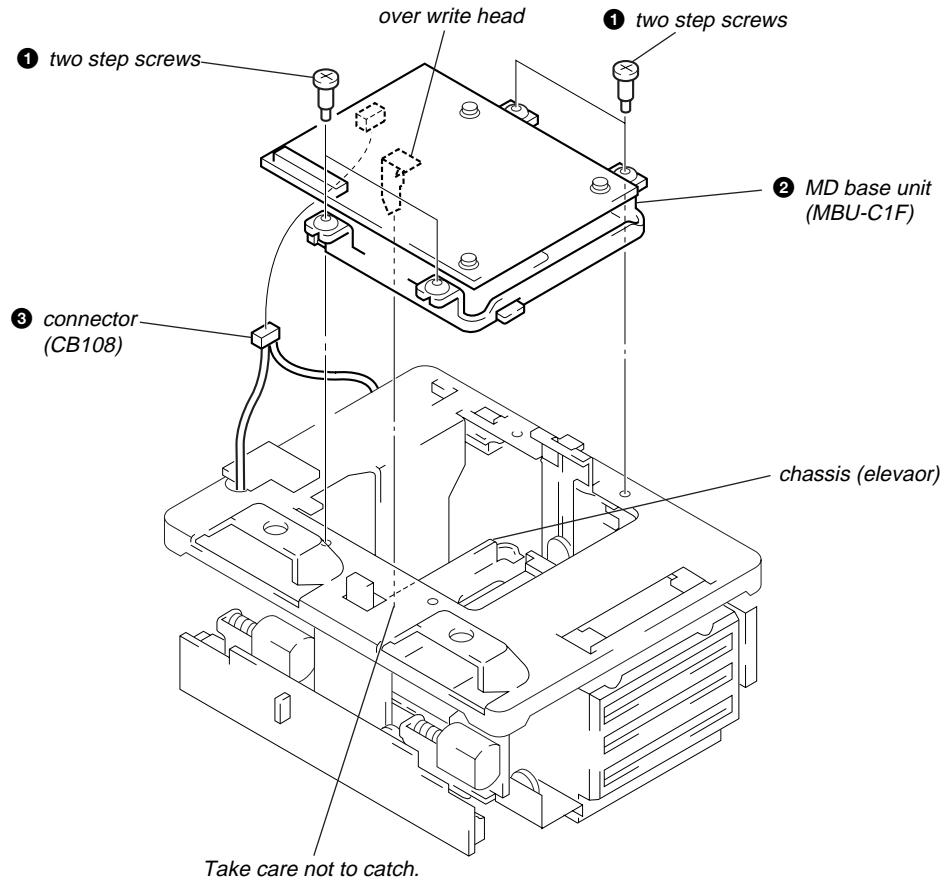
- ① Remove the chassis (elevator) (new) ass'y in the direction of the arrow.



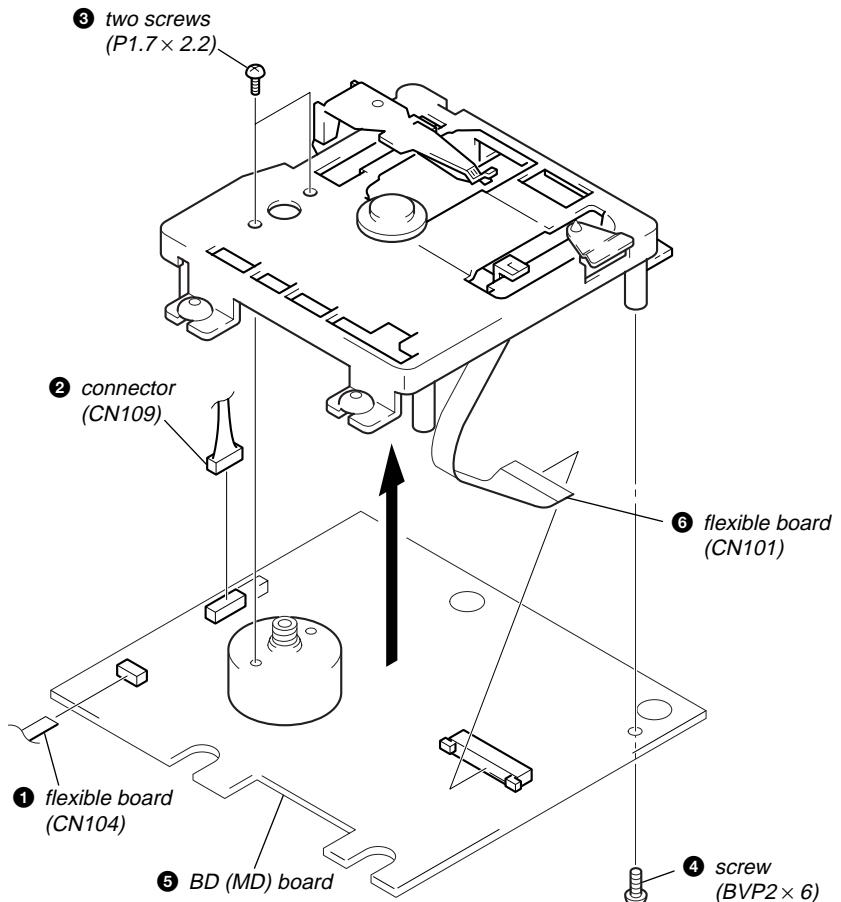
## MOTOR (HEAD) ASS'Y (M4), HEAD RELAY BOARD



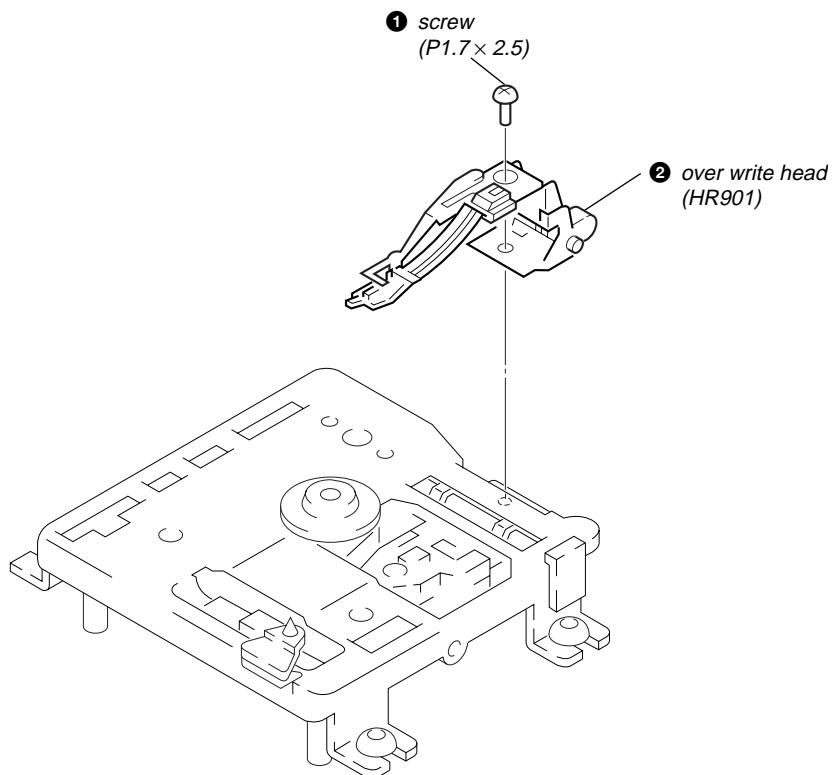
## MD BASE UNIT (MBU-C1F)



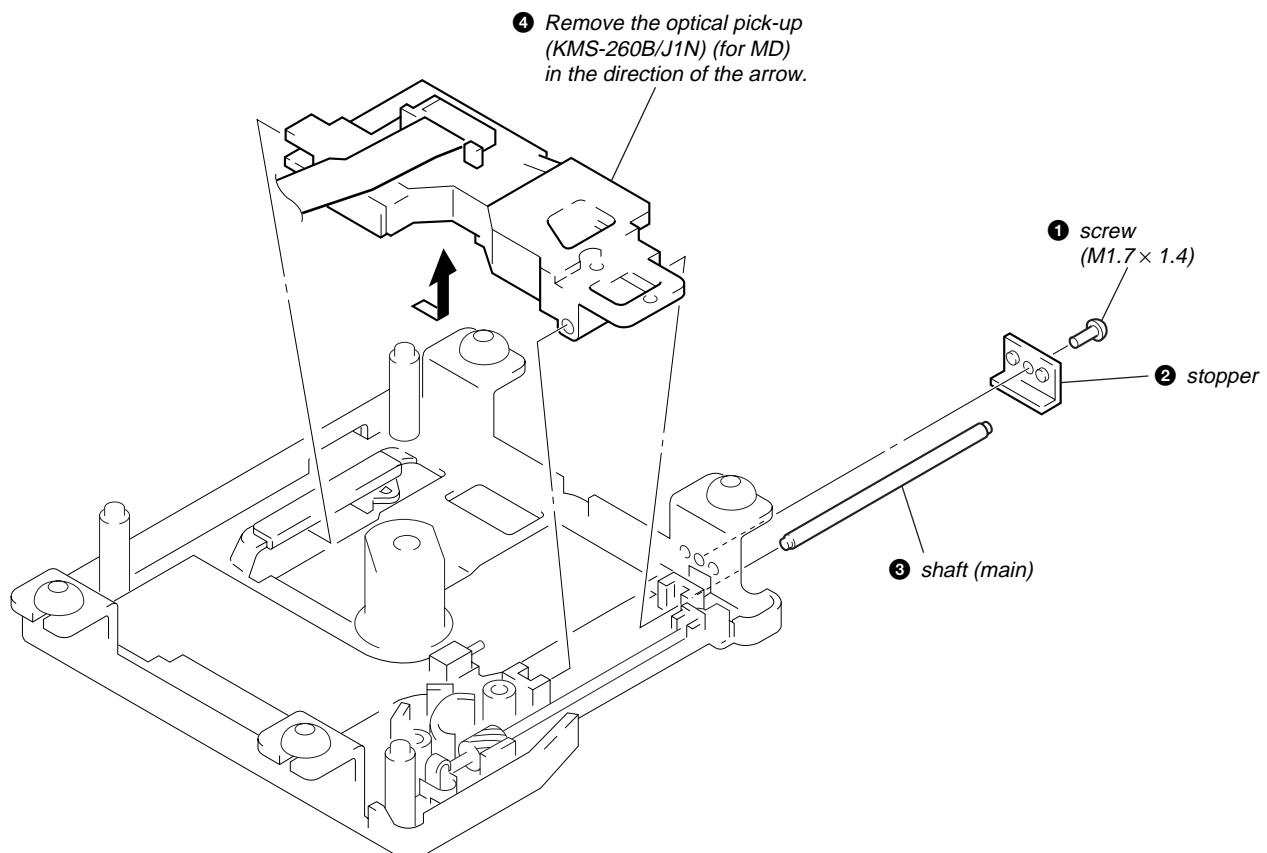
## BD (MD) BOARD



## OVER WRITE HEAD (HR901)



## OPTICAL PICK-UP (KMS-260B/J1N) (for MD)



## SECTION 4

# TEST MODE

### 1. PRECAUTIONS FOR USE OF TEST MODE

- As loading related operations will be performed regardless of the test mode operations being performed, be sure to check that the disc is stopped before setting and removing it.
- Even if the  (MD) button is pressed while the disc is rotating during continuous playback, continuous recording, etc., the disc will not stop rotating.
- Therefore, it will be ejected while rotating.

Be sure to press the  (MD) button after pressing the **[MENU/NO]** button and the rotation of disc is stopped.

#### 1-1. Recording laser emission mode and operating buttons

- Continuous recording mode (CREC MODE)
- Laser power check mode (LDPWR CHECK)
- Laser power adjustment mode (LDPWR ADJUST)
- Traverse (MO) check (EF MO CHECK)
- Traverse (MO) adjustment (EF MO ADJUST)
- When pressing the  button.

### 2. SETTING THE TEST MODE

The following are two methods of entering the test mode.

**Procedure 1:** (1) While pressing the both **[ENTER/YES]** and  buttons, turn the power ON.

When the test mode is set, “TEMP CHECK” will be displayed.

(2) Press the **[MENU/NO]** button to display “[CHECK]”.

(3) Turn the  dial switches between the following four groups:

… ↔ [Check] ↔ [Adjust] ↔ [Service] ↔ [Develop] ↔ ….

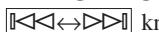
**Procedure 2:** While pressing the **[ENTER/YES]** button, turn the power ON.

When the test mode is set, “TEMP CHECK” will be displayed. By setting the test mode using this method, only the “Check” group of method 1 can be executed.

### 3. EXITING THE TEST MODE

Press the  button. The disc is ejected when loaded, and the set will be normal mode.

### 4. BASIC OPERATIONS OF THE TEST MODE

All operations are performed using the  knob, **[ENTER/YES]** button, and **[MENU/NO]** button.

The functions of these buttons are as follows.

Function name	Function
 dial	Changes parameters and modes
YES button	Proceeds onto the next step. Finalizes input.
MENU/NO button	Returns to previous step. Stops operations.

#### 4-1. Loading and Ejecting Disc in The Test Mode.

- Use MD slot1 only in the test mode.
- When loads disc, press the  (MD) button.
- When ejects disc, press the  (MD) button too.

## 5. SELECTING THE TEST MODE

There are 31 types of test modes as shown below. The groups can be switched by turning the dial. After selecting the group to be used, press the **[ENTER/YES]** button. After setting a certain group, turning the dial switches between these modes. Refer to “Group” in the table for details selected.

All items used for servicing can be treated using group S. So be carefully not to enter other groups by mistake.

Display	No.	Contents	Mark	Group (*)
TEMP CHECK	C01	Temperature compensation offset check		C S
LDPWR CHECK	C02	Laser power check		C S
EF MO CHECK	C03	Traverse (MO) check		C S
EF CD CHECK	C04	Traverse (CD) check		C S
FBIAS CHECK	C05	Focus bias check		C S
Scurve CHECK	C06	S letter check	(X)	C
VERIFY MODE	C07	Non-volatile memory check	(X)	C
DETRK CHECK	C08	Detrack check	(X)	C
TEMP ADJUST	C09	Temperature compensation offset adjustment		A S
LDPWR ADJUST	C10	Laser power adjustment		A S
EF MO ADJUST	C11	Traverse (MO) adjustment		A S
EF CD ADJUST	C12	Traverse (CD) adjustment		A S
FBIAS ADJUST	C13	Focus bias adjustment		A S
EEP MODE	C14	Non-volatile memory control	(X) (!)	D
MANUAL CMD	C15	Command transmission	(X)	D
SVDATA READ	C16	Status display	(X)	D
ERR DP MODE	C17	Error history display, clear		S
SLED MOVE	C18	Sled check	(X)	D
ACCESS MODE	C19	Access check	(X)	D
0920 CHECK	C20	Outermost circumference check	(X)	D
HEAD ADJUST	C21	Head position check	(X)	D
CPLAY2 MODE	C22	Same functions as CPLAY MODE	(X)	D
CREC 2MODE	C23	Same functions as CREC MODE	(X)	D
ADJ CLEAR	C24	Initialization of non-volatile memory of adjustment value		A S
AG Set (MO)	C25	Auto gain output level adjustment (MO)		A S
AG Set (CD)	C26	Auto gain output level adjustment (CD)		A S
Iop Read	C27	IOP data display		C S
Iop Write	C28	IOP data write		A S
INFOMATION	C29	Microprocessing version display		C S
CPLAY MODE	C30	Continuous play mode		C A S D
CREC MODE	C31	Continuous recording mode		C A S D

Group (\*)

C: Check

A: Adjust

S: Service

D: Develop

- For details of each adjustment mode, refer to “6. Electrical Adjustments”.  
For details of “ERR DP MODE”, refer to “Self-Diagnosis Function” on page 2.
- If a different mode has been selected by mistake, press the **[MENU/NO]** button to exit that mode.
- Modes with (X) in the Mark column are not used for servicing and therefore are not described in detail. If these modes are set accidentally, press the **[MENU/NO]** button to exit the mode immediately. Be especially careful not to set the modes with (!) as they will overwrite the non-volatile memory and reset it, and as a result, the unit will not operate normally.

### 5-1. Operating the Continuous Playback Mode

1. Entering the continuous playback mode
  - (1) Set the disc in the unit. (Whichever recordable discs or discs for playback only are available)
  - (2) Turn the  dial to display “CPLAY MODE” (C30).
  - (3) Press the **[ENTER/YES]** button to change the display to “CPLAY MID”.
  - (4) When access completes, the display changes to “C = 0000 AD = 00”.
- Note:** The numbers “0” displayed show you error rates and ADER.

#### 2. Changing the parts to be played back

- (1) Press the **[ENTER/YES]** button during continuous playback to change the display as below.

“CPLAY MID” → “CPLAY OUT” → “CPLAY IN”  
↑

When pressed another time, the parts to be played back can be moved.

- (2) When access completes, the display changes to “C = 0000 AD = 00”.
- Note:** The numbers “0” displayed show you error rates and ADER.

#### 3. Ending the continuous playback mode

- (1) Press the **[MENU/NO]** button. The display will change to “CPLAY MODE”.
- (2) Press the  (MD) button and take out the disc.

**Note:** The playback start addresses for IN, MID, and OUT are as follows.

IN : 40h cluster

MID : 300h cluster

OUT: 700h cluster

### 5-2. Operating the Continuous Recording Mode (Use only when performing self-recording/palyback check)

#### 1. Entering the continuous recording mode

- (1) Set a recordable disc in the unit.
- (2) Rotate the  knob to display “CREC MODE” (C31).
- (3) Press the **[ENTER/YES]** button to change the display to “CREC MID”.
- (4) When access completes, the display changes to “CREC (0000)” and **REC** lights up.

**Note:** The numbers “0” displayed shows you the recording position addresses.

#### 2. Changing the parts to be recorded

- (1) When the **[ENTER/YES]** button is pressed during continuous recording, the display changes as below.

“CREC MID” → “CREC OUT” → “CREC IN”  
↑

When pressed another time, the parts to be recorded can be changed. **REC** goes off.

- (2) When access completes, the display changes to “CREC (0000)” and **REC** lights up.
- Note:** The numbers “0” displayed shows you the recording position addresses.

#### 3. Ending the continuous recording mode

- (1) Press the **[MENU/NO]** button. The display changes to “CREC MODE” and **REC** goes off.
- (2) Press the  (MD) button and take out the disc.

**Note 1:** The recording start addresses for IN, MID, and OUT are as follows.

IN : 40h cluster

MID : 300h cluster

OUT: 700h cluster

**Note 2:** The **[MENU/NO]** button can be used to stop recording anytime.

**Note 3:** Do not perform continuous recording for long periods of time above 5 minutes.

**Note 4:** During continuous recording, be careful not to apply vibration.

### 5-3. Non-Volatile Memory Mode (EEP MODE)

This mode reads and writes the contents of the non-volatile memory.

It is not used in servicing. If set accidentally, press the **[MENU/NO]** button immediately to exit it.

## 6. FUNCTIONS OF OTHER BUTTONS

Function	Contents
▷	Sets continuous playback when pressed in the STOP state. When pressed during continuous playback, the tracking servo turns ON/OFF.
□	Stops continuous playback and continuous recording.
▶▶	The sled moves to the outer circumference only when this is pressed.
◀◀	The sled moves to the inner circumference only when this is pressed.
CLEAR	Switches between the pit and groove modes when pressed.
PLAY MODE	Switches the spindle servo mode. (CLVS ↔ CLV A)
DISPLAY/CHAR	Switches the displayed contents each time the button is pressed
⏏ (MD)	Ejects the disc
REPEAT	Exits the test mode

## 7. TEST MODE DISPLAYS

Each time the [DISPLAY] button is pressed, the display changes in the following order.

### 1. Mode display

Displays "TEMP ADJUST", "CPLAYMODE", etc.

### 2. Error rate display

Displays the error rate in the following way.

C = 00000 AD = 00000

C = Indicates the C1 error.

AD = Indicates ADER.

### 3. Address display

The address is displayed as follows. (MO: recordable disc, CD: playback only disc)  
Pressing the [CLEAR] button switches between the groove display and pit display.

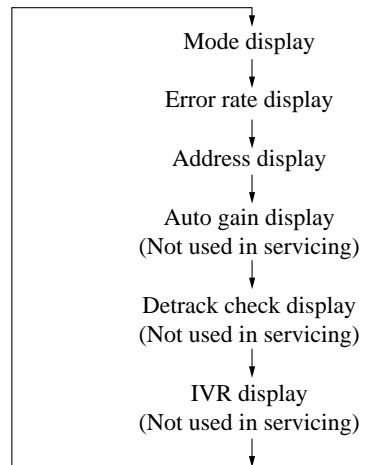
h = 00000 s = 00000 (MO pit and CD)

h = 00000 a = 00000 (MO groove)

h = Indicates the header address.

s = Indicates the SUBQ address.

a = Indicates the ADIP address.



**Note:** “–” is displayed when servo is not imposed.

### 4. Auto gain display (Not used in servicing)

The auto gain is displayed as follows.

AG = 00/00[00]

### 5. Detrack check display (Not used in servicing)

The detrack is displayed as follows.

ADR = 0000000

### 6. IVR display (Not used in servicing)

The IVR is displayed as follows.

[00][00][00]

## MEANINGS OF OTHER DISPLAYS

Display	Contents	
	When Light	When Off
▷	During continuous playback (CLV: ON)	STOP (CLV: OFF)
	Tracking servo OFF	Tracking servo ON
<b>REC</b>	Recording mode ON	Recording mode OFF
SYNC	CLV low speed mode	CLV normal mode
L-SYNC	ABCD adjustment completed	
<b>OVER</b>	Tracking offset cancel ON	Tracking offset cancel OFF
REPEAT	Tracking auto gain OK	
(REPEAT)1	Focus auto gain OK	
TRACK or ALL S	Pit	Groove
DISC or 1	High reflection	Low reflection
SHUFFLE	CLV-S	CLV-A
MONO	CLV LOCK	CLV UNLOCK
IT	LIMIT IN	

## SECTION 5

### ELECTRICAL ADJUSTMENTS

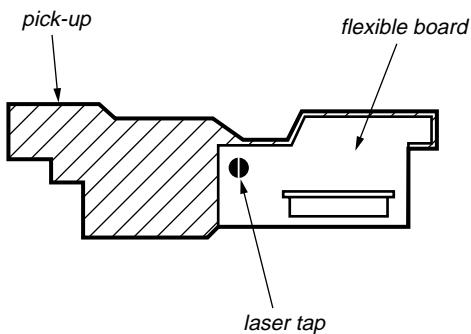
#### MD SECTION

#### 1. PRECAUTIONS FOR CHECKING LASER DIODE EMISSION

To check the emission of the laser diode during adjustments, never view directly from the top as this may lose your eye-sight.

#### 2. PRECAUTIONS FOR USE OF OPTICAL PICK-UP (KMS-260B)

As the laser diode in the optical pick-up is easily damaged by static electricity, solder the laser tap of the flexible board when using it. Before disconnecting the connector, desolder first. Before connecting the connector, be careful not to remove the solder. Also take adequate measures to prevent damage by static electricity. Handle the flexible board with care as it breaks easily.



**Optical pick-up flexible board**

#### 3. PRECAUTIONS FOR ADJUSTMENTS

1. When replacing the following parts, perform the adjustments and checks with **O** in the order shown in the following table.

	Optical Pick-up	BD (MD) Board			
		IC171	D101	IC101, IC121	IC192
1. Initial setting of adjustment value	<b>O</b>	<b>O</b>	<b>X</b>	<b>O</b>	<b>X</b>
2. Recording of IOP information (Value written on the pick-up)	<b>O</b>	<b>O</b>	<b>X</b>	<b>X</b>	<b>X</b>
3. Temperature compensation offset adjustment	<b>X</b>	<b>O</b>	<b>O</b>	<b>X</b>	<b>X</b>
4. Laser power adjustment	<b>O</b>	<b>O</b>	<b>X</b>	<b>O</b>	<b>O</b>
5. Traverse adjustment	<b>O</b>	<b>O</b>	<b>X</b>	<b>O</b>	<b>X</b>
6. Focus bias adjustment	<b>O</b>	<b>O</b>	<b>X</b>	<b>O</b>	<b>X</b>
7. Error rate check	<b>O</b>	<b>O</b>	<b>X</b>	<b>O</b>	<b>X</b>
8. Auto gain output level adjustment	<b>O</b>	<b>O</b>	<b>X</b>	<b>O</b>	<b>X</b>

2. Set the test mode when performing adjustments.

After completing the adjustments, exit the test mode.

Perform the adjustments and checks in "group S" of the test mode.

3. Perform the adjustments to be needed in the order shown.

4. Use the following tools and measuring devices.

- Extension cable (19P) (Part No. J-2501-011-B)  
Relay connector (Part No. J-2501-167-A)  
(BD (CD) board CN101 to MICROCOMPUTER board CN300)
- Extension cable (17P) (with connector)  
(Part No. J-2501-167-A)  
(CONNECTOR board CN701 to MICROCOMPUTER board CN301)
- Extension cable (4P) (with connector)  
(Part No. J-2501-165-A)  
(LOAD MOTOR board CN713 to MICROCOMPUTER board CN302)
- Check Disc (MD) TDYS-1  
(Part No. 4-963-646-01)
- TEST DISK (MDW-74/AU-1) (Part No. 8-892-341-41)
- Laser power meter LPM-8001 (Part No. J-2501-046-A) or MD Laser power meter 8010S (Part No. J-2501-145-A)
- Oscilloscope (Measure after performing CAL of probe)
- Digital voltmeter
- Thermometer
- Jig for checking BD board waveform  
(Part No. : J-2501-149-A)

5. When observing several signals on the oscilloscope, etc., make sure that VC and ground do not connect inside the oscilloscope.  
(VC and ground will become short-circuited)
6. Using the above jig enables the waveform to be checked without the need to solder.  
(Refer to Servicing Notes on page 6)
7. As the disc used will affect the adjustment results, make sure that no dusts nor fingerprints are attached to it.

#### Laser power meter

When performing laser power checks and adjustment (electrical adjustment), use of the new MD laser power meter 8010S (J-2501-145-A) instead of the conventional laser power meter is convenient.

It sharply reduces the time and trouble to set the laser power meter sensor onto the objective lens of the pick-up.

#### 4. CREATING CONTINUOUSLY RECORDED DISC

\* This disc is used in focus bias adjustment and error rate check. The following describes how to create a continuous recorded disc.

1. Insert a disc (blank disc) commercially available.
2. Turn the dial to display "CREC MODE" (C31).
3. Press the **[ENTER/YES]** button to display "CREC MID".  
Display "CREC (0300)" and start to recording.
4. Complete recording within 5 minutes.
5. Press the **[MENU/NO]** button to stop recording .
6. Press the (MD) button and take out the disc.

The above has been how to create a continuous recorded data for the focus bias adjustment and error rate check.

#### Note :

- Be careful not to apply vibration during continuous recording.

## 5. CHECK PRIOR TO REPAIRS

These checks are performed before replacing parts according to "approximate specifications" to determine the faulty locations. For details, refer to "Checks Prior to Parts Replacement and Adjustments". (See page 10)

### 5-1. Temperature Compensation Offset Check

When performing adjustments, the set internal temperature and room temperature of 22 °C to 28 °C.

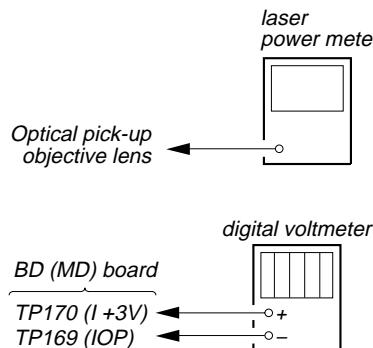
#### Checking Procedure:

1. Turn the dial to display "TEMP CHECK".
2. Press the **[ENTER/YES]** button.
3. "T=@@(##) [OK]" should be displayed. If "T=@@ (##) [NG]" is displayed, it means that the results are bad. (@@ indicates the current value set, and ## indicates the value written in the non-volatile memory)

### 5-2. Laser Power Check

Before checking, check the IOP value of the optical pick-up. (Refer to 7. Recording and Displaying IOP Information)

#### Connection :



#### Checking Procedure:

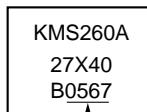
1. Set the laser power meter on the objective lens of the optical pick-up. (When it cannot be set properly, press the button or button to move the optical pick-up) Connect the digital volt meter to TP170 (I+3V) and TP169 (IOP).
2. Then, turn the dial to display "LDPWR CHECK" (C02).
3. Press the **[ENTER/YES]** button once to display "LD 0.9 mW \$ 00". Check that the reading of the laser power meter become 0.84 to 0.92 mW.
4. Press the **[ENTER/YES]** button once more to display "LD 7.0 mW \$ 00". Check that the reading the laser power meter and digital volt meter satisfy the specified value.

#### Specifications:

Laser power meter reading:  $7.0 \pm 0.2$  mW

Digital voltmeter reading : Optical pick-up displayed value  $\pm 10\%$

#### (Optical pick-up label)



*IOP=56.7 mA in this case*

*IOP (mA) = Digital voltmeter reading (mV)/1 (Ω)*

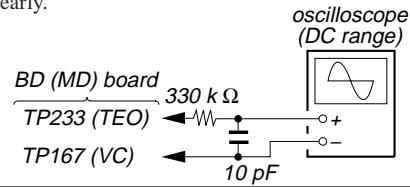
5. Press the **[MENU/NO]** button to display "LDPWR CHECK" and stop the laser emission. (The **[MENU/NO]** button is effective at all times to stop the laser emission)

**Note 1:** After step 4, each time the **[ENTER/YES]** button is pressed, the display will be switched between "LD 0.7 mW \$ 00", "LD 6.2 mW \$ 00", and "LD Wp 未セイ \$ 00". Nothing needs to be performed here.

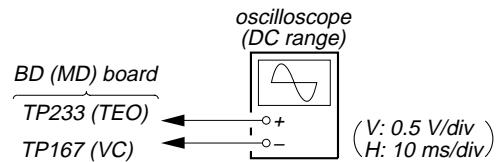
### 5-3. Traverse Check

**Note 1:** Data will be erased during MO reading if a recorded disc is used in this adjustment.

**Note 2:** If the traverse waveform is not clear, connect the oscilloscope as shown in the following figure so that it can be seen more clearly.



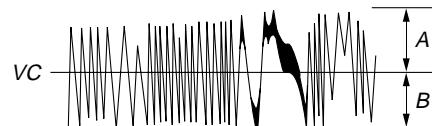
#### Connection :



#### Checking Procedure:

1. Connect an oscilloscope to TP233 (TEO) and TP167 (VC).
2. Load a disc (any available on the market). (Refer to Note 1.)
3. Press the button and move the optical pick-up outside the pit.
4. Turn the dial to display "EF MO CHECK"(C03).
5. Press the **[ENTER/YES]** button to display "EFB = 未 MO-R". (Laser power READ power/Focus servo ON/tracking servo OFF/spindle (S) servo ON)
6. Observe the waveform of the oscilloscope, and check that the specified value is satisfied. Do not turn the dial. (Read power traverse checking)

#### (Traverse Waveform)

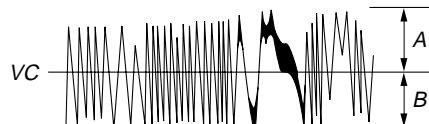


*Specified value : Below 10% offset value*

$$\text{Offset value (\%)} = \frac{|A - B|}{2(A + B)} \times 100$$

7. Press the **[ENTER/YES]** button to display "EFB = 未 MO-W".
8. Observe the waveform of the oscilloscope, and check that the specified value is satisfied. Do not turn the dial. (Write power traverse checking)

#### (Traverse Waveform)

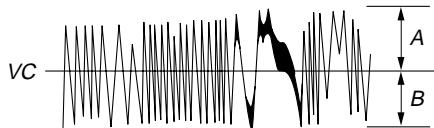


*Specified value : Below 10% offset value*

$$\text{Offset value (\%)} = \frac{|A - B|}{2(A + B)} \times 100$$

9. Press the [ENTER/YES] button to display “EFB = 00 MO-P”. Then, the optical pick-up moves to the pit area automatically and servo is imposed.
10. Observe the waveform of the oscilloscope, and check that the specified value is satisfied. Do not turn the [ $\leftrightarrow$ ] dial.

(Traverse Waveform)

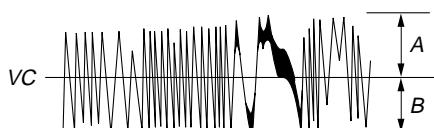


Specified value : Below 10% offset value

$$\text{Offset value (\%)} = \frac{|A - B|}{2(A + B)} \times 100$$

11. Press the [ENTER/YES] button to display “EF MO CHECK”. The disc stops rotating automatically.
12. Press the [MD] (MD) button and take out the disc.
13. Load the check disc (MD) TDYS-1.
14. Turn the [ $\leftrightarrow$ ] dial to display “EF CD CHECK” (C04).
15. Press the [ENTER/YES] button to display “EFB = 00 CD”. Servo is imposed automatically.
16. Observe the waveform of the oscilloscope, and check that the specified value is satisfied. Do not turn the [ $\leftrightarrow$ ] dial.

(Traverse Waveform)



Specified value : Below 10% offset value

$$\text{Offset value (\%)} = \frac{|A - B|}{2(A + B)} \times 100$$

17. Press the [ENTER/YES] button to display “EF CD CHECK”.
18. Press the [MD] (MD) button and take out the check disc (MD) TDYS-1.

#### 5-4. Focus Bias Check

Change the focus bias and check the focus tolerance amount.

Checking Procedure :

1. Load a test disk (MDW-74/AU-1).
  2. Turn the [ $\leftrightarrow$ ] dial to display “CPLAY MODE” (C30).
  3. Press the [ENTER/YES] button to display “CPLAY MID”.
  4. Press the [MENU/NO] button when “C = 0000 AD = 00” is displayed.
  5. Turn the [ $\leftrightarrow$ ] dial to display “FBIAS CHECK” (C05).
  6. Press the [ENTER/YES] button to display “0000/00 c = 00”. The first four digits indicate the C1 error rate, the two digits after [/] indicate ADER, and the 2 digits after “c =” indicate the focus bias value.
- Check that the C1 error is below 220 and ADER is below 2.
7. Press the [ENTER/YES] button to display “0000/00 b = 00”. Check that the C1 error is below 220 and ADER is below 2.
  8. Press the [ENTER/YES] button to display “0000/00 a = 00”. Check that the C1 error is below 220 and ADER is below 2.
  9. Press the [MENU/NO] button, next press the [MD] (MD) button and take out the test disc.

#### 5-5. C PLAY Checking

##### MO Error Rate Check

Checking Procedure :

1. Load a test disk (MDW-74/AU-1).
2. Turn the [ $\leftrightarrow$ ] dial to display “CPLAY MODE” (C30).
3. Press the [ENTER/YES] button to display “CPLAY MID”.
4. The display changes to “C = 0000 AD = 00”.
5. If the C1 error rate is below 80, check that ADER is below 2.
6. After press the [MENU/NO] button and stop playback, press the [MD] (MD) button and take out test disc.

##### CD Error Rate Check

Checking Procedure :

1. Load a check disc (MD) TDYS-1.
2. Turn the [ $\leftrightarrow$ ] dial to display “CPLAY MODE” (C30).
3. Press the [ENTER/YES] button twice to display “CPLAY MID”.
4. The display changes to “C = 0000 AD = 00”.
5. Check that the C1 error rate is below 50.
6. Press the [MENU/NO] button, stop playback, press the [MD] (MD) button and take out the test disc.

#### 5-6. Self-Recording/playback Check

Prepare a continuous recording disc using the unit to be repaired and check the error rate.

Checking Procedure :

1. Insert a recordable disc (blank disc) into the unit.
2. Turn the [ $\leftrightarrow$ ] dial to display “CREC MODE” (C31).
3. Press the [ENTER/YES] button to display the “CREC MID”.
4. When recording starts, “REC” is displayed, this becomes “CREC (@@@@)” (@@@@ indicates the address), and recording starts.
5. About 1 minute later, press the [MENU/NO] button to stop continuous recording.
6. Turn the [ $\leftrightarrow$ ] dial to display “CPLAY MODE” (C30).
7. Press the [ENTER/YES] button to display “CPLAY MID”.
8. “C = 0000 AD = 00” will be displayed.
9. Check that the C1 error becomes below 80 and the AD error below 2.
10. Press the [MENU/NO] button to stop playback, and press the [MD] (MD) button and take out the disc.

## 6. INITIAL SETTING OF ADJUSTMENT VALUE

### Note:

Mode which sets the adjustment results recorded in the non-volatile memory to the initial setting value. However the results of the temperature compensation offset adjustment will not change to the initial setting value.

If initial setting is performed, perform all adjustments again excluding the temperature compensation offset adjustment.

For details of the initial setting, refer to "3. Precautions on Adjustments" and execute the initial setting before the adjustment as required.

### Setting Procedure :

1. Turn the dial to display "ADJ CLEAR" (C24).
2. Press the **[ENTER/YES]** button. "Complete!" will be displayed momentarily and initial setting will be executed, after which "ADJ CLEAR" will be displayed.

## 7. RECORDING AND DISPLAYING THE IOP INFORMATION

The IOP data can be recorded in the non-volatile memory. The IOP value on the label of the optical pickup and the IOP value after the adjustment will be recorded. Recording these data eliminates the need to read the label on the optical pick-up.

### Recording Procedure :

1. Turn the dial to display "Iop Write" (C28), and press the **[ENTER/YES]** button.
2. The display becomes "Ref=@@.@@" (@ is an arbitrary number) and the numbers which can be changed will blink.
3. Input the IOP value written on the optical pick-up.  
To select the number : Turn the dial  
To select the digit : Press the **[MD WALKMAN SYNC]** button
4. When the **[ENTER/YES]** button is pressed, the display becomes "Measu=@@.@@" (@ is an arbitrary number).
5. As the adjustment results are recorded for the step 4. value. Leave it as it is and press the **[ENTER/YES]** button.
6. "Complete!" will be displayed momentarily. The value will be recorded in the non-volatile memory and the display will become "Iop Write".

### Display Procedure :

1. Turn the dial to display "Iop.Read"(C27).
2. "@@.@/#.#" is displayed and the recorded contents are displayed.  
@@. @ indicates the IOP value labeled on the pick-up.  
##. # indicates the IOP value after adjustment

## 8. TEMPERATURE COMPENSATION OFFSET ADJUTMENT

Save the temperature data at that time in the non-volatile memory as 25 °C reference data.

### Note :

1. Usually, do not perform this adjustment.
2. Perform this adjustment in an ambient temperature of 22 °C to 28 °C. Perform it immediately after the power is turned on when the internal temperature of the unit is the same as the ambient temperature of 22 °C to 28 °C.
3. When D101 has been replaced, perform this adjustment after the temperature of this part has become the ambient temperature.

### Adjusting Procedure :

1. Turn the dial to display "TEMP ADJUST" (C09).
2. Press the **[ENTER/YES]** button.
3. "TEMP = [OK]" and the current temperature data will be displayed.
4. To save the data, press the **[ENTER/YES]** button.  
When not saving the data, press the **[MENU/NO]** button.
5. When the **[ENTER/YES]** button is pressed, "TEMP = SAVE" will be displayed and turned back to "TEMP ADJUST" display then. When the **[MENU/NO]** button is pressed, "TEMP ADJUST" will be displayed immediately.

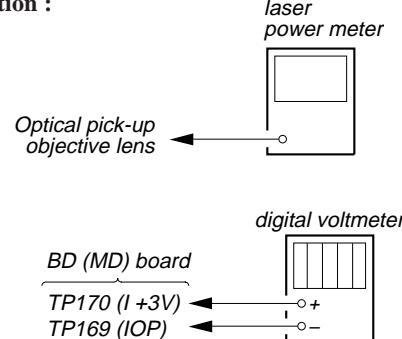
### Specified Value :

The "TEMP = " should be within "E0 to EF", "F0 to FF", "00 to 0F", "10 to 1F" and "20 to 2F".

## 9. LASER POWER ADJUSTMENT

Check the IOP value of the optical pick-up before adjustments.  
(Refer to 7. Recording and Displaying IOP Information)

### Connection :



### Adjusting Procedure :

1. Set the laser power meter on the objective lens of the optical pick-up. (When it cannot be set properly, press the button or button to move the optical pick-up.) Connect the digital volt meter to TP170 (I+3V) and TP169 (IOP).
2. Turn the dial to display "LDPWR ADJUST" (C10).  
(Laser power : For adjustment)
3. Press the **[ENTER/YES]** button to display "LD 0.9 mW \$ .
4. Turn the dial so that the reading of the laser power meter becomes 0.85 to 0.91 mW. Press the **[ENTER/YES]** button after setting the range dial of the laser power meter, and save the adjustment results. ("LD SAVE \$ " will be displayed for a moment)
5. Then "LD 7.0 mW \$ " will be displayed.
6. Turn the dial so that the reading of the laser power meter becomes 6.9 to 7.1 mW and press the **[ENTER/YES]** button to save it.

**Note:** Do not perform the emission with 7.0 mW more than 15 seconds continuously.

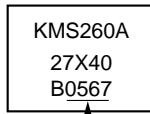
7. Then, turn the **[◀◀◀▶▶]** dial to display “LDPWR CHECK” (C02).
8. Press the **[ENTER/YES]** button once to display “LD 0.9 mW \$ 00”. Check that the reading of the laser power meter become 0.85 to 0.91 mW.
9. Press the **[ENTER/YES]** button once more to display “LD 7.0 mW \$ 00”. Check that the reading the laser power meter and digital volt meter satisfy the specified value.  
Note down the digital voltmeter reading value.

#### Specifications:

Laser power meter reading:  $7.0 \pm 0.1$  mW

Digital voltmeter reading : Optical pick-up displayed value  $\pm 10\%$

(Optical pick-up label)



IOP=56.7 mA in this case

IOP (mA) = Digital voltmeter reading (mV)/1 ( $\Omega$ )

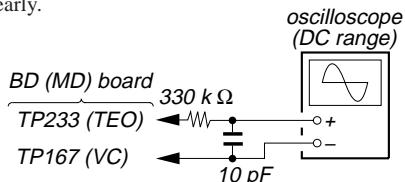
10. Press the **[MENU/NO]** button to display “LDPWR CHECK” and stop the laser emission.  
(The **[MENU/NO]** button is effective at all times to stop the laser emission)
11. Turn the **[◀◀◀▶▶]** dial to display “Iop.Write”(C28).
12. Press the **[ENTER/YES]** button. When the display becomes “Ref=@@@@.” (@ is an arbitrary number), press the **[ENTER/YES]** button to display “Measu=@@@@.” (@ is an arbitrary number).
13. The numbers which can be changed will blink. Input the IOP value noted down at step 9.  
To select the number : Turn the **[◀◀◀▶▶]** dial  
To select the digit : Press the **[MD WALKMAN SYNC]** button
14. When the **[ENTER/YES]** button is pressed, “Complete!” will be displayed momentarily. The value will be recorded in the non-volatile memory and the display will become “Iop Write”.

**Note 1:** After step 9, each time the **[ENTER/YES]** button is pressed, the display will be switched between “LD 0.7 mW \$ 00”, “LD 6.2 mW \$ 00”, and “LD Wp 木セイ \$ 00”. Nothing needs to be performed here.

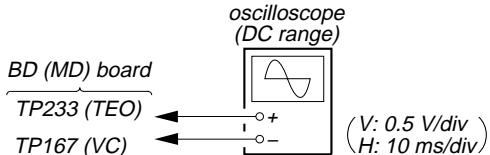
## 10. TRAVERSE ADJUSTMENT

**Note 1:** Data will be erased during MO reading if a recorded disc is used in this adjustment.

**Note 2:** If the traverse waveform is not clear, connect the oscilloscope as shown in the following figure so that it can be seen more clearly.



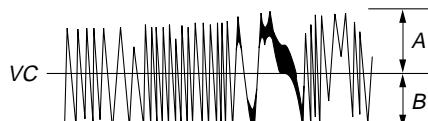
#### Connection :



#### Adjusting Procedure :

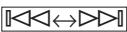
1. Connect an oscilloscope to TP233 (TEO) and TP167 (VC).
2. Load a disc (any available on the market). (Refer to Note 1)
3. Press the **[▶]** button and move the optical pick-up outside the pit.
4. Turn the **[◀◀◀▶▶]** dial to display “EF MO ADJUS” (C10).
5. Press the **[ENTER/YES]** button to display “EFB = 00 MO-R”.  
(Laser power READ power/Focus servo ON/tracking servo OFF/spindle (S) servo ON)
6. Turn the **[◀◀◀▶▶]** dial so that the waveform of the oscilloscope becomes the specified value.  
(When the **[◀◀◀▶▶]** dial is turned, the 00 of “EFB= 00” changes and the waveform transforms)  
In this adjustment, waveform varies at intervals of approx. 2%. Adjust the waveform so that the specified value is satisfied as much as possible.  
(Read power traverse adjustment)

(Traverse Waveform)

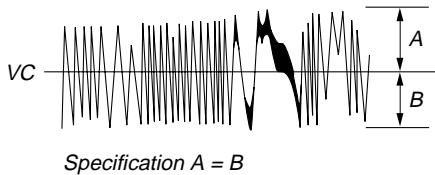


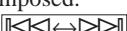
Specification A = B

7. Press the **[ENTER/YES]** button and save the result of adjustment to the non-volatile memory. (“EFB = 00 SAV” will be displayed for a moment. Then “EFB = 00 MO-W” will be displayed)

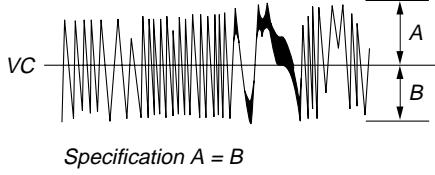
8. Turn the  dial so that the waveform of the oscilloscope becomes the specified value.  
(When the  dial is turned, the  of “EFB- 

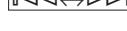
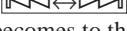
*(Traverse Waveform)*



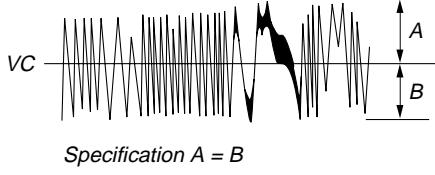
9. Press the **[ENTER/YES]** button, and save the adjustment results in the non-volatile memory. (“EFB =  SAVE” will be displayed for a moment)
10. “EFB =  MO-P”. will be displayed.  
The optical pick-up moves to the pit area automatically and servo is imposed.
11. Turn the  dial until the waveform of the oscilloscope becomes to the specified value.  
In this adjustment, waveform varies at intervals of approx. 2%. Adjust the waveform so that the specified value is satisfied as much as possible.

*(Traverse Waveform)*



12. Press the **[ENTER/YES]** button, and save the adjustment results in the non-volatile memory. (“EFB =  SAVE” will be displayed for a moment)  
Next “EF MO ADJUST” is displayed. The disc stops rotating automatically.
13. Press the  (MD) button and take out the disc.
14. Load the check disc (MD) TDYS-1.
15. Turn the  dial to display “EF CD ADJUST” (C12).
16. Press the **[ENTER/YES]** button to display “EFB =  CD”. Servo is imposed automatically.
17. Turn the  dial so that the waveform of the oscilloscope becomes to the specified value.  
In this adjustment, waveform varies at intervals of approx. 2%. Adjust the waveform so that the specified value is satisfied as much as possible.

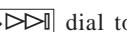
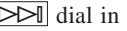
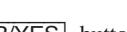
*(Traverse Waveform)*



18. Press the **[ENTER/YES]** button, display “EFB =  SAVE” for a moment and save the adjustment results in the non-volatile memory.  
Next “EF CD ADJUST” will be displayed.
19. Press the  (MD) button and take out the check disc (MD) TDYS-1.

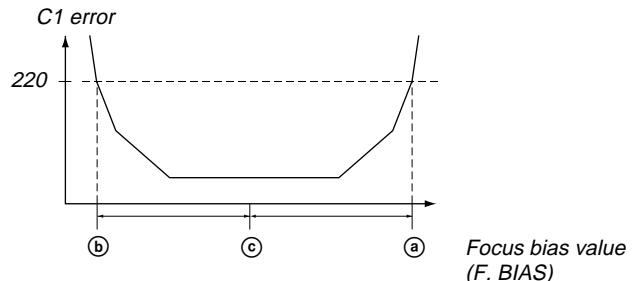
## 11. FOCUS BIAS ADJUSTMENT

### Adjusting Procedure :

1. Load a test disk (MDW-74/AU-1).
2. Turn the  dial to display “CPLAY MODE” (C30).
3. Press the **[ENTER/YES]** button to display “CPLAY MID”.
4. Press the **[MENU/NO]** button when “C =  AD =  dial to display “FBIAS ADJUST” (C13).
6. Press the **[ENTER/YES]** button to display “  a =  dial in the clockwise and find the focus bias value at which the C1 error rate becomes 220. (Refer to Note 2)
9. Turn the  dial in the counterclockwise and find the focus bias value at which the C1 error rate becomes 220.
10. Press the **[ENTER/YES]** button to display “  b = ” in “ -  -  (
  13. Press the  (MD) button and take out the test disc.

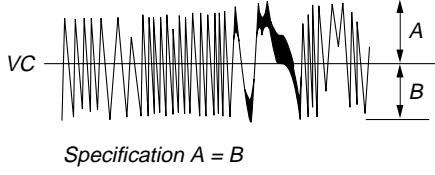
**Note 1:** The relation between the C1 error and focus bias is as shown in the following figure. Find points  and  in the following figure using the above adjustment. The focal point position  is automatically calculated from points  and .

**Note 2:** As the C1 error rate changes, perform the adjustment using the average vale.



*C1 error*  
*Focus bias value (F. BIAS)*

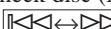
*(Traverse Waveform)*



## 12. ERROR RATE CHECK

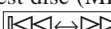
### 12-1. CD Error Rate Check

#### Checking Procedure :

1. Load a check disc (MD) TDYS-1.
2. Turn the  dial to display “CPLAY MODE” (C30).
3. Press the  button to display “CPLAY MID”.
4. The display changes to “C = 0000 AD = 00”.
5. Check that the C1 error rate is below 20.
6. Press the  button to stop playback and press the  (MD) button and take out the test disc.

### 12-2. MO Error Rate Check

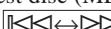
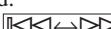
#### Checking Procedure :

1. Load a test disc (MDW-74/AU-1).
2. Turn the  dial to display “CPLAY MODE” (C30).
3. Press the  button to display “CPLAY MID”.
4. The display changes to “C1 = 0000 AD = 00”.
5. If the C1 error rate is below 50, check that ADER is below 2.
6. Press the  button to stop playback and press the  (MD) button and take out the test disc.

## 13. FOCUS BIAS CHECK

Change the focus bias and check the focus tolerance amount.

#### Checking Procedure :

1. Load a test disc (MDW-74/AU-1).
2. Turn the  dial to display “CPLAY MODE” (C30).
3. Press the  button to display “CPLAY MID”.
4. Press the  button when “C = 0000 AD = 00” is displayed.
5. Turn the  dial to display “FBIAS CHECK” (C05).
6. Press the  button to display “0000/00 c = 00”.  
The first four digits indicate the C1 error rate, the two digits after “/” indicate ADER, and the 2 digits after “c =” indicate the focus bias value.  
Check that the C1 error is below 50 and ADER is below 2.
7. Press the  button to display “0000/00 b = 00”.  
Check that the C1 error is below 220 and ADER is below 2.
8. Press the  button to display “0000/00 a = 00”.  
Check that the C1 error is below 220 and ADER is below 2
9. Press the  button, next press the  (MD) button and take out the continuously recorded disc.

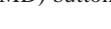
**Note 1:** If the C1 error and ADER are above other than the specified value at points a (step 8. in the above) or b (step 7. in the above), the focus bias adjustment may not have been carried out properly. Adjust perform the beginning again.

## 14. AUTO GAIN CONTROL OUTPUT LEVEL ADJUSTMENT

Be sure to perform this adjustment when the pickup is replaced. If the adjustment results becomes “Adjust NG!”, the pickup may be faulty or the servo system circuits may be abnormal.

### 14-1. CD Auto Gain Control Output Level Adjustment

#### Adjusting Procedure :

1. Load a check disc (MD) TDYS-1.
2. Turn the  dial to display “AG Set (CD)” (C26).
3. When the  button is pressed, the adjustment will be performed automatically.  
“Complete!!” will then be displayed momentarily when the value is recorded in the non-volatile memory, after which the display changes to “AG Set (CD)”.
4. Press the  (MD) button and take out the disc.

### 14-2. MO Auto Gain Control Output Level Adjustment

#### Adjusting Procedure :

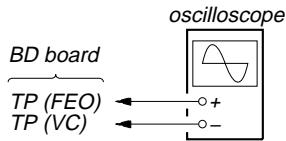
1. Load a test disc (MDW-74/AU-1) for recording.
2. Turn the  dial to display “AG Set (MO)” (C25).
3. When the  button is pressed, the adjustment will be performed automatically.  
“Complete!!” will then be displayed momentarily when the value is recorded in the non-volatile memory, after which the display changes to “AG Set (MO)”.
4. Press the  (MD) button and take out the disc.

## CD SECTION

### Note:

1. CD Block is basically designed to operate without adjustment. Therefore, check each item in order given.
2. Use YEDS-18 disc (3-702-101-01) unless otherwise indicated.
3. Use an oscilloscope with more than  $10 M\Omega$  impedance.
4. Clean the object lens by an applicator with neutral detergent when the signal level is low than specified value with the following checks.
5. Use the following extension cables and relay connector.
  - Extension cable (19P) (Part No. J-2501-011-B)  
Relay connector (Part No. J-2501-167-A)  
(BD (CD) board CN101 to MICROCOMPUTER board CN300)
  - Extension cable (17P) (with connector) (Part No. J-2501-167-A)  
(CONNECTOR board CN701 to MICROCOMPUTER board CN301)
  - Extension cable (4P) (with connector) (Part No. J-2501-165-A)  
(LOAD MOTOR board CN713 to MICROCOMPUTER board CN302)

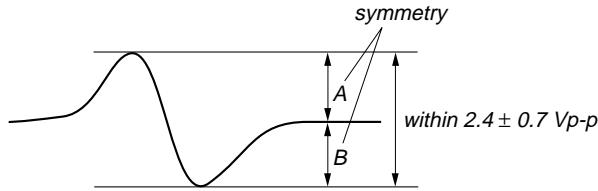
### 1. S-CURVE CHECK



#### Procedure:

1. Connect oscilloscope to TP (FEO).
2. Connect between TP (FEO) and TP (VC) by lead wire.
3. Connect between TP (AGCCON) and GND by lead wire.
4. Turn the power ON.
5. Load a disc (YEDES-18) and turn the power ON. again and actuate the focus search. (Actuate the focus search when disc tray is moving in and out)
6. Check the oscilloscope waveform (S-curve) is symmetrical between A and B. And confirm peak to peak level within  $2.4 \pm 0.7 V_{p-p}$ .

S-curve waveform

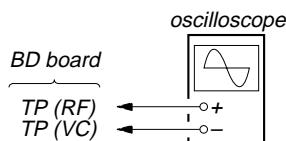


7. After check, remove the lead wire connected in step 2.

**Note:**

- Try to measure several times to make sure than the ratio of A : B or B : A is more than 10 : 7.
- Take sweep time as long as possible and light up the brightness to obtain best waveform.

### 2. RF LEVEL CHECK

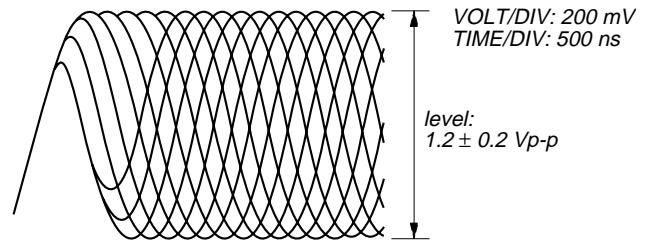


#### Procedure:

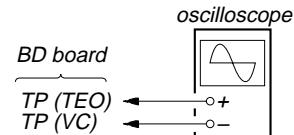
1. Connect oscilloscope to TP (RF).
2. Turn the power ON.
3. Load a disc (YEDES-18) and playback.
4. Confirm that oscilloscope waveform is clear and check RF signal level is correct or not.

**Note:** Clear RF signal waveform means that the shape "◇" can be clearly distinguished at the center of the waveform.

RF signal waveform



### 3. E-F BALANCE (TRAVERSE) CHECK (WITHOUT REMOTE COMMANDER)

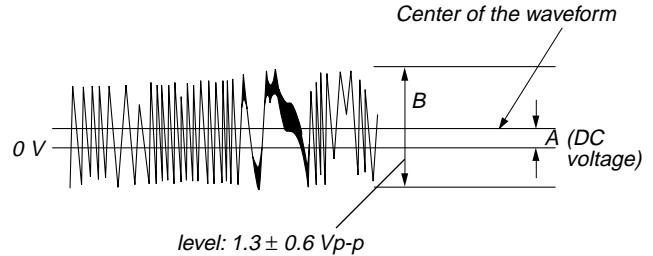


#### Procedure:

1. Connect lead wire to TP308 (ADJ) on the MICROCOMPUTER board.
2. Connect oscilloscope to TP (TEO) on the BD (CD) board.
3. Turn the set ON.
4. Connect lead wire in step1. to GND.
5. Load a disc (YEDES-18) and playback.
6. Press the [DISPLAY] button to the tracking servo and the slewing servo is turned OFF.
7. Check the level B of the oscilloscope's waveform and the A (DC voltage) of the center of the Traverse waveform. Confirm the following:

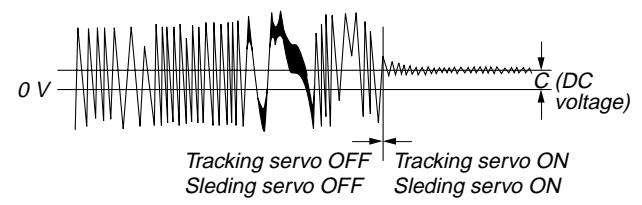
$$\frac{A}{B} \times 100 = \text{less than } \pm 22 \text{ (%)}$$

Traverse waveform



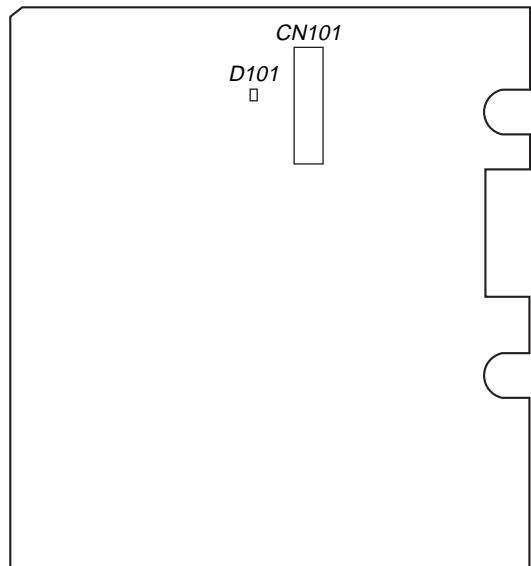
8. Press the [DISPLAY] button to the tracking servo and the slewing servo is turned ON. Confirm the C (DC voltage) is almost equal to the A (DC voltage) in step 7.

Traverse waveform

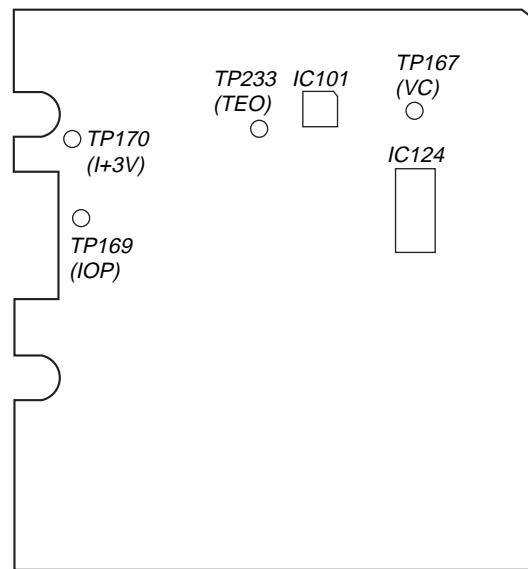


Connecting points:

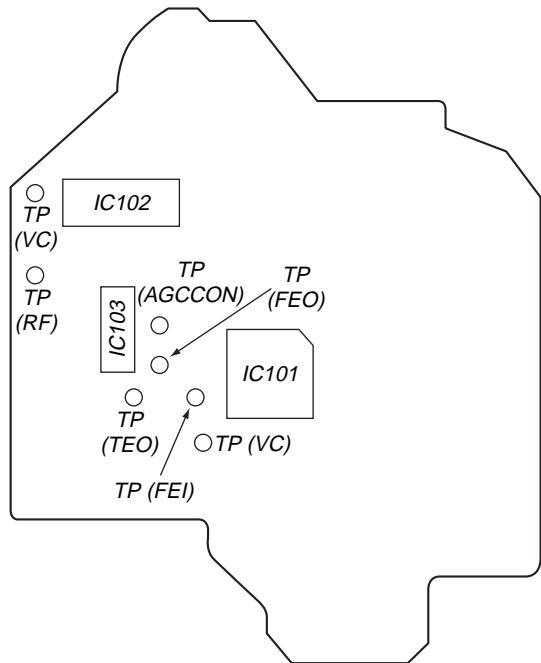
[BD (MD) Board] (Side A)



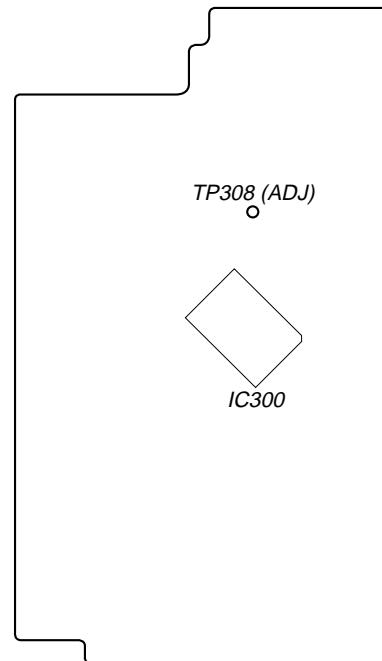
[BD (MD) Board] (Side B)



[BD (CD) Board] (Side B)

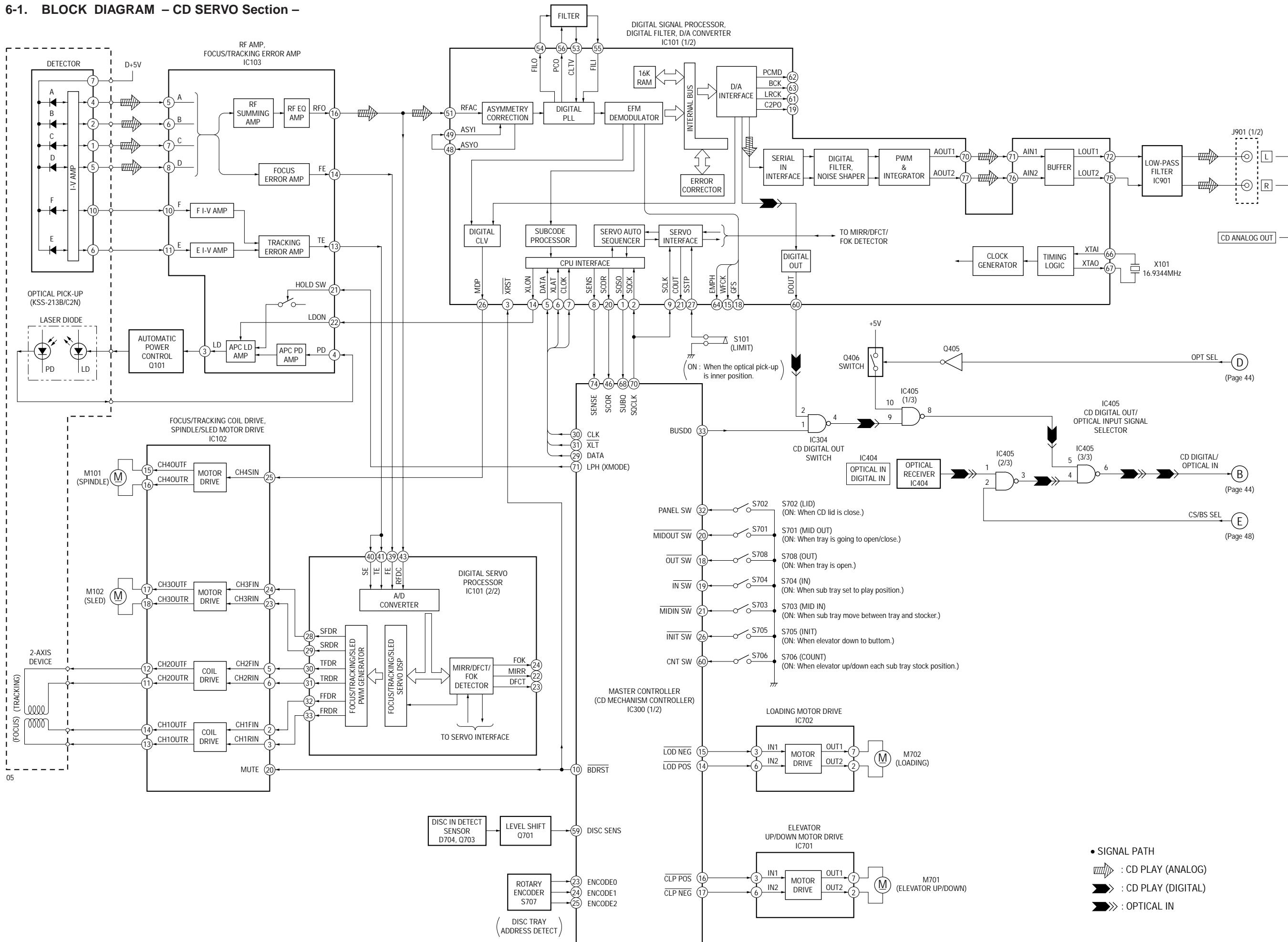


[MICROCOMPUTER Board] (Side B)

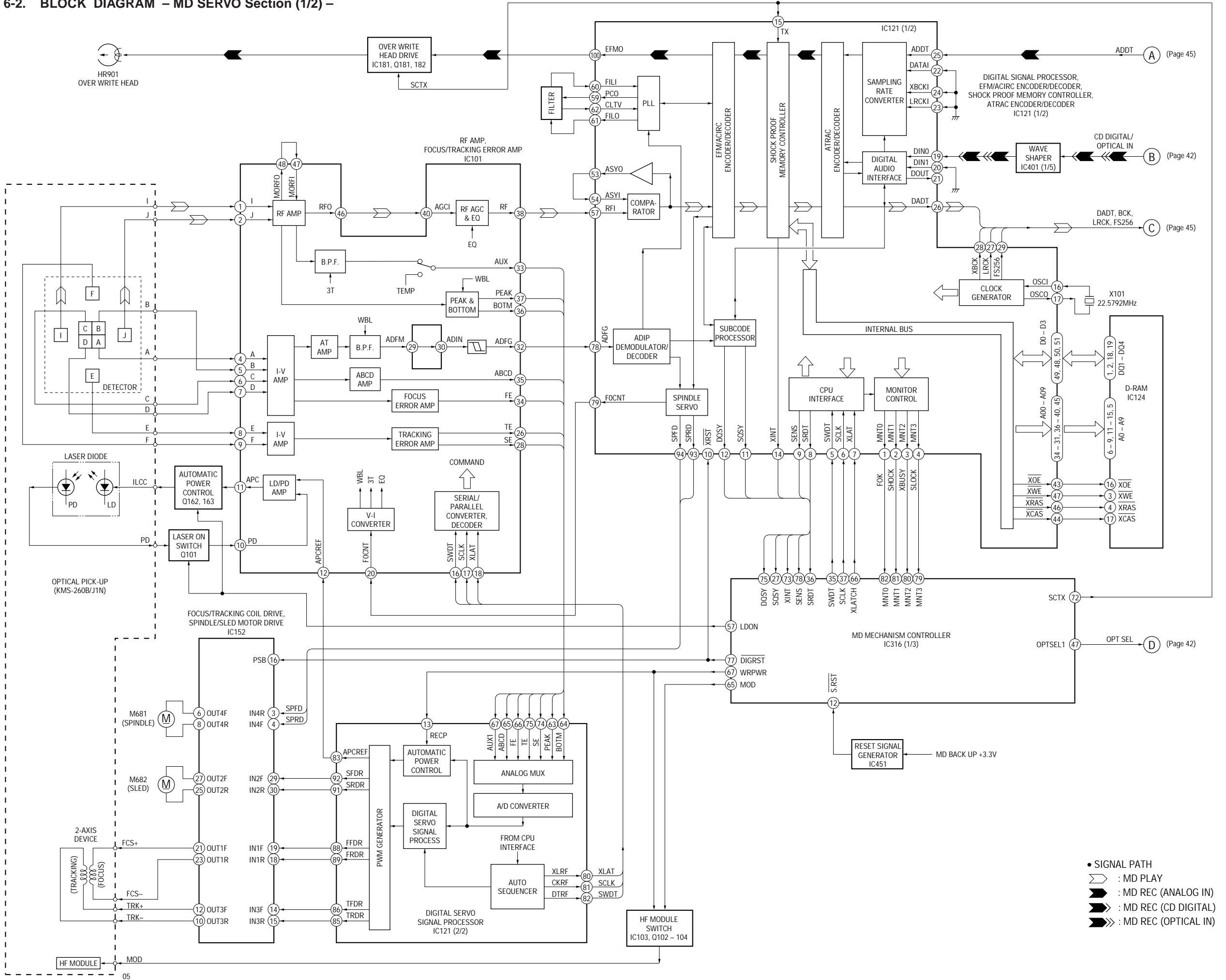


## SECTION 6 DIAGRAMS

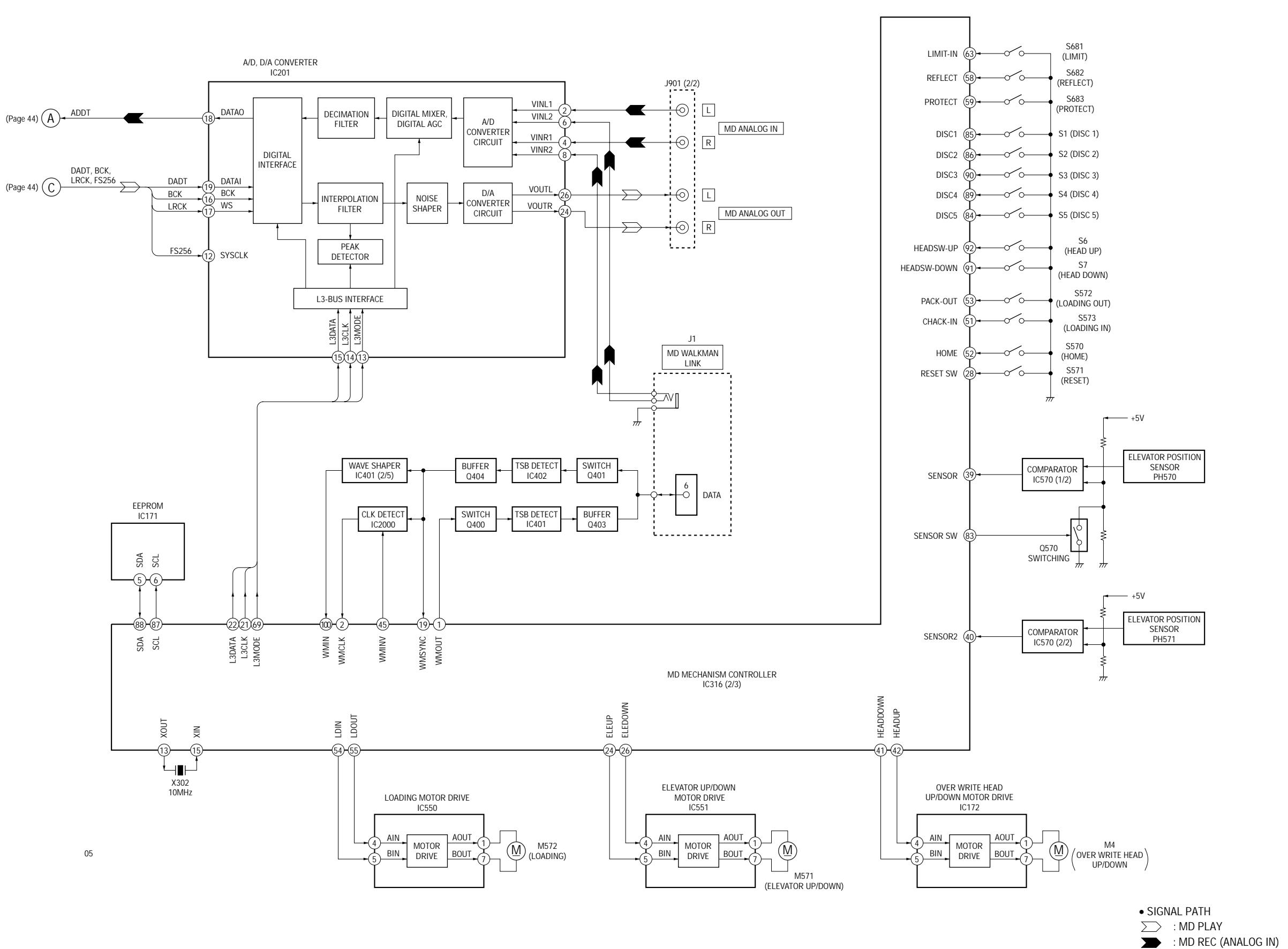
### 6-1. BLOCK DIAGRAM – CD SERVO Section –



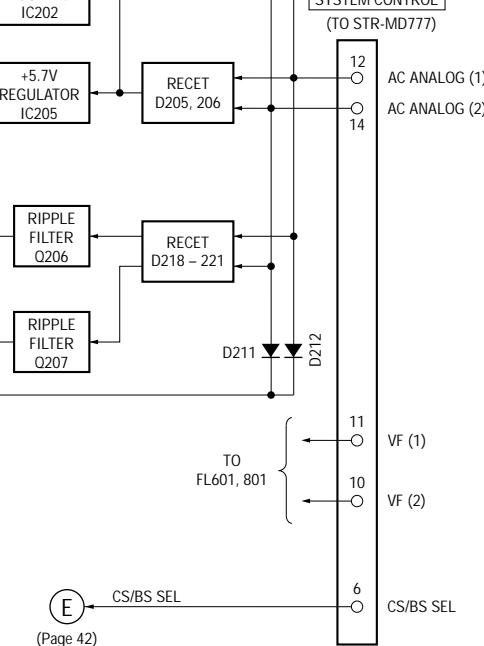
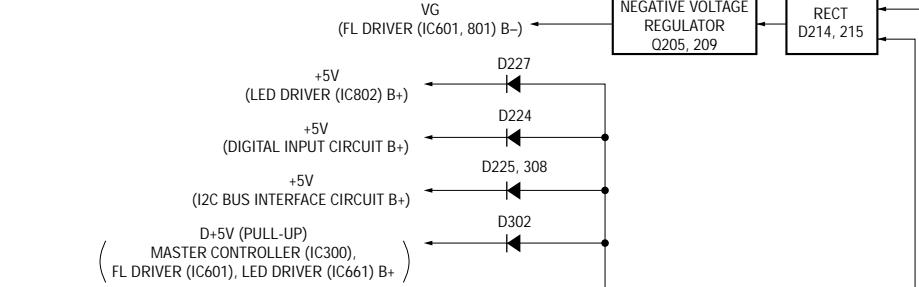
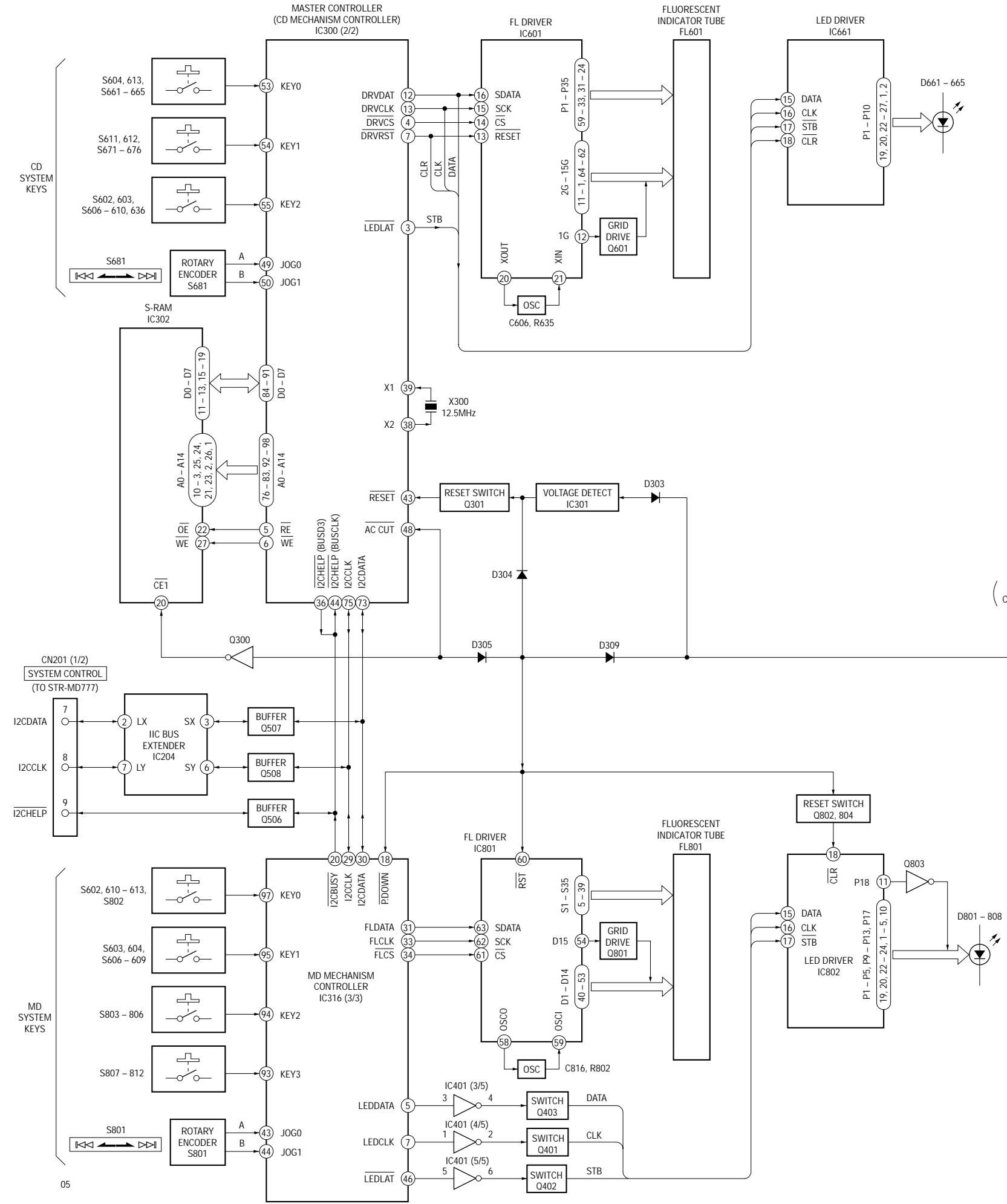
## 6-2. BLOCK DIAGRAM – MD SERVO Section (1/2) –



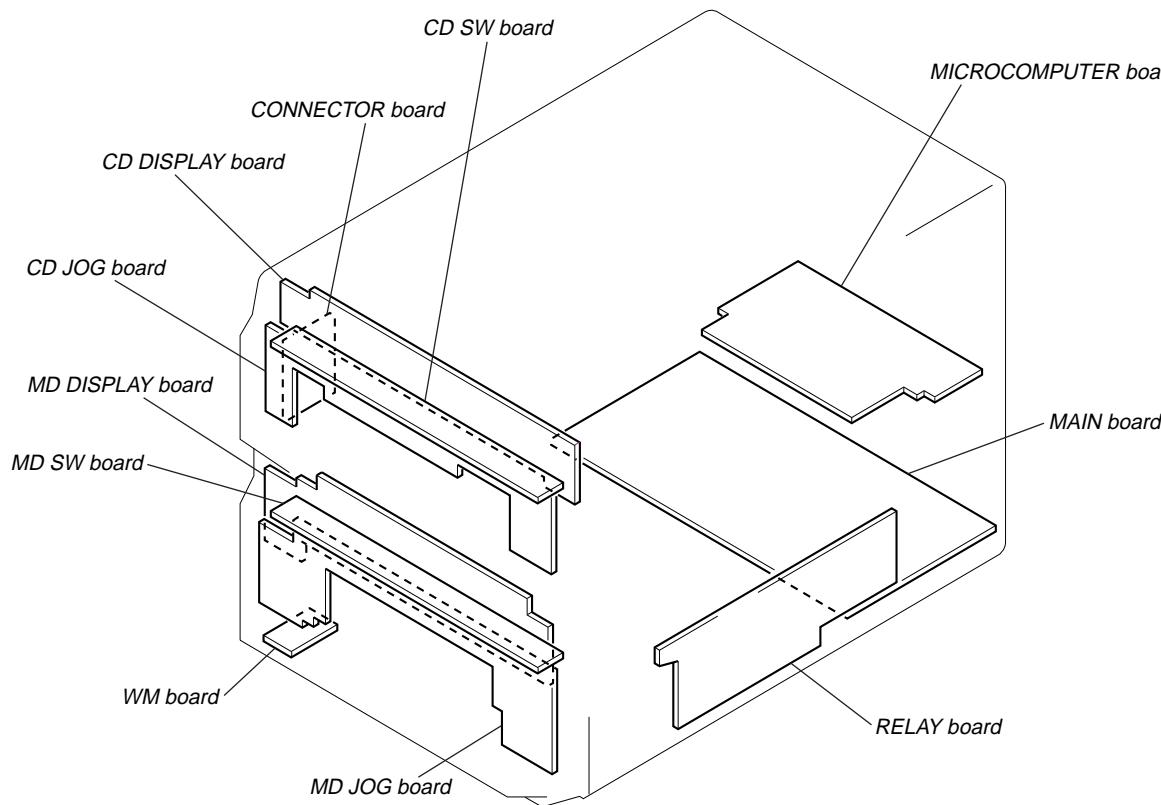
## 6-3. BLOCK DIAGRAM – MD SERVO Section (2/2) –



## 6-4. BLOCK DIAGRAM – DISPLAY/POWER SUPPLY Section –



• Circuit Boards Location



**6-5. NOTE FOR PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS**

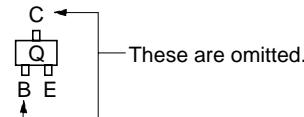
**Note on Printed Wiring Board:**

- : parts extracted from the component side.
- : parts extracted from the conductor side.
- : internal component.
- : Pattern from the side which enables seeing.  
(The other layers' patterns are not indicated.)

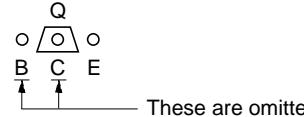
**Caution:**

Pattern face side: Parts on the pattern face side seen from (Side B)  
Parts face side: Parts on the parts face side seen from (Side A)

- Indication of transistor.



These are omitted.



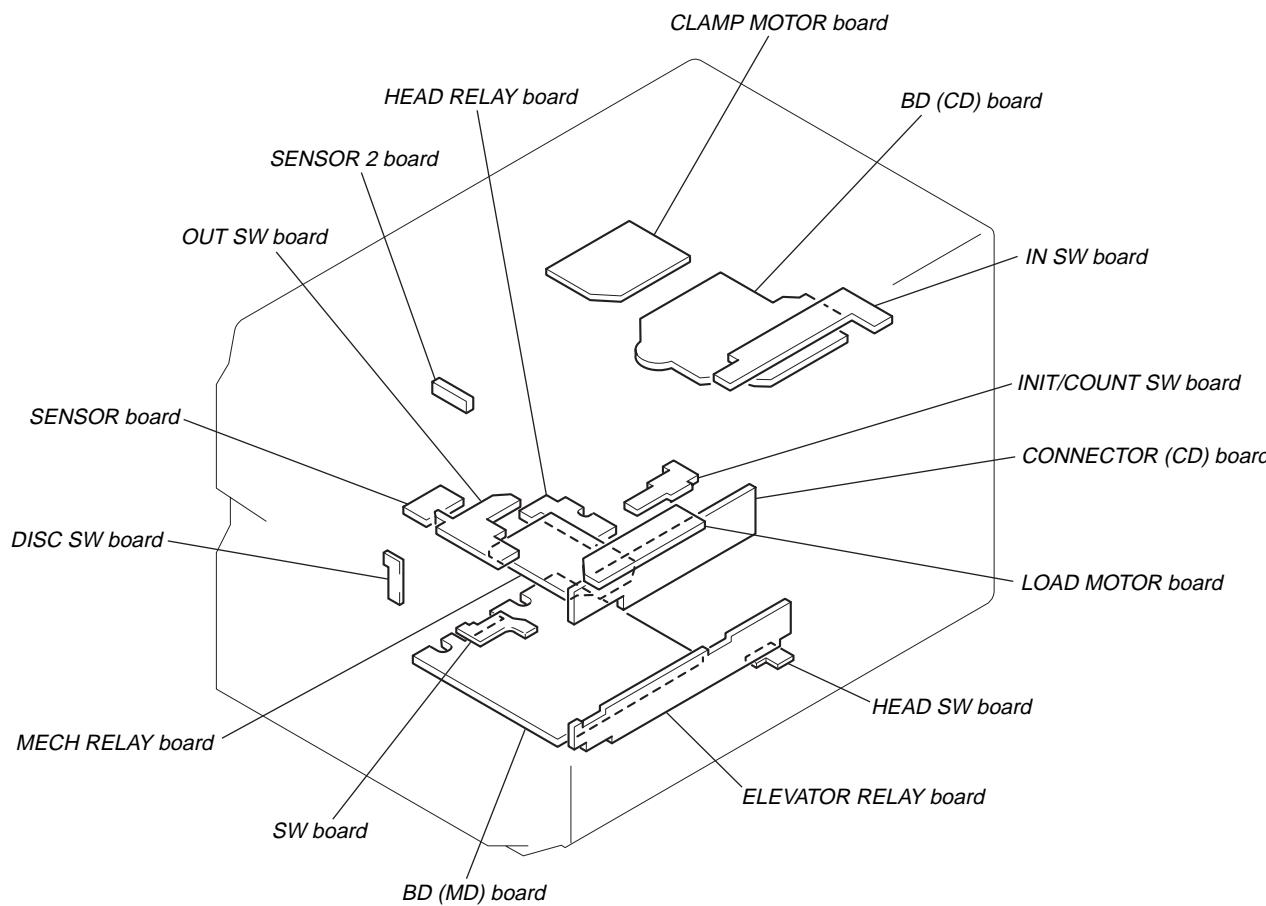
These are omitted.

**Note on Schematic Diagram:**

- All capacitors are in  $\mu\text{F}$  unless otherwise noted.  $\text{pF}$ :  $\mu\text{pF}$  50 WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in  $\Omega$  and  $1/4\text{W}$  or less unless otherwise specified.
- : internal component.
- : panel designation.

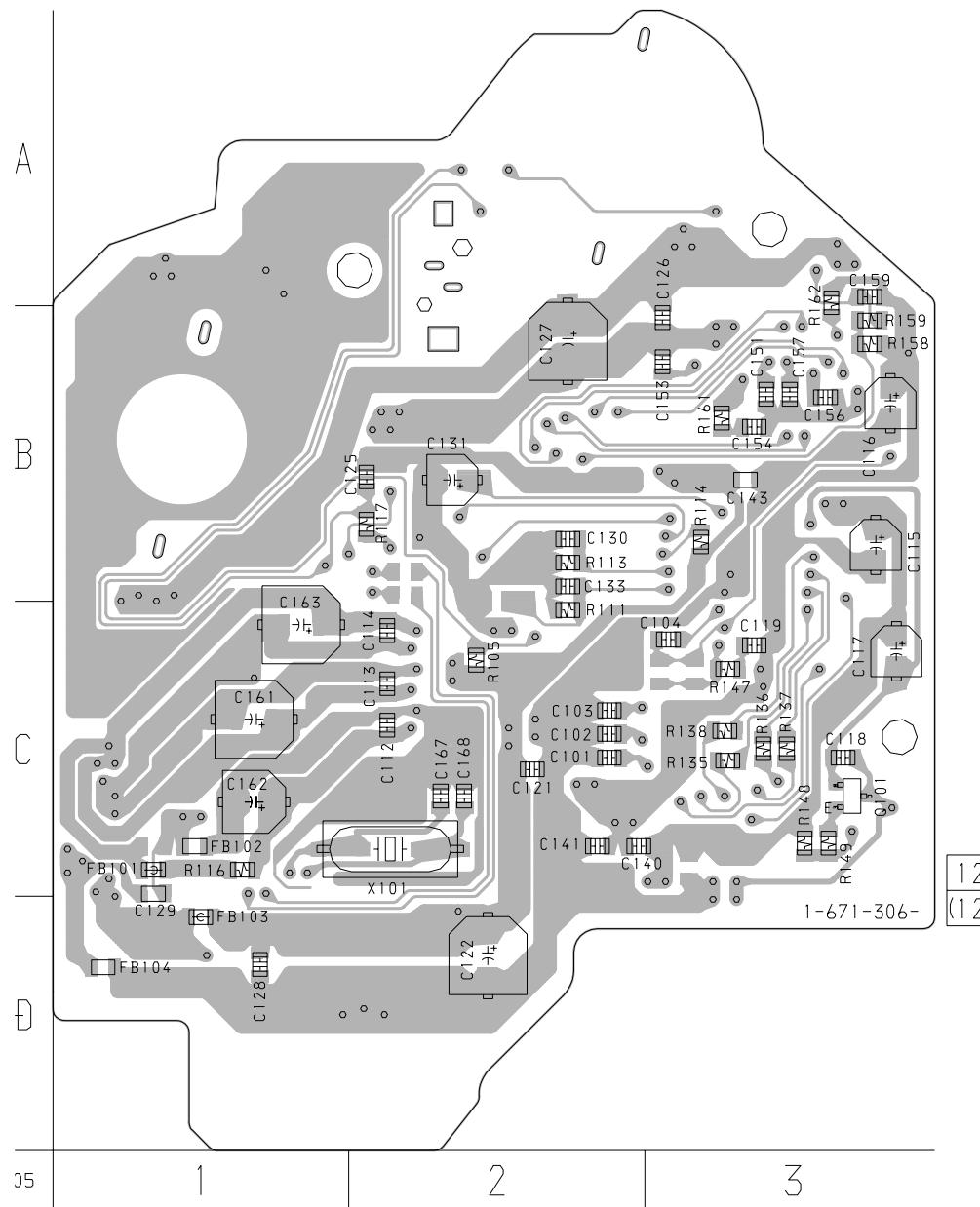
**Note:** The components identified by mark or dotted line with mark are critical for safety.  
Replace only with part number specified.

- : B+ Line.
- : B- Line.
- Voltages are taken with a VOM (Input impedance 10 M $\Omega$ ). Voltage variations may be noted due to normal production tolerances.
- Waveforms are taken with a oscilloscope. Voltage variations may be noted due to normal production tolerances.
- Circled numbers refer to waveforms.
- Signal path:  
 : CD PLAY (ANALOG)  
 : CD PLAY (DIGITAL)  
 : MD PLAY  
 : MD REC (ANALOG IN)  
 : MD REC (OPTICAL IN)



## 6-6. PRINTED WIRING BOARD - BD (CD) Section - • See Page 49 for Circuit Boards Location.

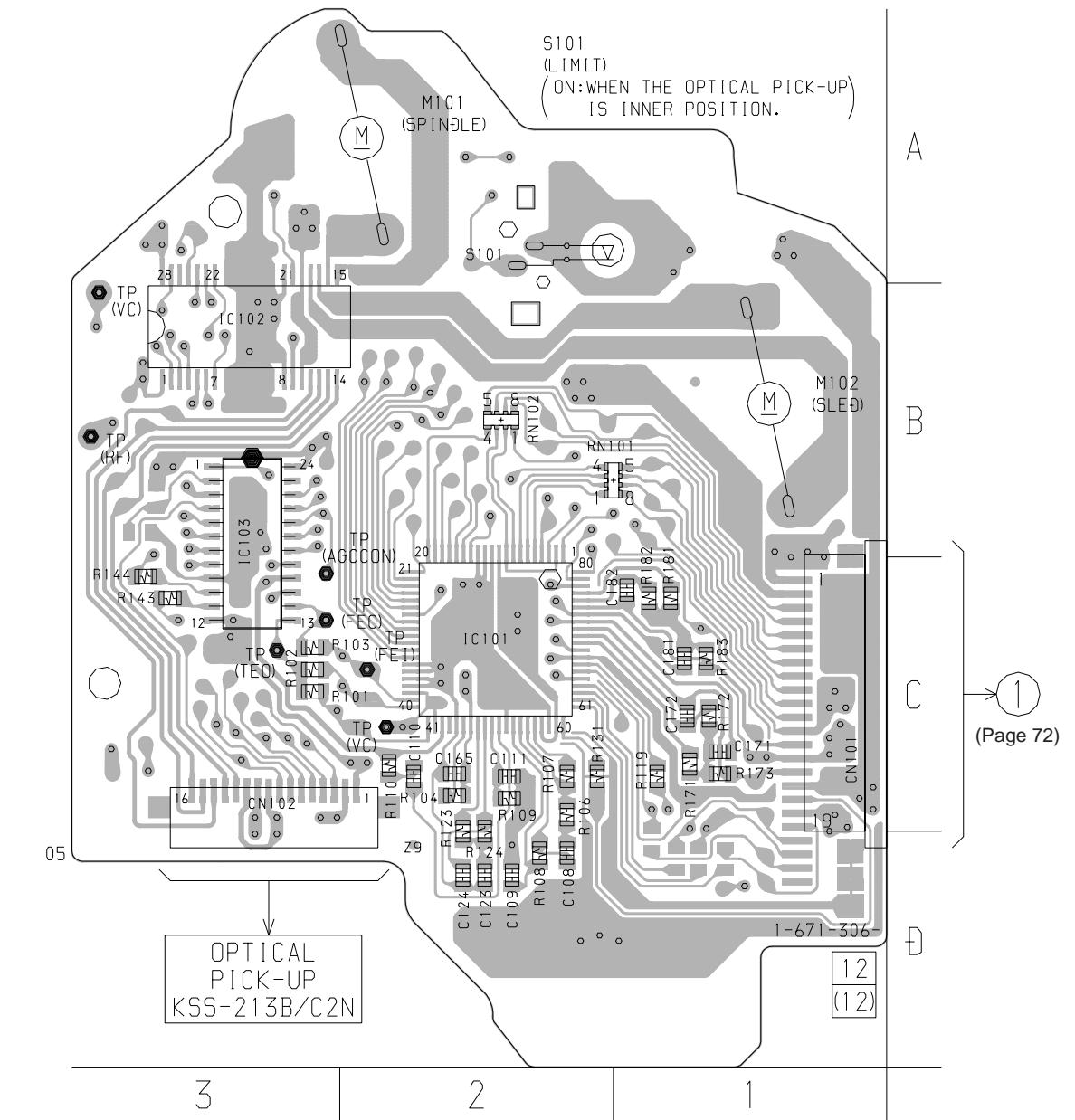
【BD (CD) BOARD】(SIDE A)



- Semiconductor Location (SIDE A)

Ref. No.	Location
Q101	C-3

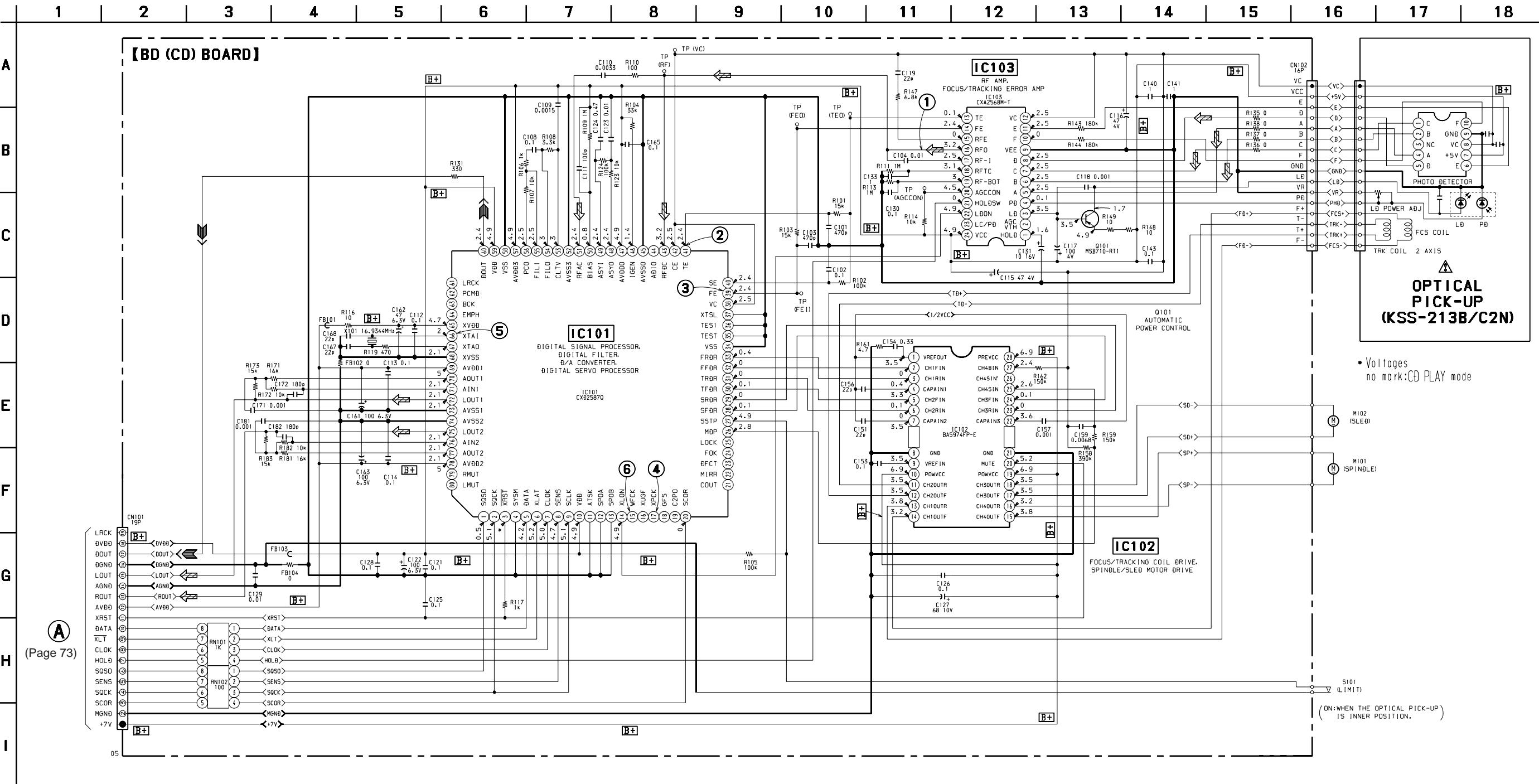
【BD (CD) BOARD】(SIDE B)



- Semiconductor Location (SIDE B)

Ref. No.	Location
IC101	C-2
IC102	B-3
IC103	B-3

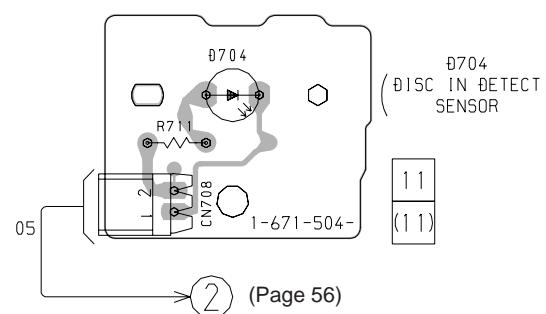
6-7. SCHEMATIC DIAGRAM – BD (CD) Section – • See page 65 for Waveforms. • See page 99 for IC Block Diagrams.



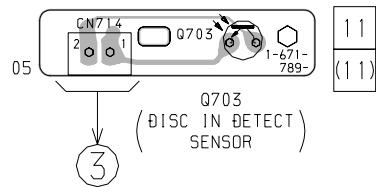
The components identified by mark or dotted line with mark are critical for safety. Replace only with part number specified.

## 6-8. PRINTED WIRING BOARDS – CD MOTOR/SENSOR Section – • See page 49 for Circuit Boards Location.

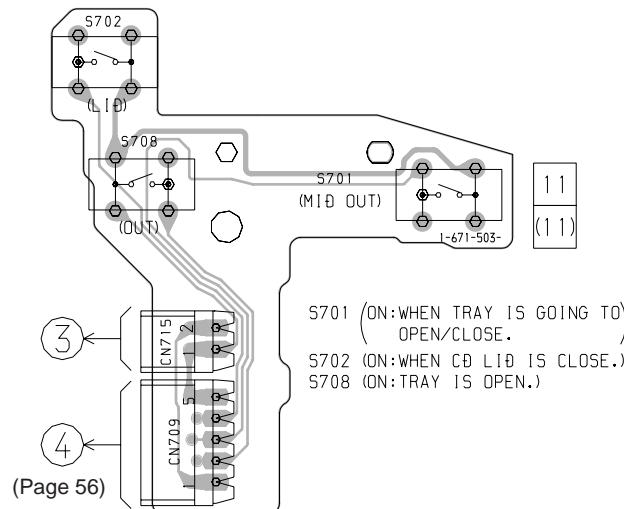
【SENSOR BOARD】



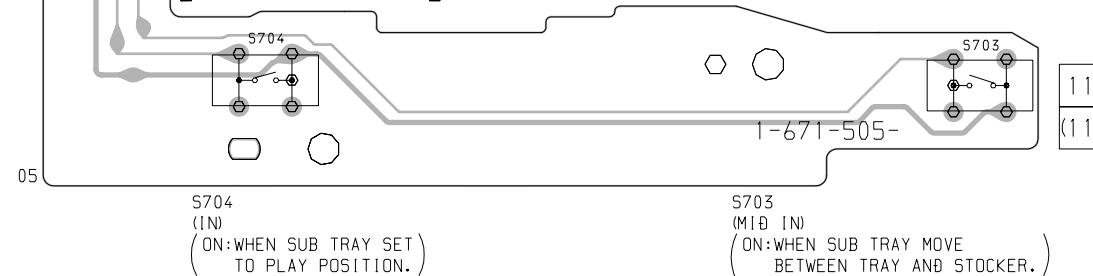
【SENSOR 2 BOARD】



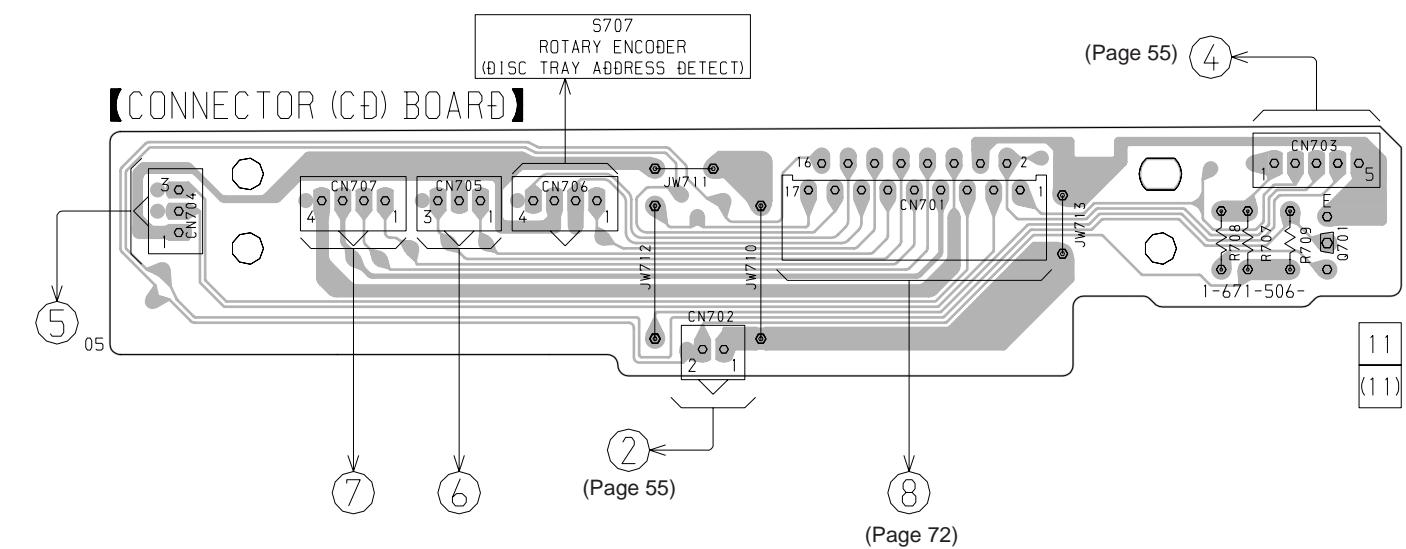
【OUT SW BOARD】



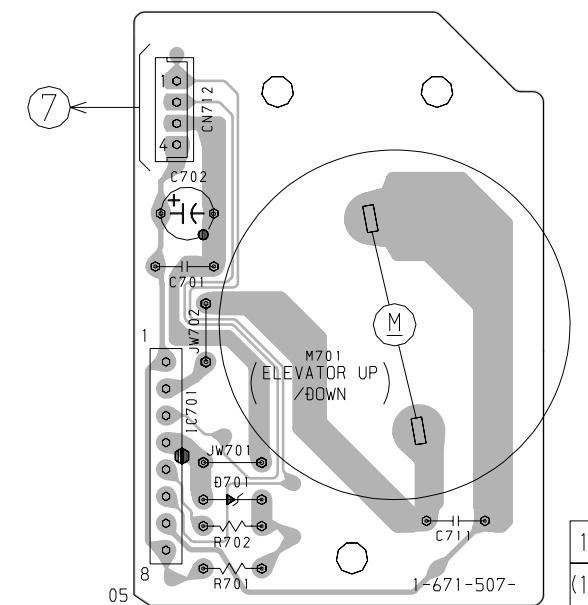
【IN SW BOARD】



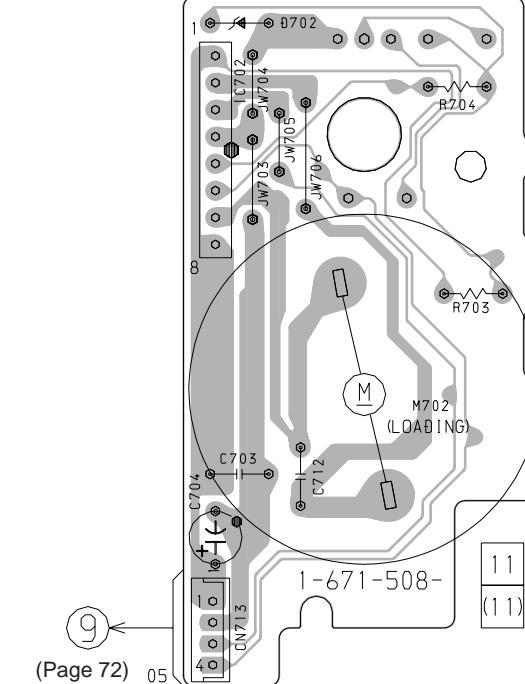
【CONNECTOR (CD) BOARD】



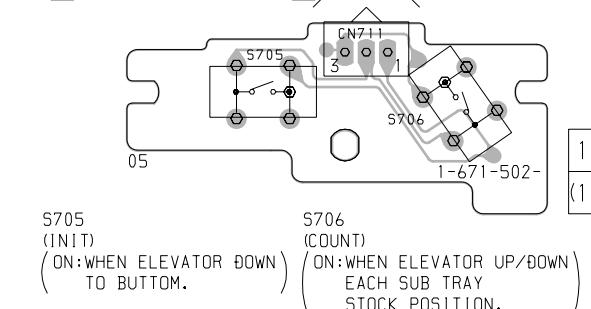
【CLAMP MOTOR BOARD】



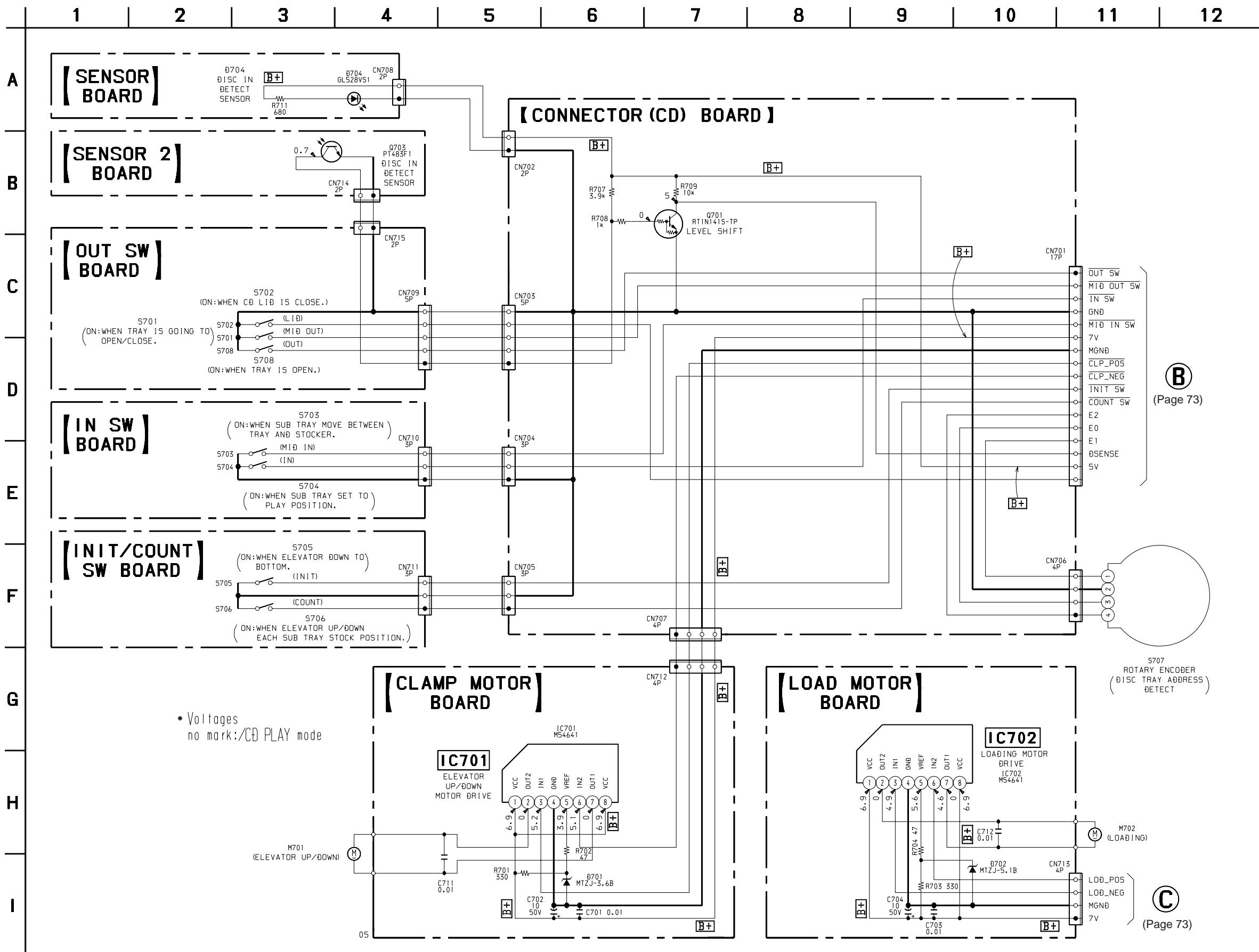
【LOAD MOTOR BOARD】



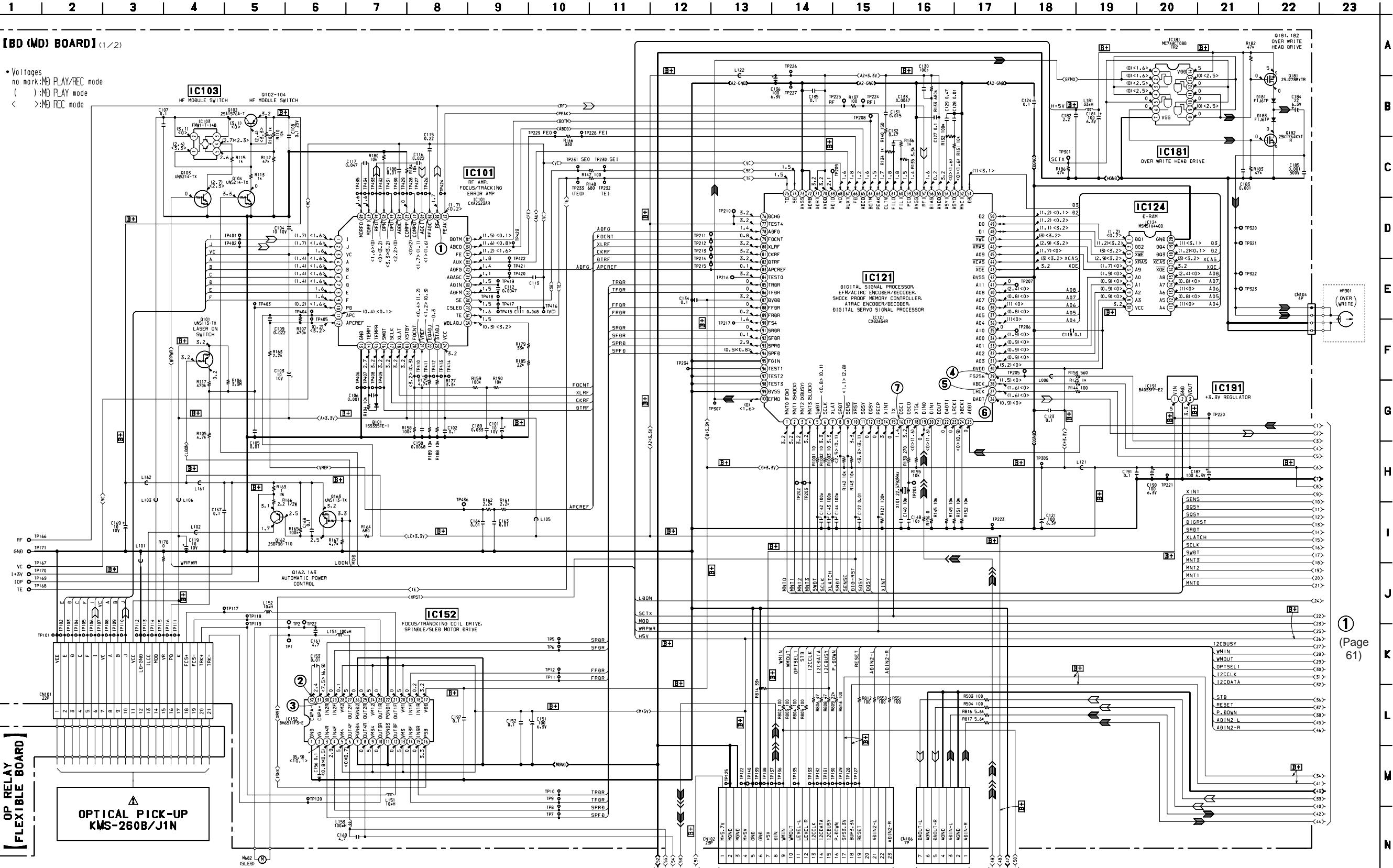
【INIT/COUNT SW BOARD】



## 6-9. SCHEMATIC DIAGRAM – CD MOTOR/SENSOR Section – • See page 100 for IC Block Diagram.



## 6-10. SCHEMATIC DIAGRAM – BD (MD) Section (1/2) – • See page 65 for Waveforms. • See page 101 for IC Block Diagrams.



(Page 62)

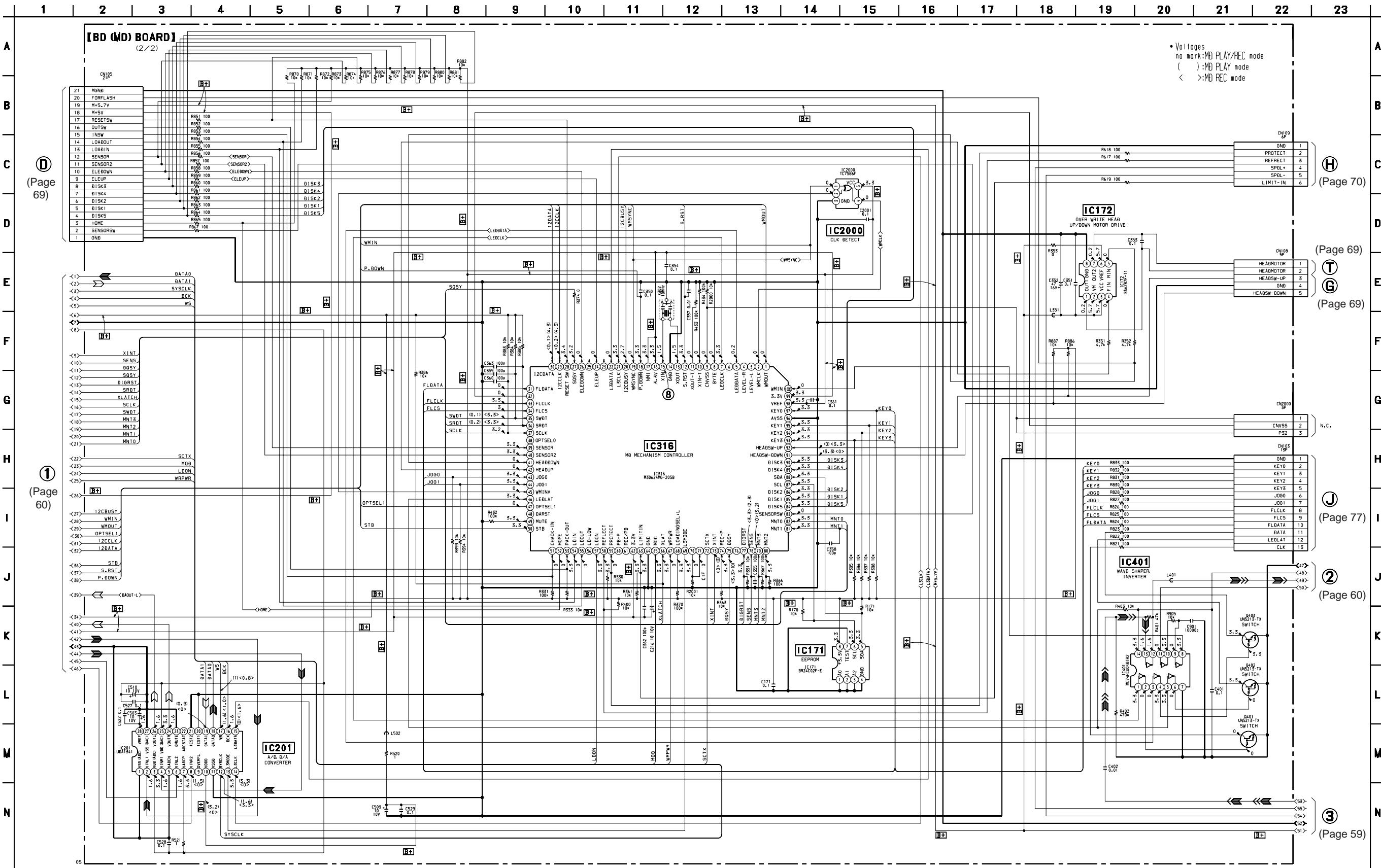
(Page 78)

(Page 81) (Page 62)

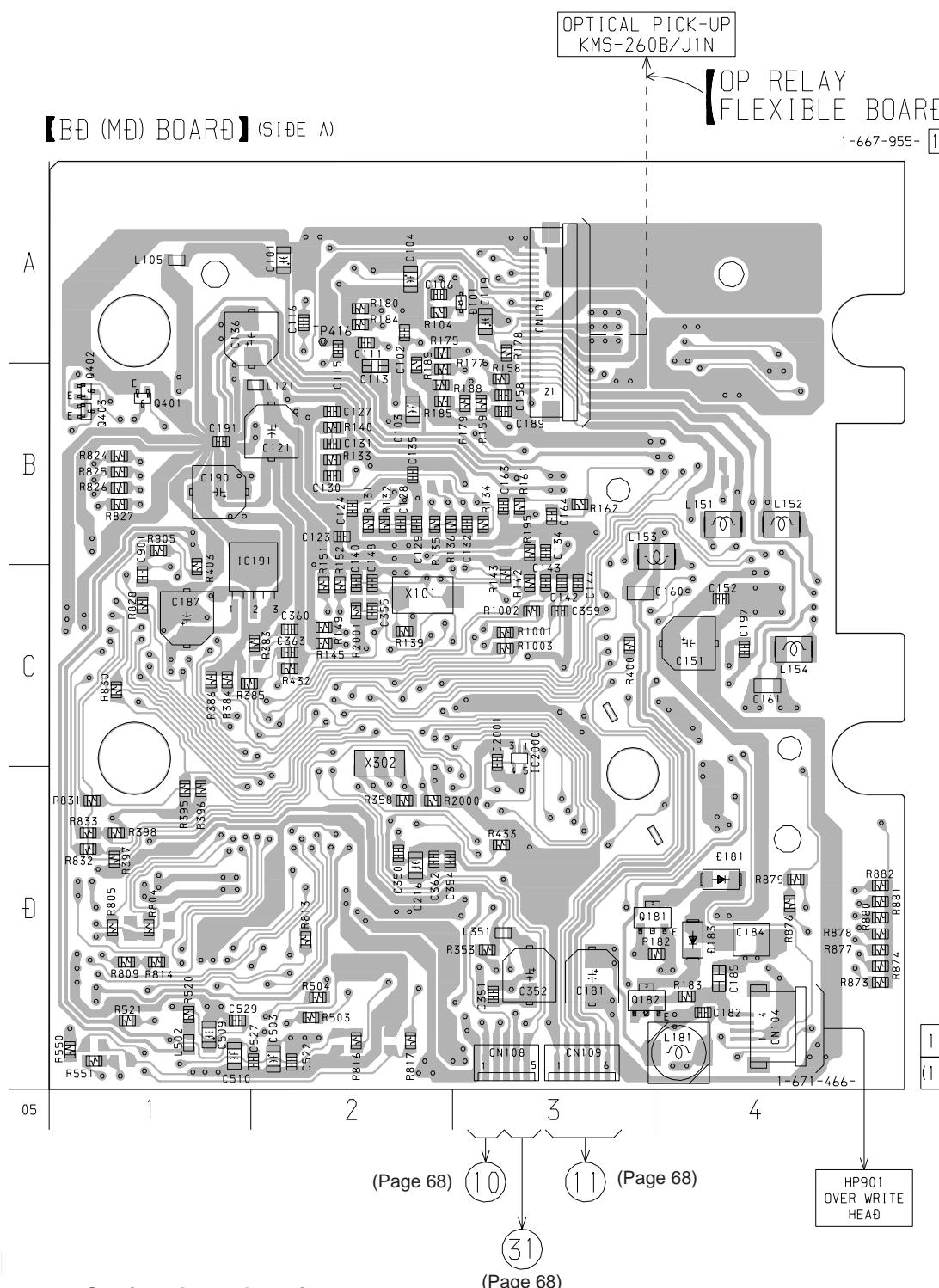
1 (Page 61)

The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety.  
Replace only with part number specified.

## 6-11. SCHEMATIC DIAGRAM – BD (MD) Section (2/2) – • See page 66 for Waveform.



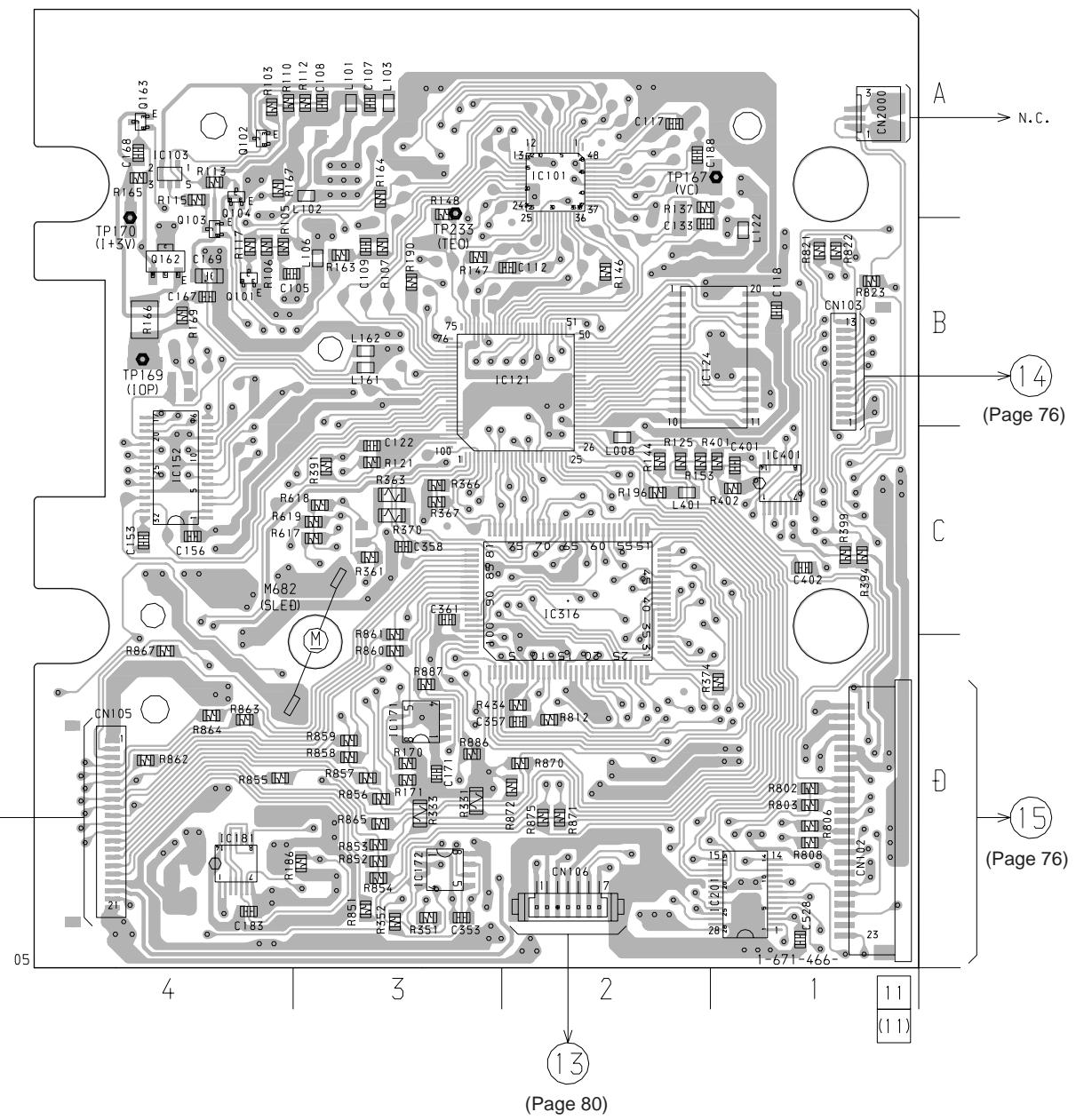
## 6-12. PRINTED WIRING BOARDS - BD (MD) Section - • See page 49 for Circuit Boards Location.



- Semiconductor Location  
(SIDE A)

Ref. No.	Location	Ref. No.	Location
D101	A-3	Q181	D-3
D181	D-4	Q182	D-3
D183	D-4	O401	B-1
IC191	C-2	Q402	B-1
IC2000	C-3	Q403	B-1

## 【BD (MD) BOARD】(SIDE B)



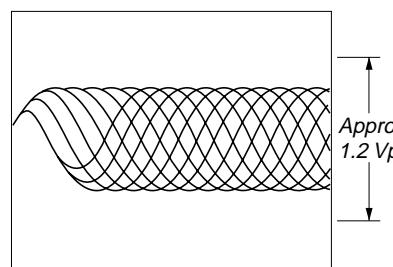
- Semiconductor Location  
(SIDE B)

Ref. No.	Location	Ref. No.	Location
IC101	A-2	IC316	C-2
IC103	A-4	IC401	C-1
IC121	B-2		
IC124	B-1	Q101	B-4
IC152	C-4	Q102	A-4
IC171	D-3	Q103	B-4
IC172	D-3	Q104	A-4
IC181	D-4	Q162	B-4
IC201	D-1	Q163	A-4

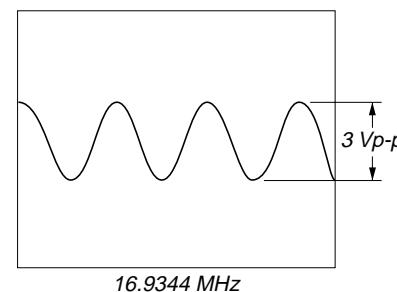
• Waveforms

– BD (CD) Board –

① IC103 ⑩ (RF O) (CD Play Mode)

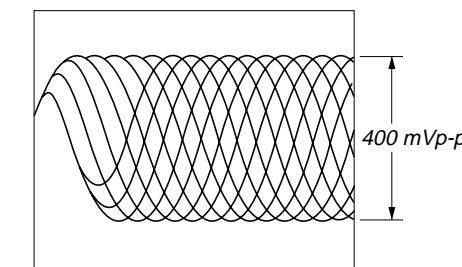


⑤ IC101 ⑯ (XTAI)

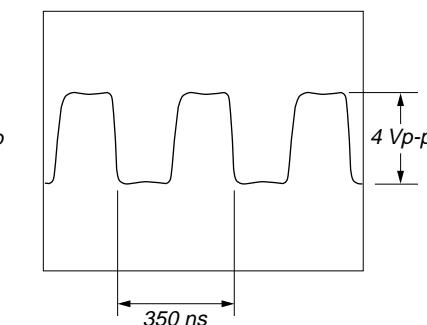


– BD (MD) Board –

① IC101 ⑩ (RF) (MD Play Mode)

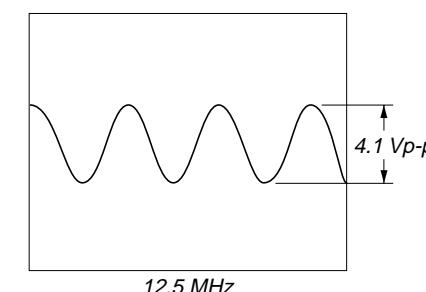


⑤ IC121 ⑧ (XBCK)



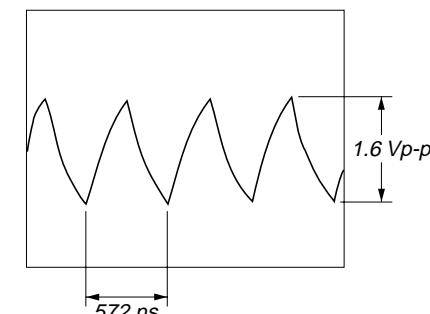
– MICROCOMPUTER Board –

① IC300 ⑩ (X2)

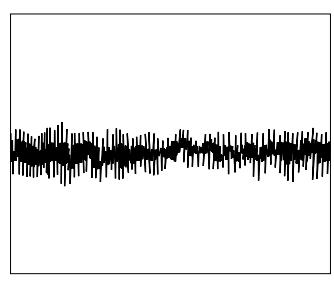


– MD DISPLAY Board –

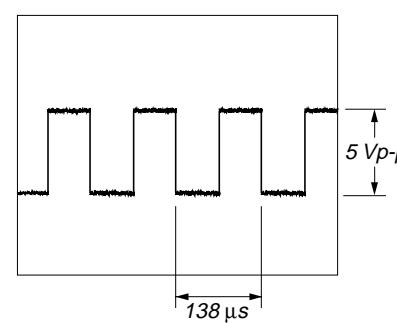
① IC801 ⑩ (OSCO)



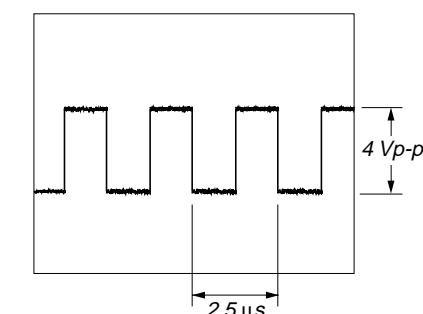
② IC101 ④ (TE) (CD Play Mode)



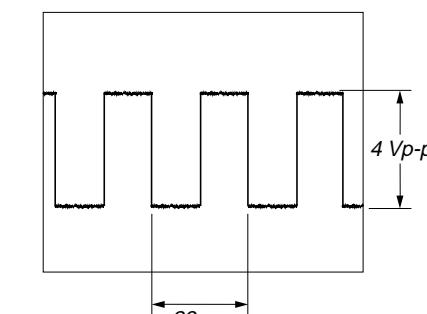
⑥ IC101 ⑮ (WFCK)



② IC152 ⑩ (CAPA-) (MD Play Mode)

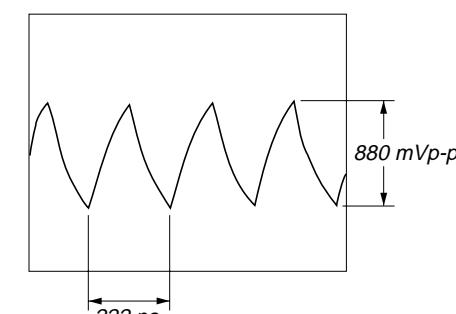


⑥ IC121 ⑦ (LRCK)

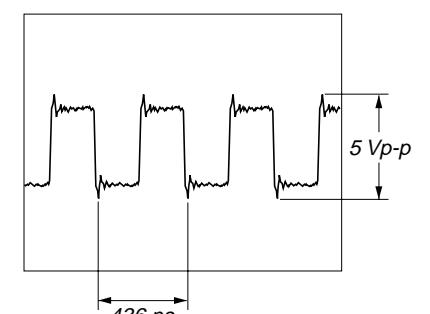


– CD DISPLAY Board –

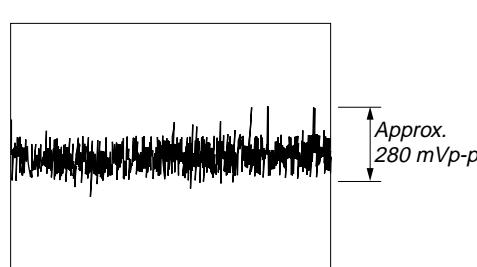
① IC601 ② (XIN)



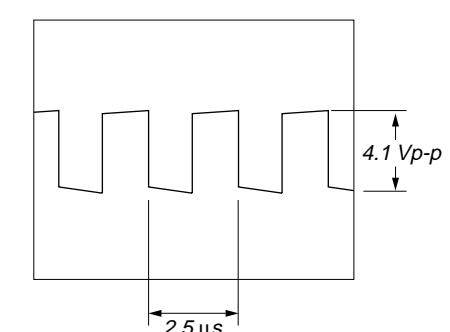
② IC801 ⑩ (OSC1)



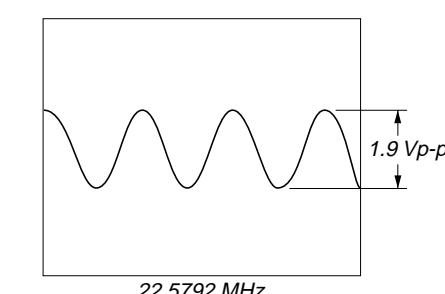
③ IC101 ⑩ (FE) (CD Play Mode)



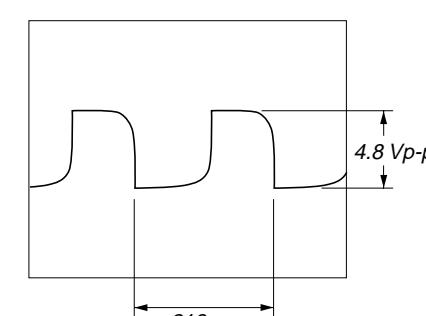
③ IC152 ⑩ (CAPA+) (MD Play Mode)



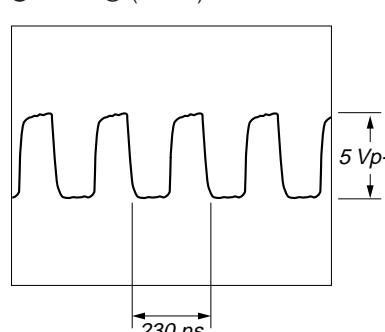
⑦ IC121 ⑩ (OSCI)



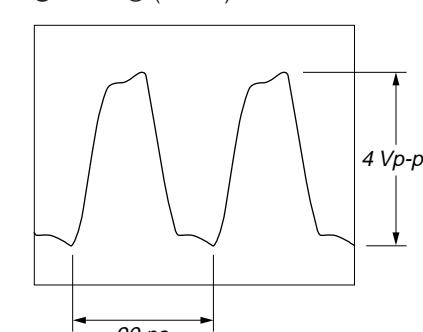
② IC601 ⑩ (XOUT)



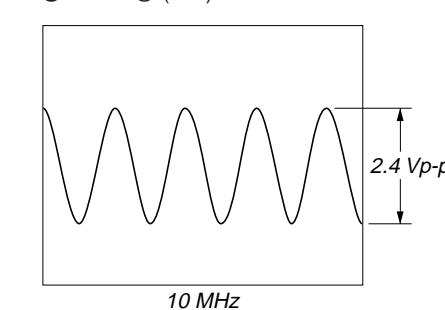
④ IC101 ⑩ (XPCK)



④ IC121 ⑩ (FS256)

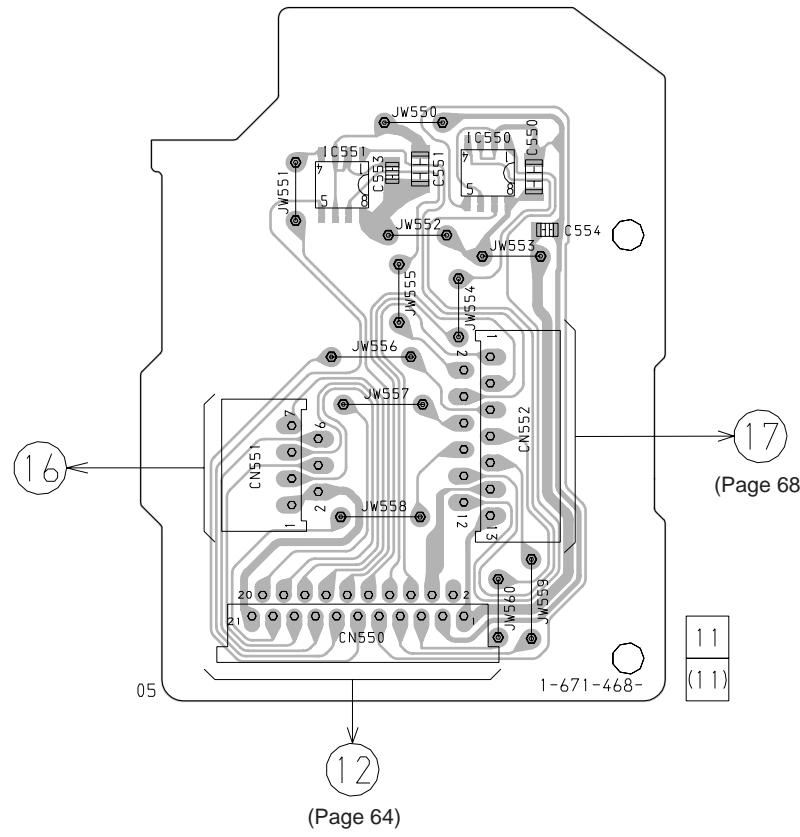


⑧ IC316 ⑮ (XIN)

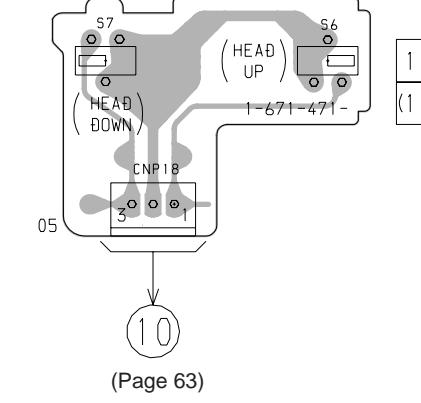


## 6-13. PRINTED WIRING BOARDS – MD MOTOR/SENSOR Section – • See page 49 for Circuit Boards Location.

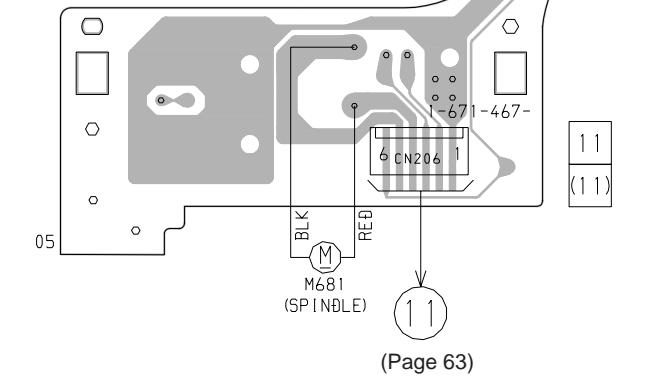
【MECH RELAY BOARD】



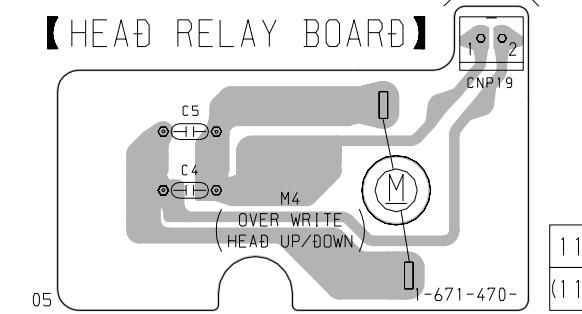
【HEAD SW BOARD】



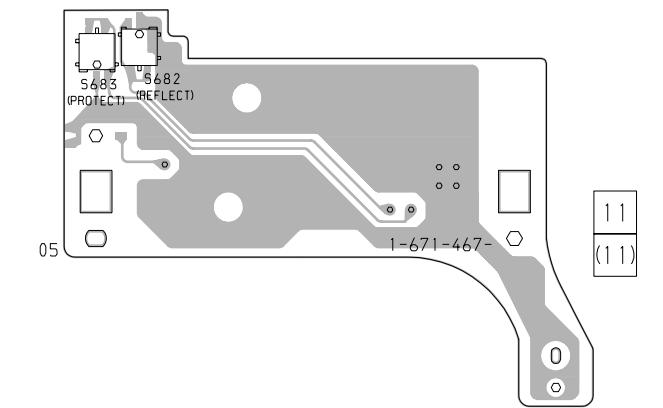
【SW BOARD】(SIDE A)



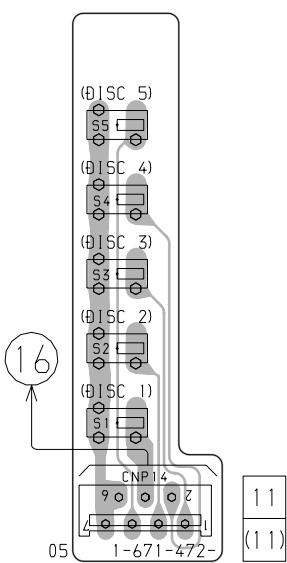
【HEAD RELAY BOARD】



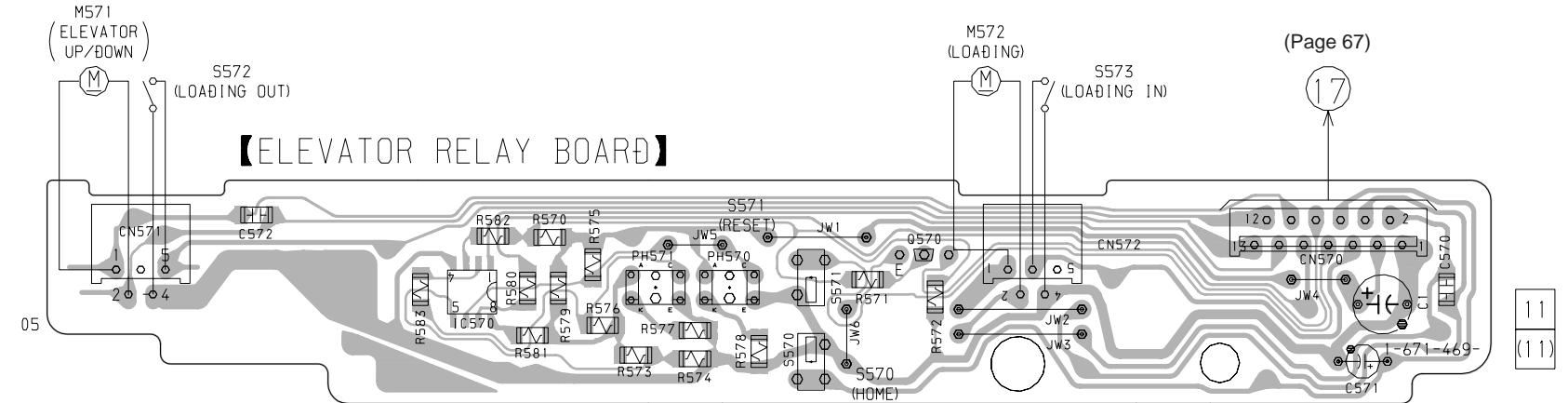
【SW BOARD】(SIDE B)



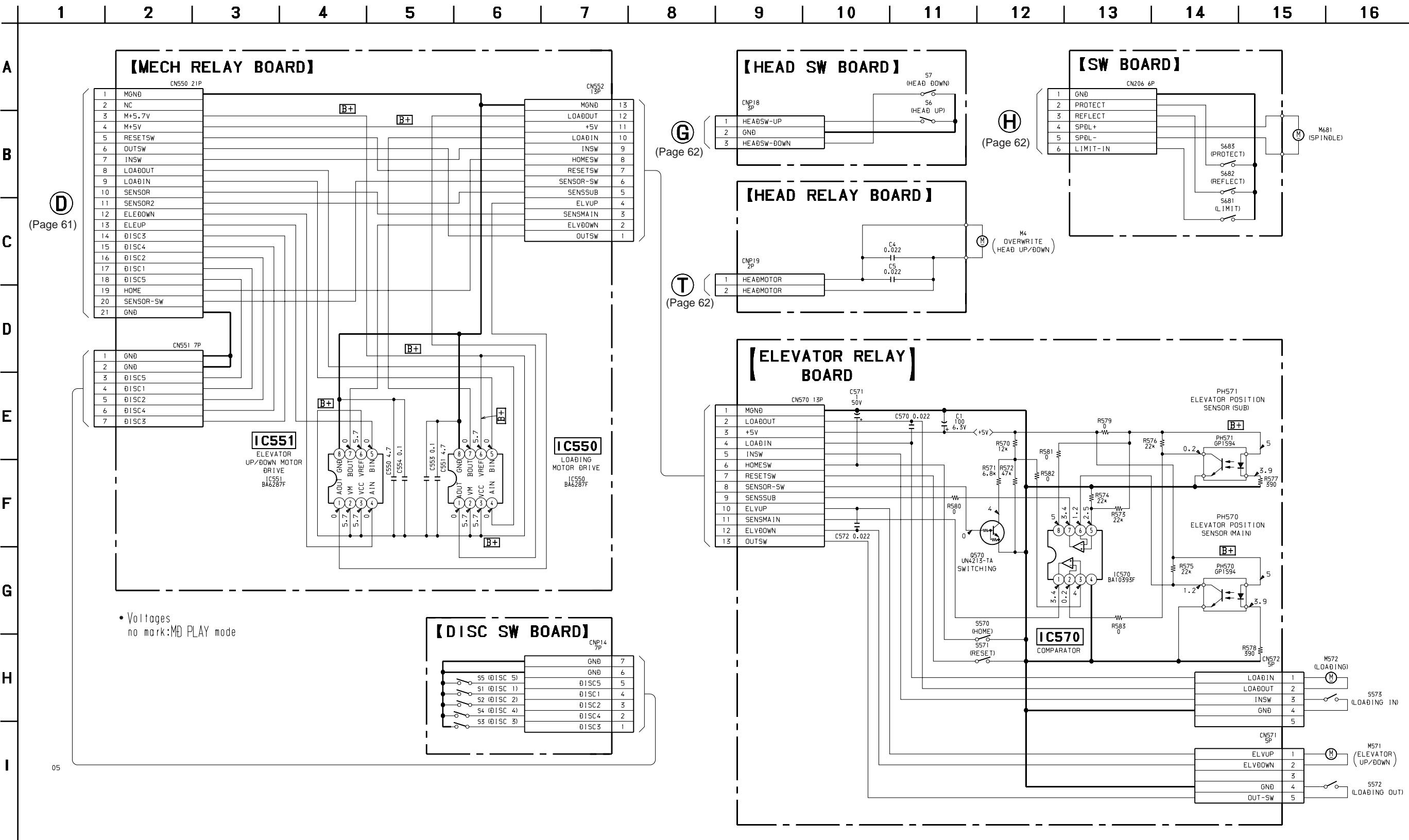
【DISC SW BOARD】

M571  
(ELEVATOR  
UP/DOWN)

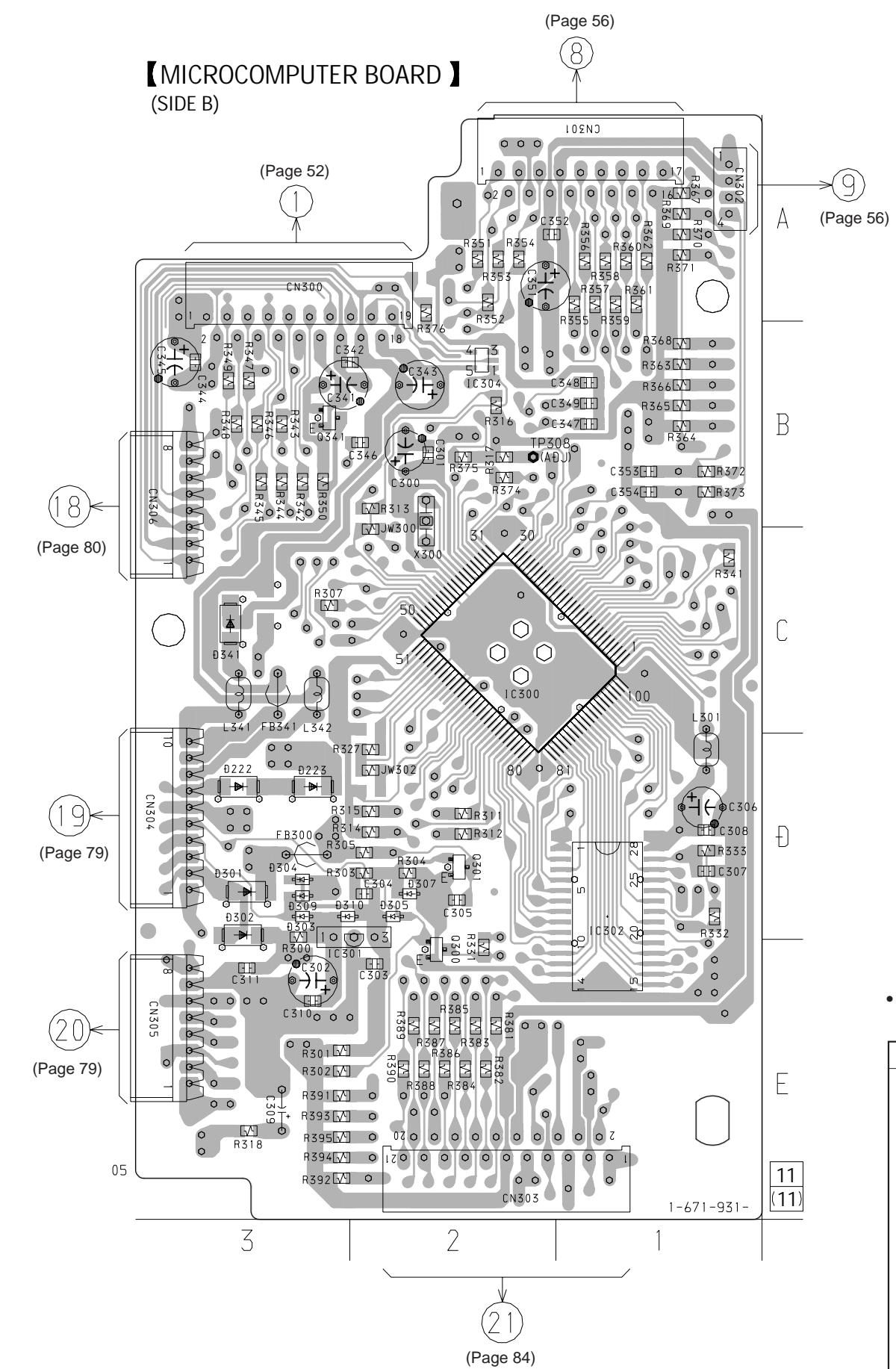
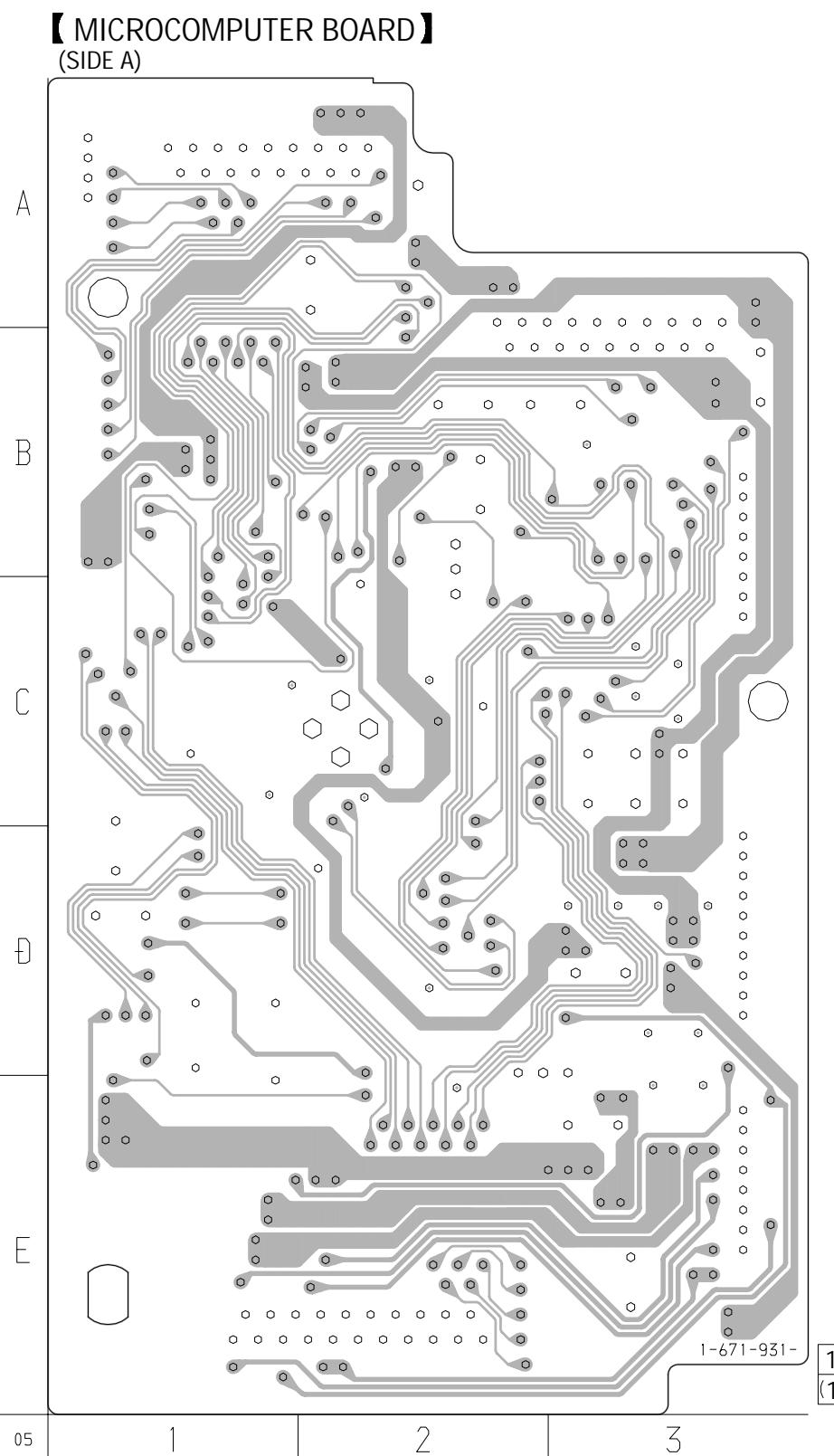
【ELEVATOR RELAY BOARD】



## 6-14. SCHEMATIC DIAGRAM – MD MOTOR/SENSOR Section – • See page 103 for IC Block Diagram.



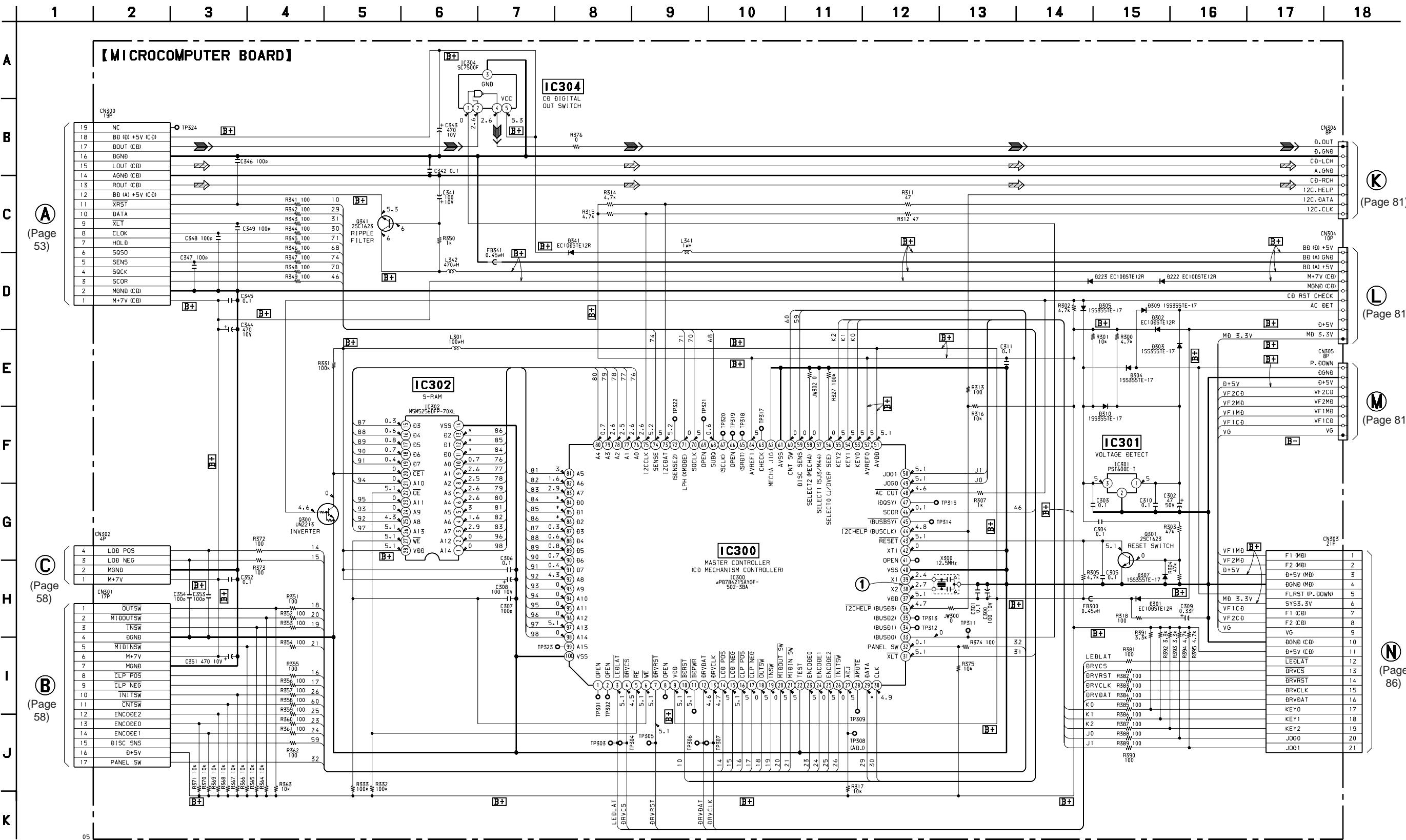
## 6-15. PRINTED WIRING BOARD - MICROCOMPUTER Section - • See page 49 for Circuit Boards Location.



## • Semiconductor Location

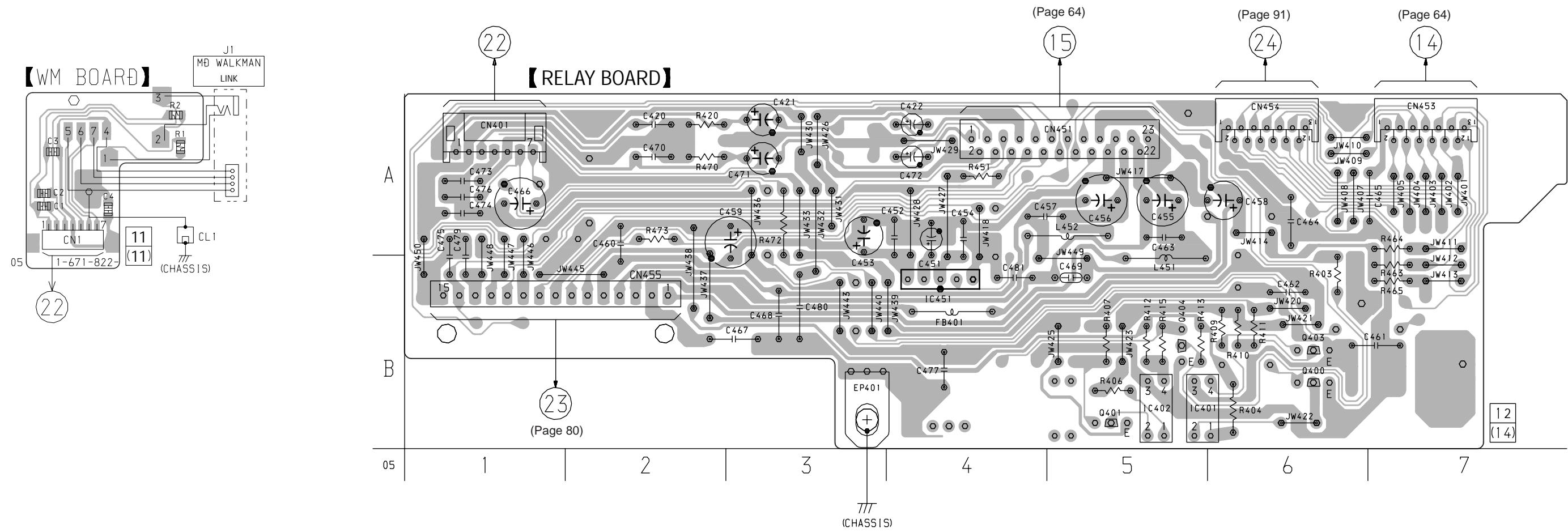
Ref. No.	Location
D222	D-3
D223	D-3
D301	D-3
D302	D-3
D303	D-3
D304	D-3
D305	D-2
D307	D-2
D309	D-3
D310	D-3
D341	C-3
IC300	C-2
IC301	E-2
IC302	D-1
IC304	B-2
Q300	E-2
Q301	D-2
Q341	B-3

## 6-16. SCHEMATIC DIAGRAMS – MICROCOMPUTER Section – • See page 66 for Waveform.



- Voltages and waveforms are dc with respect to ground under no-signal conditions.
- no mark : CD PLAY
- \* : Impossible to measure

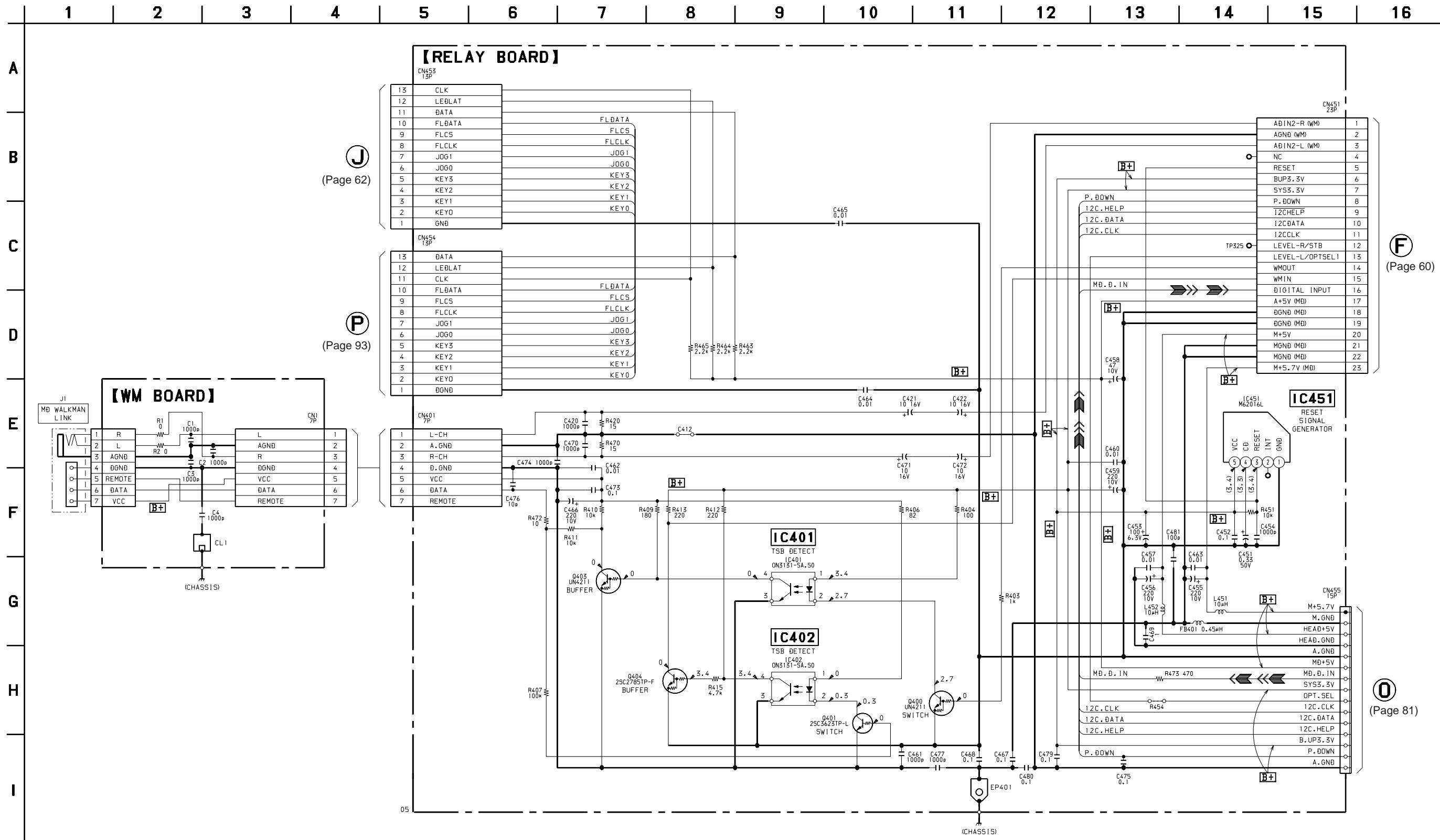
## 6-17. PRINTED WIRING BOARDS – RELAY Section – • See page 49 for Circuit Boards Location.



## • Semiconductor Location

Ref. No.	Location
IC401	B-5
IC402	B-5
IC451	B-4
Q400	B-6
Q401	B-5
Q403	B-6
Q404	B-5

## 6-18. SCHEMATIC DIAGRAM – RELAY Section – • See page 103 for IC Block Diagram.

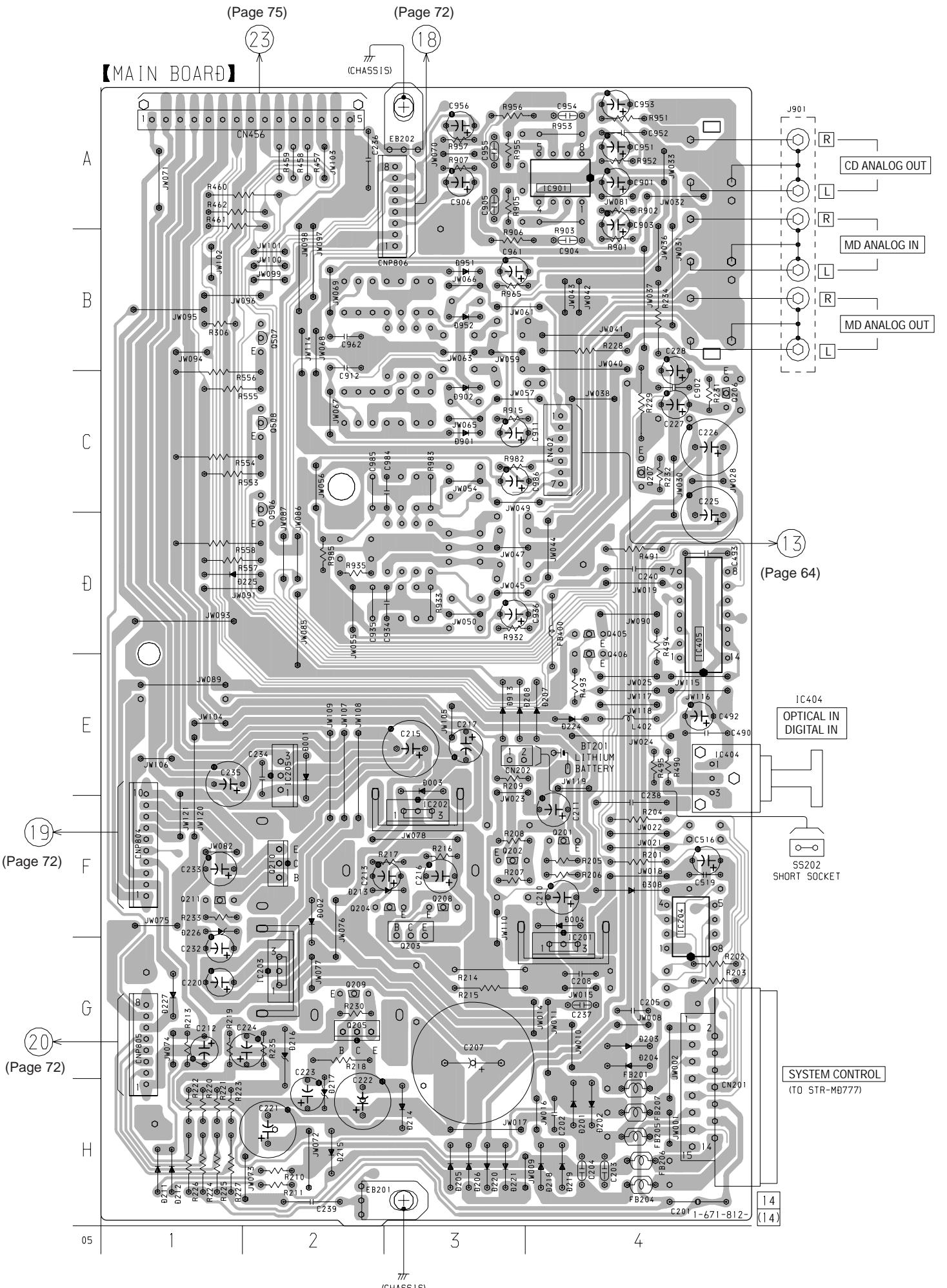


- Voltages are dc with respect to ground under no-signal conditions.
- no mark : CD PLAY
- ( ) : MD PLAY

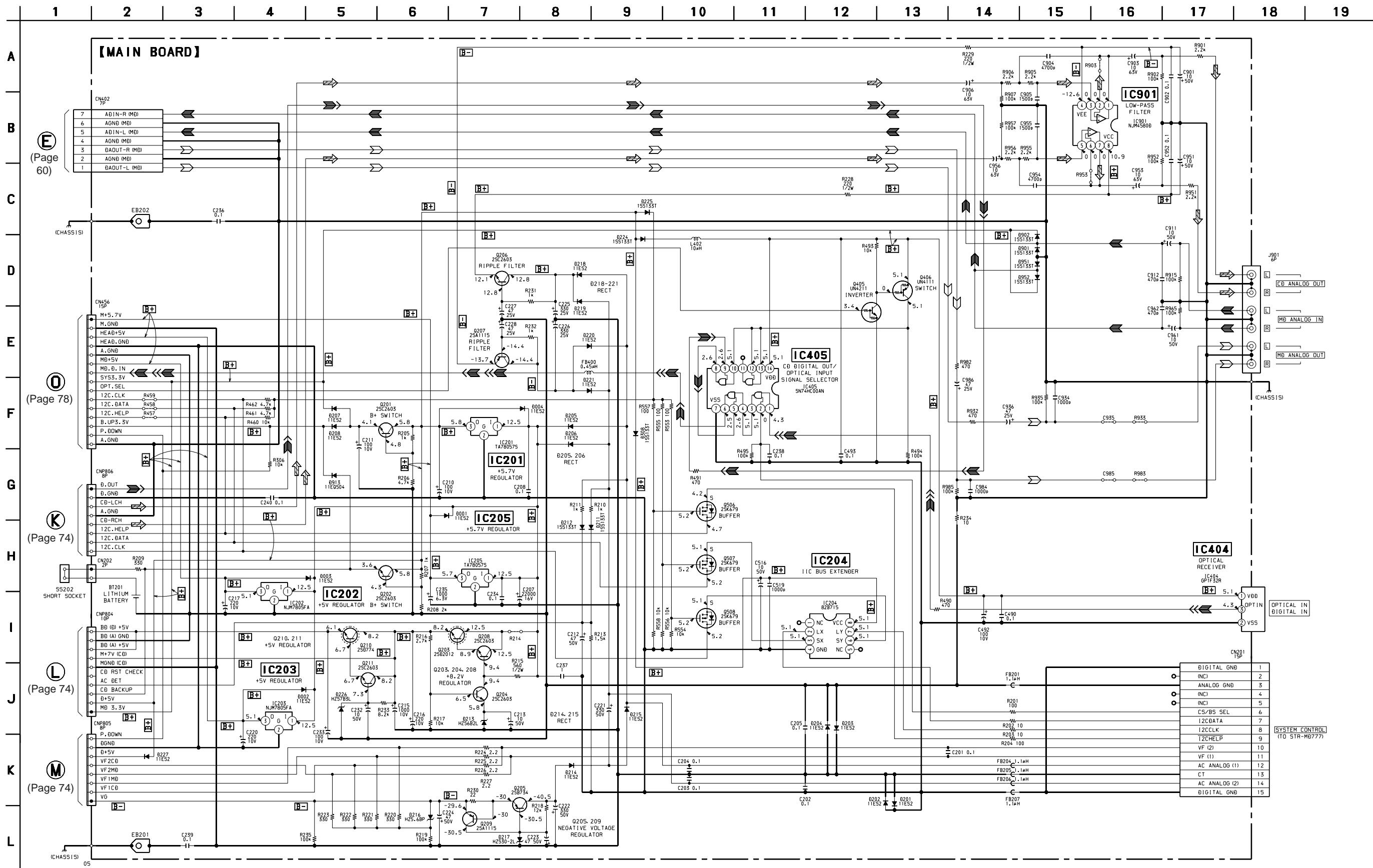
## 6-19. PRINTED WIRING BOARD - MAIN Section - • See page 49 for Circuit Boards Location.

## • Semiconductor Location

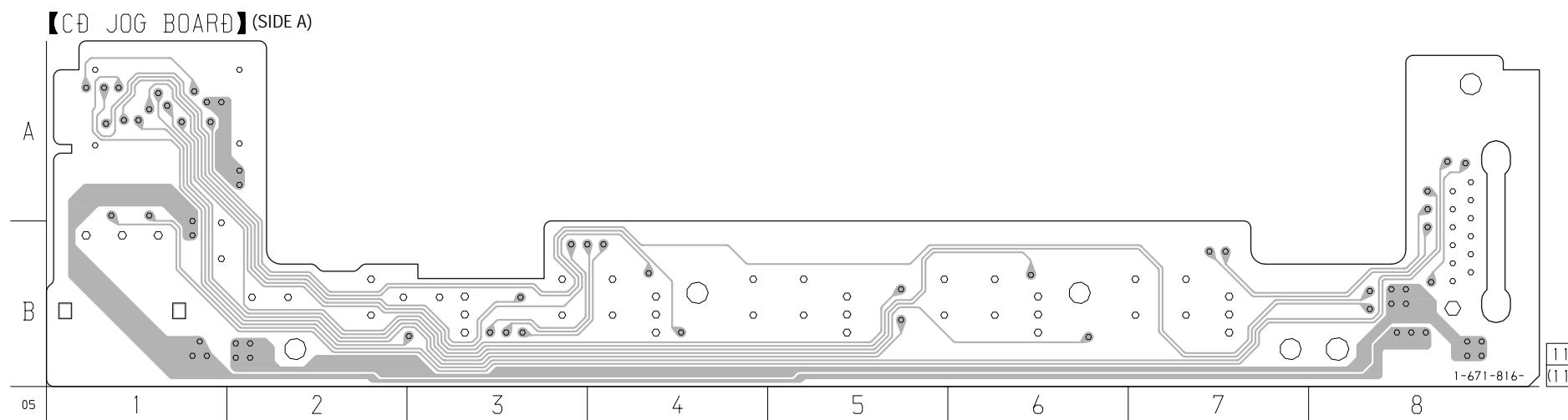
Ref. No.	Location
D001	E-2
D002	F-2
D003	E-3
D004	F-4
D201	H-4
D202	H-4
D203	G-4
D204	G-4
D205	H-3
D206	H-3
D207	E-4
D208	E-3
D211	H-1
D212	H-1
D213	F-3
D214	H-3
D215	H-2
D216	G-2
D217	H-2
D218	H-4
D219	H-4
D220	H-3
D221	H-3
D224	E-4
D225	D-1
D226	F-1
D227	G-1
D308	F-4
D901	C-3
D902	C-3
D913	E-3
D951	B-3
D952	B-3
IC201	G-4
IC202	F-3
IC203	G-2
IC204	F-4
IC205	E-2
IC404	E-4
IC405	D-4
IC901	A-4
Q201	F-4
Q202	F-3
Q203	F-3
Q204	F-3
Q205	G-2
Q206	C-4
Q207	C-4
Q208	F-3
Q209	G-2
Q210	F-2
Q211	F-1
Q405	D-4
Q406	E-4
Q506	C-2
Q507	B-2
Q508	C-2



## 6-20. SCHEMATIC DIAGRAM – MAIN Section – • See page 104 for IC Block Diagram.

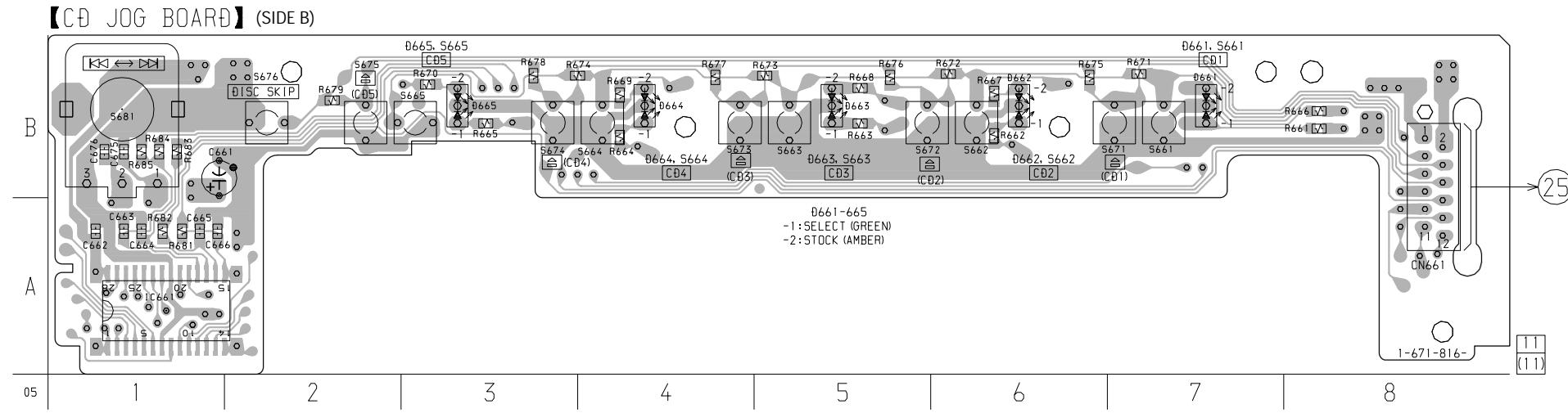


## 6-21. PRINTED WIRING BOARDS – CD JOG/SW Section – • See page 49 for Circuit Boards Location.



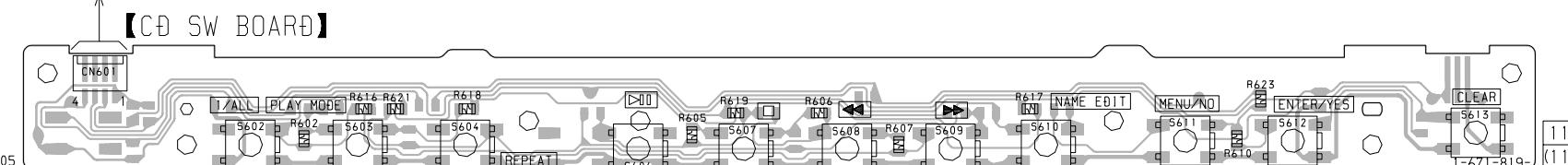
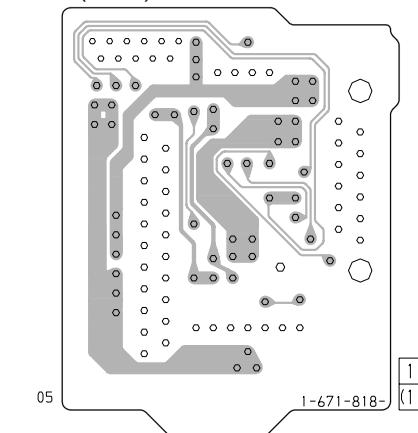
## • Semiconductor Location

Ref. No.	Location
D661	B-7
D662	B-6
D663	B-5
D664	B-4
D665	B-3
IC661	A-1

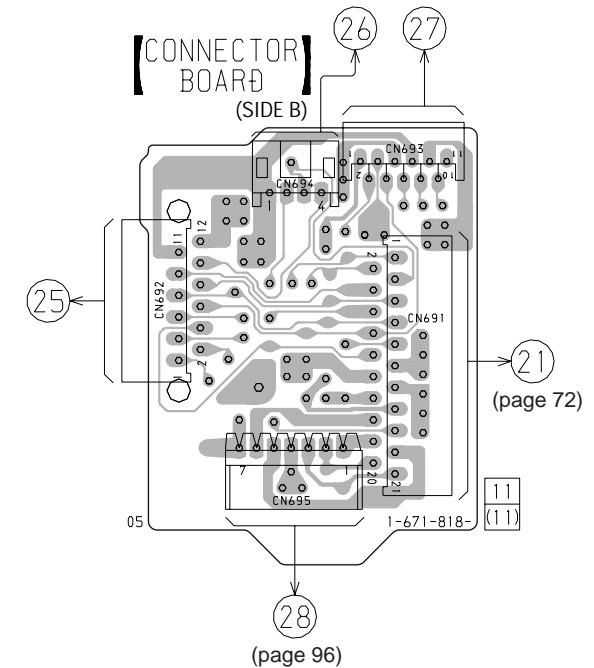


(page 84)

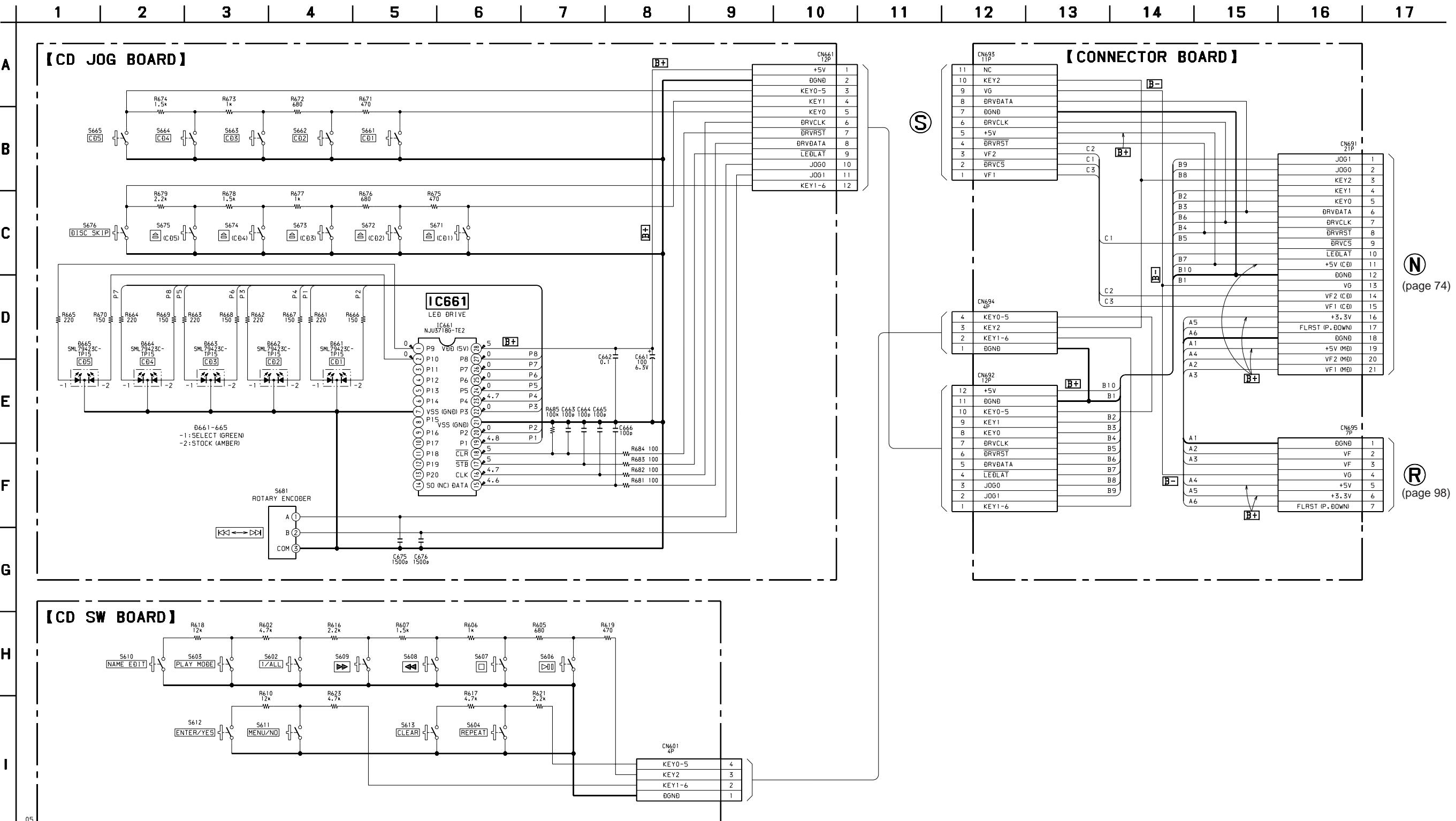
26

**[CONNECTOR BOARD] (SIDE A)**

(page 83) (page 88)



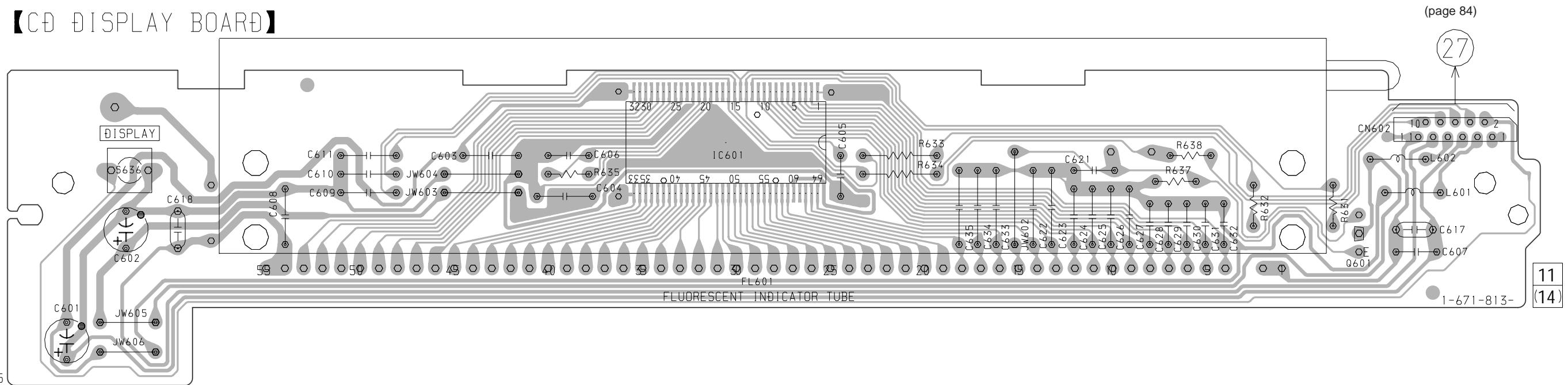
6-22. SCHEMATIC DIAGRAM – CD JOG/SW Section – • See page 104 for IC Block Diagram.



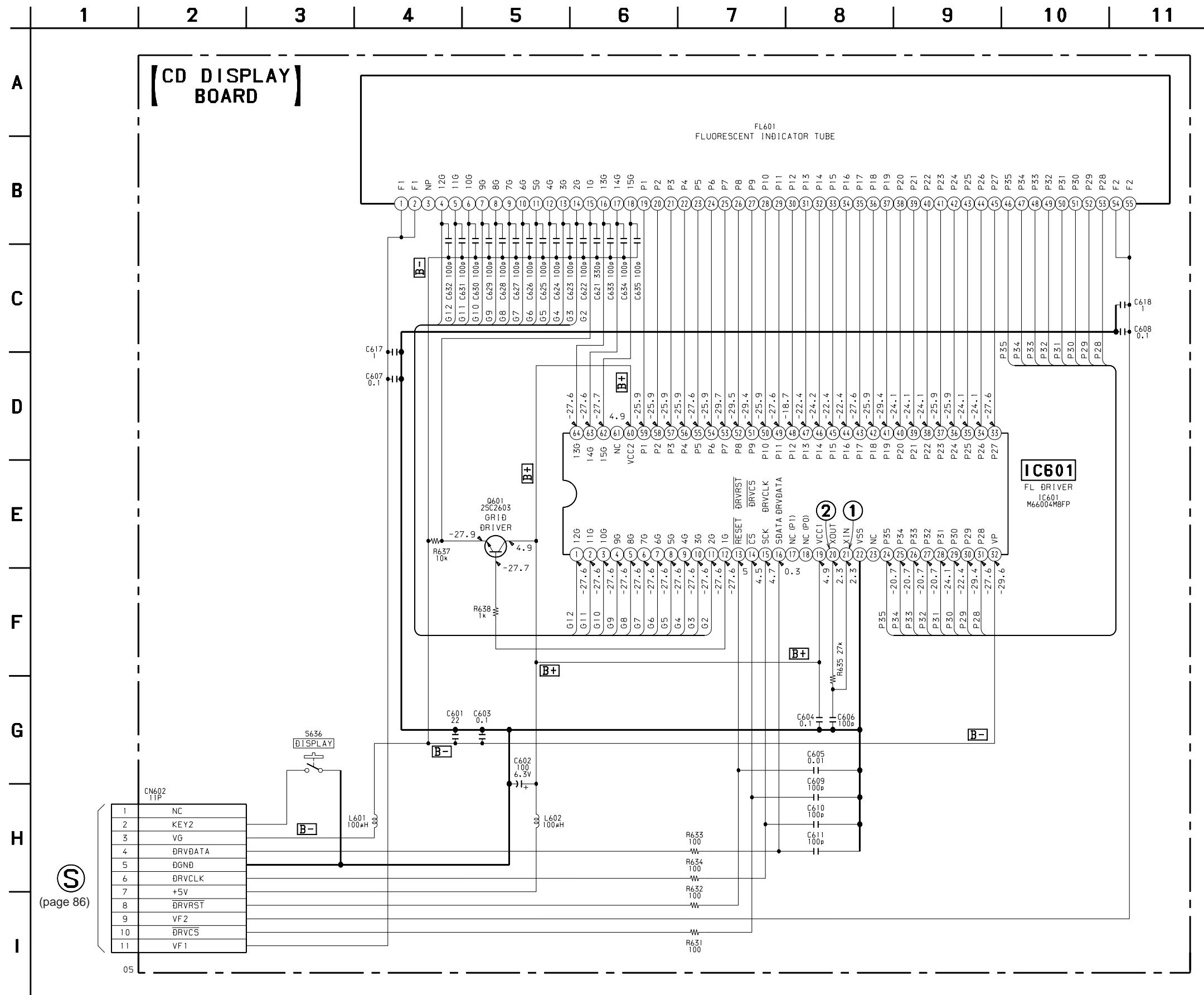
(page 74)

(page 98)

## 6-23. PRINTED WIRING BOARD – CD DISPLAY Section – • See page 49 for Circuit Boards Location.

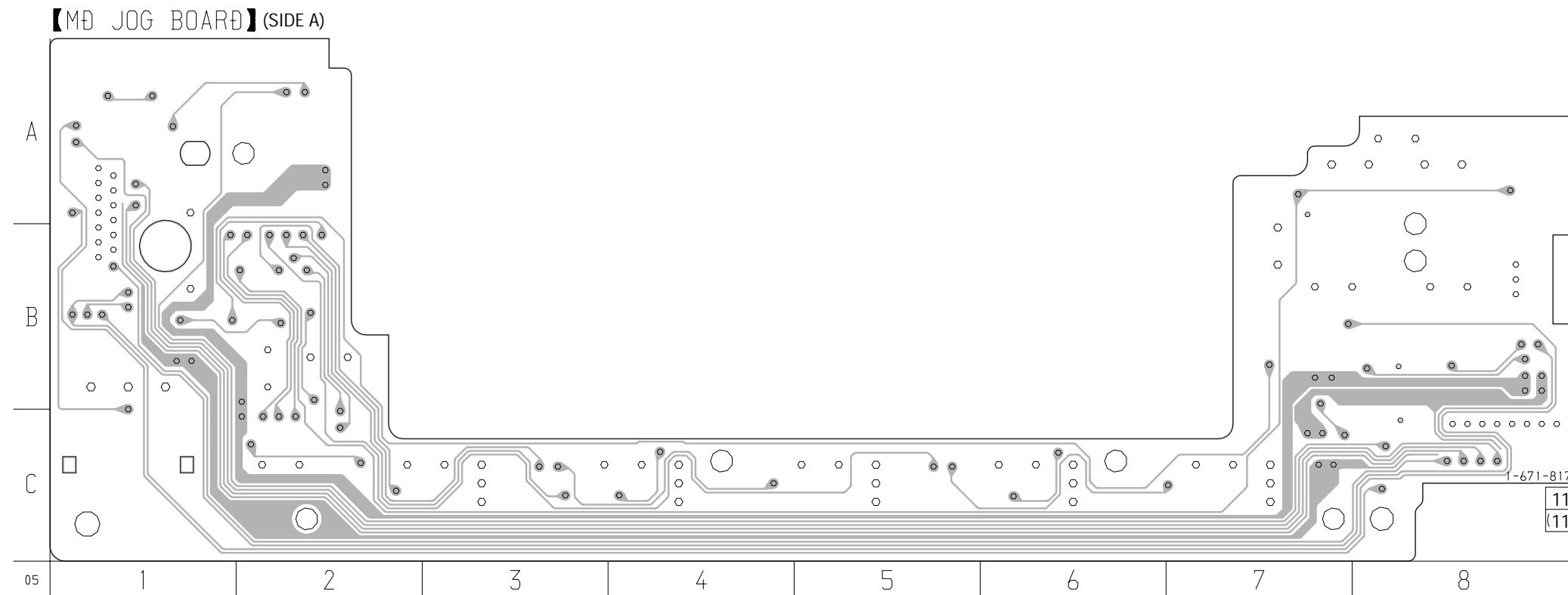


6-24. SCHEMATIC DIAGRAM – CD DISPLAY Section – • See page 66 for Waveforms. • See page 104 for IC Block Diagram.



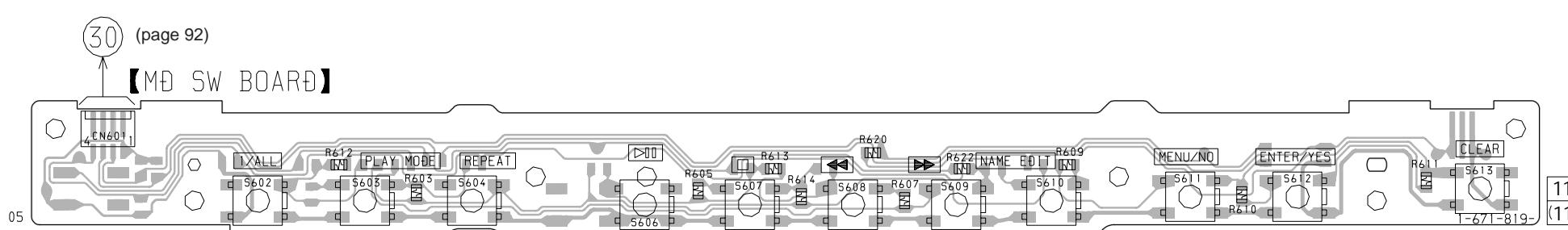
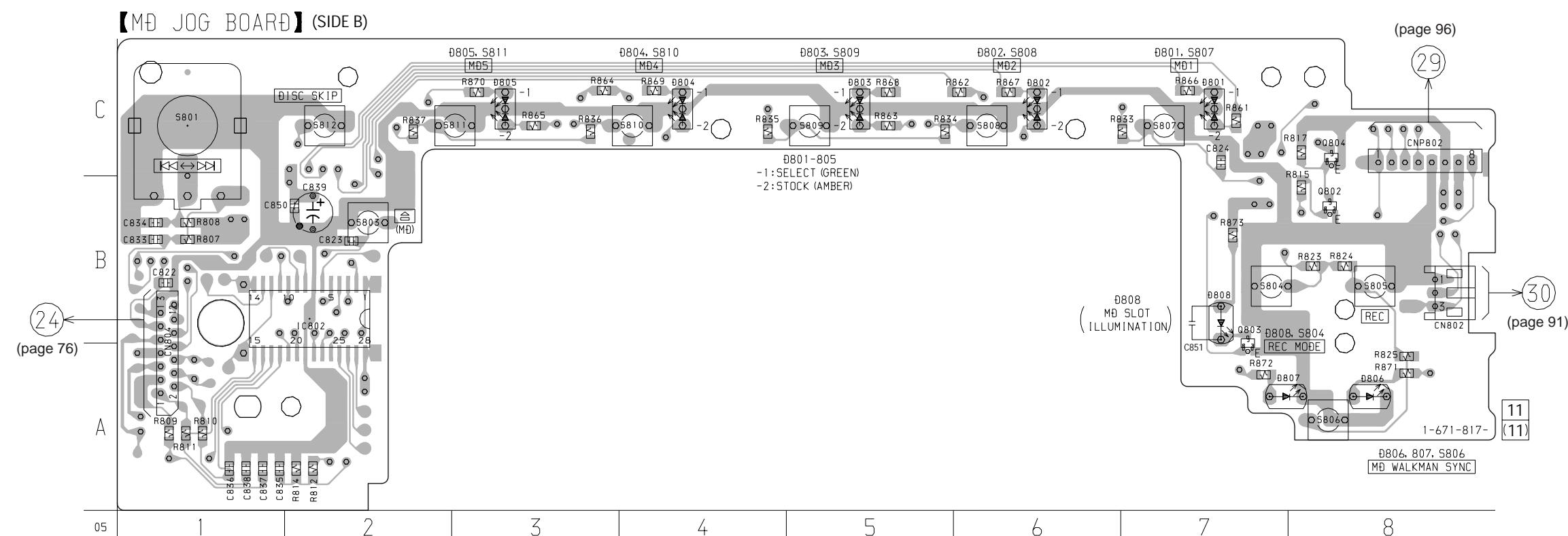
• Voltages and waveforms are dc with respect to ground under no-signal conditions.  
no mark : CD STOP

## 6-25. PRINTED WIRING BOARDS – MD JOG/SW Section – • See page 49 for Circuit Boards Location.

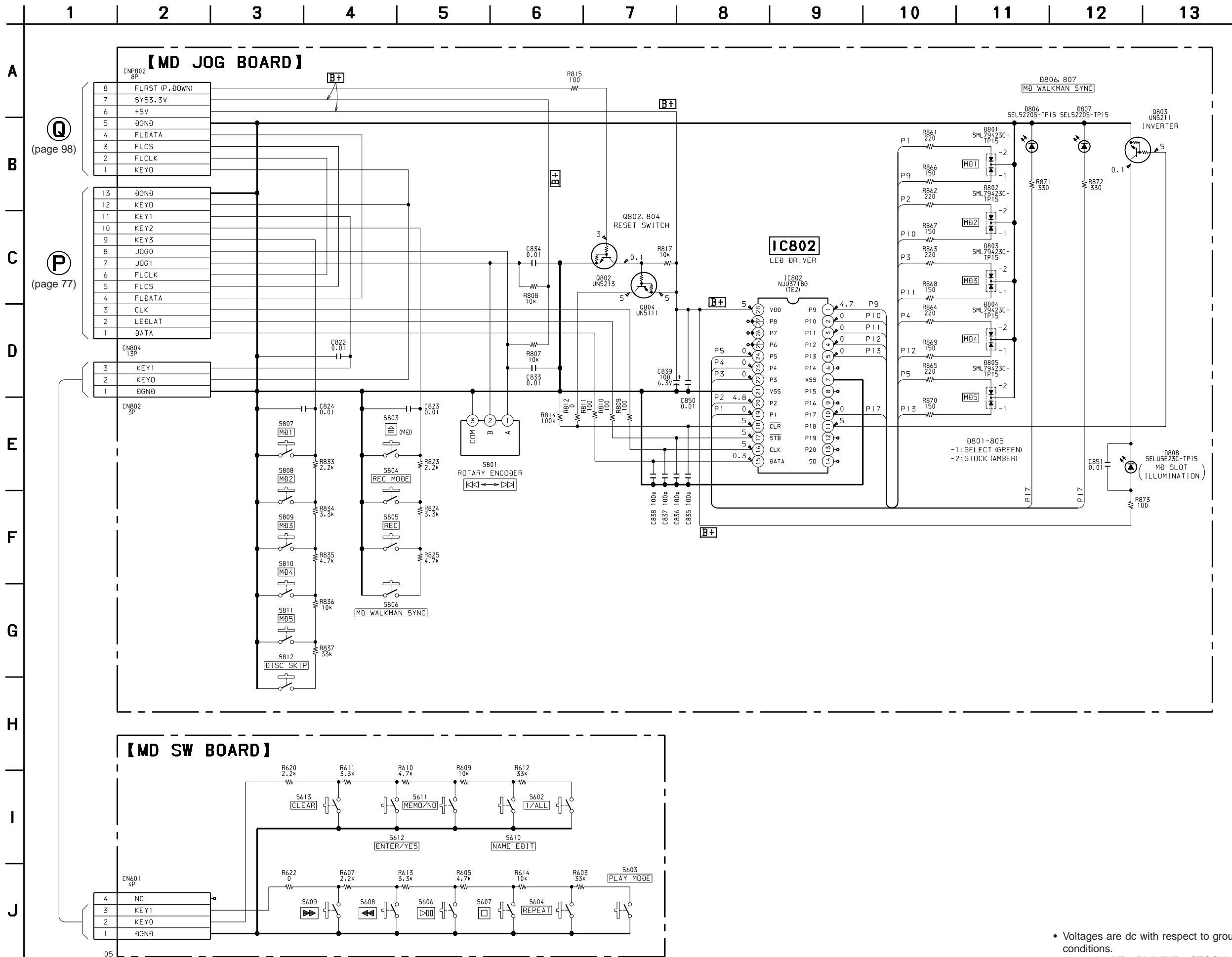


## • Semiconductor Location

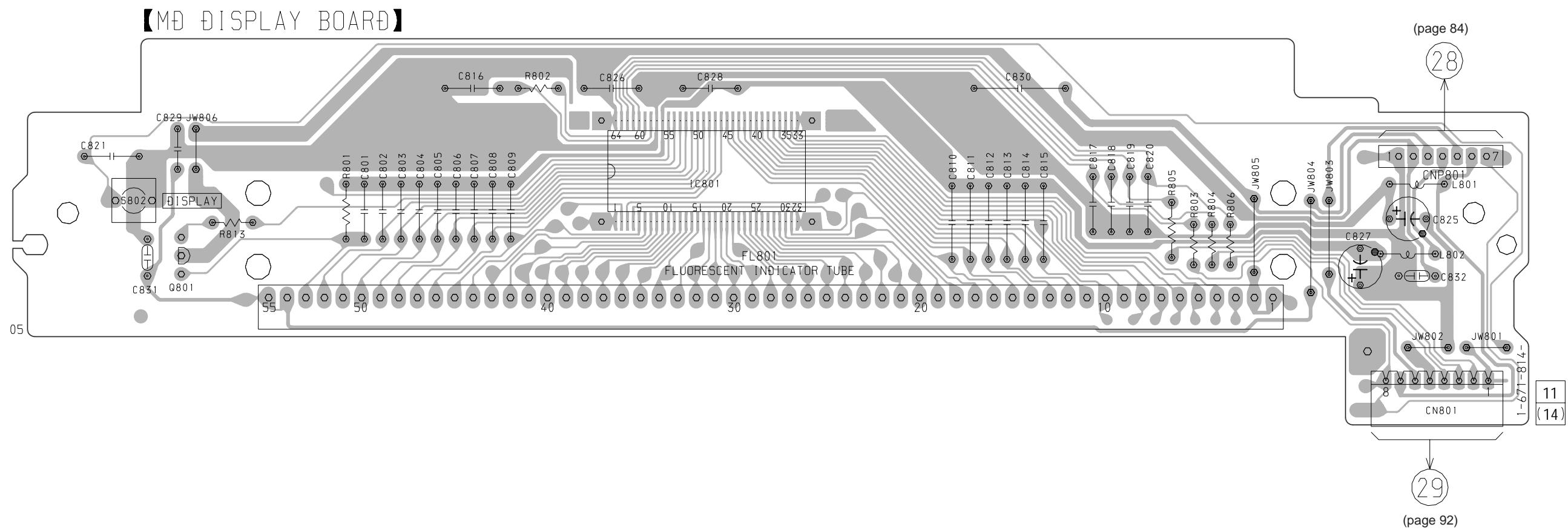
Ref. No.	Location
D801	C-7
D802	C-6
D803	C-5
D804	C-4
D805	C-3
D806	A-8
D807	A-7
D808	B-7
IC802	B-2
Q802	B-8
Q803	B-7
Q804	C-8



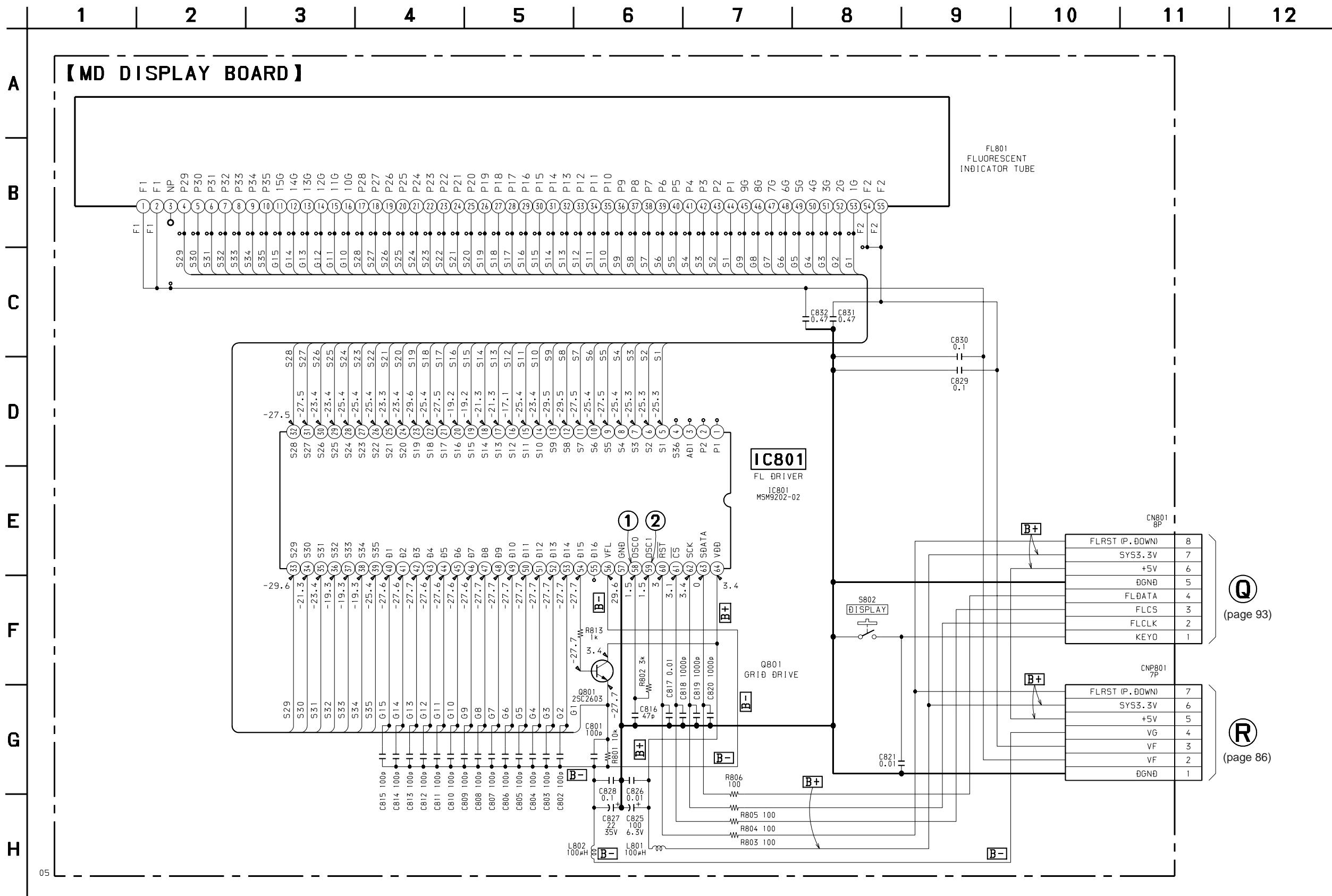
## 6-26. SCHEMATIC DIAGRAM – MD JOG/SW Section – • See page 104 for IC Block Diagram.



## 6-27. PRINTED WIRING BOARD – MD DISPLAY Section – • See page 49 for Circuit Boards Location.

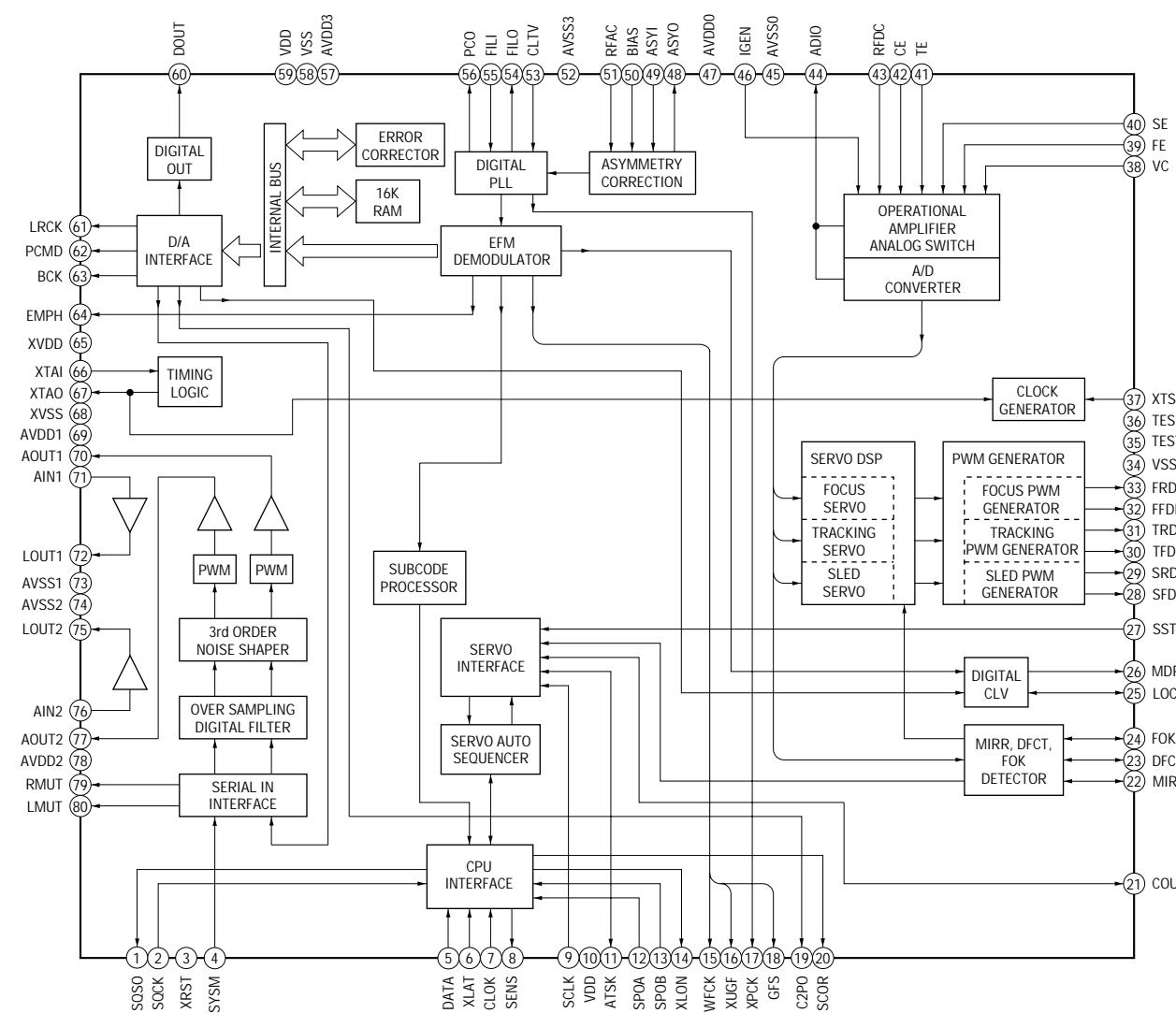


## 6-28. SCHEMATIC DIAGRAM – MD DISPLAY Section – • See page 66 for Waveforms.

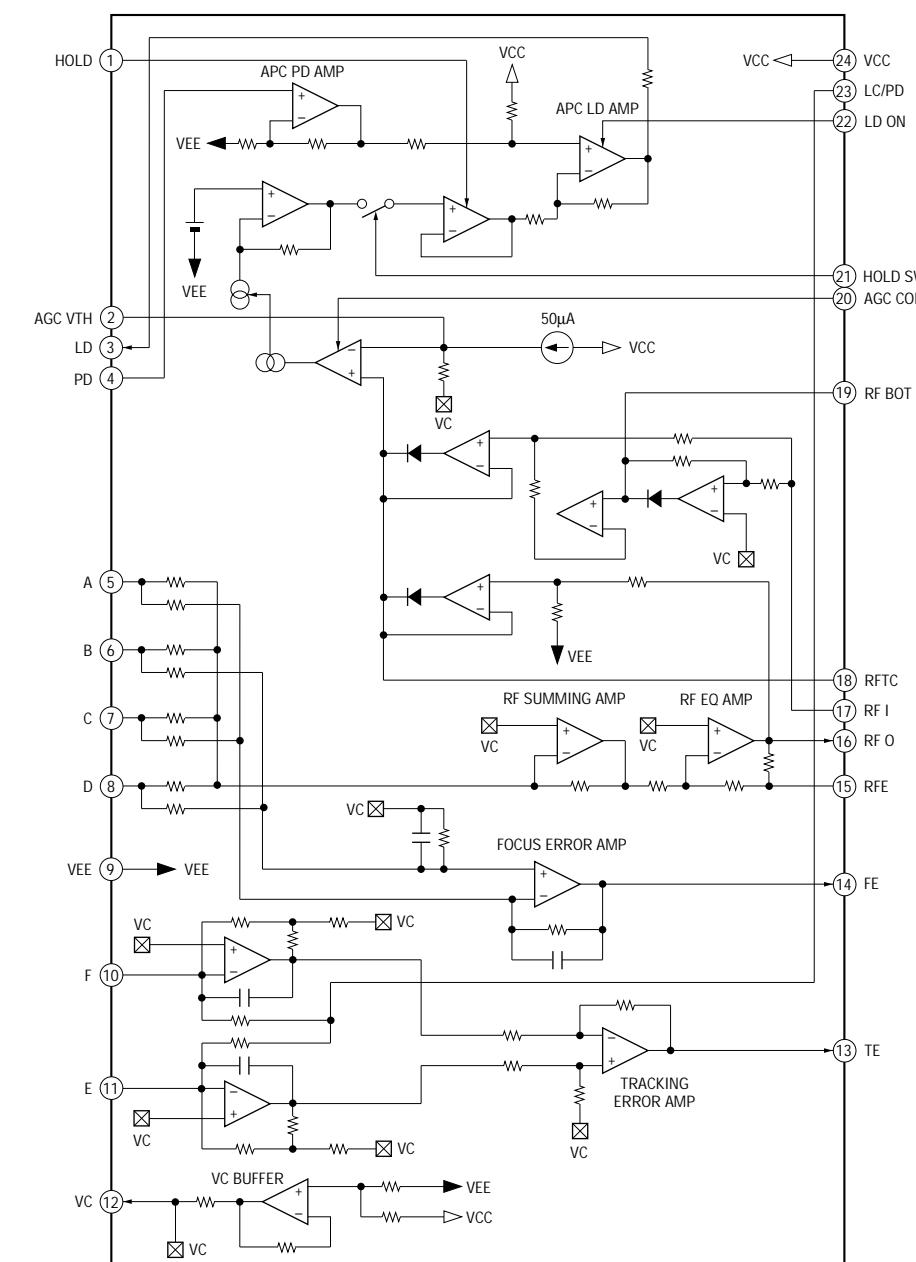


• IC Block Diagrams  
- BD (CD) BOARD -

**IC101 CXD2587Q**



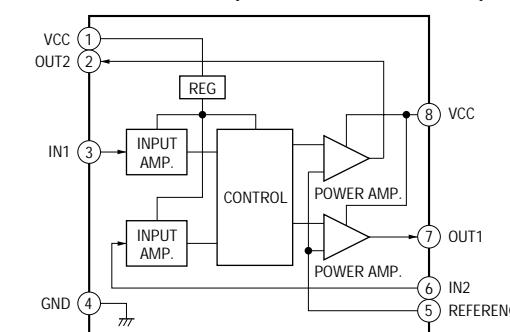
**IC103 CXA2568M-T6**



- CLAMP MOTOR BOARD/LOAD MOTOR BOARD -

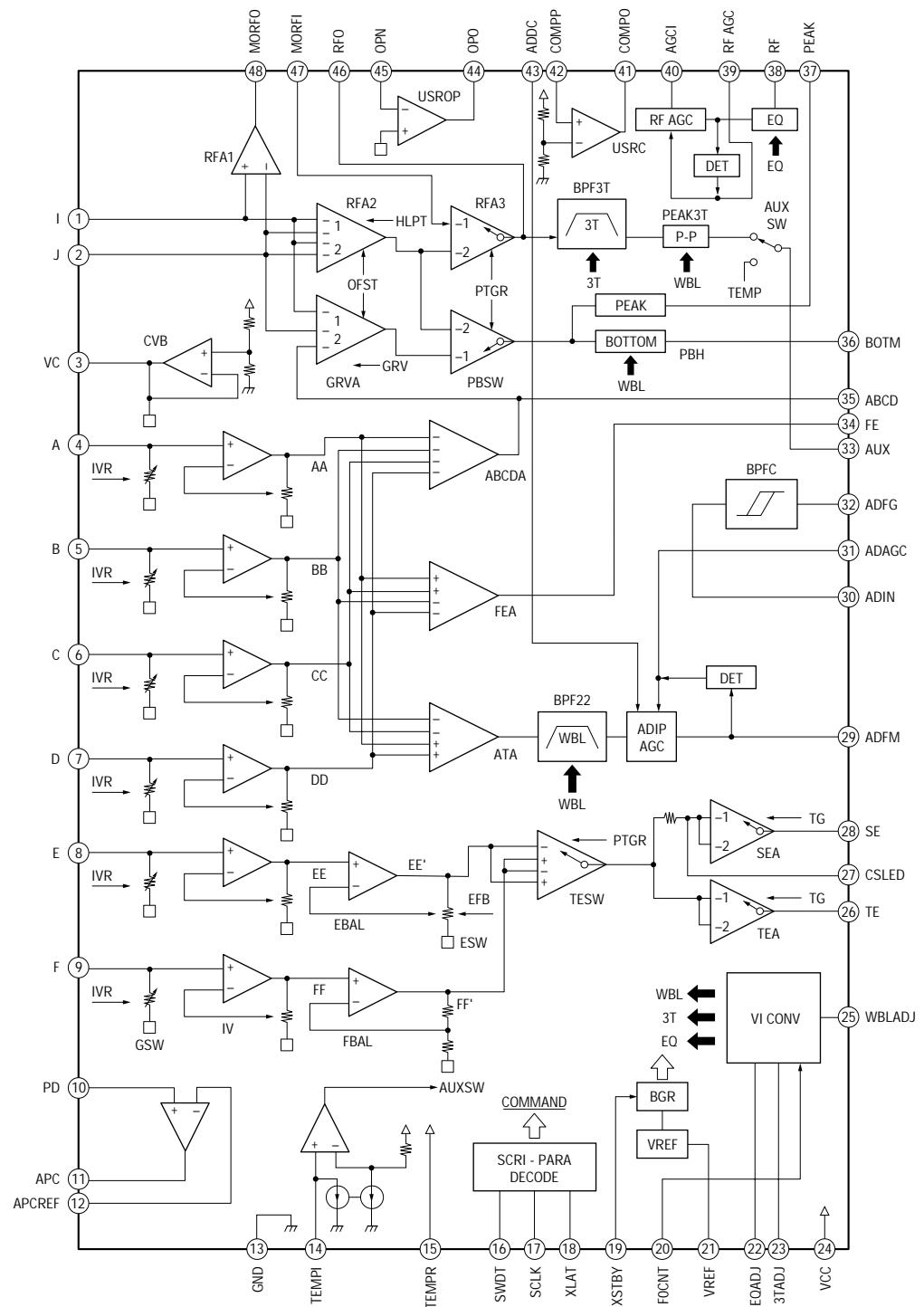
**IC701 M54641L (CLAMP MOTOR Board)**

**IC702 M54641L (LOAD MOTOR Board)**

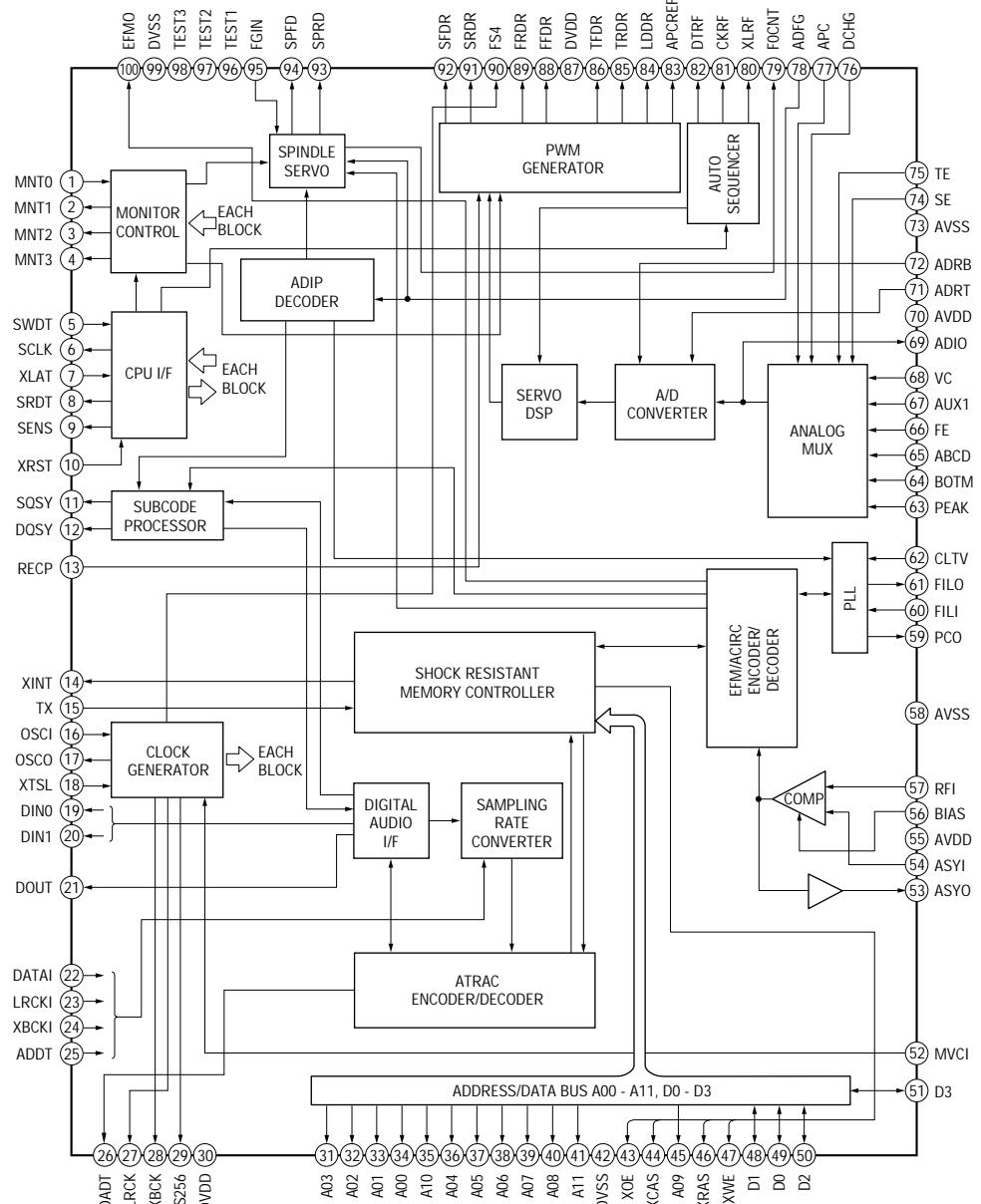


**- BD (MD) BOARD -**

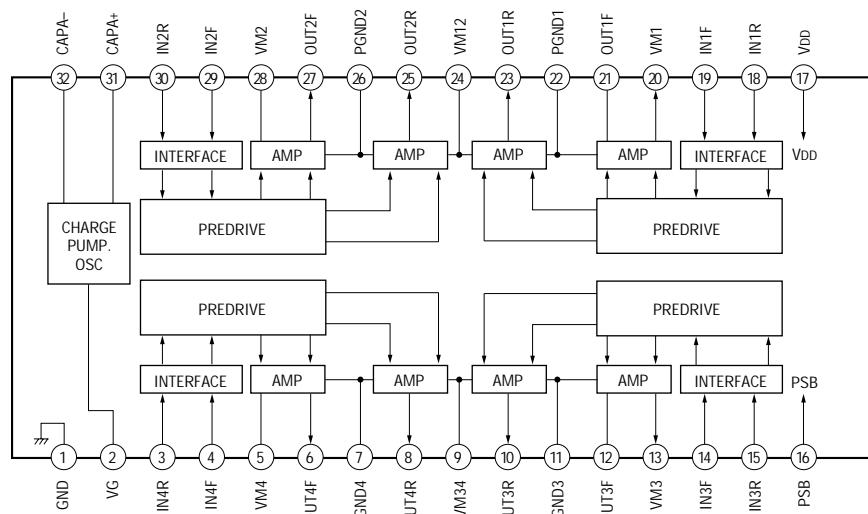
**IC101 CXA2523AR**



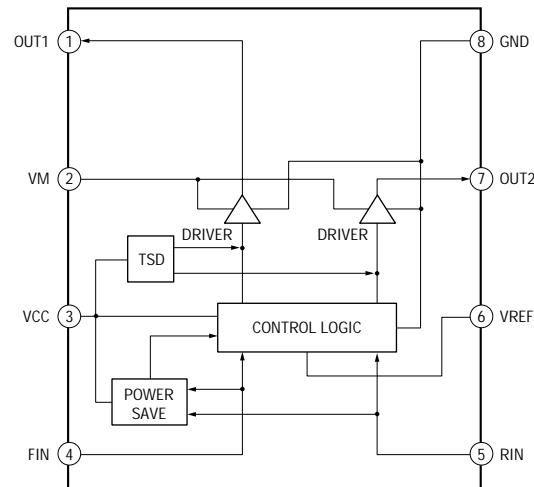
## IC121 CXD2654R



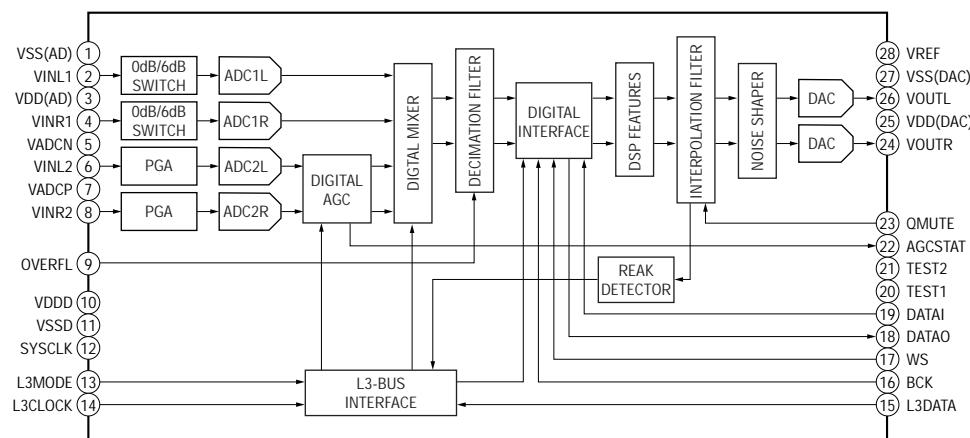
## IC152 BH6511FS-E2



### IC172 BA6287F

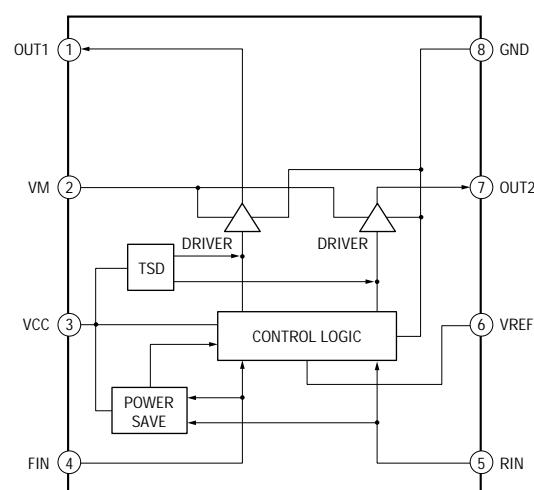


### IC201 UDA1341TS/N2



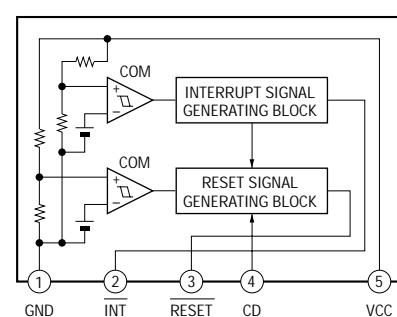
### - MECH RELAY BOARD -

#### IC505, 551 BA6287F



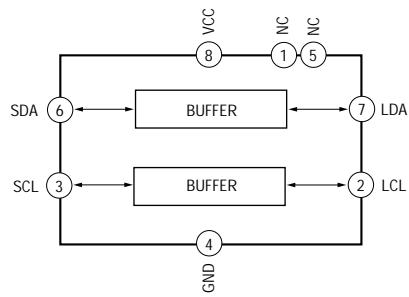
### - RELAY BOARD -

#### IC451 M62016L



**- MAIN BOARD -**

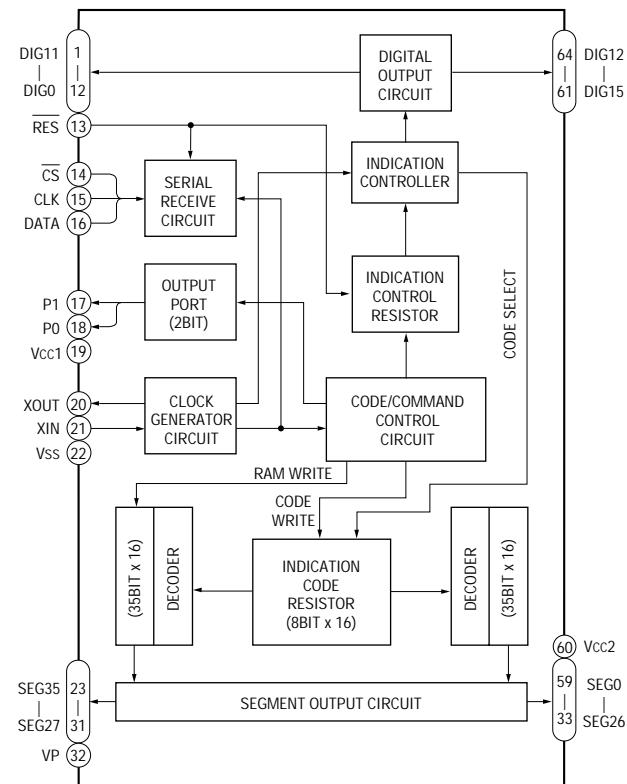
**IC204 P82B715PN**



**- CD JOG BOARD/MD JOG BOARD -**

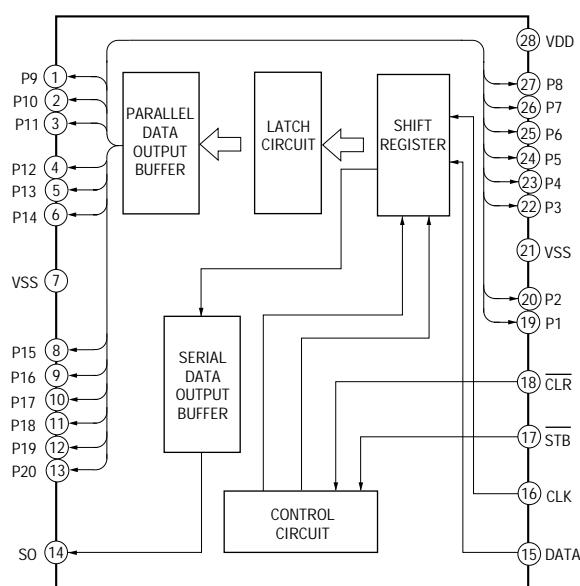
**IC661 NJU3718G (TE2) (CD JOG Board)**

**IC802 NJU3718G (TE2) (MD JOG Board)**



**- CD DISPLAY BOARD -**

**IC601 M66004M8FP**



## 6-29. IC PIN FUNCTION DESCRIPTION

### • BD (MD) BOARD IC101 CXA2523AR (RF AMP, FOCUS/TRACKING ERROR AMP)

Pin No.	Pin Name	I/O	Function
1	I	I	I-V converted RF signal I input from the optical pick-up block detector
2	J	I	I-V converted RF signal J input from the optical pick-up block detector
3	VC	O	Middle point voltage (+1.65V) generation output terminal
4 to 9	A to F	I	Signal input from the optical pick-up detector
10	PD	I	Light amount monitor input from the optical pick-up block laser diode
11	APC	O	Laser amplifier output terminal to the automatic power control circuit
12	APCREF	I	Reference voltage input terminal for setting laser power
13	GND	—	Ground terminal
14	TEMPI	I	Connected to the temperature sensor
15	TEMPR	O	Output terminal for a temperature sensor reference voltage
16	SWDT	I	Writing serial data input from the CXD2654R (IC121)
17	SCLK	I	Serial data transfer clock signal input from the CXD2654R (IC121)
18	XLAT	I	Serial data latch pulse signal input from the CXD2654R (IC121)
19	XSTBY	I	Standby signal input terminal “L”: standby (fixed at “H” in this set)
20	F0CNT	I	Center frequency control voltage input terminal of internal circuit (BPF22, BPF3T, EQ) input from the CXD2654R (IC121)
21	VREF	O	Reference voltage output terminal Not used (open)
22	EQADJ	I	Center frequency setting terminal for the internal circuit (EQ)
23	3TADJ	I	Center frequency setting terminal for the internal circuit (BPF3T)
24	VCC	—	Power supply terminal (+3.3V)
25	WBLADJ	I	Center frequency setting terminal for the internal circuit (BPF22)
26	TE	O	Tracking error signal output to the CXD2654R (IC121)
27	CSLED	I	Connected to the external capacitor for low-pass filter of the sled error signal
28	SE	O	Sled error signal output to the CXD2654R (IC121)
29	ADFM	O	FM signal output of the ADIP
30	ADIN	I	Receives a ADIP FM signal in AC coupling
31	ADAGC	I	Connected to the external capacitor for ADIP AGC
32	ADFG	O	ADIP duplex signal ( $22.05\text{ kHz} \pm 1\text{ kHz}$ ) output to the CXD2654R (IC121)
33	AUX	O	Auxiliary signal (I <sub>3</sub> signal/temperature signal) output to the CXD2654R (IC121)
34	FE	O	Focus error signal output to the CXD2654R (IC121)
35	ABCD	O	Light amount signal (ABCD) output to the CXD2654R (IC121)
36	BOTM	O	Light amount signal (RF/ABCD) bottom hold output to the CXD2654R (IC121)
37	PEAK	O	Light amount signal (RF/ABCD) peak hold output to the CXD2654R (IC121)
38	RF	O	Playback EFM RF signal output to the CXD2654R (IC121)
39	RFAGC	I	Connected to the external capacitor for RF auto gain control circuit
40	AGCI	I	Receives a RF signal in AC coupling
41	COMPO	O	User comparator output terminal Not used (open)
42	COMPP	I	User comparator input terminal Not used (fixed at “L”)
43	ADDC	I	Connected to the external capacitor for cutting the low band of the ADIP amplifier
44	OPO	O	User operational amplifier output terminal Not used (open)
45	OPN	I	User operational amplifier inversion input terminal Not used (fixed at “L”)
46	RFO	O	RF signal output terminal
47	MORFI	I	Receives a MO RF signal in AC coupling
48	MORFO	O	MO RF signal output terminal

• **BD (MD) BOARD IC121 CXD2654R**  
**(DIGITAL SIGNAL PROCESSOR, DIGITAL SERVO PROCESSOR, EFM/ACIRC ENCODER/DECODER,**  
**SHOCK PROOF MEMORY CONTROLLER, ATRAC ENCODER/DECODER)**

Pin No.	Pin Name	I/O	Function
1	MNT0 (FOK)	O	Focus OK signal output to the MD mechanism controller (IC316) “H” is output when focus is on (“L”: NG)
2	MNT1 (SHOCK)	O	Track jump detection signal output to the MD mechanism controller (IC316)
3	MNT2 (XBUSY)	O	Busy monitor signal output to the MD mechanism controller (IC316)
4	MNT3 (SLOCK)	O	Spindle servo lock status monitor signal output to the MD mechanism controller (IC316)
5	SWDT	I	Writing serial data signal input from the MD mechanism controller (IC316)
6	SCLK	I (S)	Serial data transfer clock signal input from the MD mechanism controller (IC316)
7	XLAT	I (S)	Serial data latch pulse signal input from the MD mechanism controller (IC316)
8	SRDT	O (3)	Reading serial data signal output to the MD mechanism controller (IC316)
9	SENS	O (3)	Internal status (SENSE) output to the MD mechanism controller (IC316)
10	<u>XRST</u>	I (S)	Reset signal input from the MD mechanism controller (IC316) “L”: reset
11	SQSY	O	Subcode Q sync (SCOR) output to the MD mechanism controller (IC316) “L” is output every 13.3 msec Almost all, “H” is output
12	DQSY	O	Digital In U-bit CD format subcode Q sync (SCOR) output to the MD mechanism controller (IC316) “L” is output every 13.3 msec Almost all, “H” is output
13	RECP	I	Laser power selection signal input from the MD mechanism controller (IC316) “H”: recording mode, “L”: playback mode
14	XINT	O	Interrupt status output to the MD mechanism controller (IC316)
15	TX	I	Recording data output enable signal input from the MD mechanism controller (IC316) Writing data transmission timing input (Also serves as the magnetic head on/off output)
16	OSCI	I	System clock signal (512Fs=22.5792 MHz) input terminal
17	OSCO	O	System clock signal (512Fs=22.5792 MHz) output terminal
18	XTSL	I	Input terminal for the system clock frequency setting “L”: 45.1584 MHz, “H”: 22.5792 MHz (fixed at “H” in this set)
19	DIN0	I	Digital audio signal input terminal when recording mode (for CS/BS optical digital in and CD digital playback signal)
20	DIN1	I	Digital audio signal input terminal when recording mode Not used (fixed at “L”)
21	DOUT	O	Digital audio signal output terminal when playback mode (for digital optical out/digital coaxial out) Not used (open)
22	DATAI	I	Serial data input terminal Not used (fixed at “L”)
23	LRCKI	I	L/R sampling clock signal (44.1 kHz) input terminal Not used (fixed at “L”)
24	XBCKI	I	Bit clock signal (2.8224 MHz) input terminal Not used (fixed at “L”)
25	ADDT	I	Recording data input from the A/D, D/A converter (IC201)
26	DADT	O	Playback data output to the A/D, D/A converter (IC201)
27	LRCK	O	L/R sampling clock signal (44.1 kHz) output to the A/D, D/A converter (IC201)
28	XBCK	O	Bit clock signal (2.8224 MHz) output to the A/D, D/A converter (IC201)
29	FS256	O	Clock signal (11.2896 MHz) output to the A/D, D/A converter (IC201)
30	DVDD	—	Power supply terminal (+3.3V) (digital system)
31 to 34	A03 to A00	O	Address signal output to the D-RAM (IC124)
35	A10	O	Address signal output to the external D-RAM Not used (open)
36 to 40	A04 to A08	O	Address signal output to the D-RAM (IC124)
41	A11	O	Address signal output to the external D-RAM Not used (open)
42	DVSS	—	Ground terminal (digital system)
43	<u>XOE</u>	O	Output enable signal output to the D-RAM (IC124) “L” active
44	<u>XCAS</u>	O	Column address strobe signal output to the D-RAM (IC124) “L” active

\* I (S) stands for schmitt input, I (A) for analog input, O (3) for 3-state output, and O (A) for analog output in the column I/O.

Pin No.	Pin Name	I/O	Function
45	A09	O	Address signal output to the D-RAM (IC124)
46	<u>XRAS</u>	O	Row address strobe signal output to the D-RAM (IC124) "L" active
47	<u>XWE</u>	O	Write enable signal output to the D-RAM (IC124) "L" active
48	D1	I/O	Two-way data bus with the D-RAM (IC124)
49	D0	I/O	
50	D2	I/O	
51	D3	I/O	
52	MVCI	I (S)	Digital in PLL oscillation input from the external VCO Not used (fixed at "L")
53	ASYO	O	Playback EFM full-swing output terminal
54	ASYI	I (A)	Playback EFM asymmetry comparator voltage input terminal
55	AVDD	—	Power supply terminal (+3.3V) (analog system)
56	BIAS	I (A)	Playback EFM asymmetry circuit constant current input terminal
57	RFI	I (A)	Playback EFM RF signal input from the CXA2523AR (IC101)
58	AVSS	—	Ground terminal (analog system)
59	PCO	O (3)	Phase comparison output for master clock of the recording/playback EFM master PLL
60	FILI	I (A)	Filter input for master clock of the recording/playback master PLL
61	FILO	O (A)	Filter output for master clock of the recording/playback master PLL
62	CLTV	I (A)	Internal VCO control voltage input of the recording/playback master PLL
63	PEAK	I (A)	Light amount signal (RF/ABCD) peak hold input from the CXA2523AR (IC101)
64	BOTM	I (A)	Light amount signal (RF/ABCD) bottom hold input from the CXA2523AR (IC101)
65	ABCD	I (A)	Light amount signal (ABCD) input from the CXA2523AR (IC101)
66	FE	I (A)	Focus error signal input from the CXA2523AR (IC101)
67	AUX1	I (A)	Auxiliary signal (I <sub>3</sub> signal/temperature signal) input from the CXA2523AR (IC101)
68	VC	I (A)	Middle point voltage (+1.65V) input from the CXA2523AR (IC101)
69	ADIO	O (A)	Monitor output of the A/D converter input signal Not used (open)
70	AVDD	—	Power supply terminal (+3.3V) (analog system)
71	ADRT	I (A)	A/D converter operational range upper limit voltage input terminal (fixed at "H" in this set)
72	ADRB	I (A)	A/D converter operational range lower limit voltage input terminal (fixed at "L" in this set)
73	AVSS	—	Ground terminal (analog system)
74	SE	I (A)	Sled error signal input from the CXA2523AR (IC101)
75	TE	I (A)	Tracking error signal input from the CXA2523AR (IC101)
76	DCHG	I (A)	Connected to the +3.3V power supply
77	TEST4	I (A)	Not used (fixed at "H")
78	ADFG	I (S)	ADIP duplex FM signal (22.05 kHz ± 1 kHz) input from the CXA2523AR (IC101)
79	F0CNT	O	Filter f0 control signal output to the CXA2523AR (IC101)
80	XLRF	O	Serial data latch pulse signal output to the CXA2523AR (IC101)
81	CKRF	O	Serial data transfer clock signal output to the CXA2523AR (IC101)
82	DTRF	O	Writing serial data output to the CXA2523AR (IC101)
83	APCREF	O	Control signal output to the reference voltage generator circuit for the laser automatic power control
84	TEST0	O	Not used (open)
85	TRDR	O	Tracking servo drive PWM signal (-) output to the BH6511FS (IC152)
86	TFDR	O	Tracking servo drive PWM signal (+) output to the BH6511FS (IC152)
87	DVDD	—	Power supply terminal (+3.3V) (digital system)
88	FFDR	O	Focus servo drive PWM signal (+) output to the BH6511FS (IC152)
89	FRDR	O	Focus servo drive PWM signal (-) output to the BH6511FS (IC152)
90	FS4	O	Clock signal (176.4 kHz) output terminal (X'tal system) Not used (open)

\* I (S) stands for schmitt input, I (A) for analog input, O (3) for 3-state output, and O (A) for analog output in the column I/O.

Pin No.	Pin Name	I/O	Function
91	SRDR	O	Sled servo drive PWM signal (-) output to the BH6511FS (IC152)
92	SFDR	O	Sled servo drive PWM signal (+) output to the BH6511FS (IC152)
93	SPRD	O	Spindle servo drive PWM signal (-) output to the BH6511FS (IC152)
94	SPFD	O	Spindle servo drive PWM signal (+) output to the BH6511FS (IC152)
95	FGIN	I (S)	FG signal input terminal Not used (fixed at "L")
96	TEST1	I	Input terminal for the test (fixed at "L")
97	TEST2	I	
98	TEST3	I	
99	DVSS	—	Ground terminal (digital system)
100	EFMO	O	EFM signal output terminal when recording mode

\* I (S) stands for schmitt input, I (A) for analog input, O (3) for 3-state output, and O (A) for analog output in the column I/O.

• BD (MD) BOARD IC316 M30624MG-205B (MD MECHANISM CONTROLLER)

Pin No.	Pin Name	I/O	Function
1	WMOUT	O	Serial data output to the equipment connected to MD WALKMAN LINK jack (J1)
2	WMCLK	I	Serial data transfer clock signal input from the equipment connected to MD WALKMAN LINK jack (J1)
3	LEVEL-L	O	Left channel level output terminal Not used (open)
4	LEVEL-R	O	Right channel level output terminal Not used (open)
5	LEDDATA	O	Serial data output to the LED driver IC (IC802)
6	—	O	Not used (open)
7	LEDCLK	O	Serial data transfer clock signal output to the LED driver IC (IC802)
8	BYTE	I	External data bus line byte selection signal input “L”: 16 bit, “H”: 8 bit (fixed at “L”)
9	CNVSS	—	Ground terminal
10	XIN-T	I	Sub system clock input terminal (32.768 kHz) Not used (fixed at “L”)
11	XOUT-T	O	Sub system clock output terminal (32.768 kHz) Not used (pull down)
12	<u>S.RST</u>	I	System reset signal input from the reset signal generator (IC451) “L”: reset For several hundreds msec. after the power supply rises, “L” is input, then it changes to “H”
13	XOUT	O	Main system clock output terminal (10 MHz)
14	GND	—	Ground terminal
15	XIN	I	Main system clock input terminal (10 MHz)
16	+3.3V	—	Power supply terminal (+3.3V)
17	NMI	I	Non-maskable interrupt input terminal (fixed at “H” in this set)
18	P.DOWN	I	Power down detection signal input terminal “L”: power down, normally: “H”
19	WMSYNC	I	Sync signal input from the equipment connected to MD WALKMAN LINK jack (J1)
20	<u>I2CBUSY</u>	O	Busy signal output for the I2C bus “L” active
21	L3CLK	O	L3 bus data transfer clock signal output to the A/D, D/A converter (IC201)
22	L3DATA	O	L3 bus data output to the A/D, D/A converter (IC201)
23	—	O	Not used (open)
24	ELEUP	O	Mini-disc elevator up/down motor control signal output to the motor driver IC (IC551) “H” active *1
25	—	O	Not used (open)
26	ELEDOWN	O	Mini-disc elevator up/down motor control signal output to the motor driver IC (IC551) “H” active *1
27	SQSY	I	Subcode Q sync (SCOR) input from the CXD2654R (IC121) “L” is input every 13.3 msec Almost all, “H” is input
28	RESET SW	I	Reset switch (S571) input terminal “L”: reset
29	I2CCLK	I/O	Shift clock signal input/output terminal for the I2C bus
30	I2CDATA	I/O	Serial data input/output terminal for the I2C bus
31	FLDATA	O	Display serial data output to the FL driver IC (IC801)
32	CNVSS	—	Ground terminal
33	FLCLK	O	Display serial data transfer clock signal output to the FL driver IC (IC801)
34	<u>FLCS</u>	O	Display serial chip select signal output to the FL driver IC (IC801) “L” active
35	SWDT	O	Writing data output to the CXD2654R (IC121)
36	SRDT	I	Reading data input from the CXD2654R (IC121)

\*1 Mini-disc elevator up/down motor (M571) control

Terminal \ Mode	Elevator Up	Elevator Down	Stop	Brake
ELEUP (pin ②)	“H”	“L”	“L”	“H”
ELEDOWN (pin ⑥)	“L”	“H”	“L”	“H”

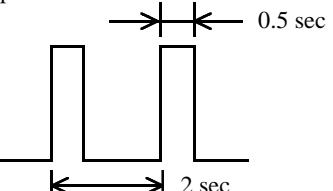
Pin No.	Pin Name	I/O	Function
37	SCLK	O	Serial clock signal output to the CXD2654R (IC121)
38	OPTSEL0	O	Selection signal output for the optical input signal Not used (open)
39	SENSOR	I	Elevator position detect sensor (PH570) input terminal
40	SENSOR2	I	Elevator position detect sensor (PH571) input terminal
41	HEADDOWN	O	Over write head up/down motor control signal output to the motor driver IC (IC172) “H” active *2
42	HEADUP	O	Over write head up/down motor control signal output to the motor driver IC (IC172) “H” active *2
43	JOG0	I	Jog dial pulse input from the rotary encoder (S801  ) (A phase input)
44	JOG1	I	Jog dial pulse input from the rotary encoder (S801  ) (B phase input)
45	WMINV	O	Clock signal phase inversion control signal output to the equipment connected to MD WALKMAN LINK jack (J1)
46	<u>LEDLAT</u>	O	Serial data latch pulse output to the LED driver IC (IC802) “L” active
47	OPTSEL1	O	CS/BS optical digital in signal or CD digital playback signal selection output to the digital input selector (IC405) “L”: CS/BS optical digital in signal, “H”: CD digital playback signal
48	<u>DARST</u>	O	Reset signal output terminal “L”: reset
49	MUTE	O	Audio line muting control signal output terminal “L”: line muting on Not used (pull down)
50	STB	O	Power control strobe signal output for the external device “L”: standby mode, “H”: power on Not used
51	CHACK-IN	I	Detection input from the disc loading in detect switch (S573) “L”: disc chucking, others: “H”
52	HOME	I	Detection input from the elevator home position detect switch (S570) “L”: home position, others: “H”
53	PACK-OUT	I	Detection input from the disc loading out detect switch (S572) “L”: loading out position, others: “H”
54	LDIN	O	Mini-disc loading motor control signal output to the motor driver IC (IC550) “H” active *3
55	LDOUT	O	Mini-disc loading motor control signal output to the motor driver IC (IC550) “H” active *3
56	LD-LOW	I	Control signal output for the loading motor drive voltage “H” active Not used (open)
57	LDON	O	Laser diode on/off control signal output to the automatic power control circuit “H”: laser on
58	REFLECT	I	Detection input from the disc reflection rate detect switch (S682) “L”: high reflection rate disc, “H”: low reflection rate disc
59	PROTECT	I	Rec-proof claw detect input from the protect detect switch (S683) “H”: write protect
60	PB-P	I	Detection input from the playback position detect switch “L” active Not used (open)
61	REC/ <u>PB</u>	O	Not used (open)
62	+3.3V	—	Power supply terminal (+3.3V)
63	LIMIT-IN	I	Detection input from the sled limit-in detect switch (S681) The optical pick-up is inner position when “L”
64	GND	—	Ground terminal

\*2 Over write head up/down motor (M4) control

Terminal \ Mode	Head Up	Head Down	Stop	Brake
HEADUP (pin ④②)	“H”	“L”	“L”	“H”
HEADDOWN (pin ④①)	“L”	“H”	“L”	“H”

\*3 Mini-disc loading motor (M572) control

Terminal \ Mode	Loading	Eject	Stop	Brake
LDIN (pin ⑤④)	“H”	“L”	“L”	“H”
LDOUT (pin ⑤⑤)	“L”	“H”	“L”	“H”

Pin No.	Pin Name	I/O	Function
65	MOD	O	Laser modulation select signal output to the HF module switch circuit Playback power: "H", Stop: "L", Recording power: 
66	XLATCH	O	Serial data latch pulse signal output to the CXD2654R (IC121)
67	WRPWR	O	Laser power select signal output to the CXD2654R (IC121) and HF module switch circuit "L": playback mode, "H": recording mode
68	LOADING SEL: L	I	Setting terminal for the loading control method "H": not used IN switch (fixed at "H")
69	L3MODE	O	L3 bus mode control signal output to the A/D, D/A converter (IC201)
70	C1E	I	Not used (fixed at "L")
71	C1F	I	Not used (fixed at "L")
72	SCTX	O	Recording data output enable signal output to the CXD2654R (IC121) and over write head driver (IC181) Writing data transmission timing output (Also serves as the magnetic head on/off output)
73	XINT	I	Interrupt status input from the CXD2654R (IC121)
74	REC-P	O	Detection input from the recording position detect switch "L" active Not used (fixed at "H")
75	DQSY	I	Digital In U-bit CD format subcode Q sync (SCOR) input from the CXD2654R (IC121) "L" is input every 13.3 msec Almost all, "H" is input
76	—	I	Not used (open)
77	<u>DIGRST</u>	O	Reset signal output to the CXD2654R (IC121) and BH6511FS (IC152) "L": reset
78	SENS	I	Internal status (SENSE) input from the CXD2654R (IC121)
79	MNT3	I	Spindle servo lock status monitor signal input from the CXD2654R (IC121)
80	MNT2	I	Busy signal input from the CXD2654R (IC121)
81	MNT1	I	Track jump detection signal input from the CXD2654R (IC121)
82	MNT0	I	Focus OK signal input from the CXD2654R (IC121) "H" is input when focus is on ("L": NG)
83	SENSOR SW	O	Control signal output for the sensor gain selection
84	DISC5	I	Detection input from the disc 5 detect switch (S5) "L": set disc 5
85	DISC1	I	Detection input from the disc 1 detect switch (S1) "L": set disc 1
86	DISC2	I	Detection input from the disc 2 detect switch (S2) "L": set disc 2
87	SCL	O	Serial clock signal output to the EEPROM (IC171)
88	SDA	I/O	Two-way data bus with the EEPROM (IC171)
89	DISC4	I	Detection input from the disc 4 detect switch (S4) "L": set disc 4
90	DISC3	I	Detection input from the disc 3 detect switch (S3) "L": set disc 3
91	HEADSW-DOWN	I	Detection input from the over write head down position detect switch (S7) "L": down position
92	HEADSW-UP	I	Detection input from the over write head up position detect switch (S6) "L": up position
93	KEY3	I	Key input terminal (A/D input) S807 to S812 (MD DISC1/2/3/4/5, DISC SKIP) keys input
94	KEY2	I	Key input terminal (A/D input) S803 to S806 (§, REC MODE, r REC, MD WALKMAN LINK) keys input

Pin No.	Pin Name	I/O	Function
95	KEY1	I	Key input terminal (A/D input) S603, S604, S606 to S609 (PLAY MODE, REPEAT, □, ▷▷, ◀◀, ▶▶) keys input
96	AVSS	—	Ground terminal (for A/D converter)
97	KEY0	I	Key input terminal (A/D input) S602, S610 to S613, S802 (1/ALL, NAME EDIT, MENU/NO, ENTER/YES, CLEAR, DISPLAY) keys input
98	VREF	I	Reference voltage (+3.3V) input terminal (for A/D converter)
99	+3.3V	—	Power supply terminal (+3.3V)
100	WMIN	I	Serial data input from the equipment connected to MD WALKMAN LINK jack (J1)

• MICROCOMPUTER BOARD IC300 μPD784215AYGF-501-3BA  
(MASTER CONTROLLER (CD MECHANISM CONTROL))

Pin No.	Pin Name	I/O	Function
1, 2	OPEN	O	Not used (open)
3	<u>LEDLAT</u>	O	Serial data latch pulse output to the LED driver IC (IC661)
4	<u>DRVCS</u>	O	Chip select signal output to the FL driver IC (IC601) “L” active
5	<u>RE</u>	O	Output enable signal output to the static RAM (IC302) “L” active
6	<u>WE</u>	O	Data write enable signal output to the static RAM (IC302) “L” active
7	<u>DRV_RST</u>	O	Reset signal output to the FL driver IC (IC601) and LED driver IC (IC661) “L”: reset
8	OPEN	O	Not used (open)
9	VDD	—	Power supply terminal (+5V)
10	<u>BDRST</u>	O	Reset signal output to the CXD2587Q (IC101) and BA5974FP (IC102) on the CD block “L”: reset
11	<u>BDPWR</u>	O	Power on/off control signal output terminal “L”: power on Not used (open)
12	DRV_DAT	O	Serial data output to the FL driver IC (IC601) and LED driver IC (IC661)
13	DRV_CLK	O	Serial data transfer clock signal output to the FL driver IC (IC601) and LED driver IC (IC661)
14	<u>LOD POS</u>	O	CD loading motor (M702) control signal output to the motor driver IC (IC702) “L” active *1
15	<u>LOD NEG</u>	O	CD loading motor (M702) control signal output to the motor driver IC (IC702) “L” active *1
16	<u>CLP POS</u>	O	CD elevator up/down motor (M701) control signal output to the motor driver IC (IC701) “L” active *2
17	<u>CLP NEG</u>	O	CD elevator up/down motor (M701) control signal output to the motor driver IC (IC701) “L” active *2
18	<u>OUT SW</u>	I	Detection input from the tray open/close detect switch (S708) on the CD mechanism block “L”: when tray is open, “H”: when tray is close
19	<u>IN SW</u>	I	Detection input from the tray open/close detect switch (S704) on the CD mechanism block “L”: when tray is close, “H”: when tray is open
20	<u>MIDOUT SW</u>	I	Detection input from the mid out detect switch (S701) on the CD mechanism block “L”: when tray is going to open or close
21	<u>MID SW</u>	I	Detection input from the mid in detect switch (S703) on the CD mechanism block “L”: when sub tray move between tray and stocker
22	TEST	I	Test input terminal (fixed at “L”)
23	ENCODE0	I	Detection input from the disc tray address detect rotary encoder (S707) on the CD mechanism block
24	ENCODE1	I	
25	ENCODE2	I	
26	<u>INIT SW</u>	I	Detection input from the INIT detect switch (S705) on the CD mechanism block “L”: when elevator down to bottom, others: “H”
27	<u>ADJ</u>	I	Setting terminal for the CD test mode Normally: fixed at “H” (“L”: test mode)
28	<u>AMUTE</u>	O	Analog muting on/off control signal output terminal Not used (open)
29	DATA	O	Serial data output to the CXD2587Q (IC101) on the CD block
30	CLK	O	Serial data transfer clock signal output to the CXD2587Q (IC101) on the CD block
31	<u>XLT</u>	O	Serial data latch pulse output to the CXD2587Q (IC101) on the CD block
32	PANEL SW	I	Detection input from the CD tray door open/close detect switch (S702) “L”: when CD lid is open, “H”: when CD lid is close

\*1 CD loading motor (M702) control

Mode Terminal	Loading	Eject	Stop	Brake
<u>LOD NEG</u> (pin ⑯)	“L”	“H”	“H”	“L”
<u>LOD POS</u> (pin ⑭)	“H”	“L”	“H”	“L”

\*2 CD elevator up/down motor (M701) control

Mode Terminal	Elevator Up	Elevator Down	Stop	Brake
<u>CLP NEG</u> (pin ⑰)	“L”	“H”	“H”	“L”
<u>CLP POS</u> (pin ⑯)	“H”	“L”	“H”	“L”

Pin No.	Pin Name	I/O	Function
33	BUSD0	O	CD digital signal selection control signal output terminal
34	BUSD1	O	Not used (open)
35	BUSD2	O	Not used (open)
36	I2CHELP (BUSD3)	O	Busy signal output for the I2C bus “L” active
37	VDD	—	Power supply terminal (+5V)
38	X2	O	Main system clock output terminal (12.5 MHz)
39	X1	I	Main system clock input terminal (12.5 MHz)
40	VSS	—	Ground terminal
41	XT2	O	Sub system clock output terminal Not used (open)
42	XT1	I	Sub system clock input terminal Not used (fixed at “L”)
43	<u>RESET</u>	I	System reset signal input terminal (Power down detect signal used as a reset signal) “L”: reset or power down For several hundreds msec. after the power supply rises, “L” is input, then it changes to “H”
44	I2CHELP (BUSCLK)	I	Busy signal input for the I2C bus “L” active
45	<u>BUSBSY</u>	O	Busy signal output when bus data in/out operation Not used (open)
46	SCOR	I	Subcode sync (S0+S1) detection signal input from the CXD2587Q (IC101) on the CD block
47	DQSY	I	Data read enable signal input terminal Not used (open)
48	<u>AC CUT</u>	I	Power down detection input terminal “L”: power down
49	JOG0	I	Jog dial pulse input from the rotary encoder (S681  (A phase input))
50	JOG1	I	Jog dial pulse input from the rotary encoder (S681  (B phase input))
51	AVDD	—	Power supply terminal (+5V) (for A/D converter analog system)
52	AVREF0	I	Reference voltage (+5V) input terminal (for A/D converter)
53	KEY0	I	Key input terminal (A/D input) S604, S613, S661 to S665 (REPEAT, CLEAR, CD 1/2/3/4/5) keys input
54	KEY1	I	Key input terminal (A/D input) S611, S612, S671 to S676 (MENU/NO, ENTER/YES, CD 1/2/3/4/5, DISC SKIP) keys input
55	KEY2	I	Key input terminal (A/D input) S602, S603, S606 to S610, S636 (1/ALL, PLAY MODE,  ,  ,  , NAME EDIT, DISPLAY) keys input
56	SELECT0	I	Setting terminal for the Japanese letter input functions “L”: input possible (fixed at “H” in this set)
57	SELECT1	I	Setting terminal for the separate/complete type setting of CD section and others section (amplifier, tuner, etc.) “L”: separate type, “H”: complete type (fixed at “L” in this set)
58	SELECT2	I	GFS NG when search mode (A/D input)
59	DISC SENS	I	Detection input from the disc in detect sensor (D704 and Q703) on the CD mechanism block “H”: disc detected
60	CNT SW	I	Detection input from the count detect switch (S706) on the CD mechanism block “L”: when elevator up/down each sub tray stock position
61	AVSS	—	Ground terminal (for A/D converter analog system)
62	MECHA JIG	I	Test input terminal (fixed at “L”)
63	CHECK	O	Not used (open)
64	AVREF1	I	Reference voltage (+5V) input terminal (for D/A converter)
65	SRDT	I	Serial data input terminal Not used (open)
66	OPEN	O	Not used (open)
67	SCLK	O	Serial data transfer clock signal output terminal Not used (open)
68	SUBQ	I	Subcode Q data input from the CXD2587Q (IC101) on the CD block
69	OPEN	O	Not used (open)
70	SQCLK	O	Subcode Q data reading clock signal output to the CXD2587Q (IC101) on the CD block

Pin No.	Pin Name	I/O	Function
71	LPH (XMODE)	O	Laser power control signal output to the CXA2568M (IC103) on the CD block
72	SENSE2	I	Monitor detection signal input of the internal status Not used (open)
73	I2CDATA	I/O	Data input/output terminal for the I2C bus
74	SENSE	I	Internal status detection monitor input from the CXD2587Q (IC101) on the CD block
75	I2CCLK	I/O	Shift clock signal input/output terminal for the I2C bus
76 to 83	A0 to A7	O	Address signal output to the static RAM (IC302)
84 to 91	D0 to D7	I/O	Two-way data bus with the static RAM (IC302)
92 to 98	A8 to A14	O	Address signal output to the static RAM (IC302)
99	A15	O	Address signal output to the external device Not used (open)
100	VSS	—	Ground terminal

## SECTION 7 EXPLODED VIEWS

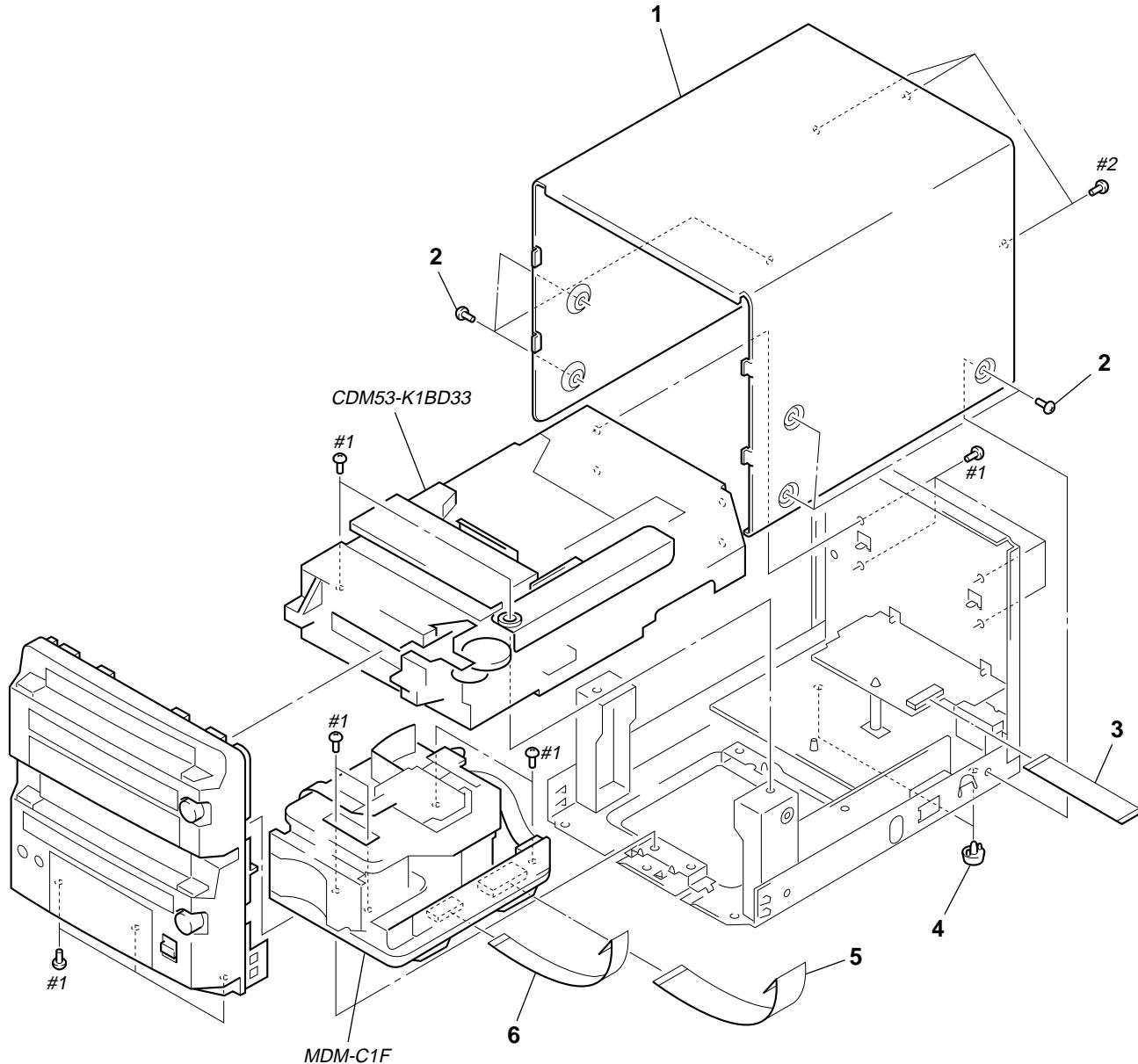
**NOTE:**

- -XX and -X mean standardized parts, so they may have some difference from the original one.
- Color Indication of Appearance Parts  
Example:  
KNOB, BALANCE (WHITE) . . . (RED)  
↑                      ↑  
Parts Color Cabinet's Color

- Items marked “\*” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- The mechanical parts with no reference number in the exploded views are not supplied.
- Hardware (# mark) list is given in the last of the electrical parts list.

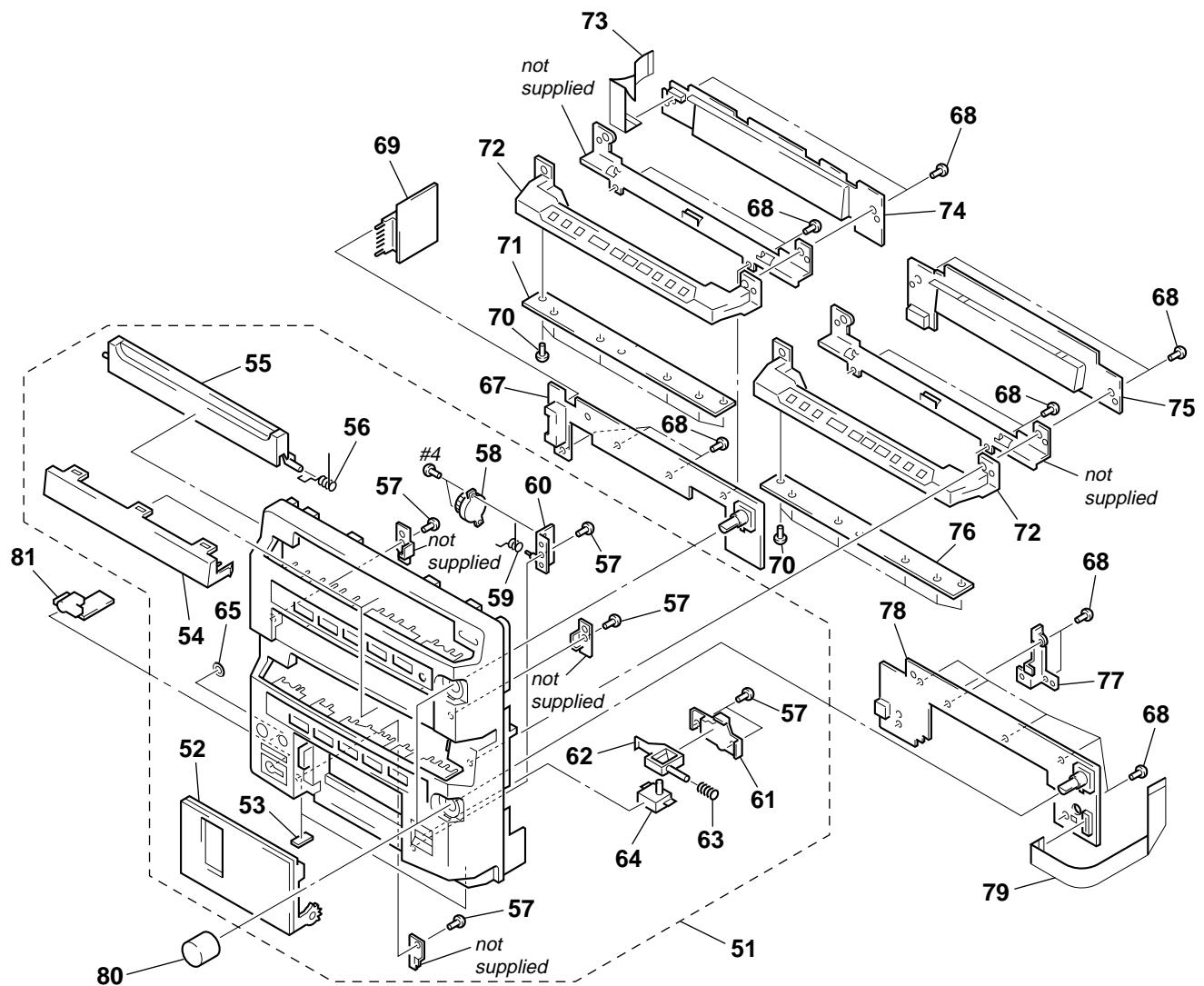
The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety.  
Replace only with part number specified.

### (1) CASE SECTION



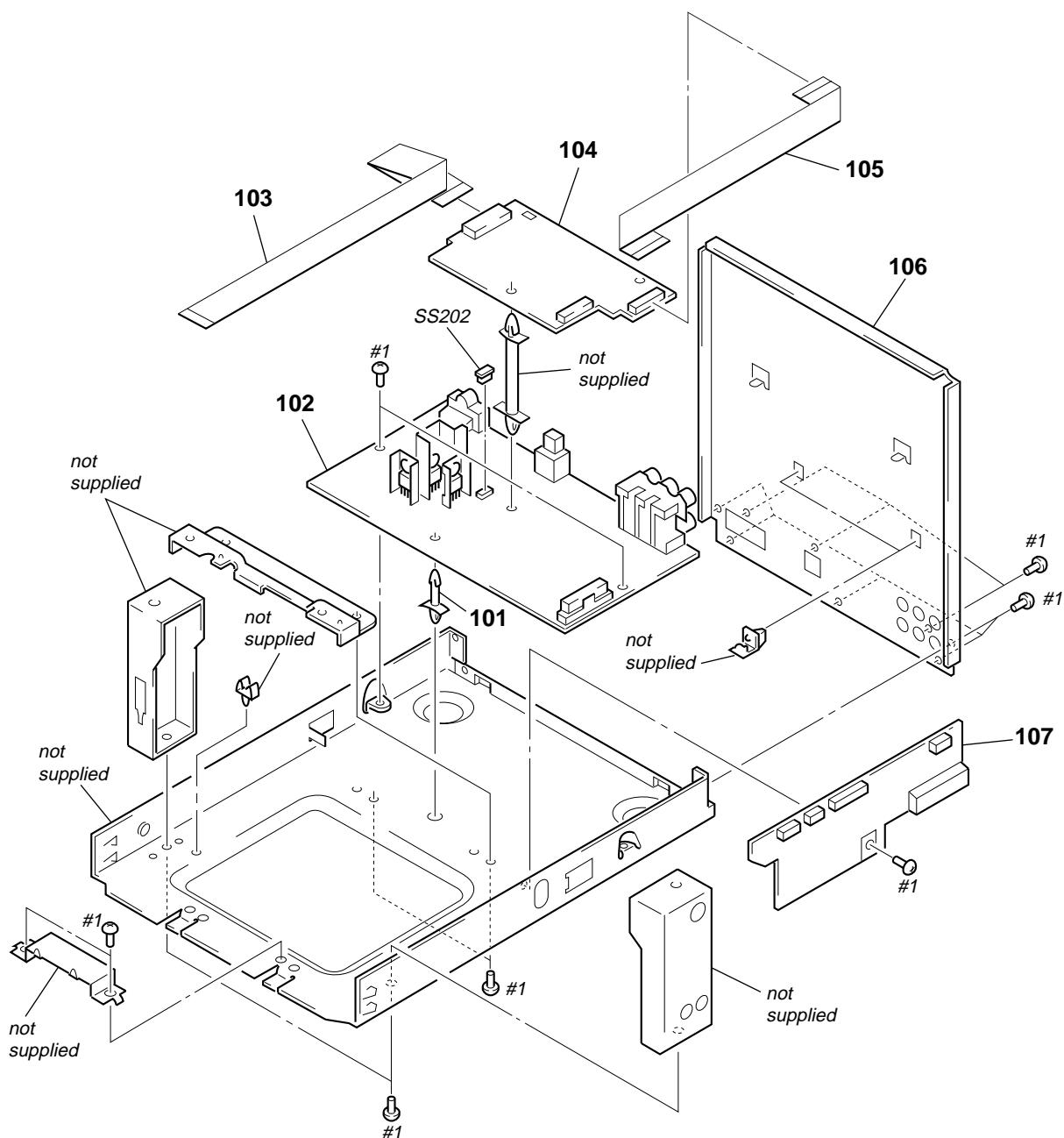
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
* 1	4-213-360-01	CASE		4	4-965-822-01	FOOT	
2	3-363-099-11	SCREW (CASE 3 TP2)		5	1-773-181-11	WIRE (FLAT TYPE) (23 CORE)	
3	1-790-267-11	WIRE (FLAT TYPE) (19 CORE)		6	1-790-263-11	WIRE (FLAT TYPE) (13 CORE) (130mm)	

(2) FRONT PANEL SECTION



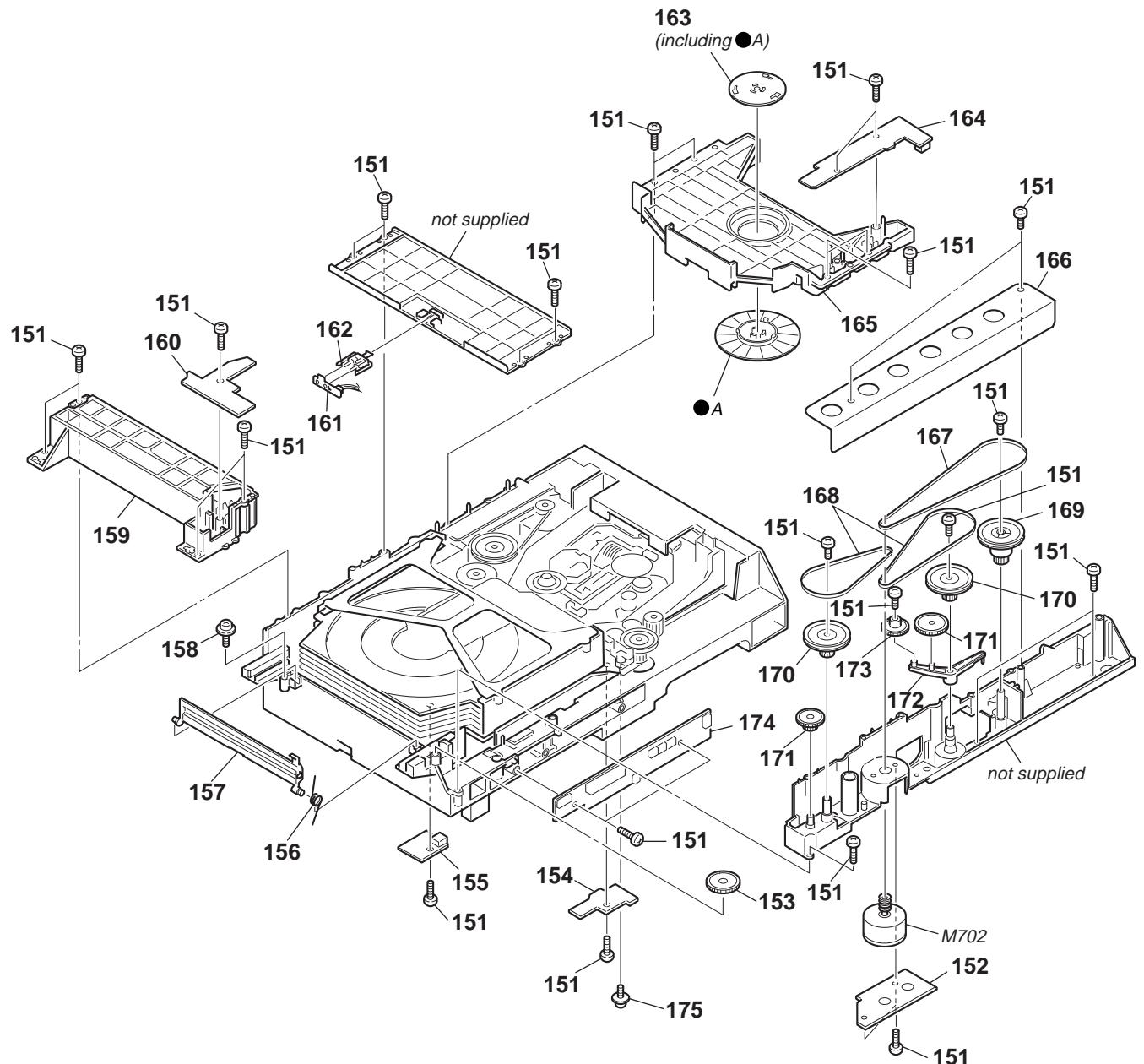
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
51	X-4950-483-1	PANEL ASSY, FRONT		* 67	A-4724-393-A	CD JOG BOARD, COMPLETE	
52	X-4950-488-1	LID (MD) ASSY		68	4-951-620-11	SCREW (2.6X10), +BVTP	
* 53	4-930-336-71	FOOT (FELT)		* 69	1-671-818-11	CONNECTOR BOARD	
54	4-213-326-01	WINDOW (FL)		70	4-908-618-21	SCREW (+BTP) (2X6)	
55	X-4950-486-1	LID (CD) ASSY		* 71	A-4724-396-A	CD SW BOARD, COMPLETE	
56	4-213-336-01	SPRING (LID-CD), TOGGLE		72	X-4950-484-1	BUTTON (TOP 1) ASSY	
57	4-951-620-01	SCREW (2.6X8), +BVTP		73	1-790-265-12	WIRE (FLAT TYPE) (11 CORE)	
* 58	3-973-975-21	DAMPER, OIL		* 74	A-4724-390-A	CD DISPLAY BOARD, COMPLETE	
59	4-213-351-01	SPRING (LID-MD), TOGGLE		* 75	A-4724-391-A	MD DISPLAY BOARD, COMPLETE	
* 60	X-4950-489-1	BRACKET (LID-MD) B ASSY		* 76	A-4724-397-A	MD SW BOARD, COMPLETE	
61	4-213-949-01	COVER (OPEN)		* 77	4-213-353-01	BRACKET (PLUG)	
62	4-213-342-01	LEVER (OPEN)		* 78	A-4724-394-A	MD JOG BOARD, COMPLETE	
63	4-213-343-01	SPRING (OPEN), COMPRESSION		79	1-790-264-11	WIRE (FLAT TYPE) (13 CORE) (179mm)	
64	4-213-341-01	BUTTON (OPEN)		80	4-213-333-01	KNOB (JOG)	
65	3-701-440-21	WASHER, 3.5		* 81	1-671-822-11	WM BOARD	

(3) CHASSIS SECTION



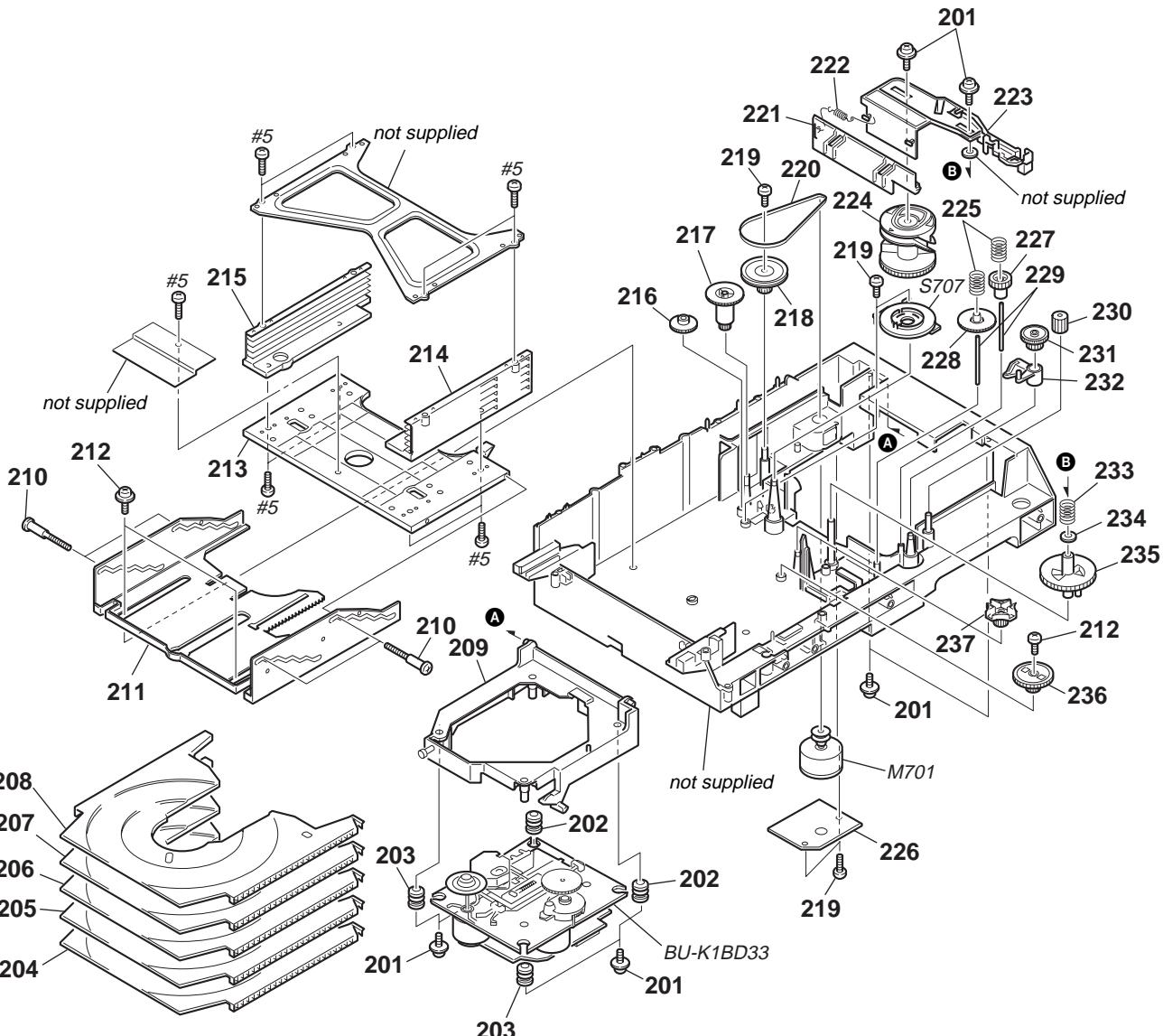
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
* 101	3-346-265-11	HOLDER, PC BOARD		105	1-790-266-11	WIRE (FLAT TYPE) (17 CORE)	
* 102	A-4724-389-A	MAIN BOARD, COMPLETE		* 106	4-213-359-11	PANEL, BACK	
103	1-790-268-11	WIRE (FLAT TYPE) (21 CORE)		* 107	A-4724-392-A	RELAY BOARD, COMPLETE	
* 104	A-4724-482-A	MICROCOMPUTER BOARD, COMPLETE		SS202	1-569-972-21	SOCKET, SHORT 2P	

(4) CD MECHANISM DECK SECTION-1  
(CDM53-K1BD33)



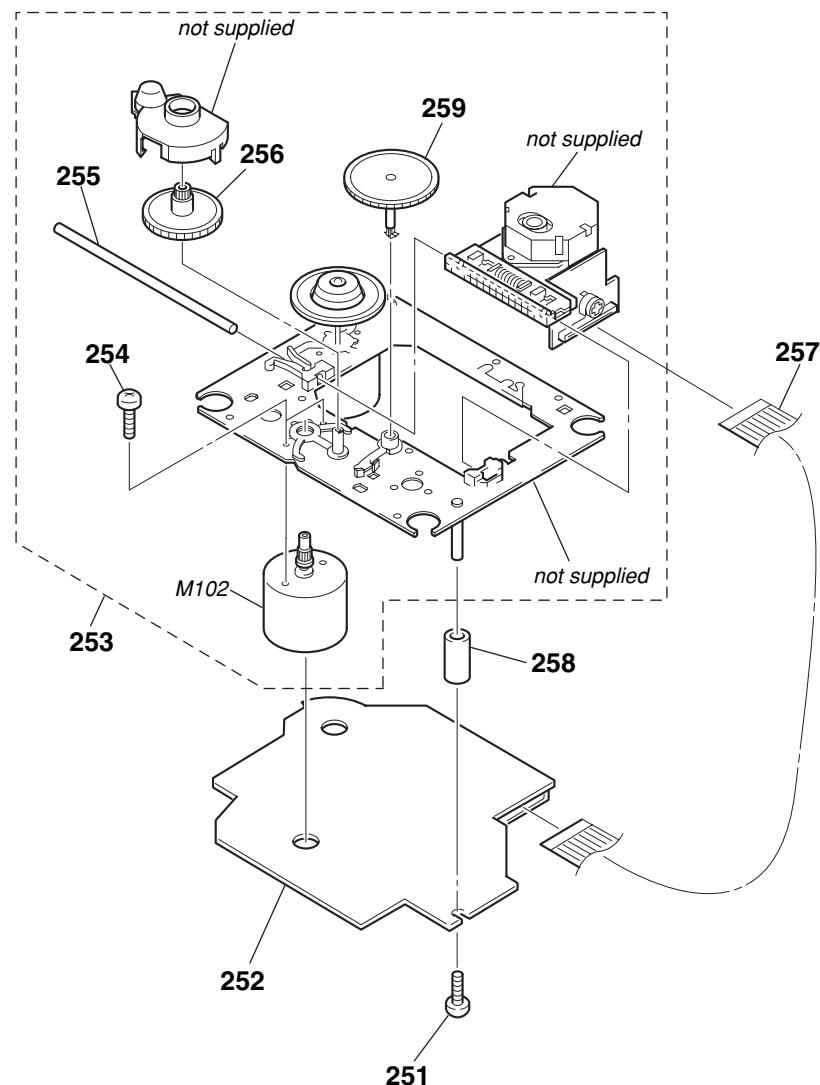
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
151	4-951-620-41	SCREW (2.6), +BVTP		164	1-671-505-11	IN SW BOARD	
* 152	1-671-508-11	LOAD MOTOR BOARD		165	A-4672-623-C	BASE (MAGNET) ASSY, FITTING	
153	4-211-215-01	GEAR (EJECT)		* 166	4-214-129-01	COVER	
* 154	1-671-502-11	INIT/COUNT SW BOARD		167	4-211-235-01	BELT (COMMUNICATION)	
* 155	1-671-504-11	SENSOR BOARD		168	4-211-236-01	BELT (LOADING)	
156	4-212-676-03	SPRING (LID), TORSIONOR		169	4-211-231-01	PULLEY (MODE)	
157	4-212-674-01	LID (DISC)		170	4-211-214-01	PULLEY (LD)	
158	4-985-672-01	SCREW (+PTPWH M2.6), FLOATING		171	4-211-227-01	GEAR (LD DECELERATION)	
159	A-4672-622-E	BASE (GUIDE) ASSY, FITTING		172	4-211-228-01	LEVER (GOOSENECK)	
* 160	1-671-503-11	OUT SW BOARD		173	4-214-130-01	GEAR (TRAY)	
* 161	1-671-789-11	SENSOR 2 BOARD		* 174	1-671-506-11	CONNECTOR (CD) BOARD	
162	4-964-461-02	HOLDER (SENSOR)		175	3-341-549-21	SCREW (2.6X12) (DIA.7.5), +PTPWH	
163	A-4672-600-B	MAGNET ASSY, CHUCKING (including ●A)		M702	X-4950-342-1	MOTOR (LOADING) ASSY	

(5) CD MECHANISM DECK SECTION-2  
(CDM53-K1BD33)



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
201	4-985-672-01	SCREW (+PTPWH M2.6), FLOATING		221	4-212-677-01	SLIDER (SHUTTER)	
202	4-211-871-11	INSULATOR (M) (BLUE)		222	4-212-678-01	SPRING (SHUTTER), TENSION	
203	4-211-871-01	INSULATOR (M) (BLACK)		223	4-211-233-01	SLIDER (SELECTION)	
204	4-211-212-41	TRAY (SUB)		224	4-211-230-01	GEAR (CHUCKING)	
205	4-211-212-31	TRAY (SUB)		225	4-211-245-01	SPRING, COMPRESSION	
206	4-211-212-21	TRAY (SUB)		* 226	1-671-507-11	CLAMP MOTOR BOARD	
207	4-211-212-11	TRAY (SUB)		227	4-211-221-01	GEAR (LD MOVABLE)	
208	4-211-212-01	TRAY (SUB)		228	4-211-217-02	GEAR (SELECTION)	
209	X-4950-322-2	HOLDER (BU) ASSY		229	4-211-242-01	SHAFT (SELECTION GEAR)	
210	4-211-244-01	SCREW, STEP		230	4-211-240-01	GEAR (LD DECELERATION B)	
211	4-211-223-01	SLIDER (U/D)		231	4-211-216-01	GEAR (RELAY)	
212	4-933-134-01	SCREW (+PTPWH M2.6X6)		232	4-211-241-01	LEVER (SELECTION)	
213	4-211-224-02	BASE (STOCKER), FITTING		233	4-216-879-01	SPRING (GEAR A), COMPRESSION	
214	4-211-211-01	STOCKER (R)		234	3-701-446-21	WASHER, 8	
215	4-211-210-01	STOCKER (L)		235	4-211-218-01	GEAR (GEAR A)	
216	4-211-215-01	GEAR (EJECT)		236	4-211-220-01	GEAR (U/D SLIDER)	
217	4-211-232-01	GEAR (MODE DECELERATION)		237	4-211-219-01	GEAR (GEAR B)	
218	4-211-214-01	PULLEY (LD)		M701	X-4950-341-1	MOTOR (CLAMP) ASSY (ELEVATOR UP/DOWN)	
219	4-951-620-41	SCREW (2.6), +BVTP		S707	1-418-045-01	ENCODER, ROTARY (DISC TRY ADDRESS DETECT)	
220	4-211-237-01	BELT (MODE)					

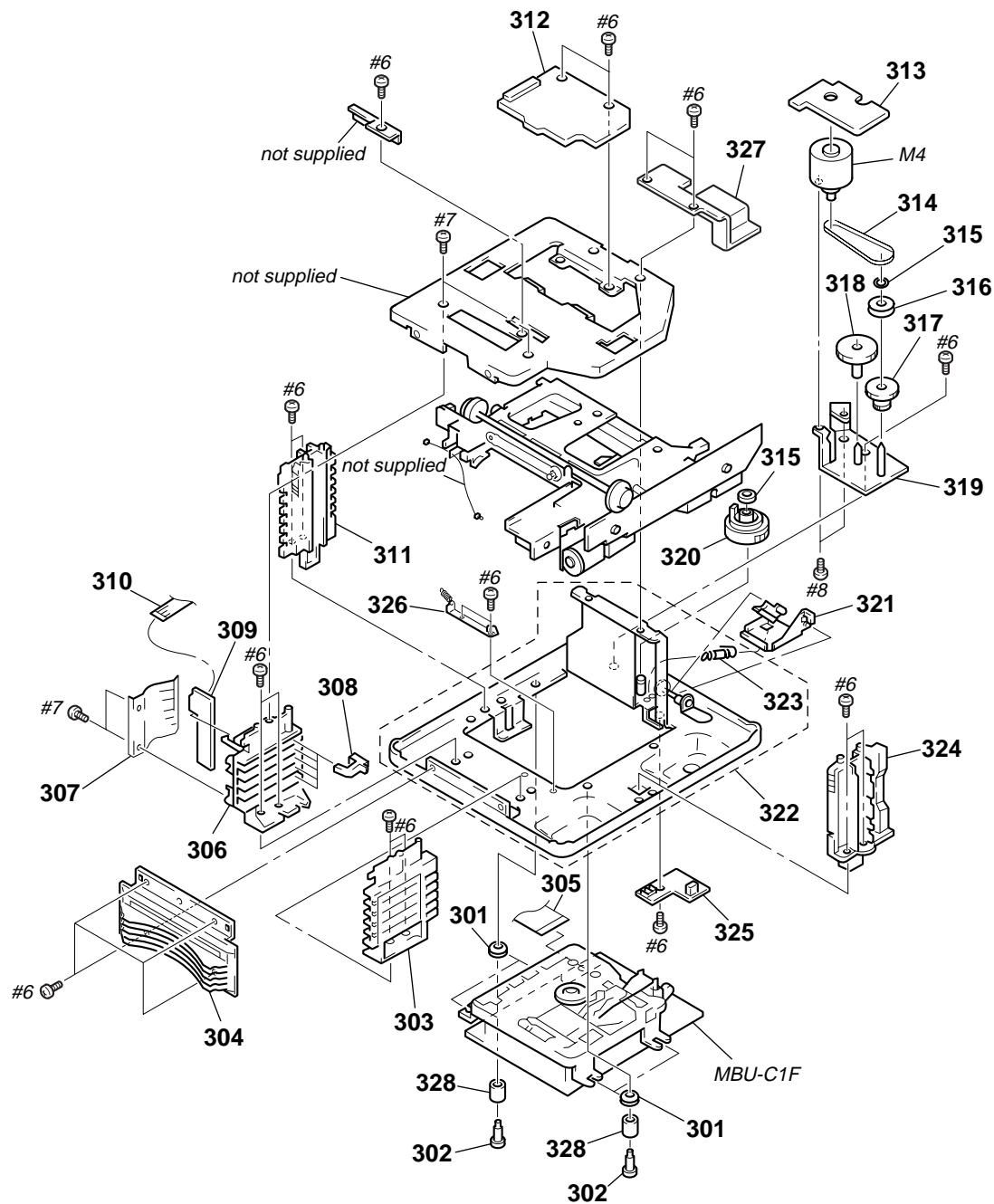
**(6) CD BASE UNIT SECTION  
(BU-K1BD33)**



The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety. Replace only with part number specified.

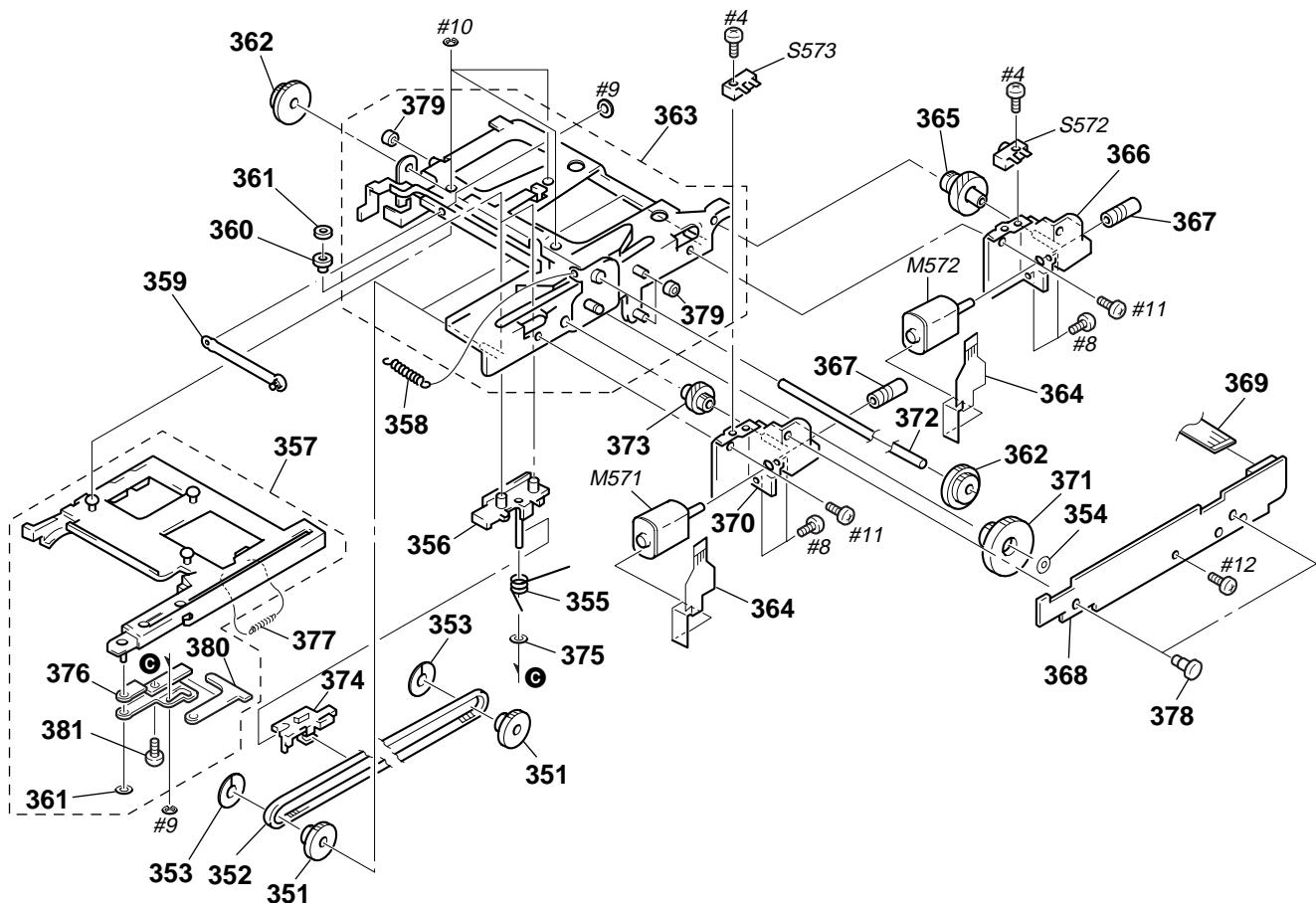
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
251	4-996-243-11	SCREW (M2), +PSW		256	2-627-003-02	GEAR (B) (RP)	
* 252	A-4724-330-A	BD (CD) BOARD, COMPLETE		257	1-769-069-11	WIRE (FLAT TYPE) (16 CORE)	
$\triangle$ 253	A-3328-818-A	OPTICAL PICK-UP (KSM-213BFN)		258	4-216-878-01	COLLAR	
254	3-713-786-51	SCREW +P 2X3		259	2-626-907-11	GEAR (A)	
255	2-626-908-01	SHAFT, SLED		M102	X-2625-769-1	SLED MOTOR (WITH GEAR) ASSY	

(7) MD MECHANISM DECK SECTION-1  
(MDM-C1F)



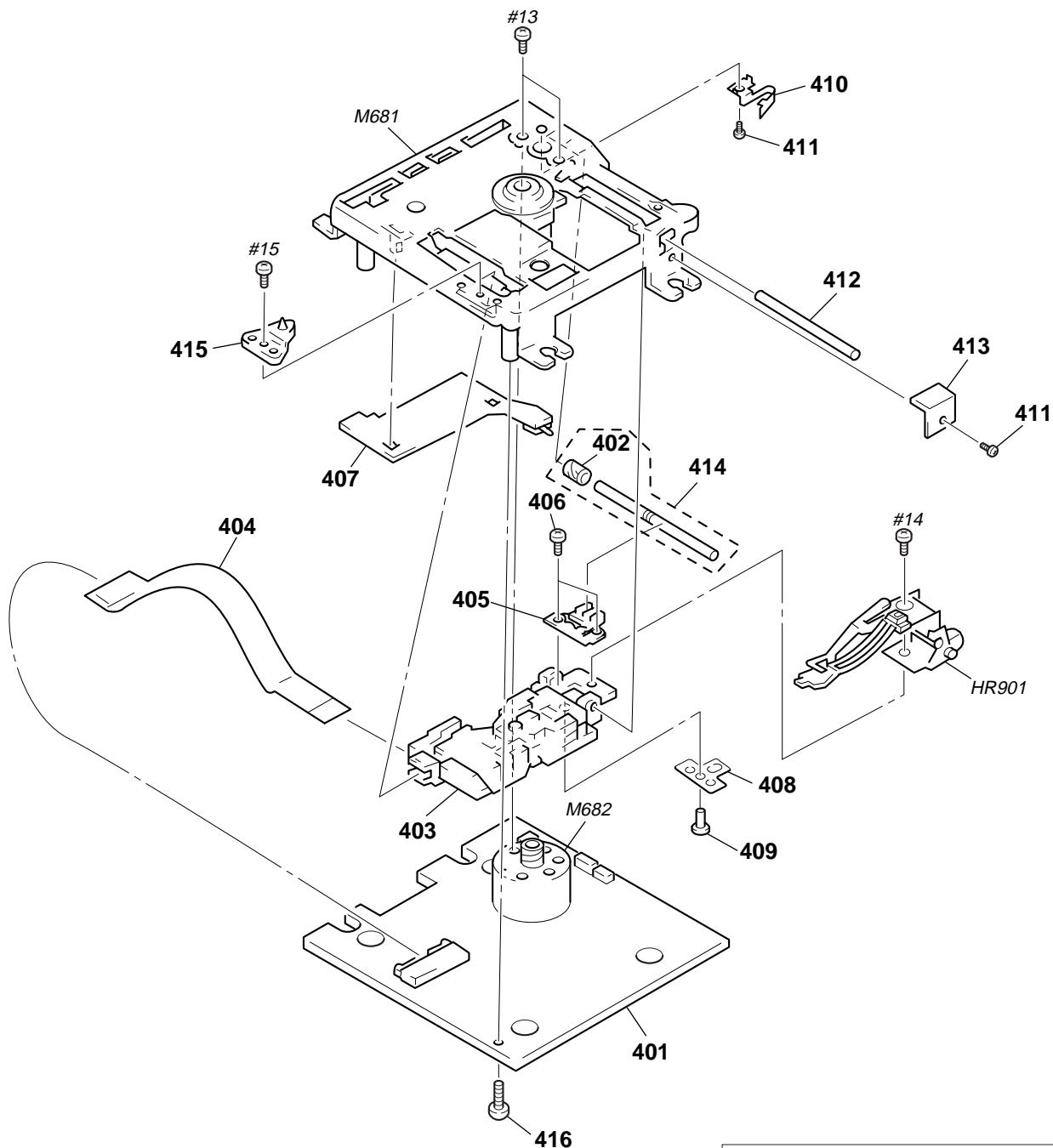
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark	
301	4-987-327-01	INSULATOR		315	3-701-438-21	WASHER (E-2.3), NYLON		
302	4-987-240-01	SCREW, STEP		316	3-018-636-01	GEAR (PULLEY) (C)		
303	4-986-932-01	HOLDER (R)		317	3-018-203-01	GEAR (HEAD) (A)		
304	4-212-592-01	ESCUTCHEON ('98 FRONT)		318	3-018-204-01	GEAR (HEAD) (B)		
305	1-790-121-01	WIRE (FLAT TYPE) (21 CORE)		319	X-3374-348-1	CHASSIS (HEAD GEAR) ASSY		
306	4-986-930-01	HOLDER (L)		320	4-987-242-01	GEAR (CAM)		
307	4-986-934-01	SPRING (LOCK), LEAF		* 321	4-987-241-01	LEVER (H)		
308	4-213-115-01	LOCK ('98 NEW)		322	X-4947-927-1	CHASSIS (BASE) ASSY		
* 309	1-671-472-11	DISC SW BOARD		323	4-996-395-02	SPRING (H), TENSION		
310	1-782-910-11	WIRE (FLAT TYPE) (7 CORE)		324	4-994-630-12	RACK (RN)		
311	4-988-375-01	RACK (L)		* 325	1-671-471-11	HEAD SW BOARD		
* 312	1-671-468-11	MECH RELAY BOARD		326	X-4949-848-1	STAY (WIRE) ASSY		
* 313	1-671-470-11	HEAD RELAY BOARD		* 327	4-997-713-01	COVER (FFC)		
314	3-661-080-00	BELT, (A)		328	4-216-886-01	COLLAR (MDM)		
					M4	X-4949-160-1	MOTOR (HEAD) ASSY(OVER WRITE HEAD UP/DOWN)	

(8) MD MECHANISM DECK SECTION-2  
(MDM-C1F)



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
351	4-986-951-01	GEAR (4)		368	1-671-469-11	ELEVATOR RELAY BOARD	
352	4-987-243-01	BELT, TOOTHED LOCK		369	1-782-909-11	WIRE (FLAT TYPE) (13 CORE)	
353	4-986-947-01	STOPPER		370	X-4947-928-1	BRACKET (1A) ASSY	
354	3-701-438-21	WASHER (E-2.3), NYLON		371	4-986-950-01	GEAR (3)	
355	4-987-236-01	SPRING, TORSION		372	4-987-244-01	SHAFT (1)	
356	X-4947-932-1	SLIDER (2) ASSY		373	4-986-949-11	GEAR (2)	
* 357	X-3374-359-1	HOLDER (1H) ASSY		374	4-987-235-01	CLAMP (B)	
358	4-987-238-01	SPRING (2), TENSION		375	3-326-162-08	WASHER, POLYETHYLENE, SLIT	
359	X-4948-193-1	LEVER (S) ASSY		376	4-214-244-01	LEVER (3H)	
360	4-987-111-01	ROLLER (2)		377	4-996-395-02	SPRING (H), TENSION	
361	3-307-948-11	WASHER, NYLON		378	4-997-937-01	SCREW (EL), STEP	
362	4-986-952-01	GEAR (5)		379	4-987-253-01	ROLLER (1)	
* 363	X-4949-171-1	CHASSIS (ELEVATOR) (NEW) ASSY		380	4-213-866-02	TOP (LEVER 3H)	
364	1-667-955-11	OP RELAY FLEXIBLE BOARD		381	4-900-590-01	SCREW, PRECISION SMALL	
365	4-986-948-01	GEAR (1)		M571	1-698-874-11	MOTOR, DC (ELEVATOR UP/DOWN)	
366	X-4949-225-3	BRACKET (1BN) ASSY		M572	1-698-874-11	MOTOR, DC (LOADING)	
367	4-986-953-01	WORM		S572	1-762-952-11	SWITCH, PUSH (1 KEY) (LOADING IN)	
				S573	1-762-952-11	SWITCH, PUSH (1 KEY) (LOADING OUT)	

(9) MD BASE UNIT SECTION  
(MBU-C1F)



The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety.  
Replace only with part number specified.

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
* 401	A-4724-315-A	BD (MD) BOARD, COMPLETE		411	3-342-375-11	SCREW (M1.7X1.4), SPECIAL	
402	4-979-911-21	GEAR (B)		* 412	4-988-702-01	SHAFT (MAIN)	
$\triangle$ 403	8-583-028-02	OPTICAL PICK-UP KMS-260A/J1RP		* 413	4-988-484-01	STOPPER	
404	1-664-039-11	OP TRANSLATION FLEXIBLE BOARD		414	A-3304-200-A	SCREW ASSY, LEAD	
405	4-963-914-02	RACK (INSERTER)		* 415	4-983-511-02	PIN (OUTSERT)	
406	3-366-890-11	SCREW (M1.4)		416	4-908-618-21	SCREW (+BTP) (2X6)	
* 407	1-671-467-11	SW BOARD		HR901	1-500-489-14	HEAD, OVER WRITE	
408	4-987-061-01	SPACER (RACK)		M681	A-4672-241-A	MOTOR ASSY, SPINDLE	
409	4-955-841-11	SCREW		M682	A-4672-240-A	MOTOR ASSY, SLED	
410	4-979-906-11	SPRING (LEAD SCREW)					





Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark	
C503	1-125-822-11	TANTALUM	10uF 20%	10V	L401	1-414-813-11	FERRITE	0uH
C509	1-125-822-11	TANTALUM	10uF 20%	10V	L502	1-414-813-11	FERRITE	0uH
C510	1-125-822-11	TANTALUM	10uF 20%	10V				
C522	1-163-038-00	CERAMIC CHIP	0.1uF	25V				< TRANSISTOR >
C527	1-163-038-00	CERAMIC CHIP	0.1uF	25V	Q101	8-729-403-35	TRANSISTOR	UN5113
C528	1-163-038-00	CERAMIC CHIP	0.1uF	25V	Q102	8-729-026-53	TRANSISTOR	2SA1576A-T106-QR
C529	1-163-038-00	CERAMIC CHIP	0.1uF	25V	Q103	8-729-402-93	TRANSISTOR	UN5214-TX
C901	1-163-021-11	CERAMIC CHIP	0.01uF 10%	50V	Q104	8-729-402-93	TRANSISTOR	UN5214-TX
C2001	1-163-038-00	CERAMIC CHIP	0.1uF	25V	Q162	8-729-101-07	TRANSISTOR	2SB798-DL
							< CONNECTOR >	
CN101	1-766-508-11	CONNECTOR, FFC/FPC (ZIF) 22P			Q163	8-729-403-35	TRANSISTOR	UN5113
CN102	1-770-072-11	CONNECTOR, FFC (LIF(NON-ZIF)) 23P			Q181	8-729-018-75	FET	2SJ278MY
CN103	1-784-865-01	CONNECTOR, FFC (LIF(NON-ZIF)) 13P			Q182	8-729-017-65	FET	2SK1764KY
* CN104	1-785-379-01	HOUSING, CONNECTOR 4P			Q401	8-729-402-42	TRANSISTOR	UN5213
CN105	1-784-833-41	CONNECTOR, FFC (LIF(NON-ZIF)) 21P			Q402	8-729-402-42	TRANSISTOR	UN5213
					Q403	8-729-402-42	TRANSISTOR	UN5213
							< RESISTOR >	
* CN106	1-695-441-21	PIN, CONNECTOR (PC BOARD) 7P			R103	1-216-049-11	RES,CHIP	1K 5% 1/10W
CN108	1-750-499-21	PIN, CONNECTOR (PC BOARD) 5P			R104	1-216-073-00	METAL CHIP	10K 5% 1/10W
* CN109	1-750-494-31	PIN, CONNECTOR (PC BOARD) 6P			R105	1-216-065-00	RES,CHIP	4.7K 5% 1/10W
* CN2000	1-750-078-11	HOUSING, CONNECTOR 3P			R106	1-216-133-00	METAL CHIP	3.3M 5% 1/10W
					R107	1-216-113-00	METAL CHIP	470K 5% 1/10W
					R110	1-216-073-00	METAL CHIP	10K 5% 1/10W
D101	8-719-988-62	DIODE 1SS355			R112	1-216-089-00	RES,CHIP	47K 5% 1/10W
D181	8-719-046-86	DIODE F1J6TP			R113	1-216-049-11	RES,CHIP	1K 5% 1/10W
D183	8-719-046-86	DIODE F1J6TP			R115	1-216-049-11	RES,CHIP	1K 5% 1/10W
					R117	1-216-113-00	METAL CHIP	470K 5% 1/10W
					R121	1-216-097-00	RES,CHIP	100K 5% 1/10W
					R125	1-216-049-11	RES,CHIP	1K 5% 1/10W
IC101	8-752-080-95	IC CXA2523AR			R131	1-216-073-00	METAL CHIP	10K 5% 1/10W
IC103	8-729-903-10	IC TRANSISTOR FMW1			R132	1-216-097-00	RES,CHIP	100K 5% 1/10W
IC121	8-752-389-44	IC CXD2654R			R133	1-216-117-00	METAL CHIP	680K 5% 1/10W
IC124	8-759-536-21	IC MSM51V4400D-10TSK-FS			R134	1-216-049-11	RES,CHIP	1K 5% 1/10W
IC152	8-759-430-25	IC BH6511FS-E2			R135	1-216-061-00	METAL CHIP	3.3K 5% 1/10W
					R136	1-216-049-11	RES,CHIP	1K 5% 1/10W
IC171	8-759-487-04	IC BR24C02F-E2			R137	1-216-025-00	RES,CHIP	100 5% 1/10W
IC172	8-759-040-83	IC BA6287F			R139	1-216-035-00	METAL CHIP	270 5% 1/10W
IC181	8-759-481-17	IC MC74ACT08DTR2			R140	1-216-029-00	METAL CHIP	150 5% 1/10W
IC191	8-759-460-72	IC BA033FP-E2			R142	1-216-073-00	METAL CHIP	10K 5% 1/10W
IC201	8-759-553-65	IC UDA1341TS/N2			R143	1-216-073-00	METAL CHIP	10K 5% 1/10W
					R144	1-216-025-00	RES,CHIP	100 5% 1/10W
IC316	8-759-578-36	IC M30624MG-205B			R145	1-216-073-00	METAL CHIP	10K 5% 1/10W
IC401	8-759-564-53	IC MC74HCU04ADTR2			R146	1-216-037-00	METAL CHIP	330 5% 1/10W
IC2000	8-759-195-81	IC TC7S86FU(TE85R)			R147	1-216-025-00	RES,CHIP	100 5% 1/10W
					R148	1-216-045-00	METAL CHIP	680 5% 1/10W
					R149	1-216-073-00	METAL CHIP	10K 5% 1/10W
					R151	1-216-073-00	METAL CHIP	10K 5% 1/10W
L008	1-500-445-21	FERRITE	0uH		R152	1-216-073-00	METAL CHIP	10K 5% 1/10W
L101	1-414-813-11	FERRITE	0uH		R153	1-216-043-00	RES,CHIP	560 5% 1/10W
L102	1-414-813-11	FERRITE	0uH		R158	1-216-097-00	RES,CHIP	100K 5% 1/10W
L103	1-414-813-11	FERRITE	0uH		R159	1-216-097-00	RES,CHIP	100K 5% 1/10W
L105	1-414-813-11	FERRITE	0uH		R161	1-216-057-00	METAL CHIP	2.2K 5% 1/10W
					R162	1-216-057-00	METAL CHIP	2.2K 5% 1/10W
L106	1-414-813-11	FERRITE	0uH		R163	1-216-057-00	METAL CHIP	2.2K 5% 1/10W
L121	1-414-813-11	FERRITE	0uH		R164	1-216-045-00	METAL CHIP	680 5% 1/10W
L122	1-414-813-11	FERRITE	0uH		R165	1-216-097-00	RES,CHIP	100K 5% 1/10W
L151	1-412-622-51	INDUCTOR	10uH		R166	1-220-149-11	REGISTER	2.2 10% 1/2W
L152	1-412-622-51	INDUCTOR	10uH					
L153	1-412-039-51	INDUCTOR CHIP	100uH					
L154	1-412-039-51	INDUCTOR CHIP	100uH					
L161	1-414-813-11	FERRITE	0uH					
L162	1-414-813-11	FERRITE	0uH					
L181	1-424-675-11	INDUCTOR	33uH					
L351	1-414-813-11	FERRITE	0uH					



## BD (MD)

## CD DISPLAY

## CD JOG

Ref. No.	Part No.	Description			Remark	Ref. No.	Part No.	Description	Remark				
R1002	1-216-001-00	METAL CHIP	10	5%	1/10W	< TRANSISTOR >							
R1003	1-216-001-00	METAL CHIP	10	5%	1/10W	Q601 8-729-620-05 TRANSISTOR 2SC2603-EF							
R2000	1-216-073-00	METAL CHIP	10K	5%	1/10W	< RESISTOR >							
R2001	1-216-073-00	METAL CHIP	10K	5%	1/10W	R631 1-247-807-31	CARBON	100	5%	1/4W			
< VIBRATOR >						R632 1-247-807-31	CARBON	100	5%	1/4W			
X101	1-579-870-21	VIBRATOR, CRYSTAL (22.5792MHz)				R633 1-247-807-31	CARBON	100	5%	1/4W			
X302	1-781-155-21	VIBRATOR, CERAMIC (10MHz)				R634 1-247-807-31	CARBON	100	5%	1/4W			
*****						R635 1-249-434-11	CARBON	27K	5%	1/4W			
* A-4724-390-A	CD DISPLAY BOARD, COMPLETE						R637 1-249-429-11	CARBON	10K	5%	1/4W		
*****						R638 1-249-417-11	CARBON	1K	5%	1/4W			
* 4-213-361-01	HOLDER (FL)	< SWITCH >						S636 1-762-875-21	SWITCH, KEYBOARD (DISPLAY)	*****			
* 4-955-901-01	CUSHION (FL)				*****			*****					
< CAPACITOR >						< CAPACITOR >							
C601	1-124-248-00	ELECT	22uF	20%	35V	* A-4724-393-A	CD JOG BOARD, COMPLETE			*****			
C602	1-124-584-00	ELECT	100uF	20%	10V	*****			*****				
C603	1-164-159-11	CERAMIC	0.1uF	50V		< CONNECTOR >			*****				
C604	1-164-159-11	CERAMIC	0.1uF	50V		C661 1-124-584-00	ELECT	100uF	20%	10V			
C605	1-162-306-11	CERAMIC	0.01uF	20%	16V	C662 1-163-038-00	CERAMIC CHIP	0.1uF	25V				
C606	1-162-282-31	CERAMIC	100PF	10%	50V	C663 1-163-251-11	CERAMIC CHIP	100PF	5%	50V			
C607	1-164-159-11	CERAMIC	0.1uF	50V		C664 1-163-251-11	CERAMIC CHIP	100PF	5%	50V			
C608	1-164-159-11	CERAMIC	0.1uF	50V		C665 1-163-251-11	CERAMIC CHIP	100PF	5%	50V			
C609	1-162-282-31	CERAMIC	100PF	10%	50V	< LED >			*****				
C610	1-162-282-31	CERAMIC	100PF	10%	50V	D661 8-719-056-13	LED	SML79423C-TP15 (CD1)	*****				
C611	1-162-282-31	CERAMIC	100PF	10%	50V	D662 8-719-056-13	LED	SML79423C-TP15 (CD2)	*****				
C617	1-136-177-00	FILM	1uF	5%	50V	D663 8-719-056-13	LED	SML79423C-TP15 (CD3)	*****				
C618	1-136-177-00	FILM	1uF	5%	50V	D664 8-719-056-13	LED	SML79423C-TP15 (CD4)	*****				
C621	1-162-288-31	CERAMIC	330PF	10%	50V	D665 8-719-056-13	LED	SML79423C-TP15 (CD5)	*****				
C622	1-162-282-31	CERAMIC	100PF	10%	50V	< IC >			*****				
C623	1-162-282-31	CERAMIC	100PF	10%	50V	IC661 8-759-448-24	IC	NJU3718G (TE2)	*****				
C624	1-162-282-31	CERAMIC	100PF	10%	50V	< RESISTOR >			*****				
C625	1-162-282-31	CERAMIC	100PF	10%	50V	R661 1-216-033-00	METAL CHIP	220	5%	1/10W			
C626	1-162-282-31	CERAMIC	100PF	10%	50V	R662 1-216-033-00	METAL CHIP	220	5%	1/10W			
C627	1-162-282-31	CERAMIC	100PF	10%	50V	R663 1-216-033-00	METAL CHIP	220	5%	1/10W			
C628	1-162-282-31	CERAMIC	100PF	10%	50V	R664 1-216-033-00	METAL CHIP	220	5%	1/10W			
C629	1-162-282-31	CERAMIC	100PF	10%	50V	R665 1-216-033-00	METAL CHIP	220	5%	1/10W			
C630	1-162-282-31	CERAMIC	100PF	10%	50V	< IC >			*****				
C631	1-162-282-31	CERAMIC	100PF	10%	50V	R666 1-216-029-00	METAL CHIP	150	5%	1/10W			
C632	1-162-282-31	CERAMIC	100PF	10%	50V	R667 1-216-029-00	METAL CHIP	150	5%	1/10W			
C633	1-162-282-31	CERAMIC	100PF	10%	50V	R668 1-216-029-00	METAL CHIP	150	5%	1/10W			
C634	1-162-282-31	CERAMIC	100PF	10%	50V	R669 1-216-029-00	METAL CHIP	150	5%	1/10W			
C635	1-162-282-31	CERAMIC	100PF	10%	50V	R670 1-216-029-00	METAL CHIP	150	5%	1/10W			
< CONNECTOR >						R671 1-216-041-00	METAL CHIP	470	5%	1/10W			
* CN602	1-770-642-11	CONNECTOR, FFC/FPC 11P	< FLUORESCENT INDICATOR >			R672 1-216-045-00	METAL CHIP	680	5%	1/10W			
FL601	1-517-820-11	INDICATOR TUBE, FLUORESCENT	< IC >			R673 1-216-049-11	RES,CHIP	1K	5%	1/10W			
IC601	8-759-297-23	IC M66004M8FP	< COIL >			R674 1-216-053-00	METAL CHIP	1.5K	5%	1/10W			
L601	1-410-521-11	INDUCTOR	100uH	< FLUORESCENT INDICATOR >			*****			*****			
L602	1-410-521-11	INDUCTOR	100uH	*****			*****			*****			

CD JOG

CD SW

CLAMP MOTOR

CONNECTOR

CONNECTOR (CD)

**DISC SW**

<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>	<u>Remark</u>		<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>	<u>Remark</u>				
R675	1-216-041-00	METAL CHIP	470	5%	1/10W	S613	1-771-544-11	SWITCH, TACTILE (CLEAR)	*****			
R676	1-216-045-00	METAL CHIP	680	5%	1/10W	*	1-671-507-11	CLAMP MOTOR BOARD	*****			
R677	1-216-049-11	RES,CHIP	1K	5%	1/10W				< CAPACITOR >			
R678	1-216-053-00	METAL CHIP	1.5K	5%	1/10W	C701	1-162-306-11	CERAMIC	0.01uF	20%	16V	
R679	1-216-057-00	METAL CHIP	2.2K	5%	1/10W	C702	1-126-964-11	ELECT	10uF	20%	50V	
R681	1-216-025-00	RES,CHIP	100	5%	1/10W	C711	1-162-306-11	CERAMIC	0.01uF	20%	16V	
R682	1-216-025-00	RES,CHIP	100	5%	1/10W				< CONNECTOR >			
R683	1-216-025-00	RES,CHIP	100	5%	1/10W	CN712	1-506-469-11	PIN, CONNECTOR 4P				
R684	1-216-025-00	RES,CHIP	100	5%	1/10W				< DIODE >			
R685	1-216-097-00	RES,CHIP	100K	5%	1/10W	D701	8-719-983-66	DIODE MTZJ-T-72-3.6B				
									< IC >			
						IC701	8-759-633-65	IC M54641L				
									< RESISTOR >			
						R701	1-249-411-11	CARBON	330	5%	1/4W	
						R702	1-249-401-11	CARBON	47	5%	1/4W	
									*****			
*	A-4724-396-A	CD SW BOARD, COMPLETE				*	1-671-818-11	CONNECTOR BOARD				
									*****			
									< CONNECTOR >			
CN601	1-750-498-11	PIN, CONNECTOR (PC BOARD) 4P				CN691	1-784-743-11	CONNECTOR, FFC 21P				
						CN692	1-764-311-11	PIN, CONNECTOR (PC BOARD) 12P				
						CN693	1-774-758-11	CONNECTOR, FFC/FPC 11P				
						*	CN694	1-564-720-11	PIN, CONNECTOR (SMALL TYPE) 4P			
						CN695	1-506-486-11	PIN, CONNECTOR 7P				
									*****			
									< CONNECTOR >			
						CN701	1-568-860-11	SOCKET, CONNECTOR 17P				
									< TRANSISTOR >			
						Q701	8-729-029-66	TRANSISTOR DTC114ESA				
									< RESISTOR >			
						R707	1-249-424-11	CARBON	3.9K	5%	1/4W	
						R708	1-249-417-11	CARBON	1K	5%	1/4W	
						R709	1-249-429-11	CARBON	10K	5%	1/4W	
									*****			
						*	1-671-472-11	DISC SW BOARD				
									*****			
									< CONNECTOR >			
									< CONNECTOR >			
						*	CNP14	1-568-826-11	SOCKET, CONNECTOR 7P			

DISC SW

ELEVATOR RELAY

HEAD RELAY

HEAD SW

INIT/COUNT SW

IN SW

LOAD MOTOR

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
		< SWITCH >		*	1-671-470-11	HEAD RELAY BOARD	*****
S1	1-771-225-12	SWITCH, LEVER (DISC 1)					
S2	1-771-225-12	SWITCH, LEVER (DISC 2)					< CAPACITOR >
S3	1-771-225-12	SWITCH, LEVER (DISC 3)		C4	1-101-005-00	CERAMIC	22000PF 50V
S4	1-771-225-12	SWITCH, LEVER (DISC 4)		C5	1-101-005-00	CERAMIC	22000PF 50V
S5	1-771-225-12	SWITCH, LEVER (DISC 5)					
*****							
*	1-671-469-11	ELEVATOR RELAY BOARD	*****				< CONNECTOR >
*	1-535-303-00	WIRE, JUMPER		*	1-671-471-11	HEAD SW BOARD	*****
		< CAPACITOR >					
C1	1-126-382-11	ELECT	100uF	20%	6.3V		< CONNECTOR >
C570	1-163-063-00	CERAMIC CHIP	0.022uF		50V		
C571	1-115-871-11	ELECT	1uF	20%	50V		* CNP18 1-564-705-11 PIN, CONNECTOR (SMALL TYPE) 3P
C572	1-163-063-00	CERAMIC CHIP	0.022uF		50V		
		< CONNECTOR >					< SWITCH >
* CN570	1-568-832-11	SOCKET, CONNECTOR 13P		S6	1-771-495-11	SWITCH, PUSH (DETECTION) (HEAD UP)	
* CN571	1-568-848-11	SOCKET, CONNECTOR 5P		S7	1-771-495-11	SWITCH, PUSH (DETECTION) (HEAD DOWN)	
* CN572	1-568-848-11	SOCKET, CONNECTOR 5P					
		< IC >					
IC570	8-759-982-73	IC BA10393F					< SWITCH >
		< PHOTO INTERRUPTER >		S705	1-771-264-11	SWITCH, PUSH(DETECTION)(1 KEY) (INIT)	
PH570	8-749-012-33	PHOTO INTERRUPTER GP1S94		S706	1-771-264-11	SWITCH, PUSH(DETECTION)(1 KEY) (COUNT)	
PH571	8-749-012-33	PHOTO INTERRUPTER GP1S94					
		< TRANSISTOR >					
Q570	8-729-030-02	TRANSISTOR DTC144ESA					< CONNECTOR >
		< RESISTOR >		*	CN710	1-568-941-11	PIN, CONNECTOR 3P
R570	1-216-224-00	RES,CHIP	12K	5%	1/8W		< SWITCH >
R571	1-216-218-00	RES,CHIP	6.8K	5%	1/8W		
R572	1-216-238-00	RES,CHIP	47K	5%	1/8W		S703 1-771-218-11 SWITCH, MICRO (MID IN)
R573	1-216-230-00	RES,CHIP	22K	5%	1/8W		S704 1-771-218-11 SWITCH, MICRO (IN)
R574	1-216-230-00	RES,CHIP	22K	5%	1/8W		
R575	1-216-230-00	RES,CHIP	22K	5%	1/8W		* 1-671-508-11 LOAD MOTOR BOARD
R576	1-216-230-00	RES,CHIP	22K	5%	1/8W		*****
R577	1-216-188-00	RES,CHIP	390	5%	1/8W		
R578	1-216-188-00	RES,CHIP	390	5%	1/8W		< CAPACITOR >
R579	1-216-296-00	SHORT	0				
		< SWITCH >					
S570	1-771-225-12	SWITCH, LEVER (HOME)					
S571	1-771-225-12	SWITCH, LEVER (RESET)					< DIODE >
*****							
D702	8-719-109-85	DIODE RD5.1ES-B2					
		< IC >					
IC702	8-759-633-65	IC M54641L					









# MICROCOMPUTER

Ref. No.	Part No.	Description		Remark	Ref. No.	Part No.	Description		Remark
<p>&lt; CONNECTOR &gt;</p> <p>CN300 1-784-741-11 CONNECTOR, FFC 19P          CN301 1-784-739-11 CONNECTOR, FFC 17P          CN303 1-784-743-11 CONNECTOR, FFC 21P          * CN304 1-568-948-11 PIN, CONNECTOR 10P          * CN305 1-568-946-11 PIN, CONNECTOR 8P          * CN306 1-568-946-11 PIN, CONNECTOR 8P</p> <p>&lt; DIODE &gt;</p> <p>D222 8-719-210-33 DIODE EC10DS2          D223 8-719-210-33 DIODE EC10DS2          D301 8-719-210-33 DIODE EC10DS2          D302 8-719-210-33 DIODE EC10DS2          D303 8-719-988-62 DIODE 1SS355            D304 8-719-988-62 DIODE 1SS355          D305 8-719-988-62 DIODE 1SS355          D307 8-719-988-62 DIODE 1SS355          D309 8-719-988-62 DIODE 1SS355          D310 8-719-988-62 DIODE 1SS355            D341 8-719-210-33 DIODE EC10DS2</p> <p>&lt; FERRITE BEAD &gt;</p> <p>FB300 1-410-396-41 FERRITE 0.45uH          FB341 1-410-396-41 FERRITE 0.45uH</p> <p>&lt; IC &gt;</p> <p>IC300 8-759-577-07 IC uPD784215AYGF-502-3BA          IC301 8-759-165-82 IC PST600E-T          IC302 8-759-557-09 IC M5M5256DFP-70XL-TR7          IC304 8-759-035-87 IC SC7S00F</p> <p>&lt; SHORT &gt;</p> <p>JW300 1-216-295-00 SHORT 0          JW302 1-216-295-00 SHORT 0</p> <p>&lt; COIL &gt;</p> <p>L301 1-410-482-31 INDUCTOR 100uH          L341 1-408-397-00 INDUCTOR 1uH          L342 1-410-682-31 INDUCTOR 470uH</p> <p>&lt; TRANSISTOR &gt;</p> <p>Q300 8-729-421-19 TRANSISTOR UN2213          Q301 8-729-120-28 TRANSISTOR 2SC1623-L5L6          Q341 8-729-120-28 TRANSISTOR 2SC1623-L5L6</p> <p>&lt; RESISTOR &gt;</p> <p>R300 1-216-065-00 RES,CHIP 4.7K 5% 1/10W          R301 1-216-073-00 METAL CHIP 10K 5% 1/10W          R302 1-216-065-00 RES,CHIP 4.7K 5% 1/10W          R303 1-216-089-00 RES,CHIP 47K 5% 1/10W          R304 1-216-089-00 RES,CHIP 47K 5% 1/10W            R305 1-216-065-00 RES,CHIP 4.7K 5% 1/10W          R307 1-216-049-11 RES,CHIP 1K 5% 1/10W          R311 1-216-017-00 RES,CHIP 47 5% 1/10W          R312 1-216-017-00 RES,CHIP 47 5% 1/10W          R313 1-216-025-00 RES,CHIP 100 5% 1/10W</p> <p>R314 1-216-065-00 RES,CHIP 4.7K 5% 1/10W          R315 1-216-065-00 RES,CHIP 4.7K 5% 1/10W          R316 1-216-073-00 METAL CHIP 10K 5% 1/10W          R317 1-216-073-00 METAL CHIP 10K 5% 1/10W          R318 1-216-025-00 RES,CHIP 100 5% 1/10W            R327 1-216-097-00 RES,CHIP 100K 5% 1/10W          R331 1-216-097-00 RES,CHIP 100K 5% 1/10W          R332 1-216-097-00 RES,CHIP 100K 5% 1/10W          R333 1-216-097-00 RES,CHIP 100K 5% 1/10W          R341 1-216-025-00 RES,CHIP 100 5% 1/10W            R342 1-216-025-00 RES,CHIP 100 5% 1/10W          R343 1-216-025-00 RES,CHIP 100 5% 1/10W          R344 1-216-025-00 RES,CHIP 100 5% 1/10W          R345 1-216-025-00 RES,CHIP 100 5% 1/10W          R346 1-216-025-00 RES,CHIP 100 5% 1/10W            R347 1-216-025-00 RES,CHIP 100 5% 1/10W          R348 1-216-025-00 RES,CHIP 100 5% 1/10W          R349 1-216-025-00 RES,CHIP 100 5% 1/10W          R350 1-216-049-11 RES,CHIP 1K 5% 1/10W          R351 1-216-025-00 RES,CHIP 100 5% 1/10W            R352 1-216-025-00 RES,CHIP 100 5% 1/10W          R353 1-216-025-00 RES,CHIP 100 5% 1/10W          R354 1-216-025-00 RES,CHIP 100 5% 1/10W          R355 1-216-025-00 RES,CHIP 100 5% 1/10W          R356 1-216-025-00 RES,CHIP 100 5% 1/10W            R357 1-216-025-00 RES,CHIP 100 5% 1/10W          R358 1-216-025-00 RES,CHIP 100 5% 1/10W          R359 1-216-025-00 RES,CHIP 100 5% 1/10W          R360 1-216-025-00 RES,CHIP 100 5% 1/10W          R361 1-216-025-00 RES,CHIP 100 5% 1/10W            R362 1-216-025-00 RES,CHIP 100 5% 1/10W          R363 1-216-073-00 METAL CHIP 10K 5% 1/10W          R364 1-216-073-00 METAL CHIP 10K 5% 1/10W          R365 1-216-073-00 METAL CHIP 10K 5% 1/10W          R366 1-216-073-00 METAL CHIP 10K 5% 1/10W            R367 1-216-073-00 METAL CHIP 10K 5% 1/10W          R368 1-216-073-00 METAL CHIP 10K 5% 1/10W          R369 1-216-073-00 METAL CHIP 10K 5% 1/10W          R370 1-216-073-00 METAL CHIP 10K 5% 1/10W          R371 1-216-073-00 METAL CHIP 10K 5% 1/10W            R372 1-216-025-00 RES,CHIP 100 5% 1/10W          R373 1-216-025-00 RES,CHIP 100 5% 1/10W          R374 1-216-025-00 RES,CHIP 100 5% 1/10W          R375 1-216-073-00 METAL CHIP 10K 5% 1/10W          R376 1-216-295-00 SHORT 0            R381 1-216-025-00 RES,CHIP 100 5% 1/10W          R382 1-216-025-00 RES,CHIP 100 5% 1/10W          R383 1-216-025-00 RES,CHIP 100 5% 1/10W          R384 1-216-025-00 RES,CHIP 100 5% 1/10W          R385 1-216-025-00 RES,CHIP 100 5% 1/10W            R386 1-216-025-00 RES,CHIP 100 5% 1/10W          R387 1-216-025-00 RES,CHIP 100 5% 1/10W          R388 1-216-025-00 RES,CHIP 100 5% 1/10W          R389 1-216-025-00 RES,CHIP 100 5% 1/10W          R390 1-216-025-00 RES,CHIP 100 5% 1/10W            R391 1-216-061-00 METAL CHIP 3.3K 5% 1/10W          R392 1-216-061-00 METAL CHIP 3.3K 5% 1/10W          R393 1-216-061-00 METAL CHIP 3.3K 5% 1/10W       </p>									

MICROCOMPUTER			OUT SW		RELAY		SENSOR	
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Ref. No.	Part No.	Description		Remark	Ref. No.	Part No.	Description	Remark	
R394	1-216-065-00	RES,CHIP	4.7K	5%	1/10W		< CONNECTOR >		
R395	1-216-065-00	RES,CHIP	4.7K	5%	1/10W		CN401	1-564-723-11 PIN, CONNECTOR (SMALL TYPE) 7P	
		< VIBRATOR >					CN451	1-784-745-11 CONNECTOR, FFC 23P	
X300	1-579-352-11	VIBRATOR, CERAMIC (12.5MHz)					CN453	1-779-203-11 CONNECTOR, FFCC/FPC 13P	
							CN454	1-779-203-11 CONNECTOR, FFCC/FPC 13P	
*	1-671-503-11	OUT SW BOARD				* CN455	1-766-953-11 CONNECTOR, BOARD TO BOARD 15P		
		*****						< GROUND TERMINAL >	
		< CONNECTOR >						EP401	1-537-771-21 TERMINAL BOARD, GROUND
* CN709	1-568-943-11	PIN, CONNECTOR 5P						< COIL >	
CN715	1-506-481-11	PIN, CONNECTOR 2P						FB401	1-410-396-41 INDUCTOR 0.45uH
		< SWITCH >						< PHOTO COUPLER/IC >	
S701	1-771-218-11	SWITCH, MICRO (MID OUT)						IC401	8-749-015-19 PHOTO COUPLER ON3131-SA.S0
S702	1-771-218-11	SWITCH, MICRO (LID)						IC402	8-749-015-19 PHOTO COUPLER ON3131-SA.S0
S708	1-771-218-11	SWITCH, MICRO (OUT)						IC451	8-759-481-02 IC M62016L
		*****						< COIL >	
*	A-4724-392-A	RELAY BOARD, COMPLETE						L451	1-408-117-00 INDUCTOR 10uH
		*****						L452	1-408-117-00 INDUCTOR 10uH
		< CAPACITOR >						< TRANSISTOR >	
C420	1-162-294-31	CERAMIC	0.001uF	10%	50V			Q400	8-729-900-80 TRANSISTOR DTC114ES
C421	1-162-157-11	ELECT	10uF	20%	16V			Q401	8-729-141-30 TRANSISTOR 2SC3623A-LK
C422	1-162-157-11	ELECT	10uF	20%	16V			Q403	8-729-900-80 TRANSISTOR DTC114ES
C451	1-124-252-00	ELECT	0.33uF	20%	50V			Q404	8-729-119-78 TRANSISTOR 2SC403SP-51
C452	1-164-159-11	CERAMIC	0.1uF		50V				
								< RESISTOR >	
C453	1-124-584-00	ELECT	100uF	20%	10V			R403	1-249-417-11 CARBON 1K 5% 1/4W
C454	1-162-294-31	CERAMIC	0.001uF	10%	50V			R404	1-247-807-31 CARBON 100 5% 1/4W
C455	1-126-176-11	ELECT	220uF	20%	10V			R406	1-249-404-00 CARBON 82 5% 1/4W
C456	1-126-176-11	ELECT	220uF	20%	10V			R407	1-249-441-11 CARBON 100K 5% 1/4W
C457	1-162-306-11	CERAMIC	0.01uF	20%	16V			R409	1-249-408-11 CARBON 180 5% 1/4W
								R410	1-249-429-11 CARBON 10K 5% 1/4W
C458	1-124-589-11	ELECT	47uF	20%	16V			R411	1-249-429-11 CARBON 10K 5% 1/4W
C459	1-126-176-11	ELECT	220uF	20%	10V			R412	1-249-409-11 CARBON 220 5% 1/4W
C460	1-162-306-11	CERAMIC	0.01uF	20%	16V			R413	1-249-409-11 CARBON 220 5% 1/4W
C461	1-162-294-31	CERAMIC	0.001uF	10%	50V			R415	1-249-425-11 CARBON 4.7K 5% 1/4W
C462	1-162-306-11	CERAMIC	0.01uF	20%	16V			R420	1-249-395-11 CARBON 15 5% 1/4W
								R451	1-249-429-11 CARBON 10K 5% 1/4W
C463	1-162-306-11	CERAMIC	0.01uF	20%	16V			R463	1-249-421-11 CARBON 2.2K 5% 1/4W
C464	1-162-306-11	CERAMIC	0.01uF	20%	16V			R464	1-249-421-11 CARBON 2.2K 5% 1/4W
C465	1-162-306-11	CERAMIC	0.01uF	20%	16V			R465	1-249-421-11 CARBON 2.2K 5% 1/4W
C466	1-126-176-11	ELECT	220uF	20%	10V			R470	1-249-395-11 CARBON 15 5% 1/4W
C467	1-164-159-11	CERAMIC	0.1uF		50V			R472	1-249-393-11 CARBON 10 5% 1/4W
								R473	1-249-413-11 CARBON 470 5% 1/4W
								*****	
C468	1-164-159-11	CERAMIC	0.1uF		50V				
C469	1-136-177-00	FILM	1uF	5%	50V				
C470	1-162-294-31	CERAMIC	0.001uF	10%	50V				
C471	1-126-157-11	ELECT	10uF	20%	16V				
C472	1-126-157-11	ELECT	10uF	20%	16V				
C473	1-164-159-11	CERAMIC	0.1uF		50V				
C474	1-162-294-31	CERAMIC	0.001uF	10%	50V	*	1-671-504-11	SENSOR BOARD	
C475	1-164-159-11	CERAMIC	0.1uF		50V			*****	
C476	1-162-199-31	CERAMIC	10PF	5%	50V				
C477	1-162-294-31	CERAMIC	0.001uF	10%	50V			< CONNECTOR >	
C479	1-164-159-11	CERAMIC	0.1uF		50V	CN708	1-506-481-11	PIN, CONNECTOR 2P	
C480	1-164-159-11	CERAMIC	0.1uF		50V				
C481	1-162-282-31	CERAMIC	100PF	10%	50V				

**SENSOR**    **SENSOR 2**    **SW**    **WM**

<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>			<u>Remark</u>
		< LED >			
D704	8-719-055-84	LED	GL-528VS1	(DISC IN DETECT SENSOR)	
		< RESISTOR >			
R711	1-249-415-11	CARBON	680	5%	1/4W
*****					
*	1-671-789-11	SENSOR 2 BOARD	*****		
		*****			

	4-964-461-02	HOLDER (SENSOR)
	< TRANSISTOR >	
Q703	8-729-926-31	PHOTO TRANSISTOR PT483F1S
*****		

*	1-671-467-11	SW BOARD
	*****	
		< CONNECTOR >
* CN206	1-750-494-31	PIN, CONNECTOR (PC BOARD) 6P
		< SWITCH >
S681	1-572-467-61	SWITCH, PUSH (1 KEY) (LIMIT)
S682	1-692-377-31	SWITCH, PUSH (1 KEY) (REFLECT)
S683	1-692-847-21	SWITCH, PUSH (1 KEY) (PROTECT)
*****		

*	1-671-822-11	WM BOARD
	*****	
		< CAPACITOR >
C1	1-163-009-11	CERAMIC CHIP
C2	1-163-009-11	CERAMIC CHIP
C3	1-163-009-11	CERAMIC CHIP
C4	1-163-009-11	CERAMIC CHIP
		< CONNECTOR >
CL1	1-690-880-81	LEAD (WITH CONNECTOR)
CN1	1-778-529-11	PIN, CONNECTOR (PC BOARD) 7P
		< JACK >
J1	1-785-382-21	JACK, MINIATURE (+ CONNECTOR) 4P (MD WALKMAN LINK)
		< SHORT >

R1	1-216-295-00	SHORT	0
R2	1-216-295-00	SHORT	0

3	1-790-267-11	WIRE (FLAT TYPE) (19 CORE)
5	1-773-181-11	WIRE (FLAT TYPE) (23 CORE)
6	1-790-263-11	WIRE (FLAT TYPE) (13 CORE) (130mm)
73	1-790-265-12	WIRE (FLAT TYPE) (11 CORE)
79	1-790-264-11	WIRE (FLAT TYPE) (13 CORE) (179mm)
103	1-790-268-11	WIRE (FLAT TYPE) (21 CORE)

The components identified by mark **▲** or dotted line with mark **▲** are critical for safety.  
Replace only with part number specified.